

INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF POWER LINE CARRIER FREQUENCY-SHIFT RECEIVER EQUIPMENT-TRANSFER TRIP.

Caution: It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet and in the system instruction leaflet before energizing the system.

Printed circuit modules should not be removed or inserted when the relay is energized. Failure to observe this precaution can result in an undesired tripping output and cause component damage.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF frequency-shift receiver equipment as adapted for transfer-trip applications responds to carrier-frequency signals transmitted from the distant end of a power line and carried on the power line conductors. The Guard signal is transmitted continuously when conditions are normal. Its reception indicates that the channel is operative and that there is no fault in the protected equipment. The Guard frequency is 100 hertz above the center frequency of the channel. When a fault occurs at the distant end of the power line protective relays switch the transmitter located there to a Trip frequency, 100 hertz below the center frequency, and may also increase the power output of the transmitter (from 1 watt to 10 watts).

The reception of Trip frequency within a fixed interval after disappearance of the Guard frequency causes the energization of a high-speed electro-mechanical relay which closes the breaker trip circuit. If trip frequency is not received within this interval, the channel is not operating normally and a second relay closes contacts to sound an alarm. Simultaneously, the Trip relay is locked out so that a spurious Trip signal resulting later from line noise cannot cause false tripping. Other circuitry, described under OPERATION, provides security against false tripping caused by severe line noise that overrides a normal Guard signal and produces a spurious Trip signal.

CONSTRUCTION

The TCF receiver unit for transfer-trip applications is mounted on a standard 19-inch wide panel 10½ inches high (6 rack units) with edge slots for mounting on a standard relay rack. All components are mounted at the rear of the panel. Fuses, a pilot light, a power switch, an input attenuator, a jack for metering the discriminator output current, and the control for the adjustable time delay in the logic circuit are accessible from the front of the panel. See Fig. No. 14

All of the circuitry that is suitable for mounting on printed circuit boards is contained in an enclosure that projects from the rear of the panel and is accessible by opening a hinged door on the front of the panel. Other components on the rear of the panel are located as shown on Fig. No. 6. Reference to the internal schematic connections on Fig. 1 will show the location of these components in the circuit. The dotted lines enclosing separate areas of Fig. 1 indicate that the components thus enclosed are all on the same printed circuit board.

The enclosure that contains the printed circuit boards is divided into seven compartments. The partitions between compartments together with the outer walls of the enclosure provide complete shielding between adjacent boards and from external fields. Frequency shift receivers for transfer-trip relaying utilize all compartments if a carrier level indicator is provided. If this is omitted, the compartment on the extreme right, front view, is left vacant. In frequency shift receivers for applications other than transfer-trip relaying, the logic circuitry is not required and the fifth compartment from the left is vacant in such cases.

The printed circuit boards slide into position in slotted guides at the top and bottom of each compartment, and the board terminals engage a terminal block at the rear of the compartment. Each board and

terminal block are keyed so that if a board is placed in the wrong compartment, it cannot be inserted into the terminal block. A handle on the front of each board is labeled to identify its function in the circuit.

A board extender (Style No. 644B315G01) is available for facilitating circuit voltage measurements or major adjustments. After withdrawing any one of the circuit boards, the extender is inserted in that compartment. The board then is inserted into the terminal block on the front of the extender. This restores all circuit connections, and all components and test points on the board are readily accessible.

A portion of the receiver operates from a regulated 20 VDC supply, and the remainder from a regulated 45 V.D.C. supply. These voltages are taken from two Zener diodes mounted on a common heat sink. Variation of the resistance value between the positive side of the unregulated D.C. supply and the 45 volt Zener adapt the receiver for operation on 48, 125, or 250 V.D.C.

External connections to the receiver are made through a 24-circuit receptacle, J3 (see Fig. 1). The r-f input connection to the receiver is made through a coaxial cable jack, J2.

OPERATION

Input Control

The signals to which the TCF receiver responds are received through a coaxial cable connected to jack J2 of Fig. No. 1. Resistor R4 and 20-volt Zener diodes CR1 and CR2 protect the receiver from abnormally high voltages received through the coaxial cable. Input attenuator R5 reduces the signal to a level suitable for best operation of the receiver. The attenuator is adjustable from the front of the panel and can be clamped at the desired setting. A scale on the panel is graduated in db. While this scale is typical rather than individually calibrated, it is accurate within one or two db. and is useful in setting approximate levels. Settings should be made by observation of the db. scale of a suitable a-c voltmeter when possible.

Crystal Filter

From the attenuator, the signal passes through a crystal filter, FL1. This filter has a narrow pass band, and frequencies several hundred cycles above

or below the center frequency (f_c) of the channel are greatly attenuated. Fig. 4 shows a typical curve for the crystal filter, as well as a characteristic curve for the intermediate frequency filter, FL2, and for the discriminator output. The narrow pass band of FL1 permits close spacing of channel frequencies and reduces the possibility of false operation caused by spurious signals such as may result from arcing disconnects or corona discharge.

Oscillator and Mixer

From the crystal filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, or IC201 (Fig. 16) and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20 kHz above the channel frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of FL1 is impressed on the emitter-collector circuit of Q11. As the result of mixing these two frequencies, the primary of transformer T12 will contain frequencies of $*20\text{kHz}$, $2f_c + 20\text{kHz}$, $f_c + 20\text{kHz}$ and f_c .

IF Amplifier

The output from the secondary of T12 is amplified by Q31, in the intermediate frequency amplifier stage, and is impressed on filter FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. While its passband is much wider than that of the crystal filter, it eliminates the frequencies present at its input that are substantially higher than 20kHz.

Amplifier and Limiter

The output from the second section of the IF amplifier stage is fed to potentiometer R52 at the input of the amplifier and limiter stage. Sufficient input is taken from R52 so that with minimum input signal (5 mv.) at J2 and with R5 set for zero attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

Discriminator

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at $f_c - 25$ hertz. The adjustment for zero output at $f_c + 25$ hertz is made by capacitor C88. C83 also is ad-

justed to obtain a maximum voltage reading across R84 when the current output is zero. Maximum current output, of opposite polarities, will be obtained when the frequency is 100 hertz above or below the zero output frequency. This separation of 200 hertz between the current peaks is affected by the value of C86, (the actual value of which may be changed slightly from its typical value in factory calibration if required.)

The purpose of offsetting the zero output frequency of the discriminator by 25 hertz in the Trip direction is to reduce the band of noise-generated trip frequencies (between the discriminator center frequency and the skirt of the FL1 filter), and to similarly increase the band of noise-generated frequencies on the Guard side of the discriminator center. It should be observed that although Guard frequency is $f_c + 100$ hertz, after leaving the mixer stage and as seen by the discriminator the Guard frequency is 20 kHz-100 hertz. Similarly, the Trip frequency is 20 kHz + 100 hertz. The intermediate frequency at which the discriminator has zero output then is 20.025 kHz.

The discriminator output is connected to the bases of transistors Q81 and Q82 in such manner that Q82 is made conductive when current flows out of terminal 4 (which occurs with trip output) and Q81 is made conductive when current flows into terminal 4. Consequently, terminal 15 is at a potential of approximately +20 volts at Guard frequency and terminal 11 is at +20 volts at Trip frequency. These two outputs feed the logic circuit board, and through it they control the operation of the loss-of-channel alarm relay, AL, and the Trip relay, AR.

As a means of increasing further the security of the receiver against false tripping on noise-generated Trip frequencies, diode CR84 is connected in the emitter circuit of Q82. This requires an increase of three or four db. in the minimum Trip signal that will pick up the Trip relay. However, when the transmitter is keyed to Trip, its output is increased by 10 db. to assure the reliability of tripping at times of severe channel deterioration or simultaneous noise conditions, and this amply compensates for the reduction of Trip sensitivity caused by diode CR84. For applications where severe noise conditions or channel deterioration are not encountered, a TCF transmitter with 1 watt output rather than 10 watts can be supplied. If in such installations it is found desirable to increase the reliability of tripping, a jumper may be connected across diode CR84.

Logic Circuits

The logic stage of the receiver employs static circuitry that permits elimination of separate guard and lockout relays but provides all of the function of these relays as well as a unique method for minimizing the effect of noise signals. The block diagram of the logic circuits is shown on Fig. 3. When the discriminator receives Guard signal, its output terminal (15) supplies positive potential to blocks A, D, and F on the block diagram. Block A represents R108, C101 and CR104 of Fig. 1. Capacitor C101 will charge in approximately 120 milliseconds to the breakdown voltage of Zener CR104 and block C (transistor Q102) then will receive input #1. The function of Q101 is not indicated on the block diagram, but it discharges C101 quickly when Guard signal disappears, so that the full 120 ms. delay is obtained on closely repetitive appearances of Guard signal. This avoids cancellation of a loss-of-channel alarm by noise-produced Guard signal.

When Q102 (block C) receives input #1 or #2, it is made conductive and capacitor C102 receives no charge. Q103 is non-conductive since it receives no base input through CR105, and its collector is held at approximately 10 volts by the voltage divider effect of R131 and R136. Note that under this condition, input #1 to block K is supplied. If Guard signal should disappear but be followed promptly by appearance of Trip signal, the trip input fed through R102 will not be diverted through CR102 to the collector of Q103 but will flow through CR101 to the base of Q102 to keep it conductive. However, if Guard signal disappears and Trip signal does not appear in approximately 150 ms., C102 will charge to the breakdown point of CR105, making Q103 conductive. This will remove base input from Q104 and the alarm relay will drop out, sounding the alarm through its normally-closed contacts. (The copper slug on the alarm relay adds an additional delay of approximately 40 ms. before the alarm contacts close.) When Q103 becomes conductive, the saturation voltage at its collector is so low that any current flowing through R102 as a result of a subsequent Trip signal will be diverted through Q103 to negative instead of flowing through CR101 and the base-emitter junction of Q102. If Guard signal reappears, the discriminator output at term. 15 will turn Q101 off. C101 will charge and after 120 ms. it will reach the breakdown voltage of CR104 and turn Q102 on. This will allow C102 to quickly discharge through R123 and Q102 and provide the full 150 ms. time delay to be effective on any subsequent loss of guard signal.

Guard signal also produces input to transistor Q109 (block D). With base input to Q109 it has negligible voltage on its collector, but if Guard signal is lost capacitor C104 will charge to the breakdown voltage of CR113 in a time ranging from about 2 to 20 ms., as determined by the setting of R7. This time delay also is quickly reset on reappearance of Guard signal, as C104 discharges through R114, CR113 and Q109. Transistors Q110 and Q111 are a part of logic block I. When C104 reaches the conduction voltage of CR113, Q110 conducts and removes base input from Q111. This raises the voltage on the collector of Q111 to about 15 volts, which constitutes input #2 to block K. The purpose of logic blocks D and I is to provide an adjustable delay between the loss of Guard signal and the pickup of the Trip relay. It is possible that a noise burst might momentarily cancel the Guard signal and produce a spurious Trip signal. Provision of this adjustable delay provides a considerable degree of protection against such incorrect operations. Resistor R7 is adjustable by means of a knob on the front of the panel, and the knob can be clamped at any desired setting.

When Trip signal appears, input is fed to transistor Q106 (block E) through R119. Under this condition Q106 becomes conducting and does not supply input #1 to Q107 (block J). If input #2 (supplied through R115) also is lacking for Q107, the latter is non-conductive and its collector voltage is approximately 15 volts. This constitutes input #3 to AND block K. Block K is a three-input diode-AND, with the inputs contributed by the collectors of transistors Q103, Q107 and Q111. When one or more of these transistors is conducting, input fed from the 45 volt supply through R138 cannot reach the base of Q108 to cause pickup of the Trip relay because the voltage drop across any of the three diodes plus the saturation resistance of a transistor is substantially less than the voltage drop across one diode (CR110) plus the base-emitter voltage required to make Q108 conductive.

The logic blocks F and G provide further protection against incorrect tripping under noise conditions. Transistor Q105 is represented by block F; and diode CR107; capacitor C103 and resistor R115 are represented by block G. Q105 receives input from either Trip or Guard signals through R101 or R106, and when either signal is present its collector voltage is a small fraction of a volt. When the transmitter is shifted from Guard to Trip by closure of a protective relay contact, the dis-

criminator shifts its outputs very rapidly and the interval during which there is no input to Q105 is only 1.5 to 2.0 ms. Most of the charge that builds up in C103 during this interval flows to the base of Q107 and keeps it conducting after the appearance of Trip signal has removed the input through R125. However, this delay has approximately the same duration as the minimum delay obtained from block I and thus does not increase the minimum overall time for tripping following a legitimate Trip signal.

At times when severe random noise is present, such as might be produced by opening a nearby disconnect switch, the noise-produced signal may override the Guard signal and produce a discriminator output that no longer has a constant Guard output but rapidly fluctuates between Guard and Trip (and beyond). There will be relatively long periods when the discriminator has neither Guard nor Trip output. At such times capacitor C103 may approach or reach its maximum voltage, thereby keeping Q107 conducting for 40 to 50 ms. Also, because of the quick reset feature of logic block I, intermittent reappearance of Guard signal during noise will fully reactivate the time delay for which it has been set. If a fault should occur and Trip frequency be transmitted at a time when high level noise frequencies are present, tripping may be somewhat delayed but will be accomplished before the cessation of noise unless conditions are extremely severe. The recommended 10 db. increase of transmitter output level at Trip frequency minimizes such delay.

It may appear that the function of block E in the logic diagram is duplicated by block F and could have been omitted. This is correct when the time constants are as normally supplied, but block E was retained to make the circuit adaptable to possible extreme conditions with minimum change.

In summary, the logic circuit provides the following functions:

1. Energizes alarm in case of loss of signal.
2. Prevents cancellation of an alarm by noise-produced signal.
3. Allows tripping upon reception of legitimate Trip signal.
4. Prevents tripping if channel is not operative immediately prior to reception of Trip signal.
5. Minimizes effect of noise-produced signals by utilizing noise characteristics to introduce additional Trip delay.

Output Circuits

The output stage of the receiver contains the alarm relay (AL) and the tripping relay (AR). Either relay is energized from the regulated 45 volt supply when the logic circuit has determined that the existing conditions require such operation. The AL relay is a telephone type relay with a copper slug on the end of the core opposite the armature. It has two sets of Form C contacts, all points of which are connected to terminals of jack J3. The AR relay has two normally-open and two normally-closed contacts. The two sets of normally-open contacts and one set of normally-closed contacts are connected to terminals of jack J3. The AR relay has been designed to provide very high speed operation with negligible contact bounce. While normally it is energized only briefly, it will not be damaged by continuous energization.

Carrier Level Indicator (When Supplied)

With the logic circuit connections shown on Fig. 1, the AL relay closes contacts to energize an alarm when there is absence of both Guard and Trip signal for a definite time interval. This is satisfactory when the channel fails suddenly and completely. However, the signal may weaken gradually from various causes, and it is desirable to have a means for providing a visual indication of the channel condition as well as for energizing an alarm when the signal has weakened seriously but has not reached the point of complete failure. These functions are provided if a carrier level indicator stage is included in the receiver.

The carrier level indicator is housed in the right-hand compartment of the enclosure that contains the circuit boards. Fig. 2 shows the connections of the components on this circuit board and also the external connections of the board. All other stages of the receiver are identical with those shown on Fig. 1. The same AL relay is used, but it is energized through transistor Q104 of the logic stage when the receiver does not include carrier level indication and through Q154 of the carrier level indicator when the latter is supplied. A TCF receiver in which the carrier level indicator was not included at time of assembly can have this feature added later by installing the printed circuit board and guides in the right hand compartment and making minor changes in the wiring.

The r.f. input to the carrier level indicator is taken from the collector of Q51, the first transistor in the amplifier and limiter stage. The input, which varies approximately as the signal at the receiver

input, is amplified by Q151 and Q152. Diodes CR151 and CR152 together with capacitors C157 and C158 establish a d-c voltage across C158 that controls the conductivity of Q153. The base current of Q153 together with the current through R164 is measured by a milliammeter (supplied by the customer) located at a point convenient for observation. This current can also be metered at the receiver by means of jack J151 on the printed circuit board. Thermistor R166 with its associated resistors, and Sensistor R152, provide compensation to minimize the variation of the metered current with ambient temperature. When Q153 becomes conductive, it supplies base input to Q154 to turn it on and pick up alarm relay AL. When the signal at the receiver input drops sufficiently, AL will drop out and close the alarm circuit. The signal level at which this will occur is determined by the setting of R156 in the emitter of Q151.

The input to the carrier level indicator is not affected by frequency variations that are within the pass band of the crystal input filter, but only by the level of the receiver input signal. When the alarm relay is energized through transistor Q104 of the logic stage (in a receiver without carrier level indicator—Fig. 1), the alarm will be activated on complete loss of signal or on loss of Guard signal if Trip signal does not appear within approximately 150 ms. After the alarm relay has dropped out and activated the alarm, the relay will not be picked up by subsequent appearance of Trip signal but only by the reappearance of Guard signal. It is desirable to retain this alarm feature when the carrier level indicator is supplied, and a single alarm relay can be caused to respond to frequency change as well as to signal level by the interconnection between the #19 terminals of the logic and carrier level indicator circuit boards.

When Guard signal is being received, the voltage at the collector of Q103 in the logic circuit is approximately 10 volts, but this voltage is blocked from the base of Q154 in the carrier level indicator circuit by diode CR155. However, if the discriminator Guard output should fail because of a sufficient frequency shift either above or below Guard frequency, Q103 would become conductive and the collector current of Q153 would be diverted to negative through CR155 and Q103 rather than entering the base of Q154. The latter would become non-conductive and the alarm relay would drop out, closing the alarm circuit even though the signal level is unchanged.

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Fig. 5 is typical of the variation of the carrier level indicator current with the receiver input level. With Guard signal being received, the signal level just below which the discriminator Guard output drops to zero is the minimum operating level of the receiver. The AL relay should energize the alarm at a signal level somewhat above this. For usual operating conditions it should be satisfactory to set the input attenuator (R5) 15 db. above the minimum operating level and set the AL relay (by means of R156) to drop out at a signal 5 db. above the minimum operating level. Fig. 5 shows that with such settings the carrier level indicator current would be approximately 2.25 ma. with the normal input signal. The alarm would be energized when the indicator current dropped to slightly less than 0.6 ma.

A TCF receiver in which the carrier level indicator was not included at time of assembly can have this feature added later by installing the printed circuit board, guides, and terminal block in the right-hand compartment of the circuit board enclosure, and making minor changes or additions to the wiring. The upper and lower guides are held in position by a snap fastener, and the terminal block by screws and nuts. The terminal block includes an insert located to mate with a corresponding slot in the end of the carrier level indicator circuit board only, which prevents accidental insertion of any other circuit board in this compartment.

Reference to the internal schematic diagrams, Figs. 1 and 2, will show the wiring changes required. Connect terminal 2 to the adjacent terminal 2 of the output board, terminal 9 to terminal 9 of the logic board, terminal 12 to terminal 12 of the output board (and remove connection from the later to terminal 12 of the logic board), terminals 14 and 17 to terminals 18 and 19 respectively of J3, terminal 16 to terminal 16 of the limiter board, terminal 18 to terminal 18 of the discriminator board and terminal 19 to terminal 19 of the logic board.

Power Supply

The regulated 20 V.D.C. and 45 V.D.C. circuits of the receiver are supplied from Zener diodes mounted on a common heat sink on the rear of the panel. Resistors (R2, R3) of suitable value are connected between the station battery supply and the 45 volt Zener to adapt the receiver for use on 48, 125 or 250 V.D.C. battery circuits. The receiver is connected to the external supply through a switch and fuses, and a pilot light indicates whether the D.C. circuits are energized. Capacitors C1 and C2 bypass r.f. or transient voltages to ground. Chokes

L1 and L2 isolate the receiver from transient voltages that may appear on the D.C. supply.

CHARACTERISTICS

Frequency range	30-300 kHz
Sensitivity (noise-free channel)	0.005 volt (65 db below 1 watt for limiting)
Input Impedance	5000 ohms minimum
Bandwidth (crystal filter)	down < 3 db at 220 hertz down > 60 db at 1000 hertz
Discriminator	Set for 200 cycles shift from Guard to Trip frequency. Offset 25 hertz to favor Guard for all relay-output applications.
Operating time	9 ms. channel (transm. and recvr.) 2 ms. min. logic delay + 3 ms. AR relay 14 ms. minimum time + 18 ms. max. added logic time (if req'd. by noise conditions) 32 ms. maximum time
Frequency spacing	A. For two or more signals over one-way channel 500 hertz minimum B. For two-way channel * 1000 hertz, minimum between transmitter and adjacent receiver frequencies.
Ambient temperature range	-20°C to +55°C temperature around chassis.
Battery voltage variations	
Rated voltage	Allowable variation
48 V.D.C.	42 - 56 V.D.C.
125 V.D.C.	105 - 140 V.D.C.
250 V.D.C.	210 - 280 V.D.C.
Battery drain	0.20 a. at 48 V.D.C. 0.27 a. at 125 or 250 V.D.C.
Dimensions	Panel height - 10½" or 6 r.u. Panel width - 19"
Weight	13 lbs.

INSTALLATION

The TCF receiver is generally supplied in a cabinet or on a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. The maximum ambient temperature around the chassis must not exceed 55°C.

ADJUSTMENTS

All factory adjustments of the TCF receiver have been carefully made and should not be altered unless there is evidence of damage or malfunctioning. Such adjustments are: frequency and output level of the oscillator and mixer; input to the amplifier and limiter; discriminator offset from center frequency; frequency spacing and magnitude of discriminator output peaks. Adjustments that must be made at time of installation are: setting of input attenuator R5; setting of the logic time delay by R7; adjustment of R156 on the carrier level indicator (if supplied) to operate the alarm at the desired input level. The input attenuator and the logic time delay adjustments are made by knobs on the front of the panel. A screw driver adjustment of a potentiometer at the front and top of the printed circuit board sets the point at which the level indicator alarm operates.

The receiver should not be set with a greater margin of sensitivity than is needed to assure correct operation with the maximum expected variation in attenuation of the transmitter signal. In the absence of data on this, the receiver may be set to operate on a signal that is 15 db below the expected maximum signal. After installation of the receiver and the corresponding transmitter, and with a normal Guard signal being received, input attenuator R5 should be adjusted to the position at which the alarm relay drops out. R5 then should be readjusted to increase the voltage supplied to the receiver by 15 db. The scale markings for R5 permit an approximate setting to be made but it is preferable to make this setting by means of the db scales of an a-c VTVM connected from ground to the sliding contact of R5.

In case the transmitter has a 1 Watt/1 Watt output and diode CR84 in the discriminator is not bypassed (see discussion under OPERATION-Discriminator), the transmitter should be keyed to trip, transistor Q103 should be kept non-conducting by connecting a short clip lead across R128, and R5

should be adjusted to the position at which the trip relay just picks up. R5 then should be readjusted for a 15 db increase in receiver input, and the jumper across R128 should be removed. If CR84 is bypassed the input levels at which the AL and AR relays just operate will be approximately the same, and the AL relay minimum operating point can be used as reference for arriving at the R5 setting, as described in the preceding paragraph.

If the receiver has a carrier level indicator, the procedure for setting R5 is somewhat different. Turn R156 to maximum clockwise position and adjust R5 to the position at which the alarm relay just drops out. At this point the signal has been attenuated to the point that the discriminator no longer has Guard output although it still would be sufficient to produce output from the carrier level indicator, and the base input to Q154 on the carrier level indicator is diverted to negative through Q103 on the logic circuit board. (Note that a milliammeter reading at J151 has no significance at this abnormal setting of R156.) Then readjust R5 to increase the input signal by 5 db and adjust R156 to the position at which the alarm relay again drops out. Again readjust R5 to increase the signal by an additional 10 db and clamp the knob in this position.

It is recommended that R7 be set for maximum time delay (full clockwise rotation) unless field tests have shown that a shorter delay can be used without danger of false tripping under conditions of severe line noise, such as may be caused by the opening of nearby disconnect switches.

Potentiometer R12, where applicable, in the oscillator and mixer should be set for 0.3 volt, measured with an a-c VTVM connected between TP11 and terminal 18 on the circuit board (ground terminal of voltmeter). A frequency counter can be connected to the same points for a check on the frequency, which should be 20kHz above the channel frequency. The frequency is fixed by the crystal used, except that it may be changed a few cycles by the value of capacitor C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that insures reliable starting of oscillation. The frequency at room temperature is usually several cycles above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should

be connected from the base of transistor Q54 to terminal 18 of the limiter. With 3 mv. of Guard frequency on the receiver input (R5 at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting.

Adjustment of the discriminator is made by capacitors C83 and C88. In order to offset the discriminator by 25 Hertz in the Trip direction, apply to the receiver input a 5 mv. signal taken from an oscillator set at $f_c - 25$ Hertz (R5 at zero.) Connect a 1.5-0-1.5 milliammeter in the circuit at J1 and a VTVM across R84. Adjust C88 for zero current in the milliammeter and C83 for maximum voltage across R84, rechecking the adjustments alternately until no further change is observed. Remove the VTVM from across R84 and observe the milliammeter reading as the oscillator frequency is varied. Positive and negative peaks should occur at $f_c + 75$ Hertz and $f_c - 125$ Hertz, with the latter peak being 20% or 25% lower than the former because of diode CR84 in the Trip output path.

In case a check is desired of any of the delay times of the receiver (such as channel time or logic delays), this can be done most conveniently by means of an oscilloscope with a calibrated triggered sweep. A two-pole toggle switch, checked to have less than 1 ms. interval between pole closures, can be used to impress the signal and trigger the sweep.

MAINTENANCE

Periodic checks of the received carrier signal and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenuation control R5. A change in operating margin from the original setting can be detected by observing the change in the dial setting required to drop out the alarm relay. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal or loss of receiver sensitivity.

All adjustable components on the printed circuit boards are accessible when the door on the front of

the panel is opened. (An offset screwdriver would be required for adjusting R12.) However, as described under "CONSTRUCTION", any board may be made entirely accessible while permitting electrical operation by using board extender Style No. 644B315G01. This permits attaching instrument leads to the various test points of terminals when making voltage, oscilloscope or frequency checks.

It is advisable to record voltage values after adjustment in order to establish reference values which will be useful when checking the apparatus. The readings will remain fairly constant over an indefinite period unless a failure occurs. However, if transistors are changed, there may be considerable difference in these readings without the overall performance being affected.

Typical voltage values are given in Table I and II. Voltages should be measured with a VTVM. Some readings may vary as much as $\pm 20\%$.

TABLE I
RECEIVER D-C MEASUREMENTS

Note: All voltage readings taken with ground of d-c VTVM on terminal 9 (neg. d.c.). Receiver adjusted for 15 db operating margin with Guard signal down 50 db from 1 watt and Trip signal down 40 db. Unless otherwise indicated, voltage will not vary appreciably whether signal is Guard, Trip or zero.

Collector of Transistor	Volts (+)
Q11	< 13
Q12	15 (Guard or Trip)
Q13	15 (Guard or Trip)
Q31	2.5
Q32	2.5
Q51	11.5
Q52	12
Q53	15.5
Q54	2.5
Q81	< 1 (No sig. or Trip)
Q81	19.5 (Guard)
Q82	< 1 (No sig. or Guard)
Q82	19.5 (Trip)
Q101	< 1 (No sig. or Trip)
Q101	7 (Guard)
Q102	21 (No signal)
Q102	< 1 (Guard or keyed Trip #)

			Collector of Transistor	Volts (1 watt-Guard)	Volts (10 watts-Trip)
Q103	< 1	(No signal)			
Q103	10	(Guard or keyed Trip)			
Q104	45	(No signal)			
Q104	< 1	(Guard or keyed Trip)	Q32	.25	.8
Q105	40	(No signal)	Q51	.3	.9
Q105	< 1	(Guard or Trip)	Q52	.4	.65
Q106	15	(No sig. or Guard)	Q53	2.1	2.2
Q106	< 1	(Trip)	Q54	4.8	4.5
Q107	< 1	(No sig. or Guard)			
Q107	15	(Trip)			
Q108	45	(No sig. or Guard)			
Q108	< 1	(Keyed Trip)			
Q109	10	(No sig. or Trip)			
Q109	< 1	(Guard)			
Q110	< 1	(No sig. or Trip)			
Q110	15	(Guard)			
Q111	15	(No sig. or Trip)			
Q111	< 1	(Guard)			
Q151	6	(No signal)			
Q151	6	(Guard)			
Q152	9.8	(No signal)			
Q152	10	(Guard)			
Q153	< 1	(No signal)			
Q153	19	(Guard)			
Q154	45	(No signal)			
Q154	< 1	(Guard)			

- "Keyed Trip" signifies minimum transition time from Guard to Trip.

TABLE II
RECEIVER RF MEASUREMENTS

Note: Voltmeter readings taken between receiver input and Q32 are not meaningful or feasible because of waveform or effect of instrument loading. Receiver adjusted as in Table I.

RELAY MAINTENANCE AND ADJUSTMENT

The AL and AR relay contacts should be cleaned periodically. A contact burnisher S#182A836H01 is recommended for this purpose. The use of abrasive material for cleaning contacts is not recommended, because of the danger of embedding small particles in the face of the soft silver and thus impairing the contact. Care must be taken to avoid distorting the contact springs during burnishing, particularly in the case of the AR relay.

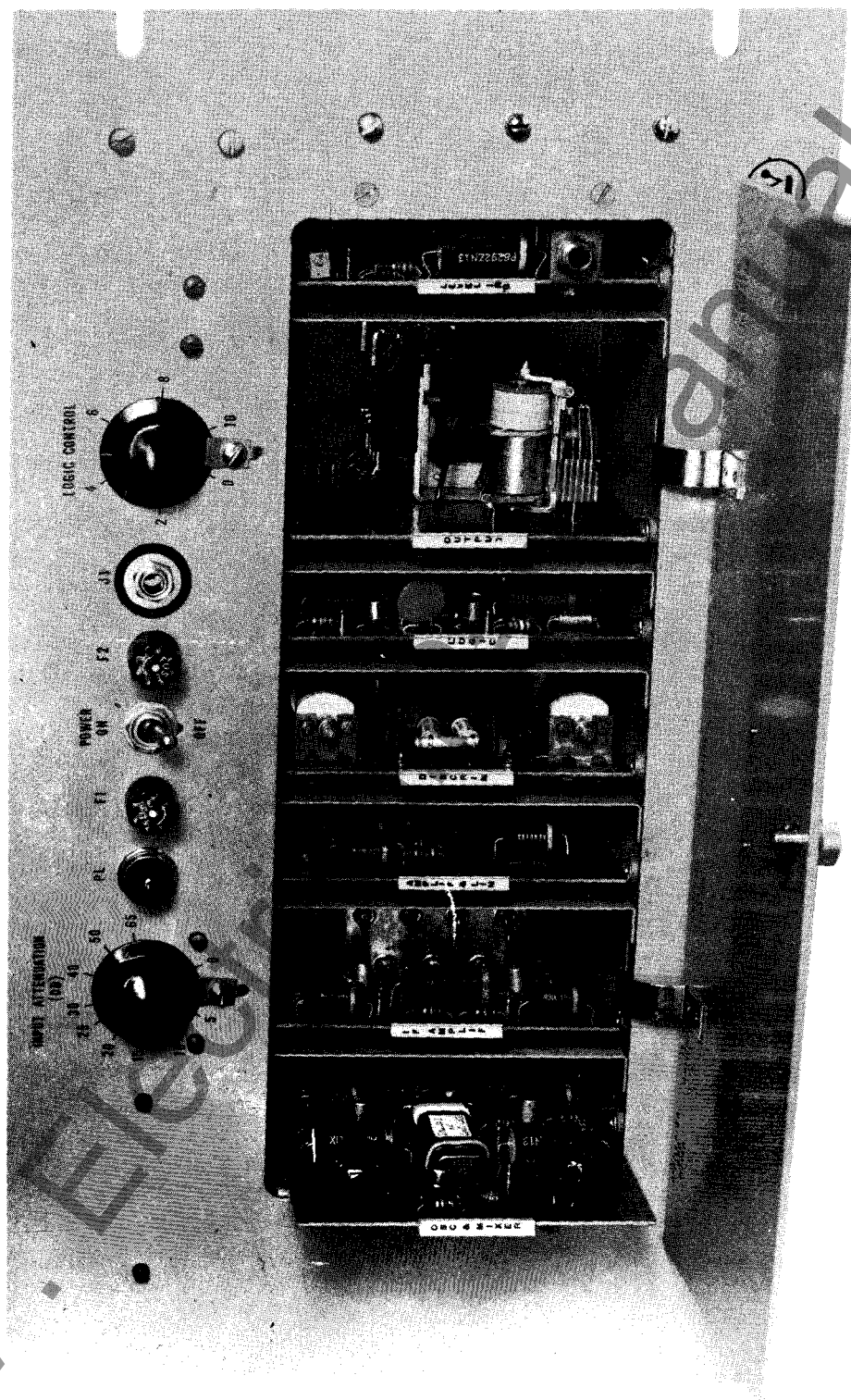
These relays have been properly adjusted at the factory to insure correct operation, and under normal field conditions they should not require readjustment. If, however, the adjustments are disturbed in error, or if it becomes necessary to replace some part, the following adjustment procedure should be used.

In the AL relay the armature gap should be approximately 0.004 inch with the armature closed. This adjustment is made with the armature stop screw and locknut. The contact leaf springs should be adjusted to obtain at least 0.015 inch gap on all contacts when fully open. There should be at least 0.010 inch follow on all normally-open contacts and 0.005 inch follow on all normally-closed contacts. The relay should pick up at approximately 35 volts.

ADDENDUM

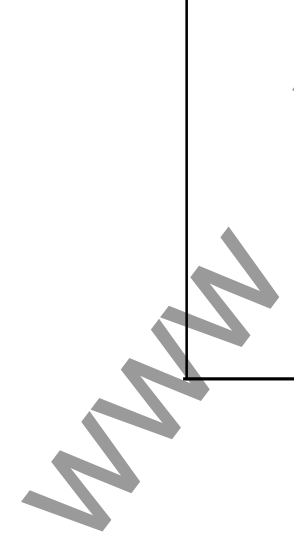
With shipments of sets starting in early 1973, the germanium transistors used in the various modules were replaced with silicon transistors. In addition, due to the nature of silicon transistors, some resistor values in the circuits had to be changed in order to correctly bias these transistors. Therefore the transistors are not replaceable on a pin for pin basis throughout the receiver. Before attempting to replace a germanium transistor with a silicon transistor on older sets using germanium, please check the schematics on the following pages to see if the location where the replacement is desired has additional component changes. If that is the case,

then the replacement can only be made by the same designation transistor or the additional component changes must also be made. It should be pointed out that the modules containing the silicon transistors are completely interchangeable with the modules containing germanium transistors. Therefore, there is no problem with intermixing the silicon transistor modules in the same receiver. Thus complete new modules containing silicon transistors can be ordered and used as replacements in older receivers having germanium transistor modules. The new modules have the same style numbers as the old germanium transistor modules they replace.

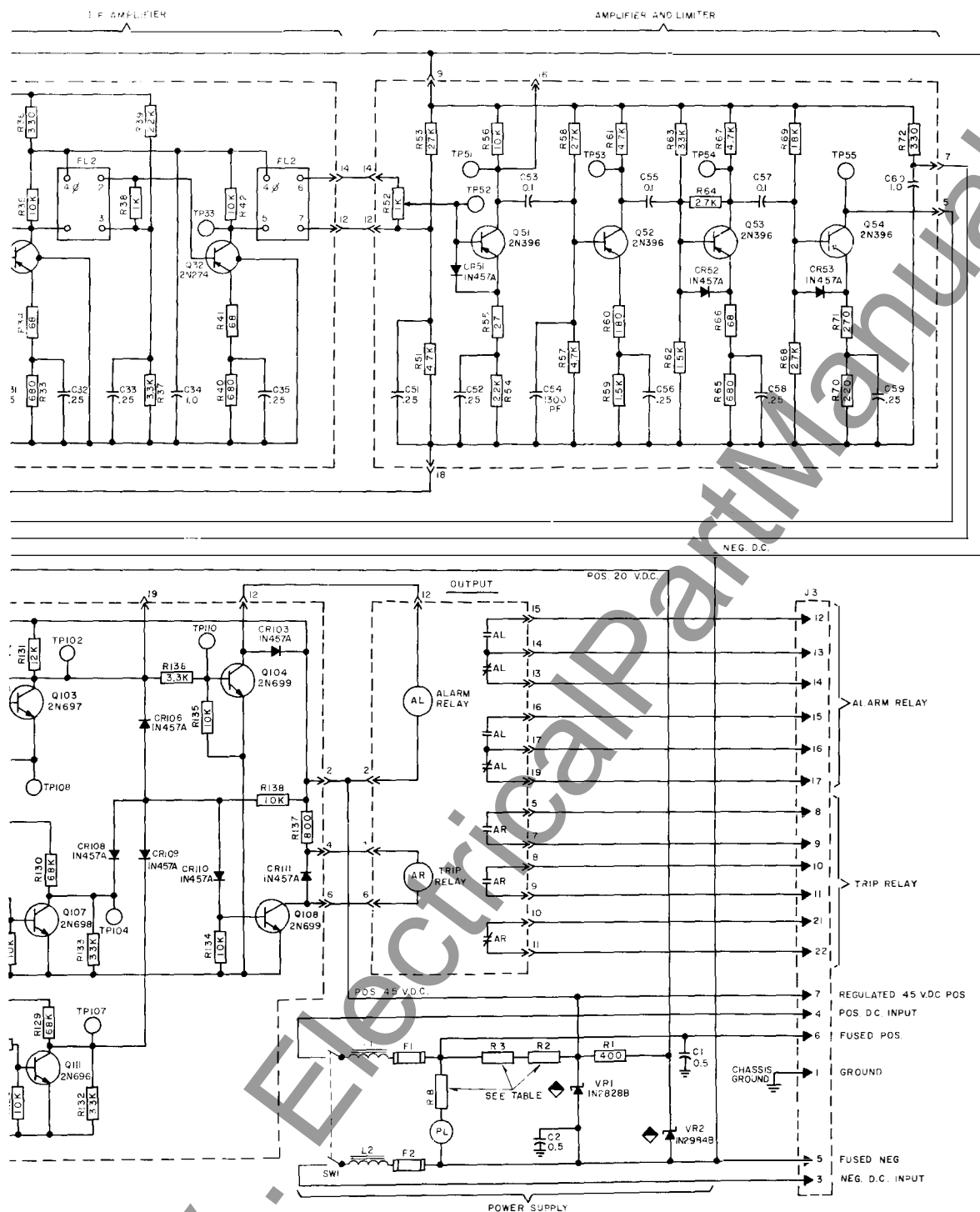


Type TCF Receiver (Front View).

com



11



543D637

TCF receiver without the carrier level indicator.

FILTER RESPONSE MEASUREMENTS

The crystal input filter (FL1) and the IF filter (FL2) are in sealed containers and repairs can be made only by the factory. The stability of the original response characteristics is such that in normal usage no appreciable change in response will occur. However the test circuits of Dwg. 849A109 can be used in case there is reason to suspect that either of the filters has been damaged.

Fig. 4 shows the -3db and -60db check points for the crystal filters. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Fig. 4 was chosen to show the crystal filter response, which permitted only a portion of the IF filter curve to be shown. The check points for the pass band of each section of the latter are "down 3db maximum at 19.75 and 20.25 kHz, and for the stop band are "down 18 db minimum at 19.00 and 21.00 kHz. The signal generator voltage must be held constant throughout the entire check. A value of 20 db (7.8 volts) is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22db below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16db less than the measured difference because of the input resistor and the difference in input and output impedances of the filter.

Because of the extreme frequency sensitivity of the crystal filter, the oscillator used in its test circuit should have very good frequency stability and a close vernier control. The oscillators used for factory testing have special modifications for this use. A value of approximately 10db (2.45 volts) is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency but should not be more than 11db below the reading of VM1. (The filter insertion loss is approximately 6db less than the difference in readings.)

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a TCF receiver for operating on a different channel frequency consist of a new crystal filter (FL1), a new local oscillator crystal (Y11) and probably a different

feedback capacitor (C12). Because the wide range of channel frequencies precludes maintaining a factory stock of the various crystals, immediate shipment of the filter and the oscillator crystal cannot be made. After the crystals have been procured and the filter has been completed, it is recommended that the receiver be returned to the factory for the conversion and for complete test and adjustment. However, if the time that the receiver can be out of service must be kept to a minimum, the conversion may be made by customers who are equipped for this work.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation.

- a. A-C vacuum Tube Voltmeter (VTVM).
Voltage range 0.003 to 30 volts, frequency range 60 Hz to 330 kHz, input impedance 7.5 megohms.
- b. D-C Vacuum Tube Voltmeter (VTVM).
Voltage Range: 1.5 to 300 volts
Input Impedance: 7.5 megohms
- c. Milliammeter, 0-3 range (if receiver has carrier level indicator).

II. Desirable Test Equipment for Apparatus Maintenance

- a. All items listed in I.
- b. Signal Generator
Output Voltage: up to 8 volts
Frequency Range: 20-kHz to 330-kHz
- c. Oscilloscope
- d. Frequency counter
- e. Ohmmeter
- f. Capacitor checker
- g. Milliammeter, 0-1.5 or preferably 1.5-0-1.5 range, for checking discriminator.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

ELECTRICAL PARTS LIST

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
CAPACITORS		
C1	Oil-filled; 0.5 mfd.; 1500 V.D.C.	1877962
C2	Oil-filled; 0.5 mfd.; 1500 V.D.C.	1877962
C11	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C12-C16	Mica, capacity as required; 500 V.D.C.	
C13	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C14	Metallized paper; 1.0 mfd.; 200 V.D.C.	187A624H04
C15	Metallized paper; 1.0 mfd.; 200 V.D.C.	187A624H04
C31	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C32	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C33	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C34	Metallized paper; 1.0 mfd.; 200 V.D.C.	187A624H04
C35	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C51	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C52	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C53	Metallized paper; 0.1 mfd.; 200 V.D.C.	187A624H01
C54	Dur-Mica, 1300 pf.; 500 V.D.C.	187A584H15
C55	Metallized paper; 0.1 mfd.; 200 V.D.C.	187A624H01
C56	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C57	Metallized paper; 0.1 mfd.; 200 V.D.C.	187A624H01
C58	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C59	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C60	Metallized paper; 1.0 mfd.; 200 V.D.C.	187A624H04
C81	Mylar; 0.22 mfd.; 50 V.D.C.	762A703H01
C82	Mylar; 0.22 mfd.; 50 V.D.C.	762A703H01
C83	Variable; 4.5 - 100 pf.	762A736H02
C84	Polystyrene, 9100 pf.; 200 V.D.C.	187A624H16
C85	Temp. compensating; 150 V.D.C.; pf. as required	
C86	100 pf.; zero temp. coef.	187A684H08
C87	Temp. compensating; 150 V.D.C.; pf. as required	
C88	Variable; 4.5 - 100 pf.	762A736H02
C89	Polystyrene; 9100 pf.; 200 V.D.C.	187A624H16
C90	Mylar; 0.22 mfd.; 50 V.D.C.	762A703H01
C91	Mylar; 0.22 mfd.; 50 V.D.C.	762A703H01
C101	Tantalum, 4.7 mfd.; 35 V.D.C.	184A661H12
C102	Tantalum, 6.8 mfd.; 35 V.D.C.	184A661H25
C103	Metallized paper; 0.5 mfd.; 200 V.D.C.	187A624H11
C104	Metallized paper; 0.5 mfd.; 200 V.D.C.	187A624H11
C105	Ceramic, 0.05 mfd.; 50 V.D.C.	184A663H02
C151	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C152	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02

ELECTRICAL PARTS LIST (Cont'd.)

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
CAPACITORS (Cont'd.)		
C153	Metallized paper; 1.0 mfd.; 200 V.D.C.	187A624H04
C154	Metallized paper; 0.25 mfd.; 200 V.D.C.	817A624H02
C155	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C156	Metallized paper; 0.25 mfd.; 200 V.C.C.	187A624H02
C157	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C158	Metallized paper; 0.25 mfd.; 200 V.D.C.	187A624H02
C211	Durmica; 100 mmf to 1000 mmf	187A695H
C212	Ceramic; .1 mf, 50 v.d.c.	184A663H04
C213	Ceramic; .1 mf, 50 v.d.c.	184A663 H04
C214	Durmica; .56 mmf	187A695H17
C215	Ceramic; .1 mf, 50 v.d.c.	184A663 H04
C216	Metallized paper; 1 mf	187A624H04
C217	Metallized Paper; 1 mf	187A624H04
DIODES – GENERAL PURPOSE		
CR51	IN457A; 60 V.; 200 MA.	184A855H07
CR52	IN475A; 60 V.; 200 MA.	184A855H07
CR53	IN457A; 60 V.; 200 MA.	184A855H07
CR81	IN91; 100 V.; 150 MA.	182A881H04
CR82	IN91; 100 V.; 150 MA.	182A881H04
CR83	IN91; 100 V.; 150 MA.	182A881H04
CR84	IN475A; 60 V.; 200 MA.	184A885H07
CR85	IN628; 125 V.; 30 MA.	184A855H12
CR86	IN628; 125 V.; 30 MA.	184A855H12
CR101	IN457A; 60 V.; 200 MA.	184A885H07
CR102	IN457A; 60 V.; 200 MA.	184A885H07
CR103	IN457A; 60 V.; 200 MA.	184A885H07
CR106	IN457A; 60 V.; 200 MA.	184A885H07
CR107	IN457A; 60 V.; 200 MA.	184A885H07
CR108	IN457A; 60 V.; 200 MA.	184A885H07
CR109	IN457A; 60 V.; 200 MA.	184A885H07
CR110	IN457A; 60 V.; 200 MA.	184A885H07
CR111	IN457A; 60 V.; 200 MA.	184A885H07
CR112	IN457A; 60 V.; 200 MA.	184A885H07
CR151	IN457A; 60 V.; 200 MA.	184A885H07
CR152	IN457A; 60 V.; 200 MA.	184A885H07
CR153	IN457A; 60 V.; 200 MA.	184A885H07
CR154	IN457A.; 60 V.; 200 MA.	184A885H07
CR155	IN457A; 60 V.; 200 MA.	184A885H07
CR156	IN457A; 60 V.; 200 MA.	184A855H07
DIODES – ZENER		
CR1	IN3027A; 20 V. \pm 10%; 1W.	188A302H10
CR2	IN3027A; 20 V. \pm 10%; 1W.	188A302H10
CR104	IN957B; 6.8 V. \pm 5%; 400 MW.	186A797H06
CR105	IN3686B; 20 V. \pm 5%; 750 MW.	185A212H06
CR113	IN957B; 6.8 V. \pm 5%; 400 MW.	186A797H06
VR1	IN2828B; 45 V. \pm 5%; 50 W.	184A854H06
VR2	IN2984B; 20 V. \pm 5%; 10 W.	762A631H01
Z201	IN753A; 6.2 V. \pm 5%; 400 MW.	862A606H01

ELECTRICAL PARTS LIST (Cont'd.)

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
POTENTIOMETERS		
R5	10K; 2 W.	185A086H10
R7	250K; 2 W.	185A086H11
R12	1K; ¼ W.	629A430H02
R52	1K; ¼ W.	629A645H04
R156	2.5K; ¼ W.	629A645H07
RESISTORS		
R1	400 ohms $\pm 5\%$; 25 W.	1202587
R2	26.5 ohms $\pm 5\%$; 40 W. (For 48 V. Supply)	04D1299H44
R2	150 ohms $\pm 5\%$; 40 W. (For 125 V. Supply)	1202499
R2	300 ohms $\pm 5\%$; 50 W. (For 250 V. Supply)	763A963H01
R3	150 ohms $\pm 5\%$; 40 W. (For 125 V. Supply)	1202499
R3	500 ohms $\pm 5\%$; 100 W. (For 250 V. Supply)	629A843H03
R4	100 ohms $\pm 5\%$; 1 W. Composition	187A643H03
R6	10K $\pm 5\%$; ½ W. Composition	184A763H51
R8	100K $\pm 5\%$; 1 W. Composition	187A643H75
R11	10K $\pm 5\%$; ½ W. Composition	184A763H51
R13	5.6K $\pm 5\%$; ½ W. Composition	184A763H45
R14	3.3K $\pm 5\%$; ½ W. Composition	184A763H39
R15	330 ohms $\pm 5\%$; ½ W. Composition	184A763H15
R16	10K $\pm 5\%$; ½ W. Composition	184A763H51
R17	33K $\pm 5\%$; ½ W. Composition	184A763H63
R18	3.3K $\pm 5\%$; ½ W. Composition	184A763H39
R19	3.3K $\pm 5\%$; ½ W. Composition	184A763H39
R20	10K $\pm 5\%$; ½ W. Composition	184A763H51
R21	33K $\pm 5\%$; ½ W. Composition	184A763H63
R22	330 ohms $\pm 5\%$; ½ W. Composition	184A763H15
R23	10K $\pm 5\%$; ½ W. Composition	184A763H51
R31	3.3K $\pm 5\%$; ½ W. Composition	184A763H39
R32	22K $\pm 5\%$; ½ W. Composition	184A763H59
R33	680 ohms $\pm 5\%$; ½ W. Composition	184A763H23
R34	68 ohms $\pm 5\%$; ½ W. Composition	187A290H21
R35	10K $\pm 5\%$; ½ W. Composition	184A763H51
R36	330 ohms $\pm 5\%$; ½ W. Composition	184A763H15
R37	3.3K $\pm 5\%$; ½ W. Composition	184A763H39
R38	1000 ohms $\pm 5\%$; ½ W. Composition	184A763H27
R39	22K $\pm 5\%$; ½ W. Composition	184A763H59
R40	680 ohms $\pm 5\%$; ½ W. Composition	184A763H23
R41	68 ohms $\pm 5\%$; ½ W. Composition	187A290H21
R42	10K $\pm 5\%$; ½ W. Composition	184A763H51
R51	4.7K $\pm 5\%$; ½ W. Composition	184A763H43

ELECTRICAL PARTS LIST (Cont'd.)

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
RESISTORS (Cont'd.)		
R53	27K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H61
R54	2.2K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H35
R55	27 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H11
R56	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R57	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R58	27K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H61
R59	1.5K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H31
R60	180 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H09
R61	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R62	1.5K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H31
R63	3.3K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H63
R64	2.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H37
R65	680 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H23
R66	68 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H21
R67	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R68	2.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H37
R69	18K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H57
R70	220 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H11
R71	270 ohms $\pm 5\%$; Wire Wound	09D832G19
R72	330 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H15
R81	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R82	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R83	2.2K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H35
R84	2.2K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H35
R85	6.8K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H47
R101	39K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H65
R102	33K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H63
R103	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R104	27K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H61
R105	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R106	39K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H65
R107	18K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H57
R108	56K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H69
R109	10K $\pm 5\%$; 1 W. Composition	187A643H51
R110	6.8K $\pm 5\%$; 1 W. Composition	187A643H47
R111	470 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H19
R112	1000 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H27
R113	470K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H91
R114	1000 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	185A763H27
R115	82K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H73

ELECTRICAL PARTS LIST (Cont'd.)

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
RESISTORS		
R116	10K \pm 5%; ½ W. Composition	184A763H51
R117	10K \pm 5%; ½ W. Composition	184A763H51
R118	10K \pm 5%; ½ W. Composition	184A763H51
R119	100K \pm 5%; ½ W. Composition	184A763H75
R120	39K \pm 5%; ½ W. Composition	184A763H65
R121	68K \pm 5%; ½ W. Composition	184A763H71
R122	68K \pm 5%; ½ W. Composition	184A763H71
R123	1000 ohms \pm 5%; ½ W. Composition	184A763H27
R124	33K \pm 5%; ½ W. Composition	184A763H63
R125	33K \pm 5%; ½ W. Composition	184A763H63
R126	10K \pm 5%; ½ W. Composition	184A763H51
R127	10K \pm 5%; ½ W. Composition	184A763H51
R128	10K \pm 5%; ½ W. Composition	184A763H51
R129	68K \pm 5%; ½ W. Composition	184A763H71
R130	68K \pm 5%; ½ W. Composition	184A763H71
R131	12K \pm 5%; ½ W. Composition	184A763H53
R132	33K \pm 5%; ½ W. Composition	184A763H63
R133	33K \pm 5%; ½ W. Composition	184A763H63
R134	10K \pm 5%; ½ W. Composition	184A763H51
R135	10K \pm 5%; ½ W. Composition	184A763H51
R136	3.3K \pm 5%; ½ W. Composition	184A763H39
R137	800 ohms \pm 5%; 3 W. Composition	184A859H06
R138	10K \pm 5%; ½ W. Composition	184A763H51
R151	2.7K \pm 5%; ½ W. Composition	184A763H37
R152	2.2K Sensistor Type TM4 (Tex. Inst. Co.)	187A685H01
R153	220 ohms \pm 5%; ½ W. Composition	184A763H11
R154	2.2K \pm 5%; ½ W. Composition	184A763H35
R155	15K \pm 5%; ½ W. Composition	184A763H55
R157	4.7K \pm 5%; ½ W. Composition	184A763H43
R158	4.7K \pm 5%; ½ W. Composition	184A763H43
R159	15K \pm 5%; ½ W. Composition	184A763H55
R160	560 ohms \pm 5%; ½ W. Composition	184A763H21
R161	1.2K \pm 5%; ½ W. Composition	184A763H29
R162	180 ohms \pm 5%; ½ W. Composition	184A763H09
R163	180 ohms \pm 5%; ½ W. Composition	184A763H09
R164	470 ohms \pm 5%; ½ W. Composition	184A763H19
R165	1000 ohms \pm 5%; ½ W. Composition	184A763H27
R166	3K Thermistor Type ID201 (G.E. Co.)	185A211H08
R167	18K \pm 5%; ½ W. Composition	184A763H57
R168	10K \pm 5%; ½ W. Composition	184A763H51
R211	10K \pm 5%; Composition	184A763H51
R212	1K \pm 5%; Composition	184A763H27
R213	10K \pm 5%; Composition	184A763H51
R214	2.7K \pm 5%; Composition	184A763H37
R215	10K \pm 5%; Composition	184A763H51
R216	8.2K \pm 5%; Composition	184A763H73
R217	2K \pm 5%; Composition	184A763H34
R218	150 ohms \pm 5%; Composition	184A763H07
R219	330 ohms \pm 5%; Composition	184A763H15
R220	47K \pm 5%; Composition	184A763H67

ELECTRICAL PARTS LIST (Cont'd.)

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
TRANSFORMERS		
T11	Toroidal type, 10000/400 ohms	205C043G03
T12	Toroidal type, 25000/300 ohms	205C043G03
T81	Pot. Core type	606B533G01
T82	Pot. Core type	606B533G02
T211	10K:10K	714B677G01
T212	25K:300	205C043G01
TRANSISTORS		
Q11	2N652A	184A638H16
Q12	2N1396	848A892H01
Q13	2N1396	848A892H01
Q31	2N274	187A270H01
Q32	2N274	187A270H01
Q51	2N396	762A575H03
Q52	2N396	762A575H03
Q53	2N396	762A575H03
Q54	2N396	762A585H03
Q81	2N652A	184A638H16
Q82	2N652A	184A638H16
Q101	2N652A	184A638H16
Q102	2N696	762A585H01
Q103	2N697	184A638H18
Q104	2N699	184A638H19
Q105	2N699	184A638H19
Q106	2N696	762A585H01
Q107	2N698	762A585H02
Q108	2N699	184A638H19
Q109	2N699	184A638H19
Q110	2N696	762A585H01
Q111	2N696	762A585H01
Q151	2N396	762A585H03
Q152	2N396	762A585H03
Q153	2N396	762A585H03
Q154	2N699	184A638H19
Q211	2N652A	184A638H16
MISCELLANEOUS		
Y11	Oscillator Crystal (Frequency 20 kHz above Channel Frequency)	762A800H01 + (Req. Freq.)
FL1	Crystal input Filter	401C466 + (Req. Freq.)
FL2	I.F. Filter	762A613G01
PL	Pilot Light Bulb — For 48 V. Supply	187A133H02
	Pilot Light Bulb — For 125 or 250 V. Supply	183A955H01
F1, F2	Fuse, 1.5 A.	11D9195H26
AL	Alarm Relay	408C062H07
AR	Trip Relay	408C845G03
L1-L2	Choke	292B096G02
IC201	Fairchild UA 710C (Int. Ckt.)	201C826H04

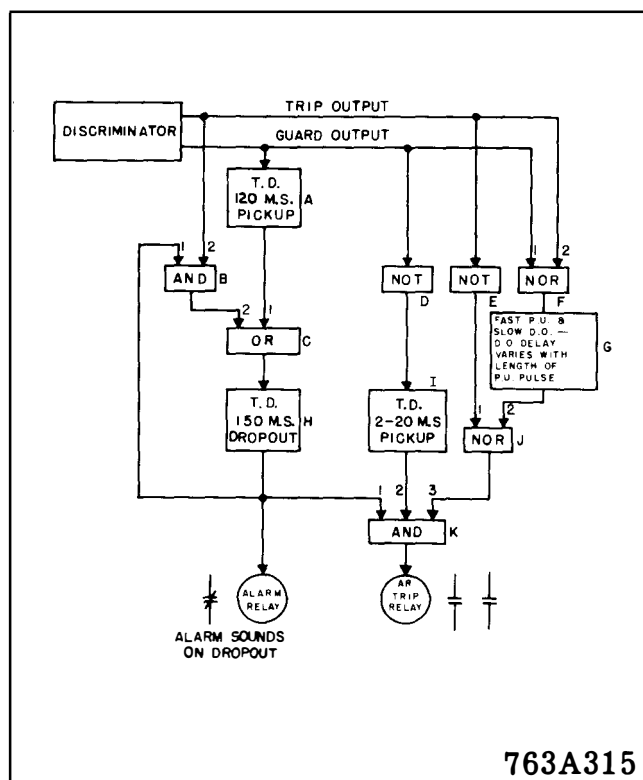


Fig. 3 Block diagram of output logic circuit

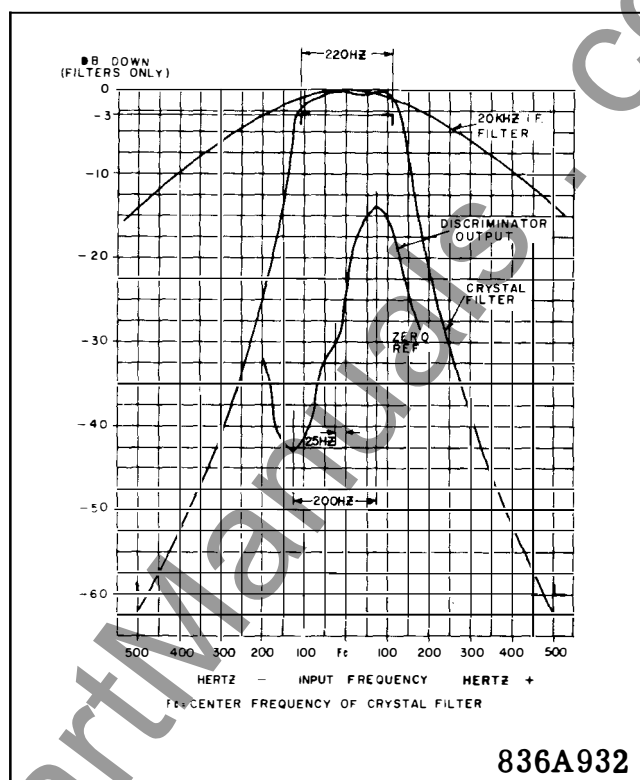


Fig. 4 Filter and discriminator characteristics of the type TCF receiver

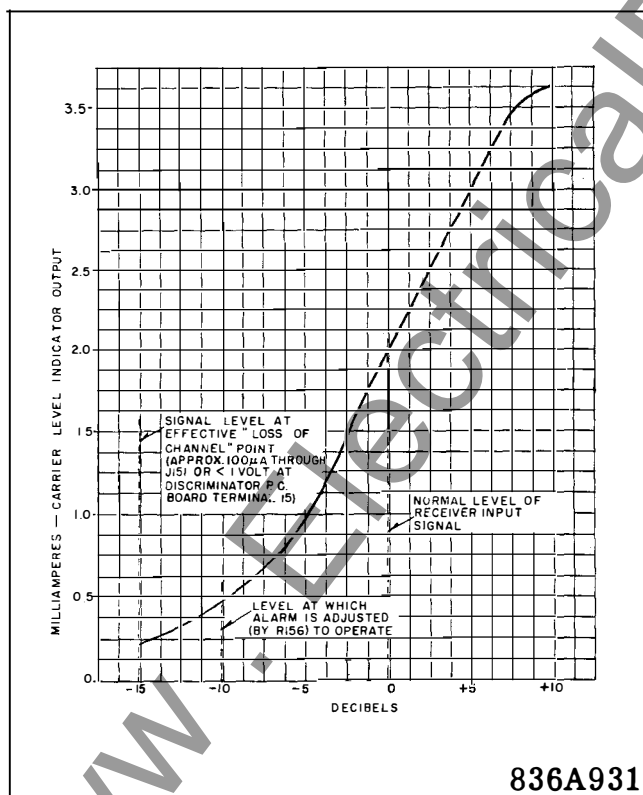


Fig. 5 Typical curve of the carrier level indicator current vs. receiver margin above minimum operating level.

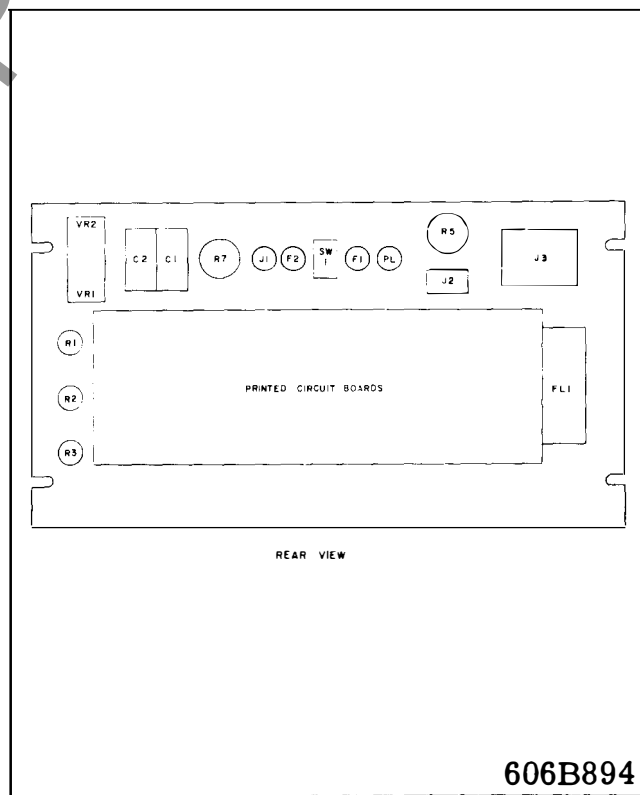


Fig. 6 Component locations on the type TCF receiver panel

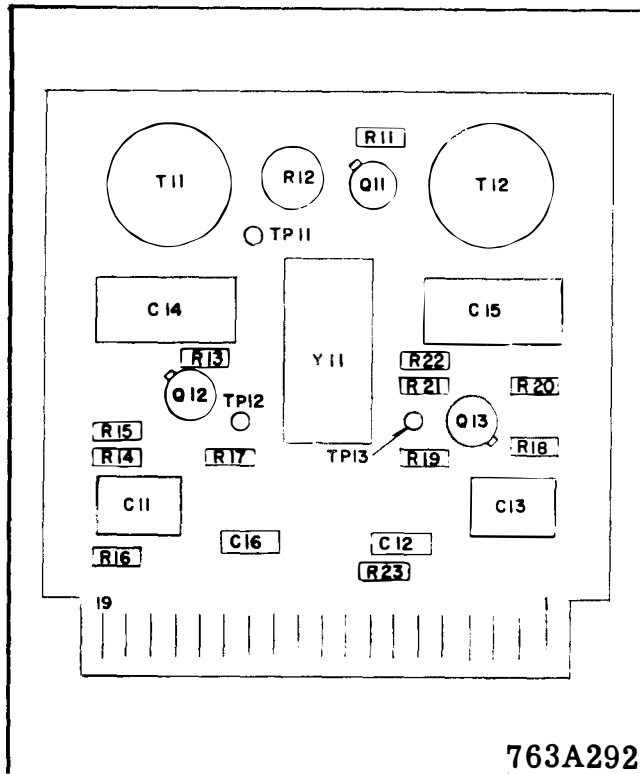


Fig. 7 Component locations on the oscillator and mixer printed circuit board.

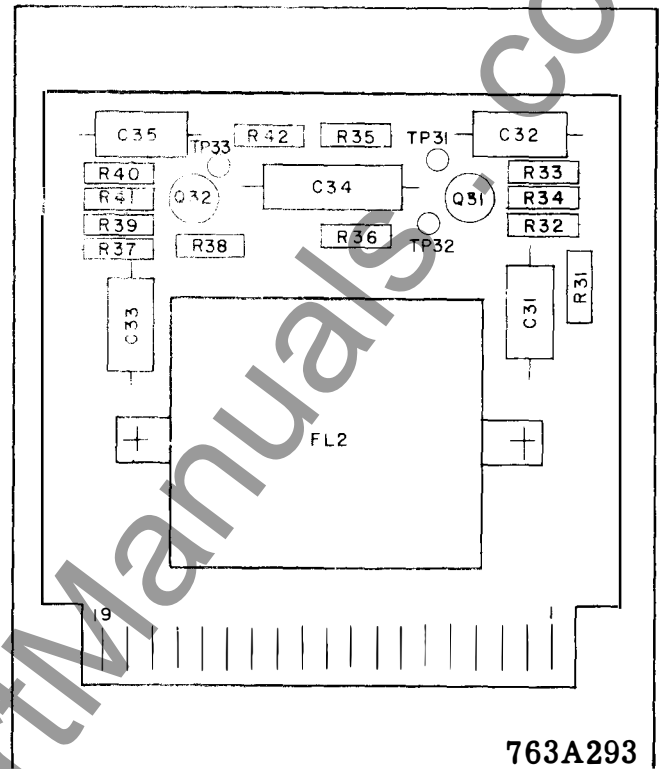


Fig. 8 Component locations on the I.F. amplifier printed circuit board.

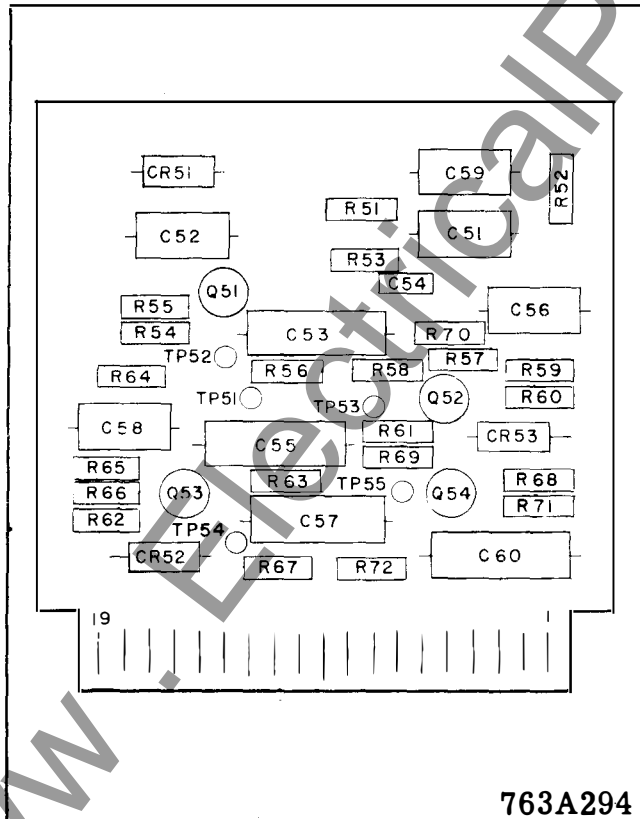


Fig. 9 Component locations on the amplifier and limiter printed circuit board.

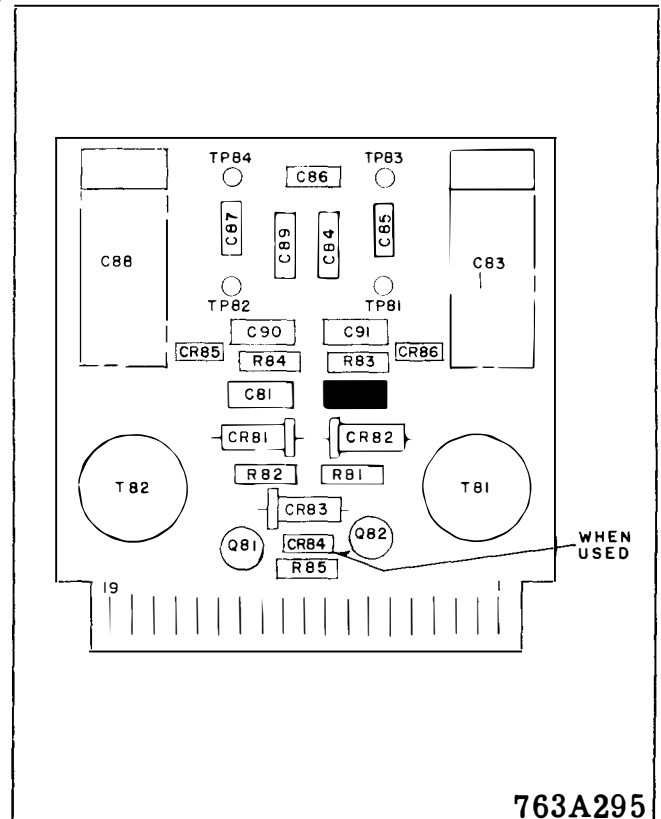


Fig. 10 Component locations on the discriminator printed circuit board.

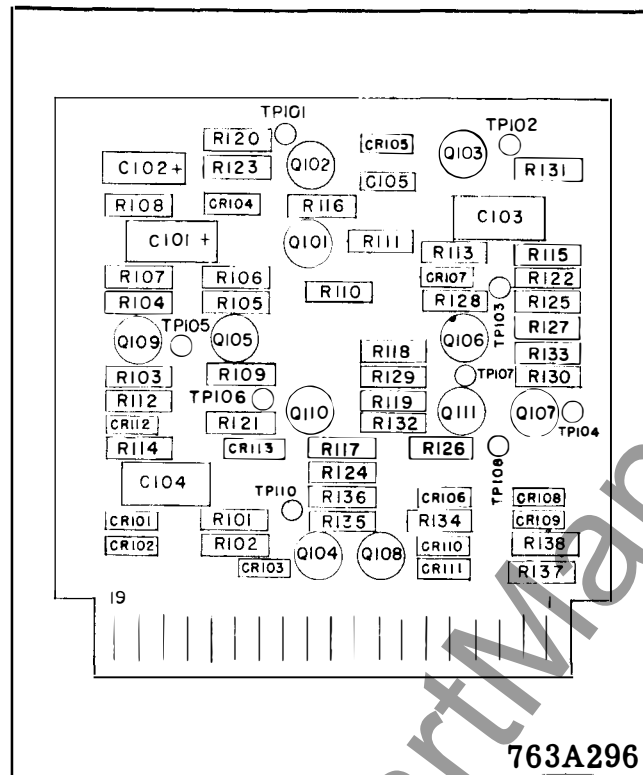


Fig. 11 Component locations on the logic printed circuit board.

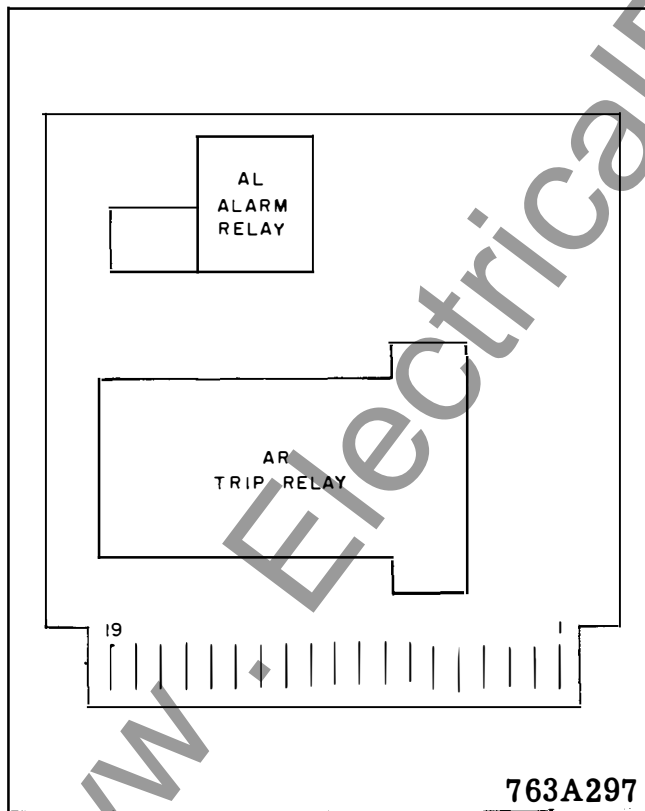


Fig. 12 Component locations on the output printed circuit board.

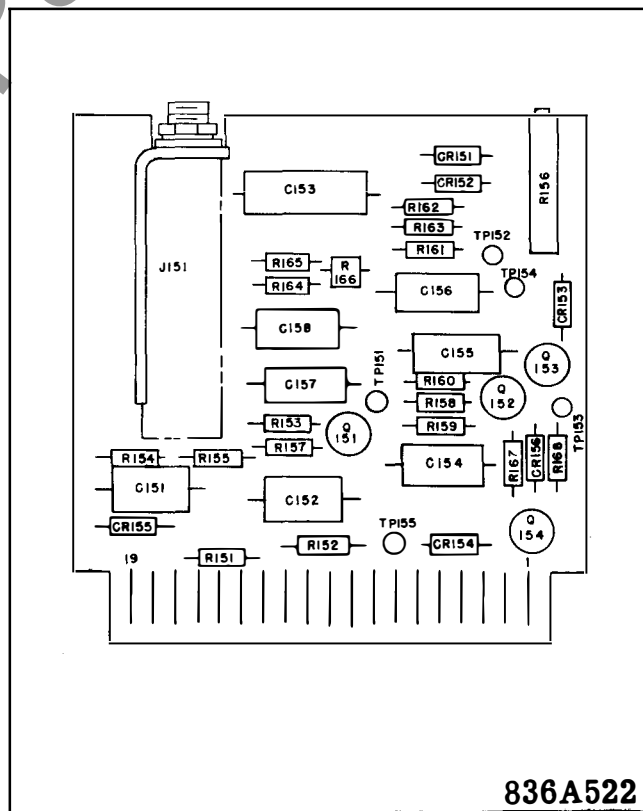


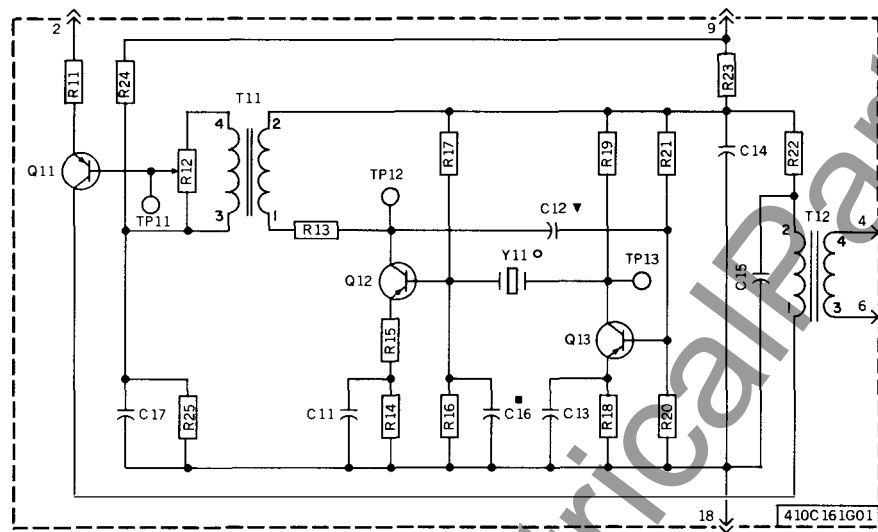
Fig. 13 Component locations on the carrier level indicator printed circuit board.



The top two diagrams show the test circuit for the I.F. Filter (FL2). In both, a signal source is connected to a 'COUNT' block. The output of the counter is connected to VM1. A 10K resistor is connected between the output of the counter and the input of the I.F. Filter (FL2). The output of the filter is connected to VM2. The filter has pins 1, 3, 5, 7, 2, 4, 6. Pin 4 is grounded. The filter is labeled 'I.F. FILTER (FL2)' and 'SEC. #1' and 'SEC. #2'.

The bottom diagram shows the test circuit for the Input Filter (FL1). It has the same components as the top diagrams. The signal source is connected to the 'COUNT' block. The output of the counter is connected to VM1. A 10K resistor is connected between the output of the counter and the input of the Input Filter (FL1). The output of the filter is connected to VM2. The filter has pins 1, 3, 5, 7, 2, 4, 6. Pin 4 is grounded. The filter is labeled 'INPUT FILTER (FL1)'.

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COMPONENT	STYLE	REQ	REF
TRANSISTOR			
Q11-Q12-Q13	849A441H03	3	2N4249
RESISTOR			
R15-R22	184A763H15	2	330Ω 1/2W ±5%
R14-R18-R19	184A763H39	3	3.3K 1/2W ±5%
R13	184A763H45	1	5.6K 1/2W ±5%
R11-R16-R20-R23	184A763H51	4	10K 1/2W ±5%
R17-R21	184A763H63	2	33K 1/2W ±5%
R24	184A763H83	1	220K 1/2W ±5%
R25	184A763H43	1	4.7K 1/2W ±5%
CAPACITOR			
C11-C13-C17	187A624H02	3	.25MFD. 200V.
C14-C15	187A624H04	2	1MFD. 200V.
C12	SEE NOTE ▼		
C16	SEE NOTE ■		
POTENTIOMETER			
R12	629A430H02	1	1000Ω
TRANSFORMER			
T11	205C043G01	1	10,000/400
T12	205C043G03	1	25,000/300
CRYSTAL			
Y11	SEE NOTE ○		

▼ = C12 RANGE 4 TO 390PF. AS REQUIRED BY FREQUENCY AND CRYSTAL CHARACTERISTICS.

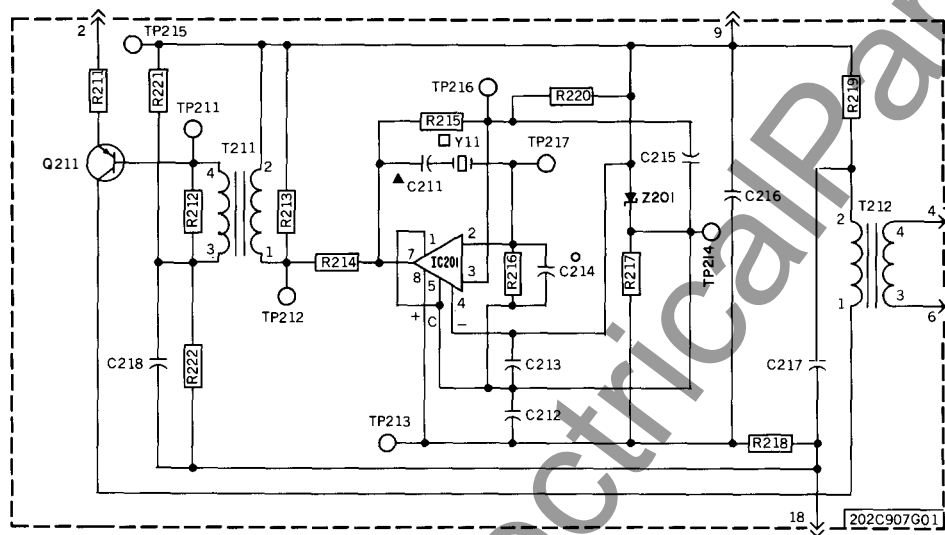
■ = C16 RANGE 22 TO 100PF. AS REQUIRED BY FREQUENCY AND CRYSTAL CHARACTERISTICS.

○ = Y11 RANGE-50 TO 220 KHZ.

REF. COMPONENT LOCATION- 763A292

264C855

* Fig. 18. Internal Schematic 30-200KHz Oscillator and Mixer Silicon Transistor Version



COMPONENT	STYLE	REQ.	REF.
TRANSISTOR			
Q211	849A441H03	1	2N4249
RESISTOR			
R211-R213-R215	184A763H51	3	10K 1/2W ±5%
R212	184A763H27	1	1K 1/2W ±5%
R214	184A763H37	1	2.7K 1/2W ±5%
R216	184A763H49	1	8.2K 1/2W ±5%
R217	184A763H34	1	2K 1/2W ±5%
R218	184A763H07	1	150Ω 1/2W ±5%
R219	184A763H15	1	330Ω 1/2W ±5%
R220	184A763H67	1	47K 1/2W ±5%
R221	184A763H83	1	220K 1/2W ±5%
R222	184A763H43	1	4.7K 1/2W ±5%
CAPACITOR			
C211	SEE NOTE ▲		
C212-C213-C215	184A663H04	3	.1MFD. 50V.
C214	SEE NOTE ○		
C216-C217	187A624H04	2	1 MFD. 200V.
C218	187A624H02	1	.25 MFD. 200V.
ZENER DIODE			
Z201	862A606H01	1	1N753A
INTERNAL CIRCUIT			
IC201	201C826H04	1	UA710C
TRANSFORMER			
T211	714B677G01	1	
T212	205C043G03	1	
CRYSTAL			
Y11	SEE NOTE □	1	

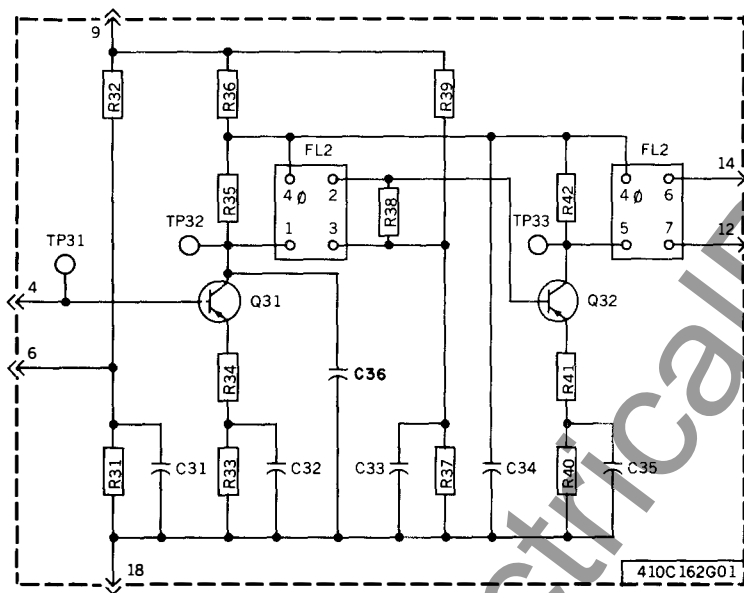
▲=C211 RANGES FROM 100PF. TO 1.000PF.

○=C214 STYLE NO. 187A695H17 .56PF. BUT MAY VARY UP TO 100PF.

□=Y11 FREQUENCY EQUALS RECEIVER (CHANNEL) FREQUENCY PLUS 20 KHZ.

264C844

* Fig. 19. Internal Schematic 200.5-300KHz. Oscillator and Mixer Silicon Transistor Version



COMPONENT	STYLE	REQ	REF
TRANSISTOR			
Q31-Q32	849A441H03	2	2N4249
RESISTOR			
R34-R41	187A290H21	2	68Ω 1/2W ±5%
R36	184A763H15	1	330Ω 1/2W ±5%
R33-R40	184A763H23	2	680Ω 1/2W ±5%
R38	184A763H27	1	1K 1/2W ±5%
R31-R37	184A763H39	2	3.3K 1/2W ±5%
R35-R42	184A763H51	2	10K 1/2W ±5%
R32-R39	184A763H59	2	22K 1/2W ±5%
CAPACITOR			
C31-C32-C33-C35	187A624H02	4	.25MFD. 200V
C34	187A624H04	1	1MFD. 200V.
C36	762A757H01	1	100 Pf.
FILTER			
.FL2	762A613G01	1	

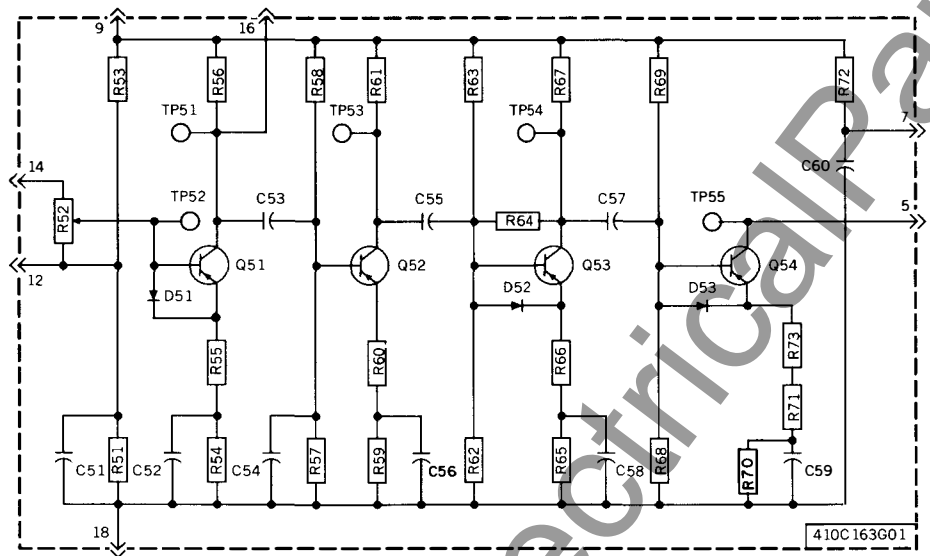
Ø = COMMON TERMINAL

264C856

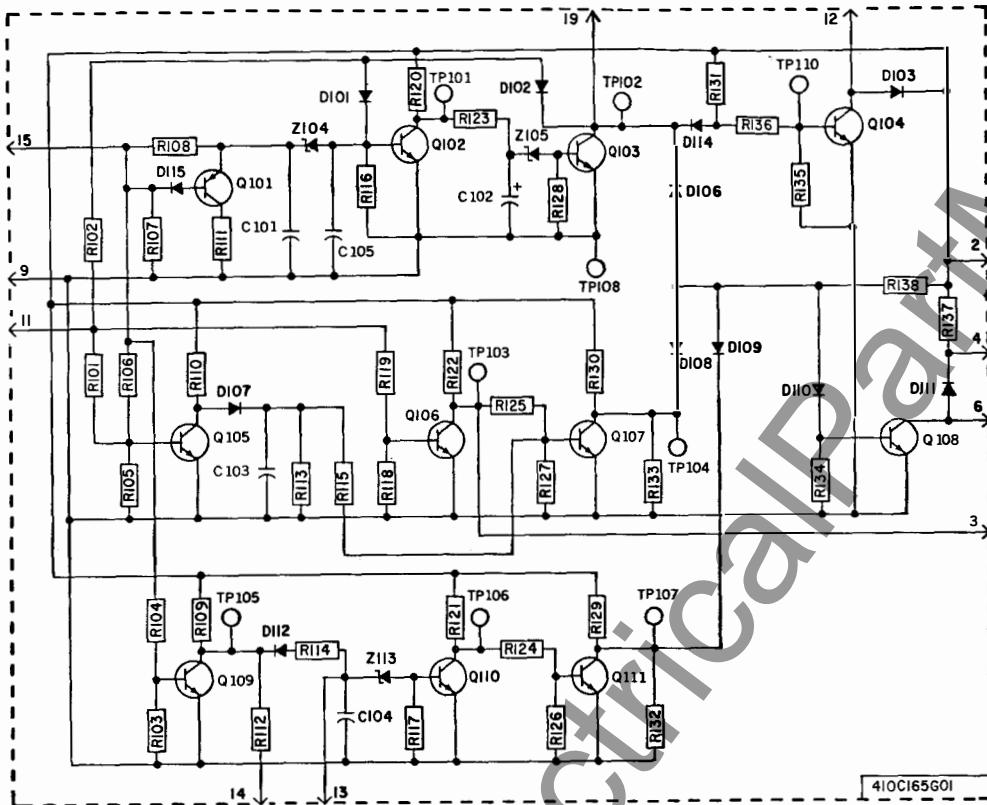
* Fig. 20. Internal Schematic I.F. Amplifier - Silicon Transistor Version

264C841

COMPONENT	STYLE	REQ	REF.
TRANSISTOR			
Q51-Q52-Q53-Q54	849A441H03	4	2N4249
RESISTOR			
R66	187A290H21	1	68Ω 1/2W ±5%
R55	187A290H11	1	27Ω 1/2W ±5%
R70	184A763H11	1	220Ω 1/2W ±5%
R72	184A763H15	1	330Ω 1/2W ±5%
R65	184A763H23	1	680Ω 1/2W ±5%
R59	184A763H31	1	1.5K 1/2W ±5%
R54-R62	184A763H35	2	2.2K 1/2W ±5%
R64-R68	184A763H37	2	2.7K 1/2W ±5%
R51-R57-R61-R67	184A763H43	4	4.7K 1/2W ±5%
R56	184A763H51	1	10K 1/2W ±5%
R69	184A763H57	1	18K 1/2W ±5%
R53-R58	184A763H61	2	27K 1/2W ±5%
R63	184A763H63	1	33K 1/2W ±5%
R71	09D8326G20	1	100Ω ±2%
R60	184A763H09	1	180Ω 1/2W ±5%
R73	629A531H02	1	56 Ω 1/2W ±2%
CAPACITOR			
C54	187A584H15	1	1300MMF. 500V.
C51-C52-C56-C58-C59	187A624H02	5	.25MFD. 200V.
C53-C55-C57	187A624H01	3	0.1MFD. 200V.
C60	187A624H04	1	1.0MFD. 200V.
DIODE			
D51-D52-D53	184A855H07	3	1N457A
POTENTIOMETER			
R52	629A645H04	1	1K



* Fig. 21. Internal Schematic Amplifier and Limiter – Silicon Transistor Version



COMPONENT	STYLE	REQ	REF
TRANSISTORS			
Q101	849A441H03	1	(2N4249)
Q102-106-110-111	762A585H01	4	(2N696)
Q103	184A638H18	1	(2N697)
Q107	762A585H02	1	(2N698)
Q105-108-109-104	184A638H19	4	(2N699)
RESISTORS			
R110	187A643H47	1	(6.8K 1W ±5%)
R109	187A643H51	1	(10K 1W ±5%)
R137	184A859H06	1	(800 Ω 3W)
R111	184A763H19	1	(470 1/2W ±5%)
R112-R114-R123	184A763H27	3	(1K 1/2W ±5%)
R136	184A763H39	1	(3.3K 1/2W ±5%)
R103-105-116 TO 118-126 TO 128-134-135-138	184A763H51	11	(10K 1/2W ±5%)
R131	184A763H53	1	(12K 1/2W ±5%)
R107	184A763H57	1	(18K 1/2W ±5%)
R104	184A763H61	1	(27K 1/2W ±5%)
R102-124-125-132-133	184A763H63	5	(33K 1/2W ±5%)
R101-106-120	184A763H65	3	(39K 1/2W ±5%)
R108	184A763H69	1	(56K 1/2W ±5%)
R121-122-129-130	184A763H71	4	(68K 1/2W ±5%)
R115	184A763H73	1	(82K 1/2W ±5%)
R119	184A763H75	1	(100K 1/2W ±5%)
R113	184A763H91	1	(470K 1/2W ±5%)
CAPACITORS			
C101	184A661H12	1	(4.7MFD. 10%)
C105	184A663H02	1	(.05MFD. 50V)
C102	184A661H25	1	(6.8MFD.)
C103-104	187A624H11	2	(.5MFD. ±10%)
DIODES			
D114	182A881H07	1	(1N100A)
D101 TO 103-106 TO 112 115	184A855H07	11	(1N457A)
DIO-ZENER			
Z105	185A212H06	1	(1N3686B)
Z113-104	186A797H06	2	(1N957B)

264C845

* Fig. 24. Internal Schematic Logic Board - Silicon Transistor Version

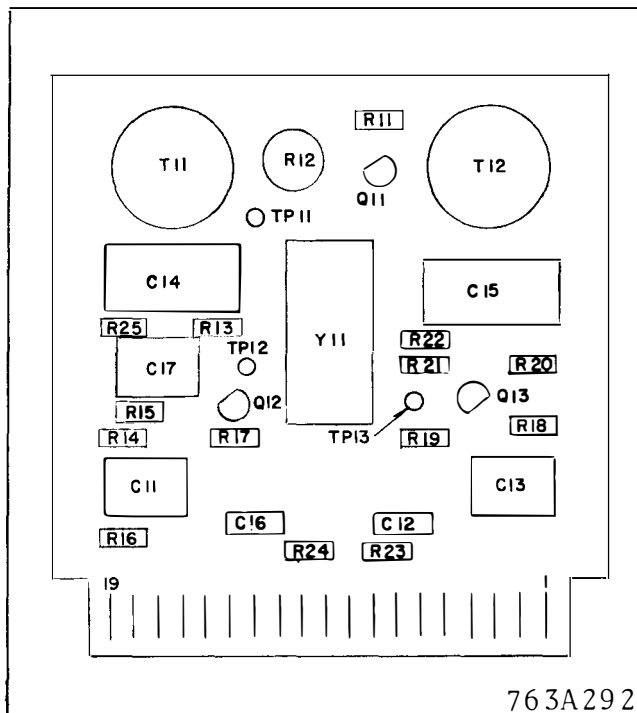


Fig. 25. Component Locations 30-200KHz. Oscillator and Mixer Silicon Transistor Version

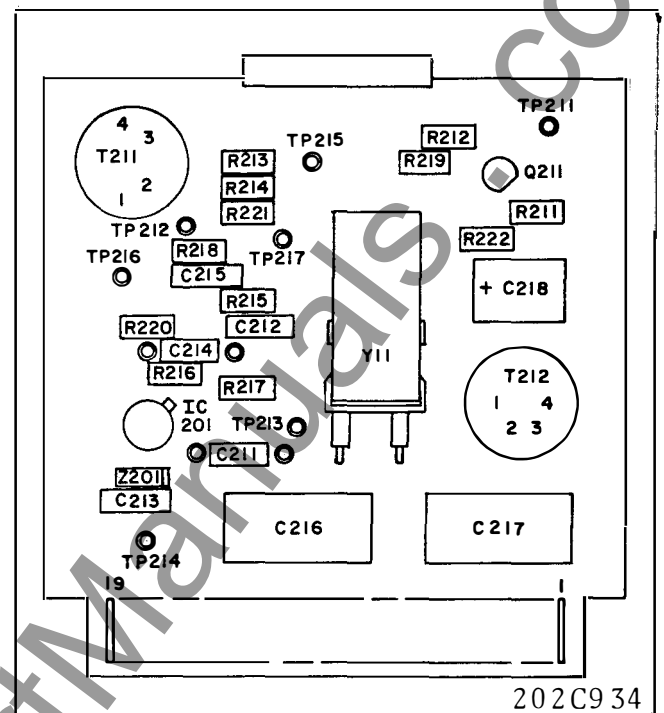


Fig. 26. Component Locations 200.5-300KHz. Oscillator and Mixer Silicon Transistor Version

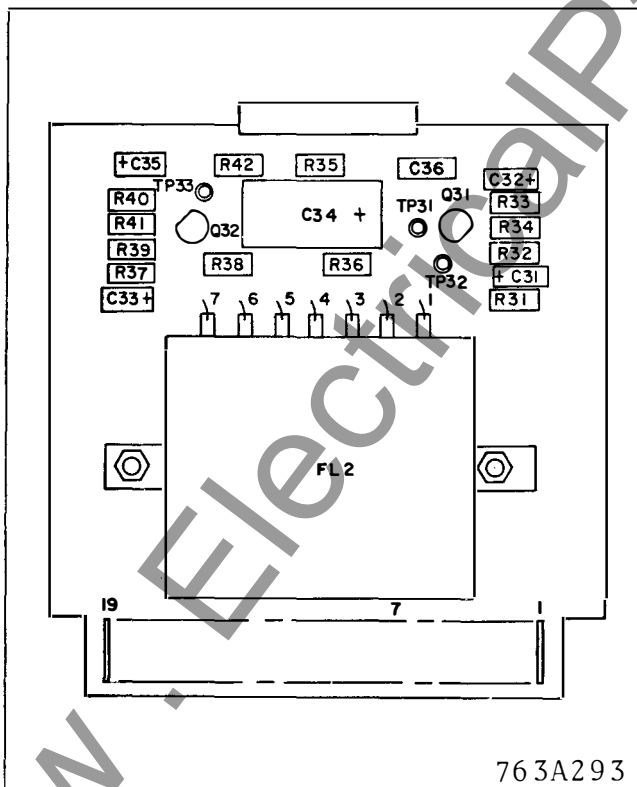


Fig. 27. Component Locations I.F. Amplifier - Silicon Transistor Version

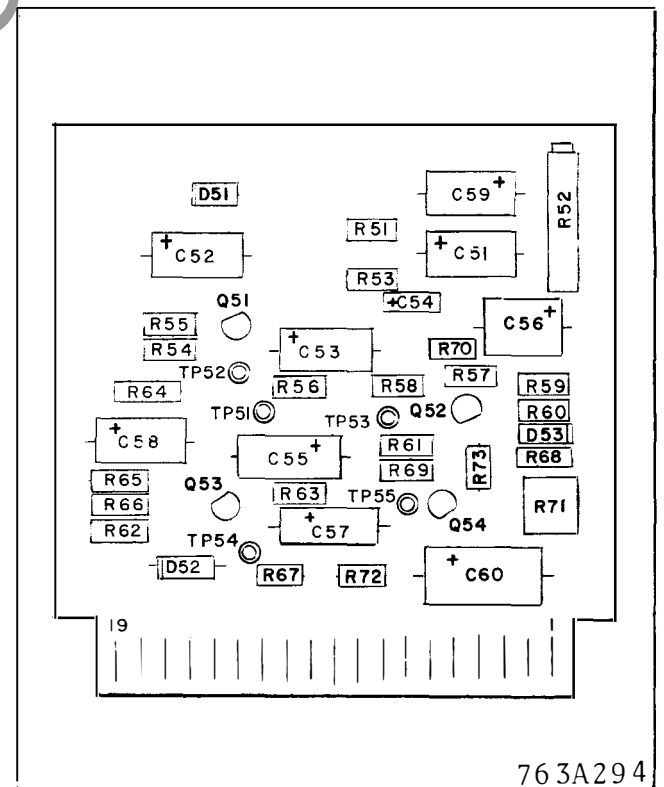


Fig. 28. Component Locations Amplifier and Limiter - Silicon Transistor Version

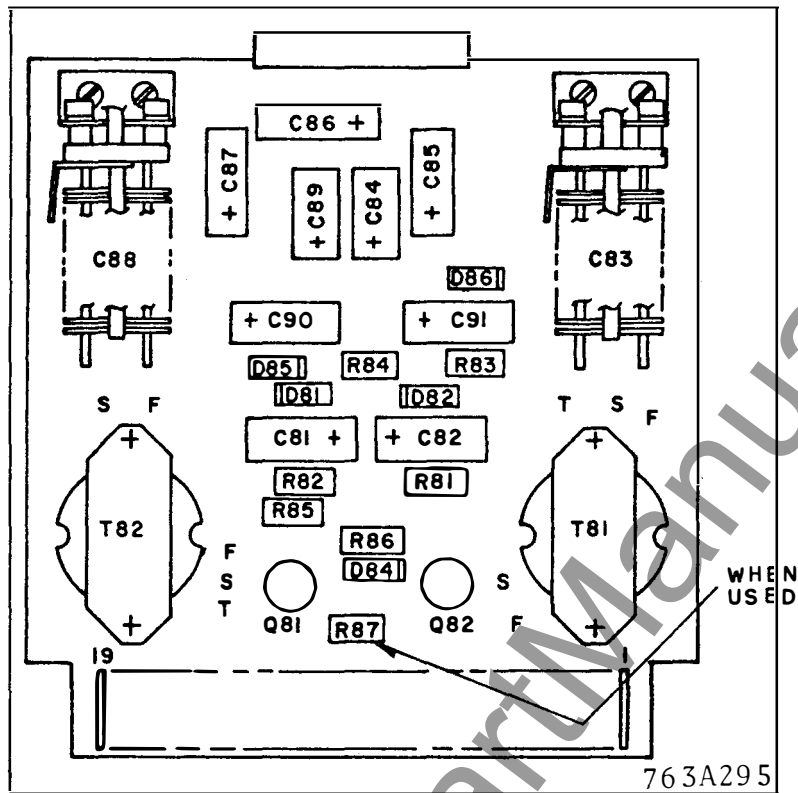


Fig. 29. Component Locations Discriminator – Silicon Transistor Version

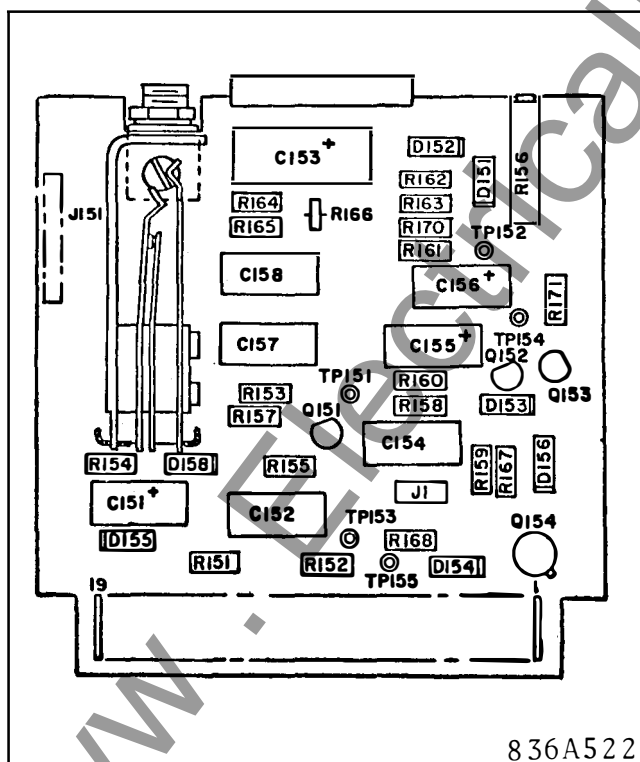


Fig. 30. Component Locations Carrier Level Indicator – Silicon Transistor Version

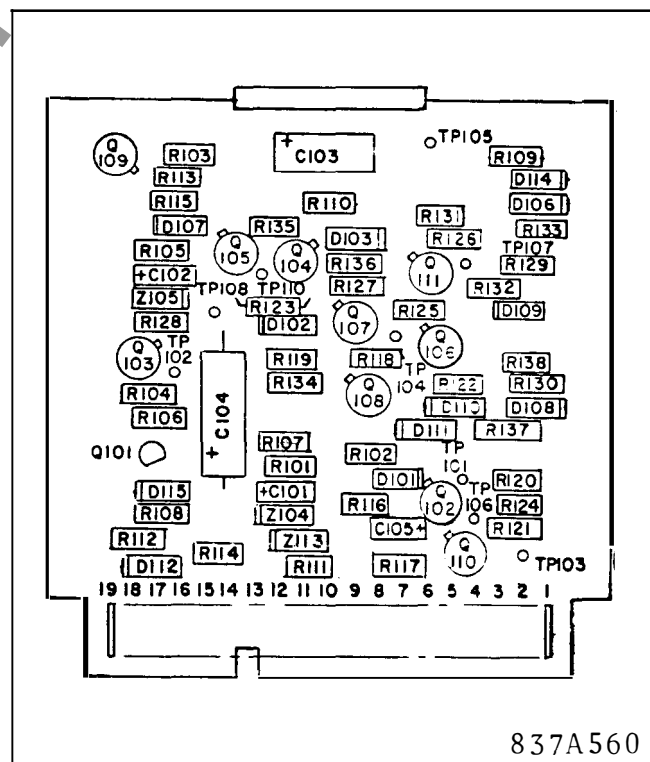
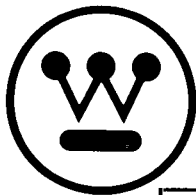


Fig. 31. Component Locations Logic Board – Silicon Transistor Version



INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF POWER LINE CARRIER FREQUENCY-SHIFT TRANSMITTER EQUIPMENT 3 FREQUENCY - 10 WATT / 1 WATT / 10 WATT

CAUTION: It is recommended that the user of this equipment become thoroughly familiar with the information in this instruction leaflet before energizing the carrier assembly. Failure to observe this precaution may result in damage to the equipment.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

A widely used high speed relaying system used for transmission line protection consists of directional-comparison unblock relaying plus a transfer-trip channel for breaker failure protection. Normally these systems of relaying require two frequency-shift channels, wideband for unblocking and narrow-band for transfer trip. A saving in channel spectrum can be effected by using a three frequency transmitter for the two relaying functions and two separate receivers, one for each function, as shown in Figure 7.

SYSTEM OPERATION

The three frequency TCF carrier transmitter provides for the transmission of any of three closely controlled discrete frequencies, all within the equivalent spacing of a single wide-band channel. The center frequency of the channel can vary from 30 kHz to 300 kHz in 0.5 kHz steps. The transmitter normally operates at a frequency that is 100 hz above the channel center frequency (fc). This frequency serves as the "guard" frequency for the transfer-trip receiver and as the "block" frequency for the unblock receiver. Note that the discriminator characteristic in the unblock receiver in this case is reversed from the normal unblock receiver used with the standard two frequency transmitter. This "guard" "block" frequency is transmitted continuously when conditions are normal. It indicates at the receiving end of the line that

the channel is operative and serves to prevent false operation of the receiver by line noise. The lowest frequency, which is 100 hz less than fc, is the "transfer trip" frequency and is transmitted as a signal that an operation (such as tripping a circuit breaker) should be performed at the receiving end of the line. The highest frequency, which is 300 hz above fc, is the "unblock" frequency and is transmitted as an unblock signal for directional comparison relaying. If a subsequent transfer-trip operation is called for, the transmitter will shift to $fc - 100$ hz which is the "trip" frequency for the transfer trip (narrow-band receiver).

Note that when the transmitter shifts to "unblock," the frequency is completely outside the passband of the narrow band transfer-trip receiver. Normally, this would cause a low-signal alarm output from that receiver. Similarly, when the frequency is shifted to "trip" ($fc - 100$ hz), the signal is well removed from the "block" peak of the wide-band receiver discriminator. In order to prevent a similar alarm output in this case, the checkback output of each receiver is cross-connected to the guard or block input of the opposite receiver (through an OR logic circuit). This logic is shown in Figure 8. The checkback output is a receiver output that indicates that a proper signal has been received without going through any time delays or other logic used for the actual relaying output. With this cross-connected logic, both receivers will function when required, but will not give any incorrect output indications.

The transmitter normally operates at an output level of one watt at the "guard" "blocking" frequency, but increases to ten watts for either "trip" or "unblock" output. An interlock is provided in the transmitter keying circuit to give transfer-trip preference. This means that even while the transmitter is shifted to the "unblock" frequency, if the transfer-trip keying circuit is energized, the transmitter will shift to the "trip" frequency without delay.

CONSTRUCTION

The 10 watt/1 watt/10 watt TCF transmitter unit is mounted on a standard 19-inch wide panel 12¼ inches (7 rack units) high with edge slots for mounting on a standard relay rack. A jack for metering the amplifier collector current is accessible from the front of the panel. See Fig. 6. All of the circuitry that is suitable for printed circuit board mounting is on two such boards, as shown in Fig. 2. The components mounted on each printed circuit board or other sub-assembly are shown enclosed by dotted lines on the internal schematic. Fig. 1. The location of components on the three printed circuit boards are shown on separate illustrations, Fig. 3, 4 & 5.

External connections to the assembly are made through a 12-circuit receptacle, J3. The r.f. output connection to the assembly is made through a coaxial cable jack, J2.

OPERATION

The transmitter is made up of four main stages and two filters. The stages include two crystal oscillators operating at frequencies that differ by the desired channel center frequency, a mixer and buffer amplifier, a driver stage and a power amplifier. The interstage filter is located between the driver and the power amplifier. The output filter removes harmonics that may be generated by distortion in the power amplifier.

A single crystal designed for oscillation in the 30 kHz to 300 kHz range cannot be forced to oscillate away from its natural frequency by as much as ± 100 hz. In order to obtain this desired frequency shift, it is necessary to use crystals in the 2 MHz range. The crystals are Y1 and Y2 of Fig. 1. The frequency of Y2 is 2.00 MHz when operated with a specified amount of series capacity, and the frequency of Y1 is 2.00 MHz plus the channel center frequency, or 2.03 MHz for 30 kHz center frequency. Capacitor C55 and crystal Y2 in series are connected between the positive side of the supply voltage and the base of transistor Q51, which operates in the emitter following mode. The emitter is coupled to the base through C57. With Y2 removed the base of Q51 would be held at approximately the midpoint of the supply voltage by R51 and R52. The crystal serves as a series-resonant circuit with very high inductance and low capaci-

tance. The circuit can be made to oscillate at other than the natural frequency of the crystal by varying the series capacitor, C55. Increasing C55 will lower the frequency of oscillations and reducing C55 will raise the frequency.

Capacitor C73 (in parallel with C70) is not effective until D55 is biased in the forward direction and becomes conductive. It is biased in the reverse direction until the keying control for unblock is closed which places 45V. dc at terminal 12 of the printed circuit board. With D55 conducting, C73 and C70 are placed in parallel with C55 and C74. The adjustment of C73 will reduce the frequency of the Y2 circuit by 200 hz. Since Y2 is the lower of the two frequencies derived from Y1 and Y2, the difference frequency, which is the frequency transmitted, is now increased by 200 hz. Thus the frequency transmitted is now 200 hz above the guard frequency or 300 hz above the center frequency.

Crystal Y1 is connected in a circuit that is similar except for the addition of C53 and diodes D51 and D52. By adjustment of C52 this circuit is made to oscillate at 100 hz above its marked frequency. Capacitors C53 and C76 are not effective until D51 is biased in the forward direction and becomes conductive. It is biased in the reverse direction until the keying control is closed, which places 45 V. dc at terminal 1 of the printed circuit board. With D51 conducting, C53 and C76 are effectively in parallel with C52 and C75. The adjustment of C53 will reduce the frequency by 200 hz. The crystals taken individually have a greater variation of frequency with temperature than would be acceptable. However, by proper matching of the two crystals, the variation in their difference frequency can be kept within limits that permit holding the frequency station of the overall transmitter to ± 10 hz over a temperature range of -20 to $+55^{\circ}\text{C}$.

The frequencies produced by the two oscillators are coupled to the base of mixer transistor Q53 through C62 and C63. The sum of the two frequencies is so high that a negligible amount appears on the secondary of transformer T51, but the difference frequency is accepted and amplified by Q53 and Q54.

When the keying control is closed, it increases the output power from 1 watt to 10 watts as well as changing the frequency from Guard to Transfer or Unblock Trip. This is effected by reducing the

emitter resistance of buffer-amplifier transistor Q54. When the keying control is open, transistor Q55 receives no base current and is non-conducting. Emitter resistor R70 therefore is effectively open-circuited. The level of output power is adjusted to 1 watt by means of R64. When Q55 is made conductive by closing the keying control circuit, R70 is placed in parallel with R68 and the amount of emitter resistance unbypassed by C66 can be adjusted as required to obtain a 10-watt output level.

Note in the keying board that diode D12 serves as interlocking logic connection between the keying for "unblock" and the keying for "transfer trip". This logic permits the "transfer trip" keying to take preference over the "unblock" keying. That is even if we have "unblock" keying and then get "transfer trip" keying, the "transfer trip" will take immediate preference over the "unblock" keying. This is accomplished by the "transfer trip" keying causing transistor Q12 to conduct which in turn shunts out the keying voltage input to transistor Q22 through diode D12. Thus while Q12 becomes conducting and consequently Q11, effecting "transfer trip" keying, this conduction of Q12 also prevents Q22 from becoming conducting and prevents "unblocking" keying.

As is shown on the Internal Schematic, Fig. 1, the voltage for the keying circuit is obtained from the 45-volt regulated supply in the transmitter.

The driver stage consists of transistors Q56 and Q57 connected in a conventional push-pull circuit with input supplied from the collector of Q54 through transformer T52. Thermistor R73 and resistors R74 and R75 are connected to provide a variable bias that reduces the effect of varying ambient temperatures on the input level. In addition, network R67, R79, and potentiometer R80 are used in the bias circuit and are adjusted by means of R80 to limit the quiescent current in the driver stage common to 0.2 ma. This adjustment is made by unsoldering the lead going from pin 2 of the transmitter to terminal 2 of transformer T1 and inserting a d-c milliammeter (0-1.0 ma) between this pin 2 and terminal 2 of T1. The R80 is adjusted to produce $0.2 \text{ ma} \pm .05$ in this circuit, after this, the milliammeter is removed and the lead replaced.

The driver filter, FL101, consists of a series-resonant inductor and capacitor connected between the driver and power amplifier stages by appropriate transformers T1 and T2. This filter greatly im-

proves the waveform of this signal applied to the power amplifier.

The power amplifier uses two series-connected power transistors, Q101 and Q102, operating as a class B push-pull amplifier with single-ended output. Diodes D101 and D103 provide protection for the base-emitter junctions of the power transistors. Zener diodes Z105 and Z106 protect the collector-emitter junctions from surges that might come in from the power line through the coaxial cable.

The output transformer T3 couples the power transistors to the output filter FL102. The output filter includes two trap circuits (L102, C_B and L103, C_C) which are factory tuned to the second and third harmonics of the transmitter frequency. Capacitor C_D approximately cancels the inductive reactance of the two trap circuits at the operating frequency. Protective gap G1 is a small lightning arrester to limit the magnitude of switching surges or other line disturbances reaching the carrier set through the line turner and coaxial cable. Auto-transformer T4 matches the filter impedance to coaxial cable of 50, 60, or 70 ohms.

The series resonant circuit composed of L105, and C_E is tuned to the transmitter frequency, and aids in providing resistive termination for the output stage. Jack J102 is mounted on the rear panel of FL102 and is used for measuring the r.f. output current of the transmitter into the coaxial cable. It should be noted that the filter contains no shunt reactive elements, thus providing a reserve impedance that is free of possible "across-the-line" resonances.

The power supply is a series-type transistorized d-c voltage regulator which has a very low stand-by current drain when there is no output current demand. The Zener diode Z1 holds a constant base-to-negative voltage on the series-connected power transistor Q1. Depending on the load current, the d-c voltage drop through transistor Q1 and resistors R1 and R2 varies to maintain a constant output voltage. The Zener diode Z2 serves to protect the collector-base junction of Q1 from surge voltages. Capacitor C1 provides a low carrier-frequency impedance across the d-c output voltage. Capacitors C2 and C3 bypass r.f. or transient voltages to ground, thus preventing damage to the transistor circuit.

CHARACTERISTICS

Frequency	30-300 kHz
Range	1 watt guard- 10 watts transfer
Output	trip (into 50 to 70 ohm resistive load) — 10 watts unblock.
Frequency Stability	±10 hz from -20°C to +55°C.
Frequency Spacing	3000 hz min. between transmitter and adjacent receiver frequencies.
Harmonics	Down 55 db (min.) from output level.
Input voltage	48 or 125 v.d.c.
Supply voltage variation	42-56 v. for nom. 47 v. supply. 105-140 v. for nom. 125 v. supply.
Battery drain	0.5 a. guard } 1.15 a. trip } 48 v.d.c.
	0.5 a. guard } 1.15 a. trip } 125 v.d.c.
Keying circuit current	4 ma.
Temperature range	-20 to +55°C. Around chassis.
Dimensions	Panel height - 12¼" or 7 r.u. Panel width - 19"
Weight	12 lbs.

INSTALLATION

The TCF transmitter is generally supplied in a cabinet or on a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. The maximum ambient temperature around the chassis must not exceed 55°C.

ADJUSTMENTS

The TCF 10W/1W/10W 3 frequency transmitter is shipped with the power output controls R64 and R70 set for outputs of 1 watt and 10 watts into a 60 ohm load. If it is desired to check these adjustments or if repairs have made readjustment necessary, the coaxial cable should be disconnected from the assembly terminals and replaced with a 50 to 70 ohm non-inductive resistor of at least a 10 watt

rating. Use the value of the expected input impedance of the coaxial cable and line tuner. If this is not known, assume 60 ohms. Connect the T4 output lead to the corresponding tap. Connect an a-c vacuum tube voltmeter (VTVM) across the load resistor. Turn power output control R64 to minimum (full counter-clockwise). Turn on the power switch on the panel and note the d-c voltage across terminals 5 and 7 of J3. If this is in the range of 42 to 46 volts, rotate R64 clockwise to obtain 4 or 5 volts across the load resistor used. At this point check the adjustment of the series output tuning coil L105 by loosening the knurled shaft-locking nut and moving the adjustable core in and out a small amount from its initial position. Leave it at the point of maximum voltage across the load resistor used. Then rotate R64 farther clockwise to obtain the correct voltage for 1 watt in the load resistor, as shown in the following table. For above 200 kHz, tuning coil L105 is a screw type adjustment and not a plunger with knurled shaft and locking nut.

Then change to Trip frequency by connecting together terminals 2 and 3 of the transmitter printed circuit board (which is approximately equivalent to connecting together terminals 7 and 8 of J3), and rotate R70 until the voltage across the load resistor is as shown in the following table for a 10 watt output. Recheck the adjustment of L105 for maximum output voltage and readjust R70 for a 10 watt output if necessary. Tighten the locking nut on L105. Open the power switch, remove the jumper used to key the transmitter to the 10 watt level, remove the load resistor, and reconnect the coaxial cable circuit to the transmitter.

T106 Tap	Voltage for 1 Watt Output	Voltage for 10 Watts Output
50	7.1	22.4
60	7.8	24.5
70	8.4	26.5

Follow the procedure outlined in the line tuner instructions for its adjustment.

Normally the output filter (FL102) will require no readjustment except as noted above. It is factory tuned for maximum second and third harmonic rejection, and for series resonance (maximum output at the fundamental frequency) with a 60-ohm load. A small amount of reactance in the transmitter output load circuit may be tuned out by readjustment of the movable core of L105. This may be necessary with some types of line coupling equipment. The adjust-

able cores of L102 and L103 have been set for maximum harmonic rejection and no change should be made in these settings unless suitable instruments are available for measuring the second and third harmonic present in the transmitter output.

The operating frequencies of crystals Y1 and Y2 have been carefully adjusted at the factory and good stability can be expected. If it is desired to check the frequencies of the individual crystals, this can be done by turning the matched pair 180° and inserting a crystal in its proper socket with other crystal unconnected. A sensitive frequency counter with a range of at least 2.3 MHz can be connected from TP51 to TP54. (Connection to TP54 rather than to TP53 provides a better signal to the counter input capacitance on the oscillator circuit.) While measurement of the oscillator crystals individually is necessary for the initial adjustment of the oscillators, generally any subsequent checks may be made with a lower range counter connected at the transmitter output. If any minor adjustment of the Guard and Trip frequencies should be needed, the Guard adjustment should be made with capacitor C52 and the Trip adjustment with C53.

MAINTENANCE

Periodic checks of the transmitter Guard and Trip power outputs will detect impending failure so that the equipment can be taken out of service for correction. At regular maintenance intervals, any accumulated dust should be removed, particularly from the heat sinks. It is also desirable to check the transmitter power output at such times, making any necessary readjustments to return the equipment to its initial settings.

Voltage values should be recorded after adjustment in order to establish reference values which will be useful when checking the apparatus. The readings will remain fairly constant over an indefinite period unless a failure occurs. However, if transistors are changed, there may be considerable difference in these readings without the overall performance being affected.

Typical voltage values are given in the following tables. Voltages should be measured with a VTVM. Readings may vary as much as $\pm 20\%$.

TABLE I
TRANSMITTER D-C MEASUREMENTS

Note: All voltages are positive with respect to Neg. 45 V. (TP51). All voltages read with d-c VTVM.

Test Point	Voltage at 1 Watt Output	Voltage at 10 Watts Output
TP52	20	20
TP53	5.4	5.4
TP54	3.4	3.4
TP55	21	18.5
TP56	21	18.5
TP57	* < 1.0	* < 1.0
TP58	44.3	44.1
TP59	* < 1.0	* < 1.0
TP101	0	0
TP103	21 \pm 2	21 \pm 2
TP105	44.3	44.0

TABLE II
TRANSMITTER RF MEASUREMENTS

Note: Voltages taken with transmitter set to indicated output across 60 ohms. These voltages subject to variations, depending upon frequency and transistor characteristics. T51-3 = Terminal 3 of transformer T51. Other transformer terminals identified similarly. All read with a-c VTVM.

Test Point	Voltage at 1 Watt Output	Voltage at 10 Watts Output
TP54 to TP51	0.015-0.03	0.015-0.03
TP57 to TP51	0.05 -0.09	0.3 -1.2
TP59 to TP51	0.05 -0.09	0.3 -1.2
T1-1 to TP51	1.65	5.6
T1-3 to TP51	1.45	4.9
T1-4 to Gnd.	.6	2.0
T2-1 to Gnd.	.57	1.85
TP101 to TP103	5.2	17.0
TP103 to TP105	5.2	17.0
T3-4 to Gnd.	35	112
T4-2 to Gnd.	31	110
TP109 to Gnd.	9.8	31
J102 to Gnd.	7.8	24.5

CONVERSION OF TRANSMITTER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a 1W/10W TCF transmitter for operation on a different channel frequency consist of a pair of matched crystals for the new channel frequency, new capacitors C103 and C104 on the power amplifier circuit board if the old and new frequencies are not in the same frequency group (see table on internal schematic drawing) and, in general, new or modified filters FL101 and FL102. Inductors L101, L102 and L103 in these filters are adjustable over a limited range, but thirty-two combinations of capacitors and inductors are required to cover the frequency range of 30 to 200 kHz. The widths of the frequency groups vary from 1.5 kHz at the low end of the channel frequency range to 13 kHz at the upper end. A particular assembly can be adjusted over a somewhat wider range than the width of its assigned group since some overlay is necessary to allow for component tolerances. The nominal kHz adjustment ranges of the group are:

30.0-31.5	61.0- 64.0	113.0-119.5	207.1-214.0
32.0-33.5	64.5- 68.0	120.0-127.0	214.1-222.0
34.0-36.0	68.5- 72.0	127.5-135.0	222.1-230.0
36.5-38.5	72.5- 76.0	135.5-143.0	230.1-240.0
39.0-41.0	76.5- 80.0	143.5-151.0	240.1-250.0
41.5-44.0	80.5- 84.5	151.5-159.5	250.1-262.0
44.5-47.0	85.0- 89.0	160.0-169.5	262.1-274.0
47.5-50.0	89.5- 94.5	170.0-180.0	274.1-287.0
50.5-53.5	95.0-100.0	180.5-191.5	287.1-300.0
54.0-57.0	100.5-106.0	192.0-220.0	
57.5-60.5	106.5-112.5	200.1-207.0	

If the new frequency lies within the same frequency group as the original frequency, the filters can be readjusted. If the frequencies are in different groups, it is possible that changes only in the fixed capacitors may be required. In general, however, it is desirable to order complete filter assemblies adjusted at the factory for the specified frequency.

A signal generator, a frequency counter and a vacuum tube voltmeter are required for readjustment of FL101. The signal generator and the counter should be connected across terminals 4 and 5 of transformer T1 and the voltmeter across terminals 1 and 2 of transformer T2. The signal generator should be set at the channel center frequency and at 2 to 3 volts output. The core screw of the small inductor should be turned to the position that gives

a true maximum reading on the VTVM. Turning the screw to either side of this position should definitely reduce the reading. The change in inductance with core position is less at either end of the travel than when near the center and consequently the effect of core screw rotation on the VTVM reading will be less when the resonant inductance occurs near the end of core travel.

The procedure for readjustment of the 2nd and 3rd harmonic traps of filter FL102 is somewhat similar. A signal generator and a counter should be connected to terminals 3 and 4 of transformer T3, and a 500 ohm resistor and a VTVM to the terminals of protective gap G1. The ground or shield lead of all instruments should be connected to the grounded terminal of the transformer. Set the signal generator at exactly twice the channel center frequency and at 5 to 10 volts output. Turn the core screw of the large inductor, L102, to the position that gives a definite minimum reading on the VTVM. Similarly, with the signal generator set at exactly three times the channel center frequency and 5 to 10 volts output, set the core screw of the small inductor, L103, to the position that gives a definite minimum reading on the VTVM. Then remove the instruments and the 500 ohm resistor.

After the new pair of matched crystals have been adjusted, as described under "ADJUSTMENTS", the transmitter can be operated with a 50 to 70 ohm load (depending on which tap of T4 is used) connected to its output, and inductor L105 can be readjusted for maximum output at the changed channel frequency by the procedure described in the same section.

If a frequency-sensitive voltmeter is available, the 2nd and 3rd harmonic traps may be adjusted without using an oscillator as a source of double and triple the channel frequency. Connect the frequency-sensitive voltmeter from TP109 to ground and adjust the transmitter for rated output into the selected load resistor. Set the voltmeter at twice the channel frequency and, using the tuning dial and db range switch, obtain a maximum on-scale reading of the 2nd harmonic. Then vary the core position of L102 until a minimum voltmeter reading is obtained. Similarly, tune the voltmeter to the third harmonic and adjust L103 for minimum voltmeter reading. Although the transmitter frequency will differ from the channel center frequency by 100 Hz, the effect of this difference on the adjustment of the harmonic traps will be negligible. It should be

noted that the true magnitude of the harmonics cannot be measured in this manner because of the preponderance of the fundamental frequency at the voltmeter terminals. Accurate measurement of the harmonics requires use of a filter between TP109 and the voltmeter that provides high rejection of the fundamental. The insertion losses of this filter for the 2nd and 3rd harmonics must be measured and taken into account.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation.

- a. 60-ohm 10-watt non-inductive resistor.
- b. A-C vacuum Tube Voltmeter (VTVM). Voltage range 0.003 to 30 volts, frequency range 60 hz to 330-kHz; input impedance 7.5 megohms.
- c. D-C Vacuum Tube Voltmeter (VTVM).
Voltage Range: 1.5 to 300 volts.
Input Impedance: 7.5 megohms.

II. Desirable Test Equipment for Apparatus Maintenance.

- a. All items listed in I.
- b. Signal Generator
Output Voltage up to 8 volts.
Frequency Range: 20-kHz to 330-kHz.
- c. Oscilloscope
- d. Frequency counter
- e. Ohmmeter
- f. Capacitor checker.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data and identify the part by its designation on the Internal Schematic drawing.

ELECTRICAL PARTS LIST

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
CAPACITORS		
C1	Oil-filled; 0.45 mfd.; 330 V.A.C.	1723408
C2	Oil-filled; 0.5 mfd.; 1500 V.D.C.	1877962
C3	Oil-filled; 0.5 mfd.; 1500 V.D.C.	1877962
C11	Metallized Paper, .047 mfd.;	849A437H04
C21	Metallized Paper, .047 mfd.;	849A437H04
C51	Dur-Mica, 1500 pf.; 500 V.D.C.	762A757H03
C52	Variable, 5.5-18 pf.	879A834H01
C53	Variable 5.5 -18 pf.	879A834H01
C54	Metallized paper, .1 mfd.; 200 V.D.C.	187A624H01
C55	Variable, 5.5-18 pf.	762A736H01
C56	Dur-Mica, 2000 pf.; 500 V.D.C.	187A584H01
C57	Dur-Mica, 2000 pf.; 500 V.D.C.	187A584H01
C58	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C59	Dur-Mica, 100 pf., 500 V.D.C.	762A757H01
C60	Dur-Mica, 100 pf., 500 V.D.C.	762A757H01
C61	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C62	Dur-Mica, 4700 pf.; 500 V.D.C.	762A757H04
C63	Dur-Mica, 1000 pf.; 500 V.D.C.	762A757H02
C64	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C65	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C66	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C67	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C68	Metallized paper, 0.5 mfd.; 200 V.D.C.	187A624H03
C69	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C70	3 pf.	861A846H03
C71	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C72	Dur-Mica, 300 pf, 500 V.D.C.	187A584H09
C73	Variable, 5.5-18 pf.	879A834H01
C74	3 pf.	861A846H03
C75	3 pf.	861A846H03
C76	3 pf.	861A846H03
C101	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C102	Metallized paper, 0.25 mfd.; 200 V.D.C.	187A624H02
C103 & C104	(30-50 KC) — Extended foil, 0.47 mfd.; 400 V.D.C.	188A293H01
C103 & C104	(50.5-75 KC) — Extended foil, 0.22 mfd.; 400 V.D.C.	188A293H02
C103 & C104	(75.5 - 100 KC) — Extended foil, 0.15 mfd., 400 V.D.C.	188A293H03
C103 & C104	(100.5 - 150 KC) — Extended foil, 0.10 mfd., 400 V.D.C.	188A293H04
C103 & C104	(150.5 - 300 KC) — Extended foil, 0.047 mfd.; 400 V.D.C.	188A293H05
DIODES — GENERAL PURPOSE		
D11	1N645A	837A692H03
D12	1N645A	837A692H03
D13	1N4822	188A342H11
D14	1N4822	188A342H11

ELECTRICAL PARTS LIST

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
DIODES – GENERAL PURPOSE		
D15	1N4822	188A342H11
D16	1N4822	188A342H11
D21	1N645A	837A692H03
D22	1N4822	188A342H11
D23	1N4822	188A342H11
D24	1N4822	188A342H11
D25	1N4822	188A342H11
D51	1N628; 125 V.; 30 MA.	184A885H12
D52	1N628; 125 V.; 30 MA.	184A885H12
D53	1N457A; 60 V.; 200 MA.	184A885H07
D55	1N628; 125V; 30 MA.	184A885H12
D56	1N628; 125 V.; 30 MA.	184A885H12
D57	1N457A; 60 V.; 200 MA.	184A885H07
D101	1N538; 200 V.; 750 MA.	407C703H03
D102	1N91; 100 V.; 150 MA.	182A881H04
D103	1N538; 200 V.; 750 MA.	407C703H03
D104	1N91; 100 V.; 150 MA.	182A881H04
DIODES – ZENER		
Z1	1N2828B; 45V. $\pm 5\%$; 50 W.	184A854H06
Z2	1N3009A; 130 V. $\pm 10\%$; 10 W.	184A617H12
Z11	1N957B	186A797H06
Z12	1N3688A	862A288H01
Z13	1N3688A	862A288H01
Z14	1N3686B	185A212H06
Z21	1N957B	186A797H06
Z22	1N3688A	862A288H01
Z23	1N3688A	862A288H01
Z24	1N3686B	185A212H06
Z54	1N3686B; 20 V. $\pm 5\%$; 750 MW.	185A212H06
Z105	1N2999A; 56 V. $\pm 10\%$; 10 W.	184A617H13
Z106	1N2999A; 56 V. $\pm 10\%$; 10 W.	184A617H13
RESISTORS		
R1	26.5 ohms $\pm 5\%$; 40 W. (For 125 V Supply)	04D1299H44
R2	26.5 ohms $\pm 5\%$; 40 W. (For 125 V Supply)	04D1299H44
R3	26.5 ohms $\pm 5\%$; 40 W. (For 48 V Supply)	04D1299H44
R3	500 ohms $\pm 5\%$; 40 W. (For 125 V Supply)	1268047
R4	100 ohms $\pm 10\%$; 1 W. Composition	187A644H03
R5	1K $\pm 10\%$; $\frac{1}{2}$ W. Composition	187A641H27
R6	3K $\pm 5\%$; 5 W. Wire Wound	188A317H01
R7	15K $\pm 10\%$; 2 W. Composition	187A642H55
R11	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R12	12K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H58
R13	10K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H56

ELECTRICAL PARTS LIST

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
RESISTORS (Continued)		
R14	6.2K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H51
R15	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R16	47K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze (For 125 Vdc)	629A531H72
R17	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R21	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R22	12K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H58
R23	10K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H56
R24	6.2K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H51
R25	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R26	15 K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze (For 48 Vdc)	629A531H60
R27	4.7K $\pm 2\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H48
R51	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R52	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R53	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R54	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R55	100 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H03
R56	3.6K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H40
R57	3.6K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H40
R58	100 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H03
R59	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R60	5.6K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H45
R61	15K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H55
R62	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R63	1K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H27
R64	Potentiometer, 1K; $\frac{1}{4}$ W.	629A430H02
R65	1.8K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H02
R66	8.2K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H49
R67	12K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H53
R68	330 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H15
R69	800 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A859H06
R70	Potentiometer, 1K; $\frac{1}{4}$ W.	629A430H02
R71	4.7K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H43
R72	39K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H65
R73	Thermistor, 30 ohms, Type 3D202 (G.E.C.)	185A211H06
R74	180 Ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H02
R75	100 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H03
R76	2K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H34
R77	10 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H01
R78	10 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H01
R79	20K $\pm 20\%$; $\frac{1}{2}$ W. Metal Glaze	629A531H63
R80	25K Potentiometer $\pm 20\%$; $\frac{1}{4}$ W.	629A430H09
R81	1K $\pm 1\%$ $\frac{1}{2}$ W. Metal Film	849A819H48

ELECTRICAL PARTS LIST

CIRCUIT SYMBOL	DESCRIPTION	WESTINGHOUSE DESIGNATION
RESISTORS (Cont'd.)		
R82	5K Pot. $\pm 20\%$; $\frac{1}{2}$ W.	629A430H07
R83	10.2K $\pm 1\%$; $\frac{1}{2}$ W. Metal Film	848A820H46
R84	27 Ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H11
R85	Thermistor 3D402 10 ohms	185A211H03
R86	750 ohms $\pm 1\%$; $\frac{1}{2}$ W. Metal Film	848A819H36
R87	10K $\pm 5\%$; $\frac{1}{2}$ W. Composition	184A763H51
R101	10 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A280H01
R102	2.2K $\pm 10\%$; 1 W. Composition	187A644H35
R103	2.7 ohms $\pm 10\%$; $\frac{1}{2}$ W. Wire Wound	184A636H14
R104	0.27 ohms $\pm 10\%$; 1 W. Wire Wound	184A636H18
R105	10 ohms $\pm 5\%$; $\frac{1}{2}$ W. Composition	187A290H01
R106	4.7K $\pm 10\%$; 1 W. Composition	187A644H43
R107	2.7 ohms $\pm 10\%$; $\frac{1}{2}$ W. Wire Wound	184A636H14
R108	0.27 ohms $\pm 10\%$; 1 W. Wire Wound	184A636H18
TRANSFORMERS		
T1	Driver Output Transformer	606B410G01
T2	Power Amp. Input Transformer	292B526G01
T3	Power Amp. Output Transformer	292B526G02
T4	Load-Matching Auto-Transformer	292B526G03
T51	Buffer Amplifier Transformer	606B537G01
T52	Driver Input Transformer	606B537G02
TRANSISTORS		
Q11	2N4356	849A441H02
Q12	2N699	184A638H19
Q21	2N4356	849A441H02
Q22	2N699	184A638H19
Q51	2N697	184A638H18
Q52	2N697	184A638H18
Q53	2N697	184A638H18
Q54	2N699	184A638H19
Q55	2N697	184A638H18
Q56	2N2726	762A672H07
Q57	2N2726	762A672H07
Q101	2N1908 (Use in Matched Pairs)	187A673H02
Q102	2N1908 (Use in Matched Pairs)	187A673H02
MISCELLANEOUS		
Y1-Y2	Supplied for Desired Channel Frequency in Pair Matched Per Specifications on Drawing	408C743
FL101	Driver Filter	408C261 + (Req. Freq.)
FL102	Output Filter	541D214 + (Req. Freq.)
PL	Pilot Light Bulb - For 48 V. Supply (When supplied)	187A133H02
	Pilot Light Bulb - For 125 or 250 V. Supply (When supplied)	183A955H01
F1, F2	Fuse, 1.5A (When supplied)	11D9195H26

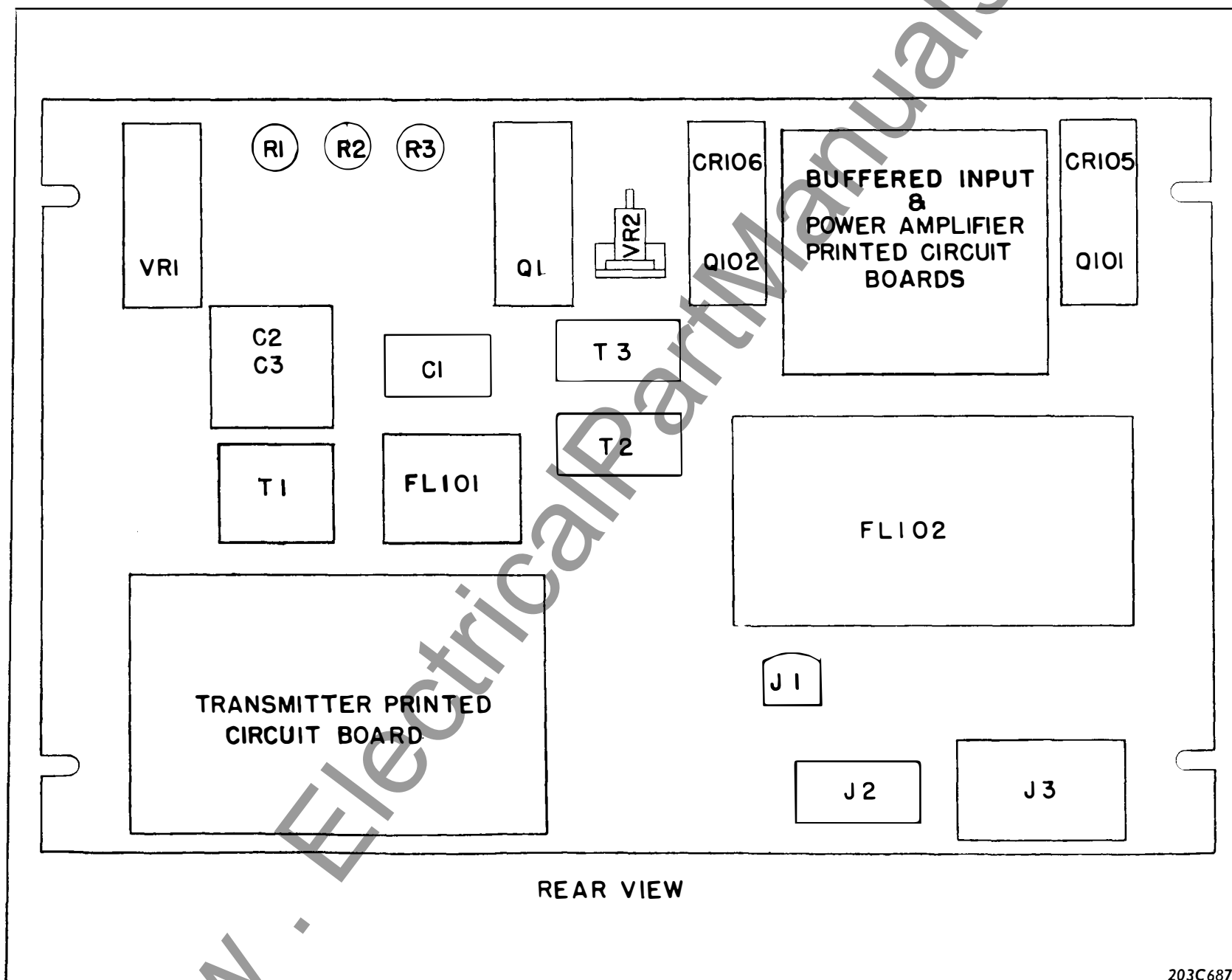


Fig. 2. Component locations of the type TCF Transmitter Assembly.

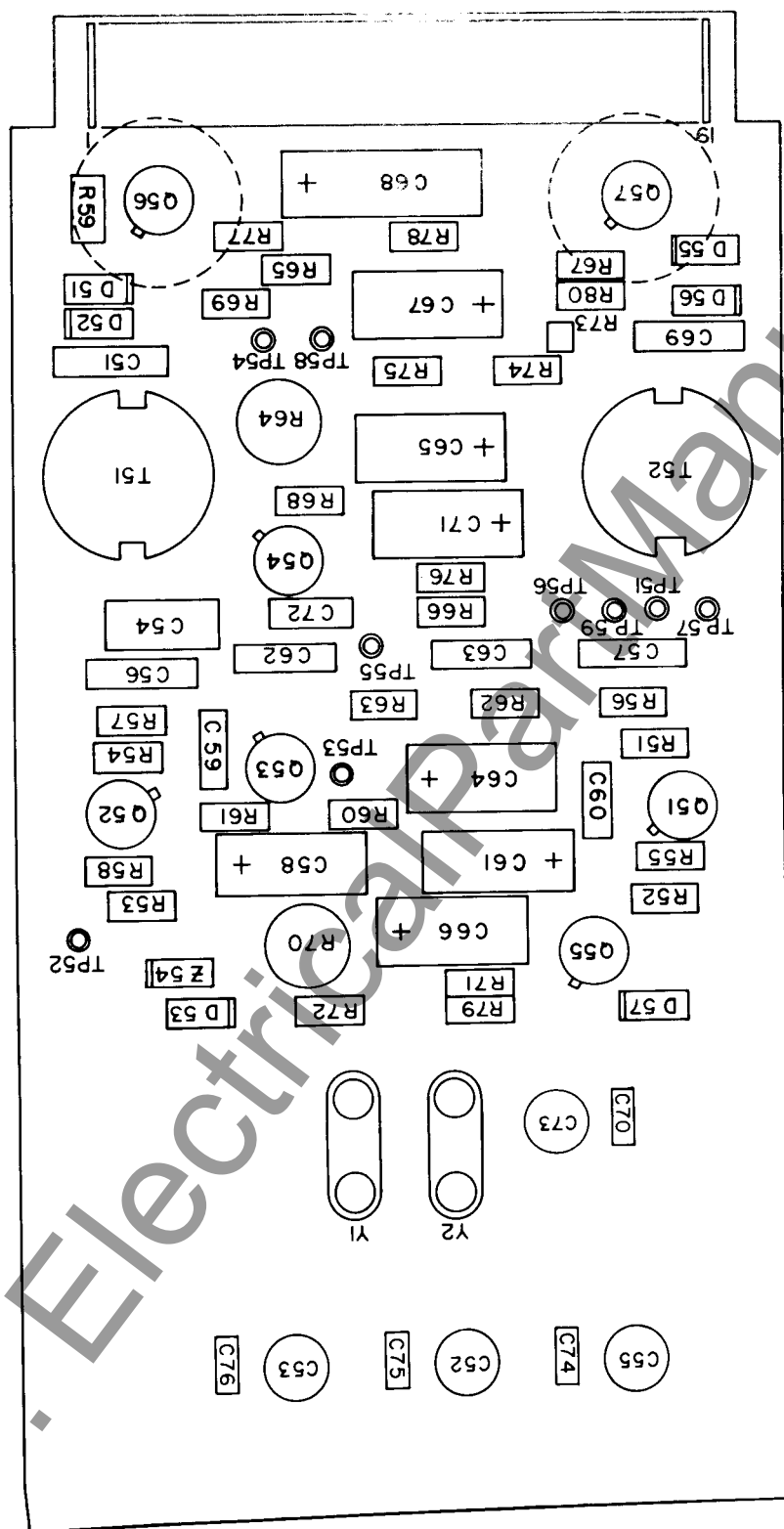
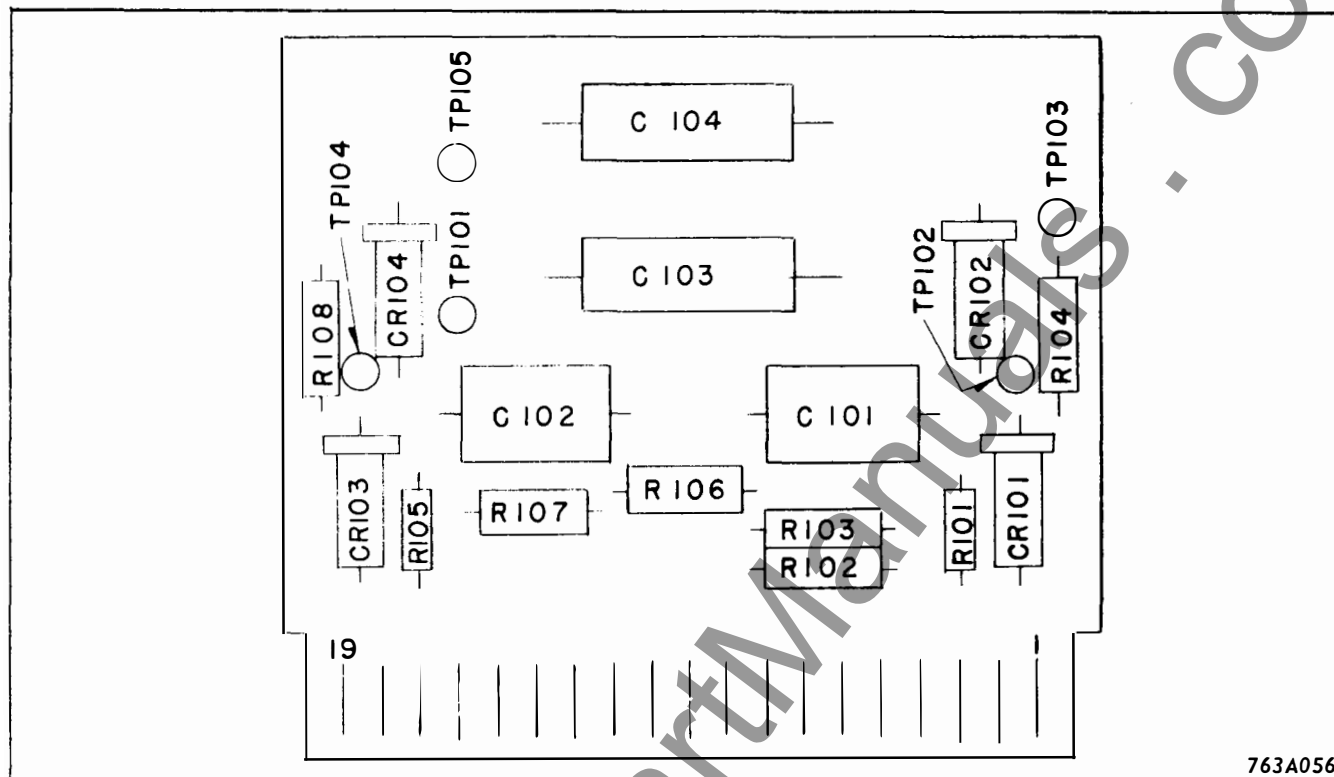
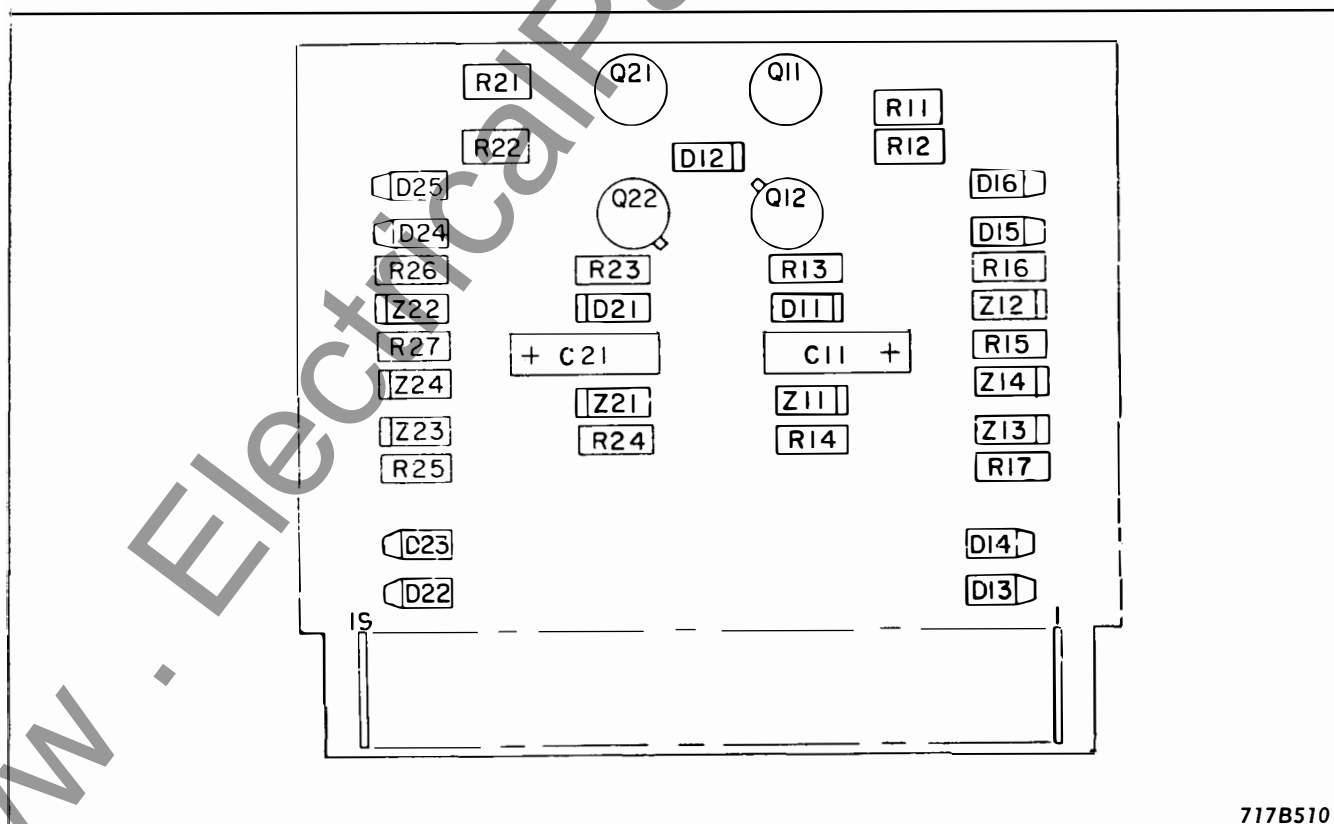


Fig. 3. Component Locations of the Transmitter Printed Circuit Board.



763A056

Fig. 4. Component Locations of the Power Amplifier Printed Circuit Board



717B510

Fig. 5. Component Location of Buffer Keying Circuit Board

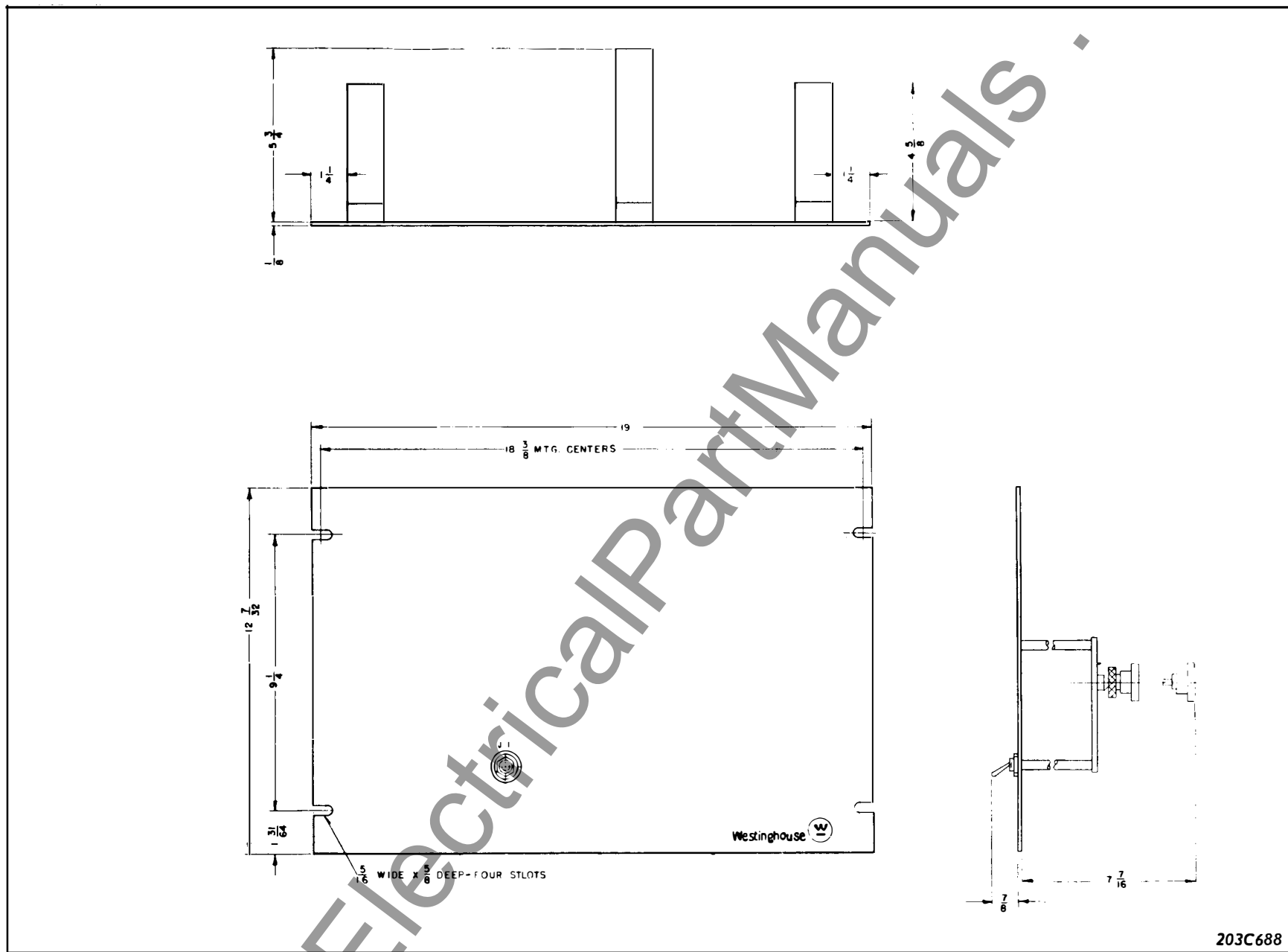
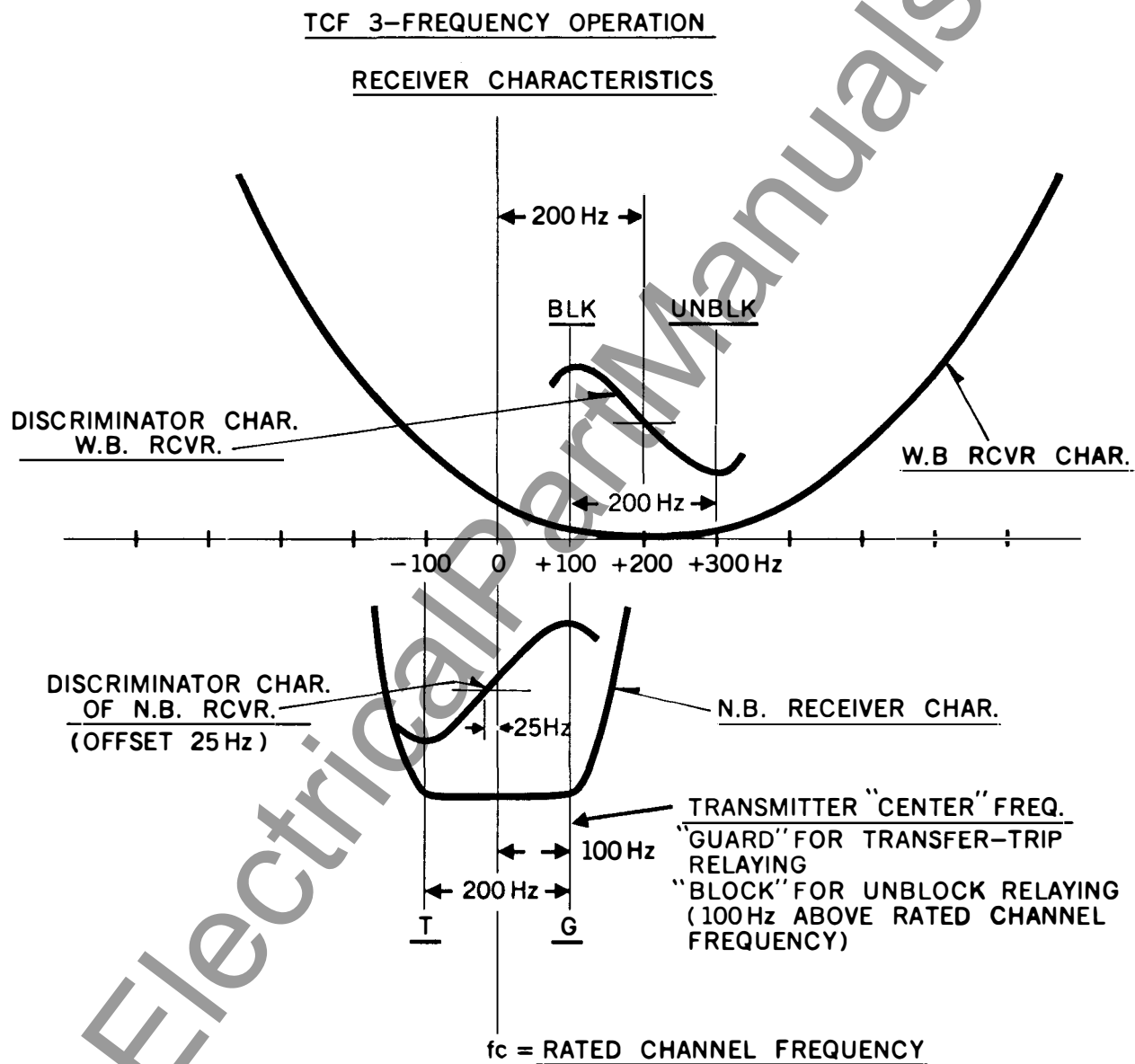


Fig. 6. Outline and Drilling Plan for the Type TCF Transmitter Assembly



880A986

Fig. 7. Three Frequency Operation – Receiver Characteristics

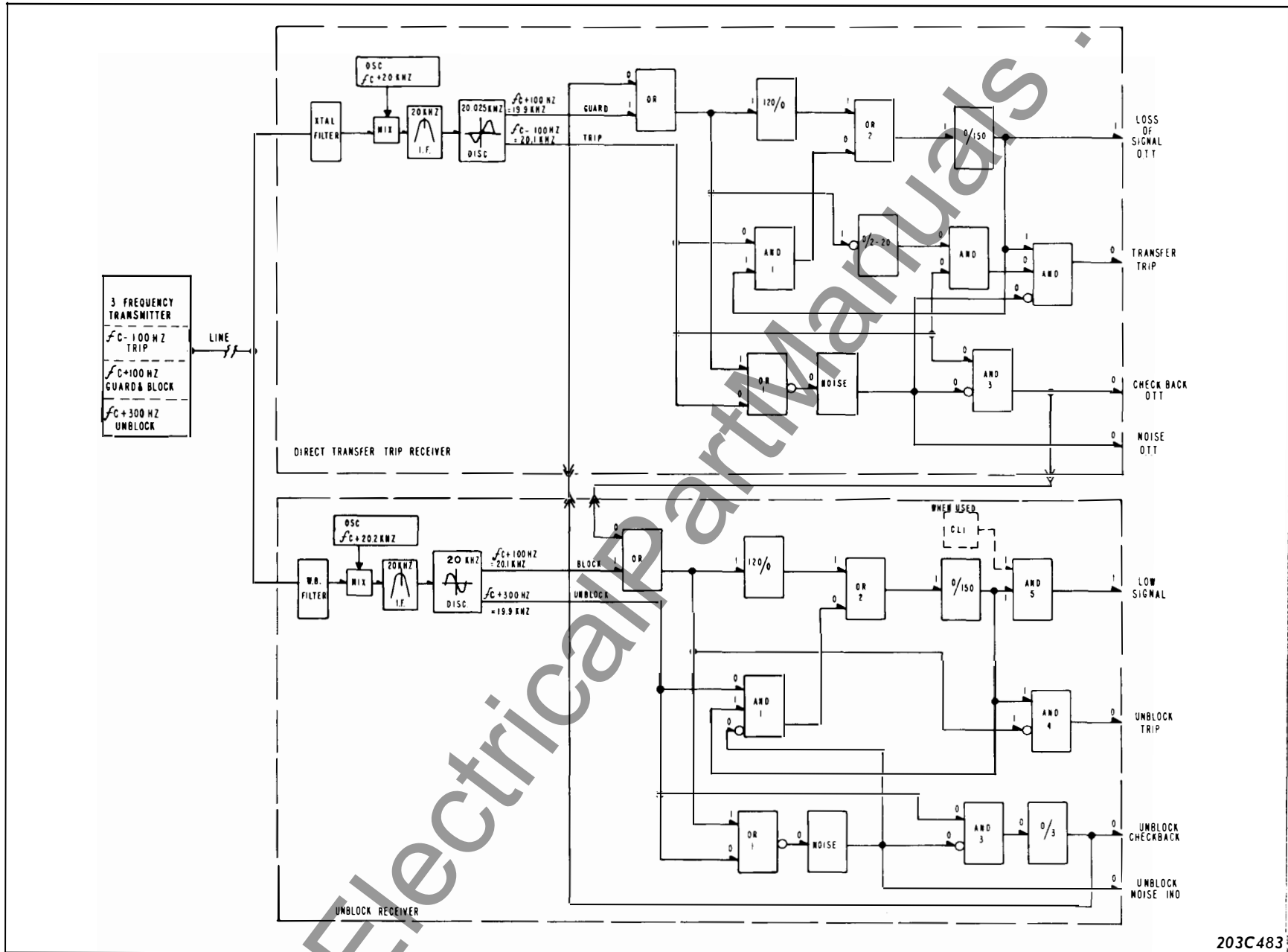
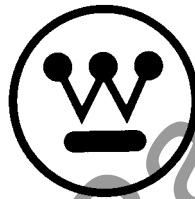


Fig. 8. Receivers Logic Diagram - 3 Frequency Operation for Direct Transfer Trip and Unblock Relaying

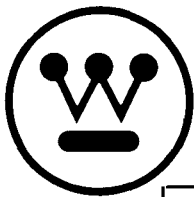
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INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT RECEIVER EQUIPMENT-TRANSFER TRIP (WITHOUT CARRIER LEVEL INDICATOR)

CAUTION: It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet and in the system instruction leaflet before energizing the system.

Printed circuit modules should not be removed or inserted when the relay is energized. Failure to observe this precaution can result in an undesired tripping output and cause component damage.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF-10 frequency-shift receiver equipment as adapted for transfer-trip applications responds to carrier-frequency signals transmitted from the distant end of a power line and carried on the power line conductors. The Guard signal is transmitted continuously when conditions are normal. Its reception indicates that the channel is operative and that there is no fault in the protected equipment. The Guard frequency is 100 hertz above the center frequency of the channel. When a fault occurs within the protected equipment, protective relays switch the transmitter located there to a Trip frequency, 100 hertz below the center frequency, and also increase the power output of the transmitter (from 1 watt to 10 watts).

The reception of Trip frequency within a fixed interval after disappearance of the Guard frequency causes the energization of a high-speed electro-

mechanical relay which closes the breaker trip circuit. If trip frequency is not received within this interval, the channel is not operating normally and a second relay closes contacts to sound an alarm. Simultaneously, the Trip relay is locked out so that a spurious Trip signal resulting later from line noise cannot cause false tripping. Other circuitry, described under OPERATION, provides security against false tripping caused by severe line noise that overrides a normal Guard signal and produces a spurious Trip signal.

CONSTRUCTION

The TCF-10 receiver unit for transfer-trip applications is mounted on a standard 19-inch wide Chassis 5 1/4 inches high (3 rack units) with edge slots for mounting on a standard relay rack. All components not mounted on Printed Circuit Modules are mounted at the rear of the panel. An input attenuator, a jack for metering the discriminator output current, and the control for the adjustable time delay in the logic circuit are accessible from the front of the Chassis See Fig. 15.

All of the circuitry that is suitable for mounting on printed circuit boards is contained on printed circuit modules that plug into the chassis from the front and are readily accessible by removing the transparent cover on the front of the chassis. The power supply components and external connectors are located at the rear of the chassis as shown in Figure 5. Reference to the internal schematic connections of Figure 1 will show the location of these components in the circuit.

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

The printed circuit modules slide into position in slotted guides at the top and bottom of the chassis, and the module terminals engage a terminal block at the rear of the chassis. A handle on the front of each module is labeled to identify its function, and also identify adjustments and indicating lights if any are available at the front of the module. Of particular significance, is the input attenuator contained on the front of the filter module which is used in adjusting the input receiver signal during initial field installation.

A module extender (Style No. 1447C86G01) is available for facilitating circuit measurements or major adjustments. After withdrawing any one of the circuit modules, the extender is inserted in that position. The module is then inserted into the terminal block on the front of the extender. This restores all circuit connections and renders all components and test points on the module readily accessible.

The receiver operates from a regulated +20V supply and a +10V supply operating from a regulated +45dc supply. These voltages are taken from three zener diodes mounted on a common heat sink. Variation of the resistance value between the positive side of the unregulated dc supply, and the 45 volt zener adapt the receiver for operation on 48 or 125 volts dc.

External connections to the receiver are made through a 36 terminal receptacle, J3. The r-f input connection to the receiver is made through a coaxial cable jack J2.

OPERATION

INPUT MODULE

The input module contains the input control and the input filter. The signals to which the TCF-10 receiver responds are fed through a coaxial cable connected to jack J2 at the rear of the chassis to the input module. The input control R5, accessible at the front of the input module, attenuates the signal to a level suitable for the best operating range of the receiver.

A scale on the panel is graduated in dB. While this scale is typical rather than individually cali-

brated, it is accurate within several dB and is useful in setting approximate levels. Settings should be made more accurately utilizing a suitable ac voltmeter with a dB scale when possible.

CRYSTAL FILTER

From the attenuator, the signal passes through a crystal filter, FL1. This filter has a narrow pass band, and frequencies several hundred cycles above

OSCILLATOR, MIXER, AND IF AMPLIFIER MODULE

From the input filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20kHz above the channel center frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of filter FL201 is impressed on the emitter-collector circuit of Q11. As a result of mixing these two frequencies, the primary of transformer will contain frequencies of 20kHz, $2f_c + 20\text{kHz}$, $f_c + 20\text{kHz}$, and f_c .

The output from the secondary of T12 is amplified by Q31 in the intermediate frequency (IF) stage, and is impressed on FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. Since its pass band is narrower than that of the input filter, it eliminates the frequencies present at its input that are substantially higher than 20kHz. The output of this filter is the IF output which is fed to both the amplifier-limiter and the S/N Detection module. The output from the secondary of transformer T12, the RF output, is also fed to the S/N detection module.

AMPLIFIER LIMITER AND DISCRIMINATOR MODULE

AMPLIFIER AND LIMITER

The output from the second section of the IF amplifier stage is fed to potentiometer R52 at the input of the amplifier and limiter stage. Sufficient input is taken from R52 so that with minimum input signal (5 mv.) at J2 and with R5 set for zero

attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

DISCRIMINATOR

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at $f_c - 25$ hertz. The adjustment for zero output at $f_c - 25$ hertz is made by capacitor C68. C63 is adjusted to obtain a maximum voltage reading across R80 when the current output is zero. Maximum current output, of opposite polarities, will be obtained when the frequency is 100 hertz above or below the zero output frequency. This separation of 200 hertz between the current peaks is affected by the value of C66 (the actual value of which may be changed slightly from its typical value in factory calibration if required.)

The purpose of offsetting the zero output frequency of the discriminator by 25 hertz in the Trip direction is to reduce the band of noise-generated trip frequencies (between the discriminator center frequency and the skirt of the FL1 filter), and to similarly increase the band of noise-generated frequencies on the Guard side of the discriminator center. It should be observed that although Guard frequency is $f_c + 100$ hertz, after leaving the mixer stage and as seen by the discriminator the Guard frequency is $20 \text{ kHz} - 100$ hertz. Similarly, the Trip frequency is $20 \text{ kHz} + 100$ hertz. The intermediate frequency at which the discriminator has zero output then is 20.025 kHz .

The discriminator output is connected to the bases of transistors Q55 and Q56 in such a manner that transistor Q56 is made conductive when current flows, from the discriminator output, in the forward direction of diode D54, (which occurs with Trip output) and Q55 is made conductive when current flows in the forward direction of diode D55 (which occurs with Guard output) Consequently, terminal 35 is at a potential of approximately +20 volts at Guard frequency and terminal 1 is at +20 volts at Trip frequency. These two outputs feed the logic circuit board, and through it they control the operation of the loss-of-channel alarm relay, AL, and the Trip relay, AR.

As a means of increasing further the security of the receiver against false tripping on noise-generated Trip frequencies, diode D56 is connected in the emitter circuit of Q56. This requires an increase of three or four db. in the minimum Trip signal that will pick up the Trip relay. However, when the transmitter is keyed to Trip, its output is increased by 10 db. to assure the reliability of tripping at times of severe channel deterioration or simultaneous noise conditions, and this amply compensates for the reduction of Trip sensitivity caused by diode D56. For applications where severe noise conditions or channel deterioration are not encountered, a TCF-10 transmitter with 1 watt output rather than 10 watts can be supplied. If in such installations it is found desirable to increase the reliability of tripping, a jumper may be connected across diode D56.

LOGIC CIRCUITS

The logic stage of the receiver employs static circuitry that permits elimination of separate guard and lockout relays but provides all of the function of these relays as well as a unique method for minimizing the effect of noise signals. The block diagram of the logic circuits is shown on Fig. 3. When the discriminator receives Guard signal, its output terminal (15) supplies positive potential to blocks A, D, and F on the block diagram. Block A represents R108, C101 and D104 of Fig. 1. Capacitor C101 will charge in approximately 120 milliseconds to the breakdown voltage of Zener Z104 and block C (transistor Q102) then will receive input # 1. The function of Q101 is not indicated on the block diagram, but it discharges C101 quickly when Guard signal disappears, so that the full 120 ms. delay is obtained on closely repetitive appearances of Guard signal. This avoids cancellation of a loss-of-channel alarm by noise-produced Guard signal.

When Q102 (block C) receives input # 1 or # 2, it is made conductive and capacitor C102 receives no charge. Q103 is non-conductive since it receives no base input through Z105, and its collector is held at approximately 10 volts by the voltage divider effect of R131 and R136. Note that under this condition, input # 1 to block K is supplied. If Guard signal should disappear but be followed promptly by appearance of Trip signal, the trip input fed through R102 will not be diverted

through D102 to the collector of Q103 but will flow through D101 to the base of Q102 to keep it conductive. However, if Guard signal disappears and Trip signal does not appear in approximately 150 ms., C102 will charge to the breakdown point of Z105 making Q103 conductive. This will remove base input from Q104 and the alarm relay will drop out, sounding the alarm through its normally-closed contacts. (The copper slug on the alarm relay adds an additional delay of approximately 40 ms. before the alarm contacts close.) When Q103 becomes conductive, the saturation voltage at its collector is so low that any current flowing through R102 as a result of a subsequent Trip signal will be diverted through Q103 to negative instead of flowing through D101 and the base-emitter junction of Q102. If Guard signal reappears, the discriminator output at term. 15 will turn Q101 off. C101 will change and after 120 ms. it will reach the breakdown voltage of Z104 and turn Q102 on. This will allow C102 to quickly discharge through R123 and Q102 and provide the full 150 ms. time delay to be effective on any subsequent loss of guard signal.

Guard signal also produces input to transistor Q109 (block D). With base input to Q109 it has negligible voltage on its collector, but if Guard signal is lost, capacitor C104 will charge to the breakdown voltage of Z113 in a time ranging from about 2 to 20 ms., as determined by the setting of R7. This time delay also is quickly reset on reappearance of Guard signal, as C104 discharges through R114, Z113 and Q109. Transistors Q110 and Q111 are a part of logic block I. When C104 reaches the conduction voltage of Z113, Q110 conducts and removes base input from Q111. This raises the voltage on the collector of Q111 to about 15 volts, which constitutes input # 2 to block K. The purpose of logic blocks D and I is to provide an adjustable delay between the loss of Guard signal and the pickup of the Trip relay. It is possible that a noise burst might momentarily cancel the Guard signal and produce a spurious Trip signal. Provision of this adjustable delay provides a considerable degree of protection against such incorrect operations. Resistor R7 is adjustable by means of a knob on the front of the panel, and the knob can be clamped at any desired setting.

When Trip signal appears, input is fed to transistor Q106 (block E) through R119. Under this

condition Q106 becomes conducting and does not supply input # 1 to Q107 (block J). If input # 2 (supplied through R115) also is lacking for Q107, the latter is non-conductive and its collector voltage is approximately 15 volts. This constitutes input # 3 to AND block K. Block K is a three-input diode-AND, with the inputs contributed by the collectors of transistors Q103, Q107 and Q111. When one or more of these transistors is conducting, input fed from the 45 volt supply through R138 cannot reach the base of Q108 to cause pickup of the Trip relay because the voltage drop across any of the three diodes plus the saturation resistance of a transistor is substantially less than the voltage drop across one diode (D110) plus the base-emitter voltage required to make Q108 conductive.

The logic blocks F and G provide further protection against incorrect tripping under noise conditions. Transistor Q105 is represented by block F; and diode D107 capacitor C103 and resistor R115 are represented by block G. Q105 receives input from either Trip or Guard signals through R101 or R106, and when either signal is present its collector voltage is a small fraction of a volt. When the transmitter is shifted from Guard to Trip by closure of a protective relay contact, the discriminator shifts its outputs very rapidly and the interval during which there is no input to Q105 is only 1.5 to 2.0 ms. Most of the charge that builds up in C103 during this interval flows to the base of Q107 and keeps it conducting after the appearance of Trip signal has removed the input through R125. However, this delay has approximately the same duration as the minimum delay obtained from block I and thus does not increase the minimum overall time for tripping following a legitimate Trip signal.

At times when severe random noise is present, such as might be produced by opening a nearby disconnect switch, the noise-produced signal may override the Guard signal and produce a discriminator output that no longer has a constant Guard output but rapidly fluctuates between Guard and Trip (and beyond). There will be relatively long periods when the discriminator has neither Guard nor Trip output. At such times capacitor C103 may approach or reach its maximum voltage, thereby keeping Q107 conducting for 40 to 50 ms. Also, because of the quick reset feature of logic block I, intermittent reappearance of Guard signal during

noise will fully reactivate the time delay for which it has been set. If a fault should occur and Trip frequency be transmitted at a time when high level noise frequencies are present, tripping may be somewhat delayed but will be accomplished before the cessation of noise unless conditions are extremely severe. The recommended 10 db. increase of transmitter output level at Trip frequency minimizes such delay.

It may appear that the function of block E in the logic diagram is duplicated by block F and could have been omitted. This is correct when the time constants are as normally supplied, but block E was retained to make the circuit adaptable to possible extreme conditions with minimum change.

In summary, the logic circuit provides the following functions:

1. Energizes alarm in case of loss of signal.
2. Prevents cancellation of an alarm by noise-produced signal.
3. Allows tripping upon reception of legitimate Trip signal.
4. Prevents tripping if channel is not operative immediately prior to reception of Trip signal.
5. Minimizes effect of noise-produced signals by utilizing noise characteristics to introduce additional Trip delay.

OUTPUT CIRCUITS

The output stage of the receiver contains the alarm relay (AL) and the tripping relay (AR). Either relay is energized from the regulated 45 volt supply when the logic circuit has determined that the existing conditions require such operation. The AL relay is a telephone type relay with a copper slug on the end of the core opposite the armature. It has two sets of Form C contacts, all points of which are connected to terminals of jack J3. The AR relay has two normally-open and two normally-closed contacts. The Four sets of contacts are connected to terminals of jack J3. The AR relay has been designed to provide very high speed operation with negligible contact bounce. While normally it is energized only briefly, it will not be damaged by continuous energization.

CARRIER LEVEL INDICATOR (WHEN SUPPLIED)

With the logic circuit connections shown on Fig. 1, the AL relay closes contacts to energize an alarm when there is absence of both Guard and Trip signal for a definite time interval. This is satisfactory when the channel fails suddenly and completely. However, the signal may weaken gradually from various causes, and it is desirable to have a means for providing a visual indication of the channel condition as well as for energizing an alarm when the signal has weakened seriously but has not reached the point of complete failure. These functions are provided if a carrier level indicator stage is included in the receiver.

The carrier level indicator is housed in the right-hand compartment of the enclosure that contains the circuit boards. Fig. 2 shows the connections of the components on this circuit board and also the external connections of the board. All other stages of the receiver are identical with those shown on Fig. 1. The same AL relay is used, but it is energized through transistor Q104 of the logic stage when the receiver does not include carrier level indication and through Q154 of the carrier level indicator when the latter is supplied. A TCF-10 receiver in which the carrier level indicator was not included at time of assembly can have this feature added later by installing the required circuit boards and making minor changes in the wiring.

The S/N detection module (carrier level indicator) has one basic function: to measure incoming in-band signal level and provide both an output to a carrier level indicating instrument and to an alarm circuit in the output module for alarming at the desired low level of signal.

This same output is also fed to an alarm circuit on the output module (contact output) for alarming at low signal levels.

The narrow-band signal of 220 hertz bandwidth called the I.F. is fed into the S/N detection board through isolation transformer T32. The amount of signal fed into the board is adjustable by means of potentiometer R111. The circuit composed of operational amplifiers IC7 and IC8 and associated components is an RMS circuit which

converts the signals into a dc voltage proportional to the r.m.s. value of the ac signals present in the IF bandwidth.

The output of the IF rms circuit is then fed to the logarithmic circuit composed of IC11A, IC12A, and IC11B which puts out a dc signal level linearly proportional to signal level in dB for feeding a microammeter calibrated with a linear dB scale with 10dB equal to 33 1/3 microamperes, is contained on the output module (contact output).

The input to the carrier level indicator is not affected by frequency variations that are within the pass band of the crystal input filter, but only by the level of the receiver input signal. When the alarm relay is energized through transistor Q104 of the logic stage (in a receiver without carrier level indicator—Fig. 1), the alarm will be activated on complete loss of signal or on loss of Guard signal if Trip signal does not appear within approximately 150 ms. After the alarm relay has dropped out and activated the alarm, the relay will not be picked up by subsequent appearance of Trip signal but only by the reappearance of Guard signal. It is desirable to retain this alarm feature when the carrier level indicator is supplied, and a single alarm relay can be caused to respond to frequency change as well as to signal level by the interconnection between the terminals of the logic and carrier level indicator circuit boards.

When Guard signal is being received, the voltage at the collector of Q103 in the logic circuit is approximately 10 volts, but this voltage is blocked from the base of (Q154) in the carrier level indicator circuit by diode D155. However, if the discriminator Guard output should fail because of a sufficient frequency shift either above or below Guard frequency, Q103 would become conductive and the collector current of (Q153) would be diverted to negative through D155 and Q103 rather than entering the base of (Q154). The latter would become nonconductive and the alarm relay would drop out, closing the alarm circuit even though the signal level is unchanged.

With Guard signal being received, the signal level just below which the discriminator Guard output drops to zero is the minimum operating level of the receiver. The AL relay should energize

the alarm at a signal level somewhat above this. For usual operating conditions it should be satisfactory to set the input attenuator (R5) 15 db. above the minimum operating level and set the AL relay (by means of R156) to drop out at a signal 5 db. above the minimum operating level.

POWER SUPPLY

The regulated 20 V.D.C. and 45 V.D.C. circuits of the receiver are supplied from Zener diodes mounted on a common heat sink on the rear of the panel. Resistors (R2, R3) of suitable value are connected between the station battery supply and the 45 volt Zener to adapt the receiver for use on 48, 125 or 250 V.D.C. battery circuits. The receiver is connected to the external supply through a switch and fuses, and a pilot light indicates whether the D.C. circuits are energized. Capacitors C1 and C2 bypass r.f. or transient voltages to ground. Chokes L1 and L2 isolate the receiver from transient voltages that may appear on the D.C. supply.

CHARACTERISTICS

Frequency range	30-300 kHz
Sensitivity (noise-free channel)	0.005 volt (65 db below 1 watt for limiting)
Input Impedance	5000 ohms minimum
Bandwidth (crystal filter)	down < 3 db at 220 hertz down > 60 db at 1000 hertz
Discriminator	Set for 200 cycles shift from Guard to Trip frequency. Offset 25 hertz to favor Guard for all relay-output applications.
Operating time	9 ms. channel (transm. and recvr.) 2 ms. min. logic delay + 3 ms. AR relay 14 ms. minimum time +18 ms. max. added logic time (if req'd. by noise conditions) <u>32 ms.</u> maximum time

Frequency spacing	
A. For two or more signals over one-way channel	500 hertz minimum
B. For two-way channel	1000 hertz, minimum between transmitter and adjacent receiver frequencies.
Ambient temperature range	-20°C to +55°C temperature around chassis.
Battery voltage variations	
Rated voltage	Allowable variation
48 V.D.C.	42 - 56 V.D.C.
125 V.D.C.	105 - 140 V.D.C.
250 V.D.C.	210 - 280 V.D.C.
Battery drain	0.20 a. at 48 V.D.C. 0.27 a. at 125 or 250 V.D.C.
Dimensions	Chassis height - 5 1/4" or 3 r.u. Chassis width - 19"
Weight	13 lbs.

INSTALLATION

The TCF-10 receiver is generally supplied in a cabinet or on a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. The maximum ambient temperature around the chassis must not exceed 55°C.

ADJUSTMENTS

All factory adjustments of the TCF-10 receiver have been carefully made and should not be altered unless there is evidence of damage or malfunctioning. Such adjustments are: frequency and output level of the oscillator and mixer; input to the amplifier and limiter; discriminator offset from center frequency; frequency spacing and magnitude of discriminator output peaks. Adjustments that must be made at time of installation are: setting of input attenuator R5; setting of the logic time delay by R7. The input attenuator and the logic time delay ad-

justments are made by knobs on the front of the panel.

The receiver should not be set with a greater margin of sensitivity than is needed to assure correct operation with the maximum expected variation in attenuation of the transmitter signal. In the absence of data on this, the receiver may be set to operate on a signal that is 15 db below the expected maximum signal. After installation of the receiver and the corresponding transmitter, and with a normal Guard signal being received, input attenuator R5 should be adjusted to the position at which the alarm relay drops out. R5 then should be readjusted to increase the voltage supplied to the receiver by 15 db. The scale markings for R5 permit an approximate setting to be made but it is preferable to make this setting by means of the db scales of an ac VTVM connected from ground to the sliding contact of R5.

In case the transmitter has a 1 Watt/1 Watt output and diode D56 in the discriminator is not bypassed (see discussion under OPERATION-Discriminator), the transmitter should be keyed to trip, transistor Q103 should be kept non-conducting by connecting a short clip lead across R128, and R5 should be adjusted to the position at which the trip relay just picks up. R5 then should be readjusted for a 15 db increase in receiver input, and the jumper across R128 should be removed. If D56 is bypassed the input levels at which the AL and AR relays just operate will be approximately the same, and the AL relay minimum operating point can be used as reference for arriving at the R5 setting, as described in the preceeding paragraph.

The only other adjustment which may be necessary at the time of initial installation is the adjustment of the CL1 instrument to correspond to proper variation of signal level from normal. This may be necessary if the instrument was not supplied with the receiver and was not adjusted by the factory. If this instrument was supplied and adjusted by the factory, then it could be used in adjusting R5. In this case, it would be necessary only to adjust R5 with a normal signal being received so that the instrument indicates 0dB.

If the instrument was not previously adjusted by the factory, then the following procedure should

be used in adjusting the instrument. (Note: When CL1 instrument is supplied within the chassis, this is factory adjusted.)

1. Set incoming level into receiver at +10dB above normal level.
2. Adjust span adjustment, R147, so that the voltage at TP72 with respect to TP62 (common) is +3.000 volts.
3. Reduce incoming signal into receiver by 30dB.
4. Adjust full scale adjustment, R153, so that instrument now reads -20dB. (This is approximately 0 microamperes).
5. Increase signal to +10dB level. (This is 100 microamperes).
6. Adjust slope adjustment R155 to read +10dB on instrument.
7. Reduce signal to normal level. Instrument should read 0dB. If desired, instrument could be adjusted to read 0dB with R155 with sacrifice in reading accuracy for +10dB.

It is recommended that R7 be set for maximum time delay (full clockwise rotation) unless field tests have shown that a shorter delay can be used without danger of false tripping under conditions of severe line noise, such as may be caused by the opening of nearby disconnect switches.

FACTORY ADJUSTMENTS

In case the factory adjustments have been altered or there is suspicion of improper adjustments or malfunctioning, then the following procedures can be used. In addition, alterations to the settings used by the factory for low signal level clamping and low signal-to-noise ratio clamping can be made using these procedures if desired.

Potentiometer R12 in the oscillator and mixer should be set for 0.3 volts, measured with a VTVM connected between TP11 and terminal 33 on the circuit board (ground terminal of voltmeter). A frequency counter can be connected to the same points for a check on the frequency which should be 20kHz above the channel center frequency. The frequency is fixed by the crystal used, except that it may be changed a few cycles by the value of capacitor C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that assures reliable starting of oscillation. The fre-

quency at room temperature is usually several cycles above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should be connected from TP56 at the base of Q54 to terminal 33 of the limiter. With 5 millivolts of higher frequency on the receiver input (R5 set at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting. (Note: Input attenuator R5 could be used to produce 5 mv of signal across input test jacks J1 and J2 if desired.)

Adjustment of the discriminator is made by capacitors C63 and C68. In order to offset the discriminator by 25 Hertz in the Trip direction, apply to the receiver input a 5 mv. signal taken from an oscillator set at $f_c - 25$ Hertz (R5 at zero.) Connect a 1.5-0-1.5 milliammeter in the circuit at J1 and a VTVM across R80. Adjust C68 for zero current in the milliammeter and C63 for maximum voltage across R80 rechecking the adjustments alternately until no further change is observed. Remove the VTVM from across R80 and observe the milliammeter reading as the oscillator frequency is varied. Positive and negative peaks should occur at $f_c + 75$ Hertz and $f_c - 125$ Hertz, with the latter peak being 20% or 15% lower than the former because of diode D56 in the Trip output path.

In case a check is desired of any of the delay times of the receiver (such as channel time or logic delays), this can be done most conveniently by means of an oscilloscope with a calibrated triggered sweep. A two-pole toggle switch, checked to have less than 1 ms. interval between pole closures, can be used to impress the signal and trigger the sweep.

MAINTENANCE

Periodic checks of the received carrier signal and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenua-

tion control R5. A change in operating margin from the original setting can be detected by observing the change in the dial setting required to drop out the alarm relay. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal or loss of receiver sensitivity.

All adjustable components on the printed circuit boards are accessible when the front cover is removed. However, as described under "CONSTRUCTION", any board may be made entirely accessible while permitting electrical operation by using board extender style no. 1447C86G01. This permits attaching instrument leads to the various test points of terminals when making voltage, oscilloscope or frequency checks. It also contains switches to facilitate trouble shooting.

It is advisable to record voltage values after adjustment in order to establish reference values which will be useful when checking the apparatus. The readings will remain fairly constant over an indefinite period unless a failure occurs. However, if transistors are changed, there may be considerable difference in these readings without the overall performance being affected.

Typical voltage values are given in Table I and II. Voltages should be measured with a VTVM. Some readings may vary as much as $\pm 20\%$.

**TABLE I
RECEIVER D-C MEASUREMENTS**

NOTE: All voltage readings taken with ground of dc VTVM on terminal 9 (neg. d.c.). Receiver adjusted for 15 db operating margin with Guard signal down 50 db from 1 watt and Trip signal down 40 db. Unless otherwise indicated, voltage will not vary appreciably whether signal is Guard, Trip or zero.

Collector Transistor	Volts (+)
Q11	<13
Q12	15 (Guard or Trip)
Q13	15 (Guard or Trip)
Q31	2.5

Q32	2.5
Q51	11.5
Q52	12
Q53	15.5
Q54	2.5
Q55	< 1 (No. sig. or Trip)
Q55	19.5 (Guard)
Q56	< 1 (No sig. or Guard)
Q56	19.5 (Trip)
Q101	< 1 (No sig. or Trip)
Q101	7 (Guard)
Q102	21 (No signal)
Q102	< 1 (Guard or keyed Trip #)
Q103	< 1 (No signal)
Q103	10 (Guard or keyed Trip)
Q104	45 (No signal)
Q104	< 1 (Guard or keyed Trip)
Q105	40 (No signal)
Q105	< 1 (Guard or Trip)
Q106	15 (No sig. or Guard)
Q106	< 1 (Trip)
Q107	< 1 (No sig. or Guard)
Q107	15 (Trip)
Q108	45 (No sig. or Guard)
Q108	< 1 (Keyed Trip)
Q109	10 (No sig. or Trip)
Q109	< 1 (Guard)
Q110	< 1 (No sig. or Trip)
Q110	15 (Guard)
Q111	15 (No sig. or Trip)
Q111	< 1 (Guard)

- "Keyed Trip" signifies minimum transition time from Guard to Trip.

**TABLE II
RECEIVER RF MEASUREMENTS**

NOTE: Voltmeter readings taken between receiver input and Q32 are not meaningful or feasible because of waveform or effect of instrument loading. Receiver adjusted as in Table I. Reference to +20V.

Collector of Transistor	Volts (1 watt-Guard)	Volts (10 watts-Trip)
Q32	.25	.8
Q51	.3	.9
Q52	.4	.65
Q53	2.1	2.2
Q54	4.8	4.5

RELAY MAINTENANCE AND ADJUSTMENT

The AL and AR relay contacts should

be cleaned periodically. A contact burnisher S # 182A836H01 is recommended for this purpose. The use of abrasive material for cleaning contacts is not recommended, because of the danger of embedding small particles in the face of the soft silver and thus impairing the contact. Care must be taken to avoid distorting the contact springs during burnishing, particularly in the case of the AR relay.

These relays have been properly adjusted at the factory to insure correct operation, and under normal field conditions they should not require readjustment. If, however, the adjustments are disturbed in error, or if it becomes necessary to replace some part, the following adjustment procedure should be used.

In the AL relay the armature gap should be approximately 0.004 inch with the armature closed. This adjustment is made with the armature closed. This adjustment is made with the armature stop screw and locknut. The contact leaf springs should be adjusted to obtain at least 0.015 inch gap on all contacts when fully open. There should be at least 0.010 inch follow on all normally-open contacts and 0.005 inch follow on all normally-closed contacts. The relay should pick up at approximately 35 volts.

FILTER RESPONSE MEASUREMENTS

The crystal input filter (FL1) and the IF filter (FL2) are in sealed containers and repairs can be made only by the factory. The stability of the original response characteristics is such that in normal usage no appreciable change in response will occur. However the test circuits of Dwg. 849A109 can be used in case there is reason to suspect that either of the filters has been damaged.

Fig. 4 shows the -3db and -60db check points for the crystal filters. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Fig. 4 was chosen to show the crystal filter response, which permitted only a portion of the IF filter curve to be shown. The check points for the pass band of each section of the latter are "down 3db maximum

at 19.75 and 20.25 kHz, and for the stop band are "down 18 db minimum at 19.00 and 21.00 kHz. The signal generator voltage must be held constant throughout the entire check. A value of 20 db (7.8 volts) is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22db below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16db less than the measured difference because of the input resistor and the difference in input and output impedances of the filter.

Because of the extreme frequency sensitivity of the crystal filter, the oscillator used in its test circuit should have very good frequency stability and a close vernier control. The oscillators used for factory testing have special modifications for this use. A value of approximately 10db (2.45 volts) is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency but should not be more than 11db below the reading of VM1. (The filter insertion loss is approximately 6db less than the difference in readings.)

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a TCF-10 receiver for operating on a different channel frequency consist of a new crystal filter (FL1), a new local oscillator crystal (Y11) and probably a different feedback capacitor (C12). Because the wide range of channel frequencies precludes maintaining a factory stock of the various crystals, immediate shipment of the filter and the oscillator crystal cannot be made. After the crystals have been procured and the filter has been completed, it is recommended that the receiver be returned to the factory for the conversion and for complete test and adjustment. However, if the time that the receiver can be out of service must be kept to a minimum, the conversion may be made by customers who are equipped for this work.

RECOMMENDED TEST EQUIPMENT

- I. Minimum Test Equipment for Installation.
 - a. AC vacuum Tube Voltmeter (VTVM).
Voltage range 0.003 to 30 volts, frequency range 60 Hz to 330 kHz, input impedance 7.5 megohms.
 - b. DC Vacuum Tube Voltmeter (VTVM).
Voltage Range: 1.5 to 300 volts
Input Impedance: 7.5 megohms
 - c. Milliammeter, 0-3 range (if receiver has carrier level indicator).
- II. Desirable Test Equipment for Apparatus Maintenance
 - a. All items listed in I.
 - b. Signal Generator
Output Voltage: up to 8 volts
Frequency Range: 20-kHz to 330-kHz
 - c. Oscilloscope
 - d. Frequency counter

- e. Ohmmeter
- f. Capacitor checker
- g. Milliammeter, 0-1.5 or preferably 1.5-0-1.5 range, for checking discriminator.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

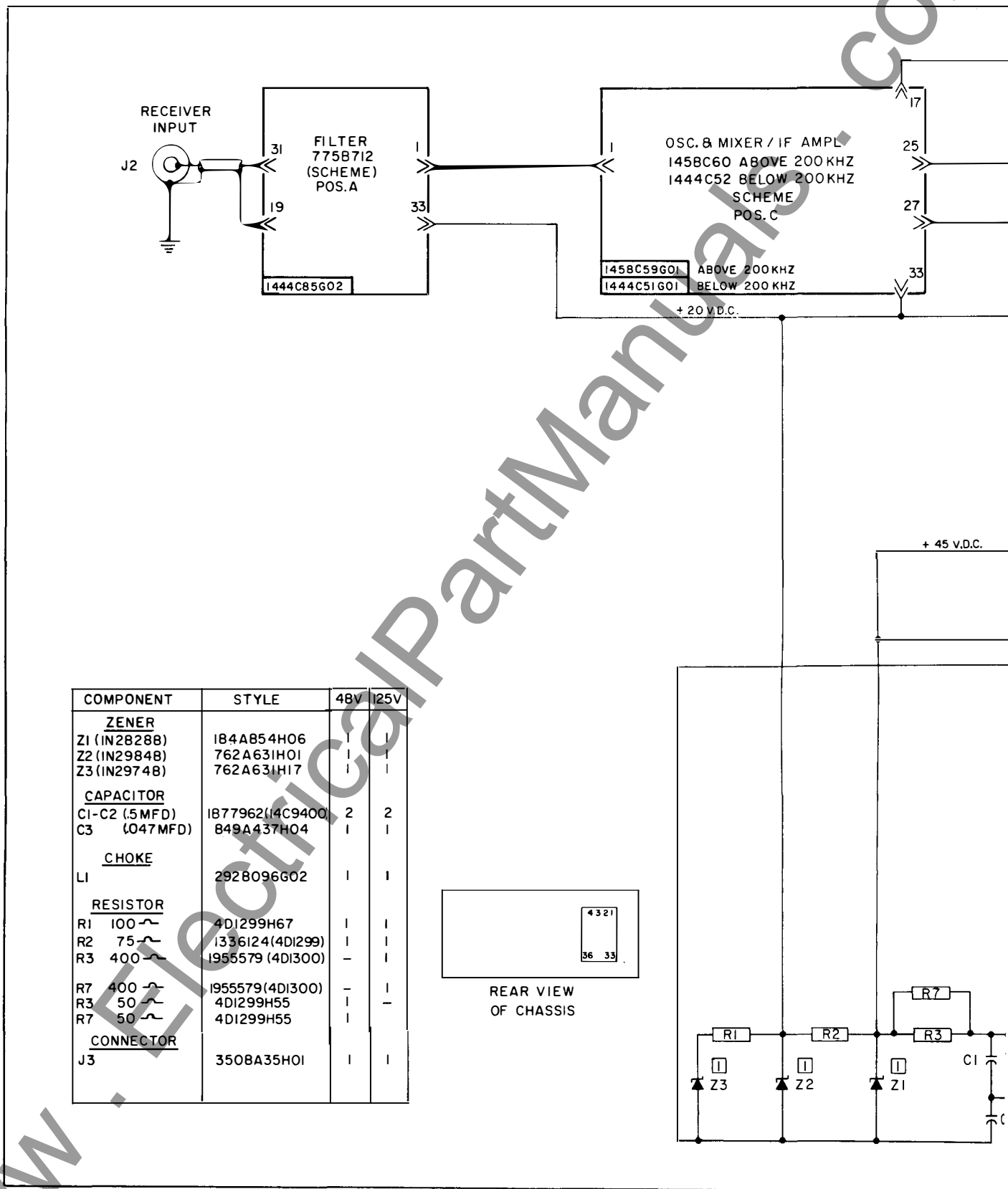
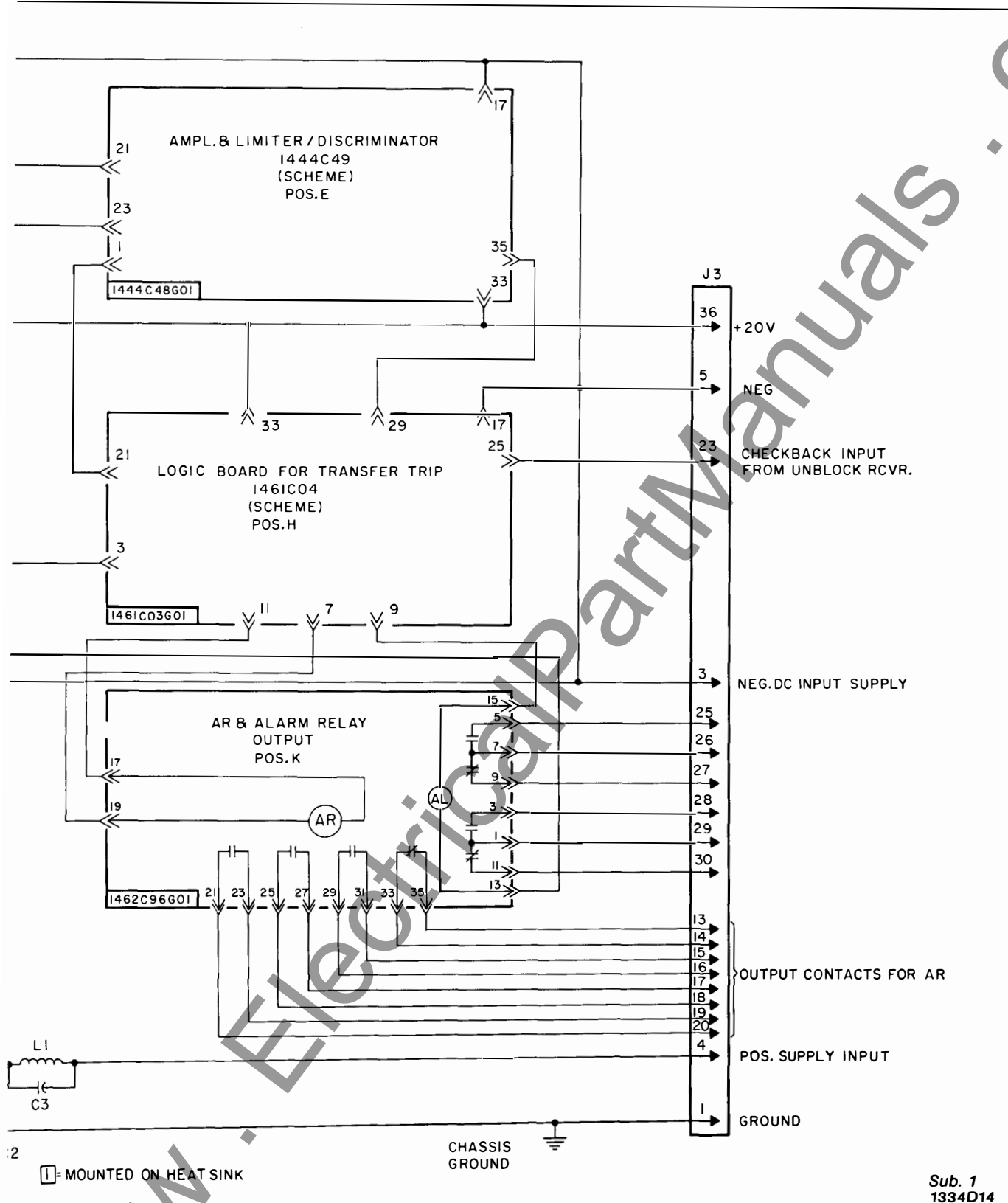


Fig. 1 Internal Schematic of Transfer Trip Receiver



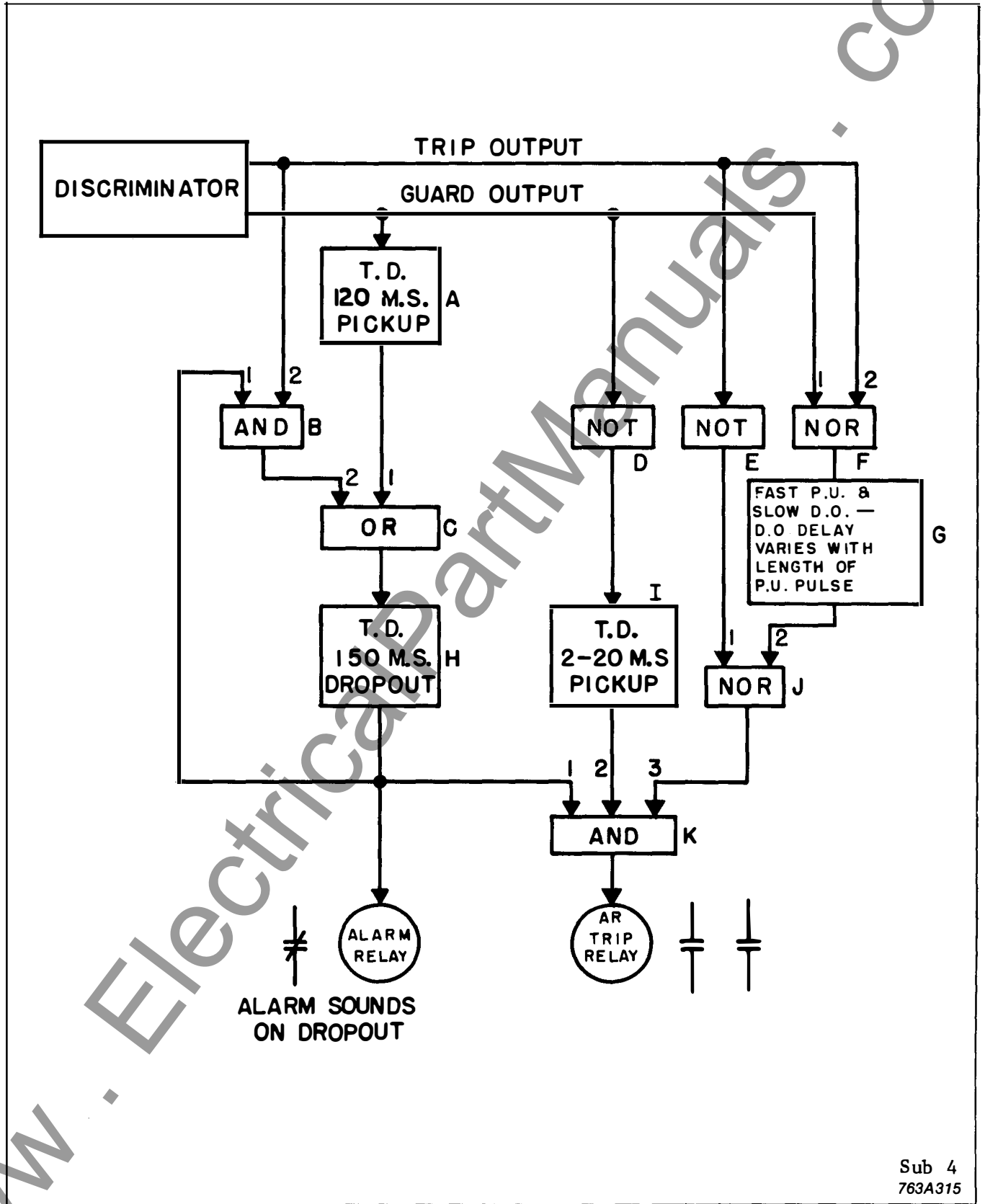
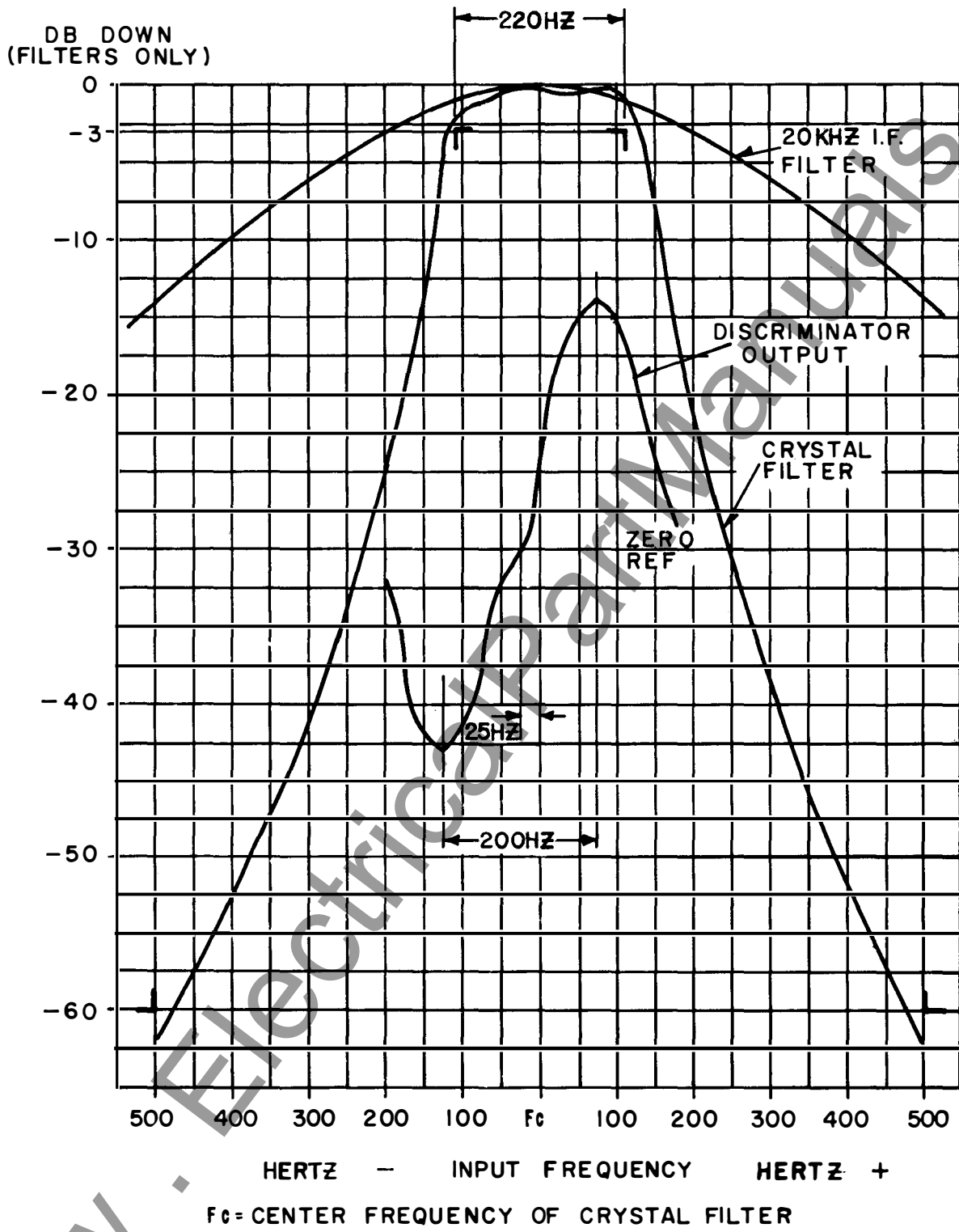


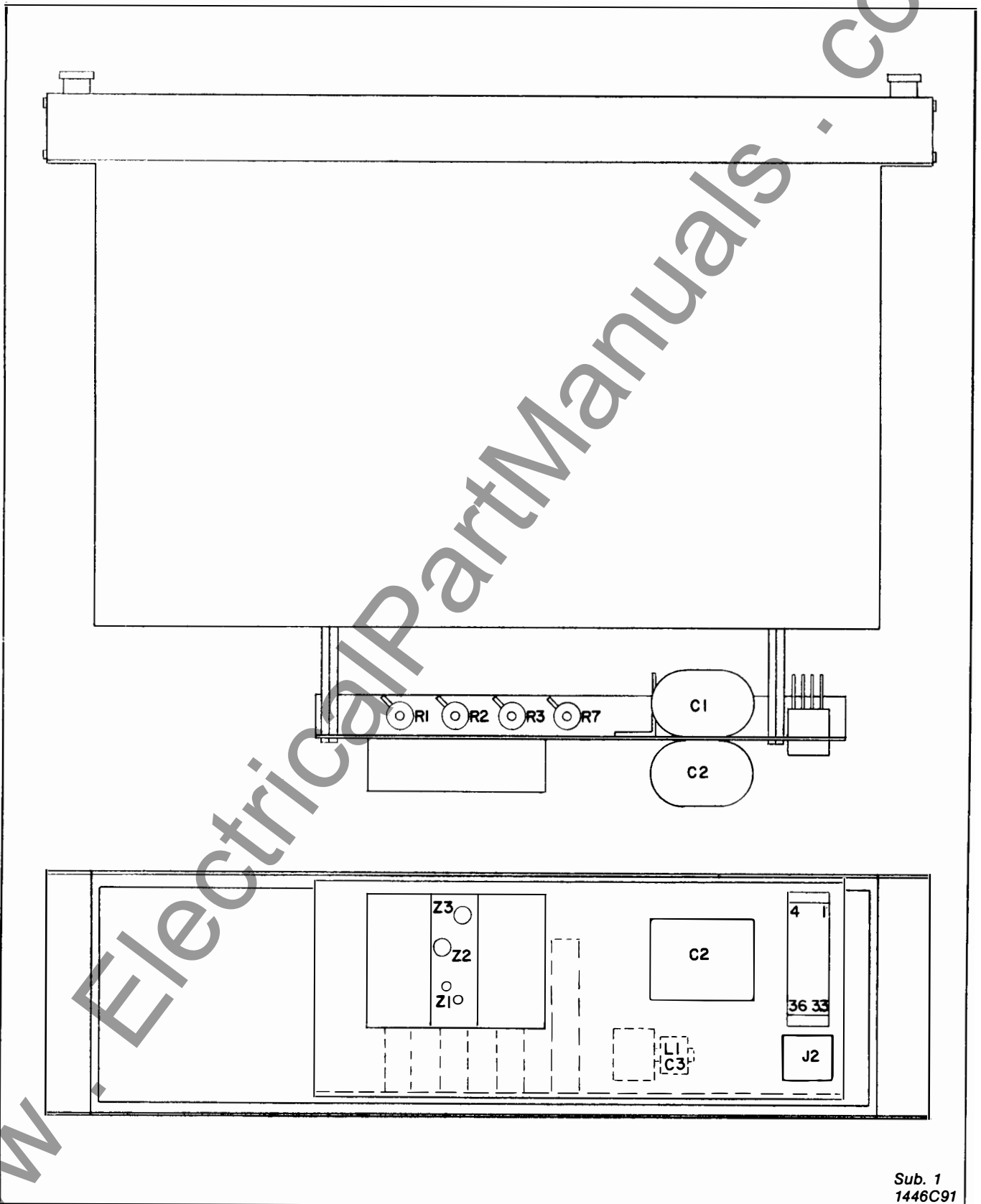
Fig. 3. Block Diagram of Output Logic Circuit

Sub 4
763A315



Sub 2
836A932

Fig. 4. Filter and Discriminator Characteristics of the Receiver



Sub. 1
1446C91

Fig. 5. Component Location of the Receiver Panel

I.L. 41-945.85

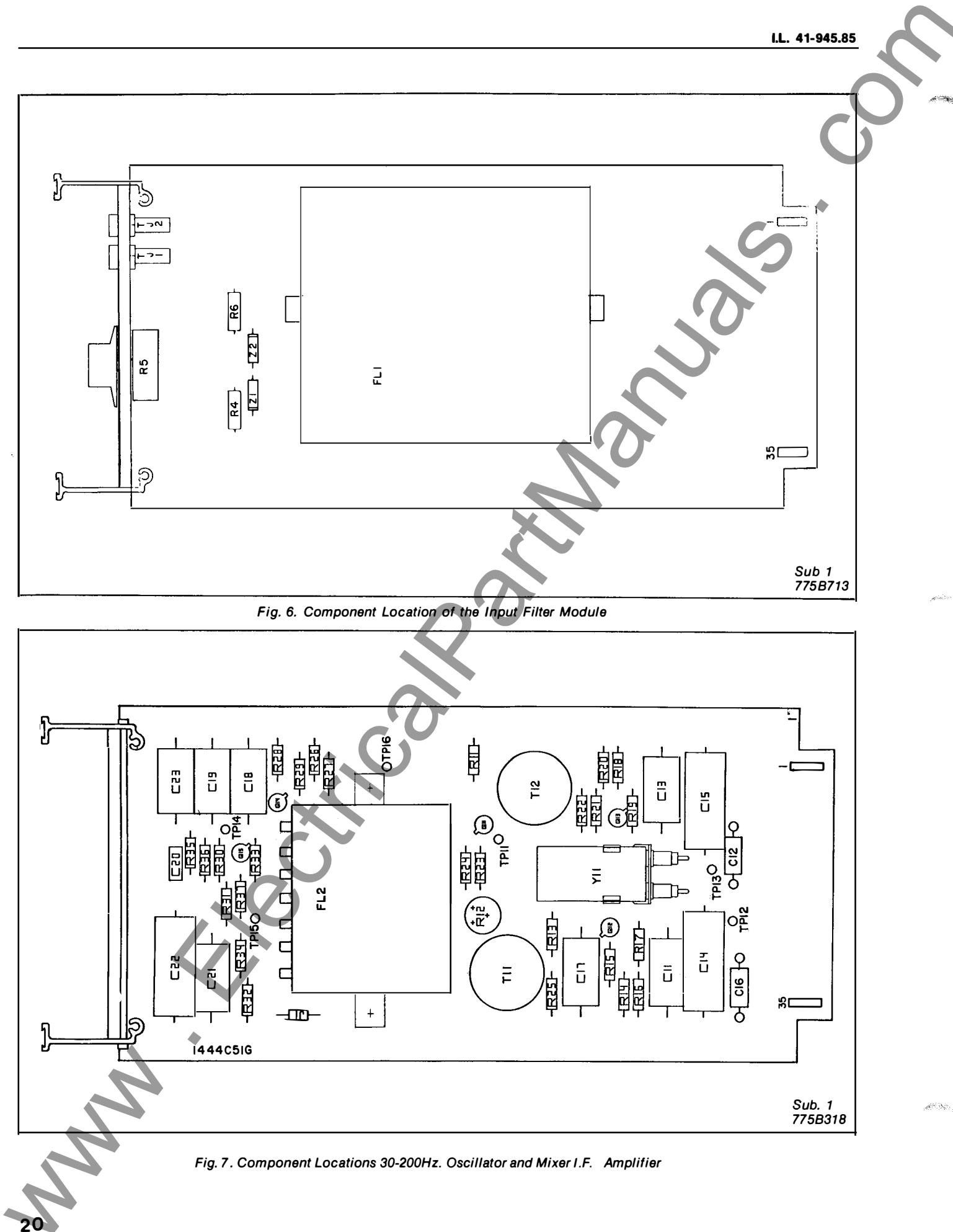
Sub 1
775B713

Fig. 6. Component Location of the Input Filter Module

Sub 1
775B318

Fig. 7. Component Locations 30-200Hz. Oscillator and Mixer I.F. Amplifier

20



I.L. 41-945.85

Sub 1
775B713

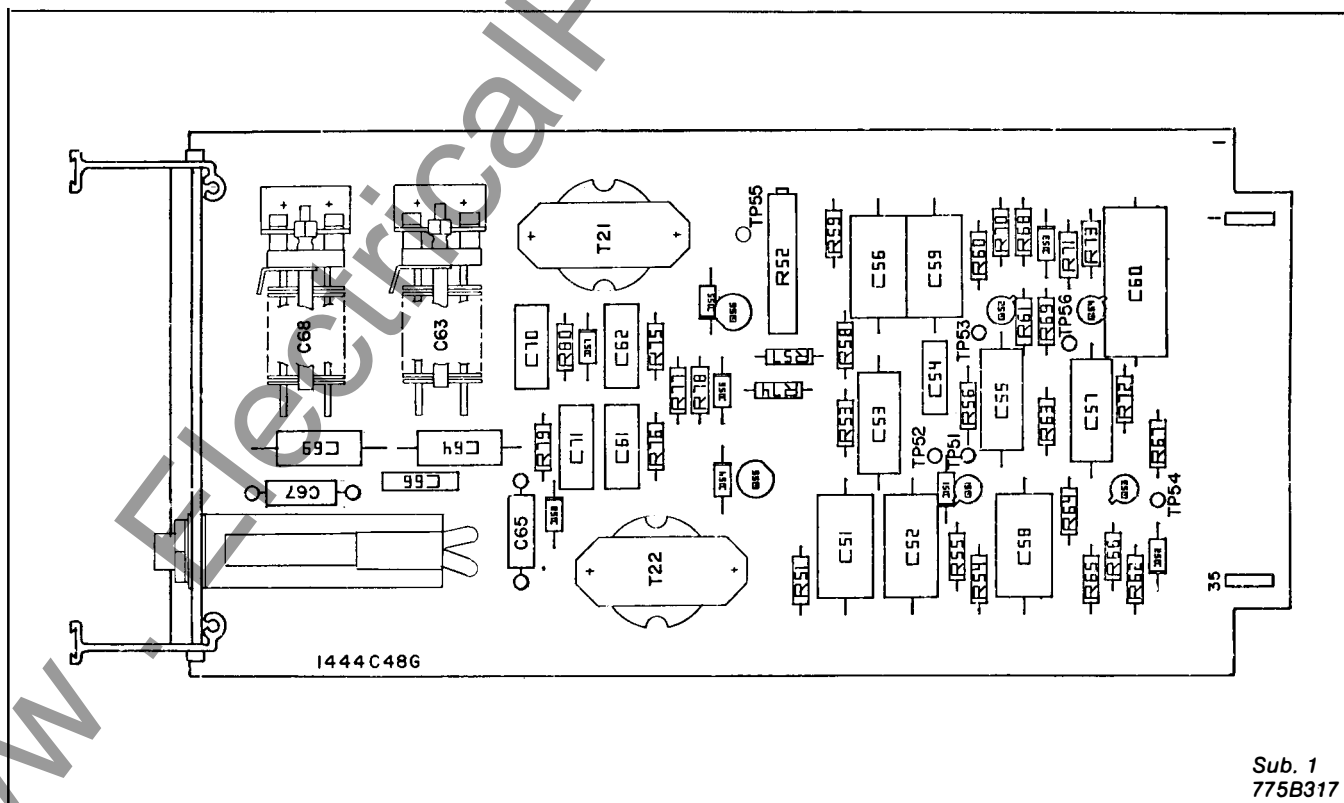
Fig. 6. Component Location of the Input Filter Module

Sub. 1
775B318

Fig. 7. Component Locations 30-200Hz. Oscillator and Mixer I.F. Amplifier

20

Sub. 1
775B922



Sub. 1
775B317

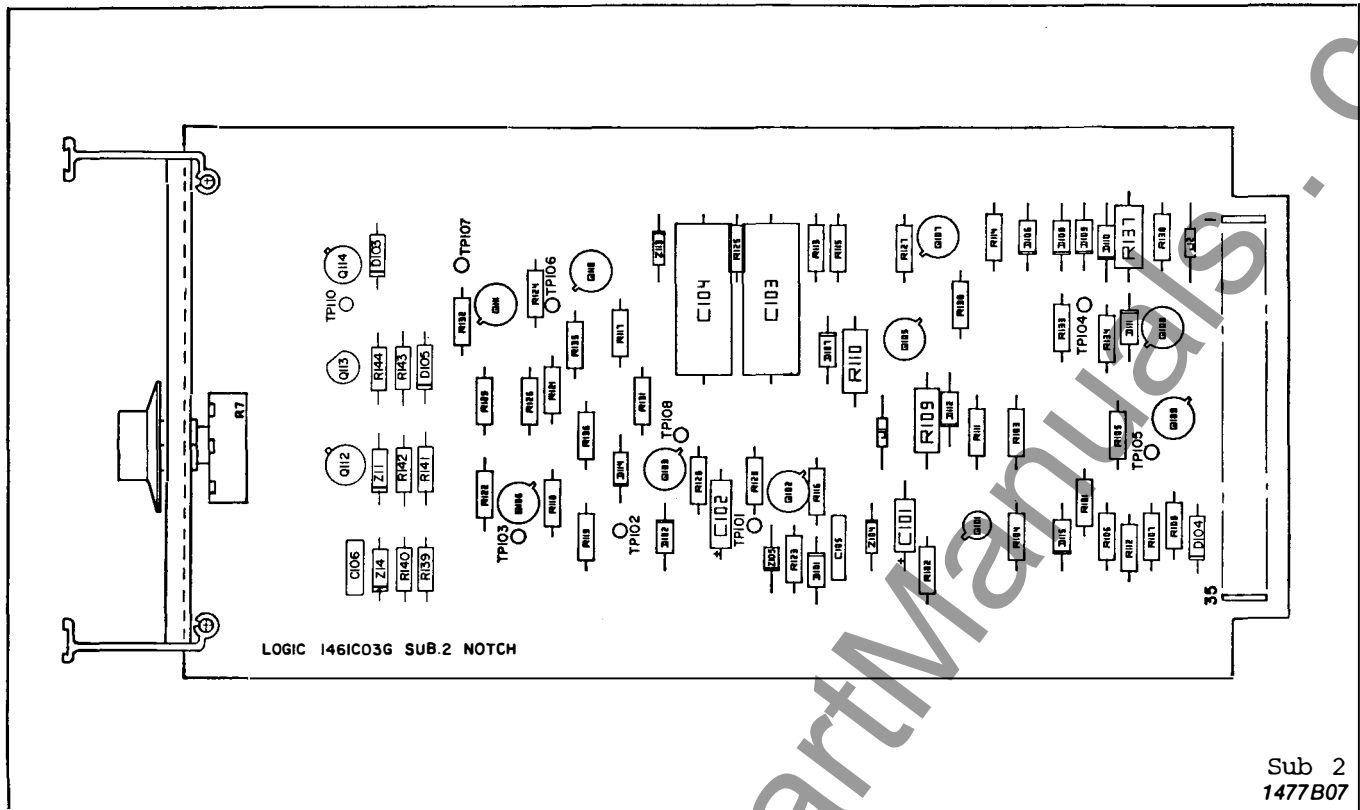


Fig. 10. Component Locations Logic Board for Transfer Trip

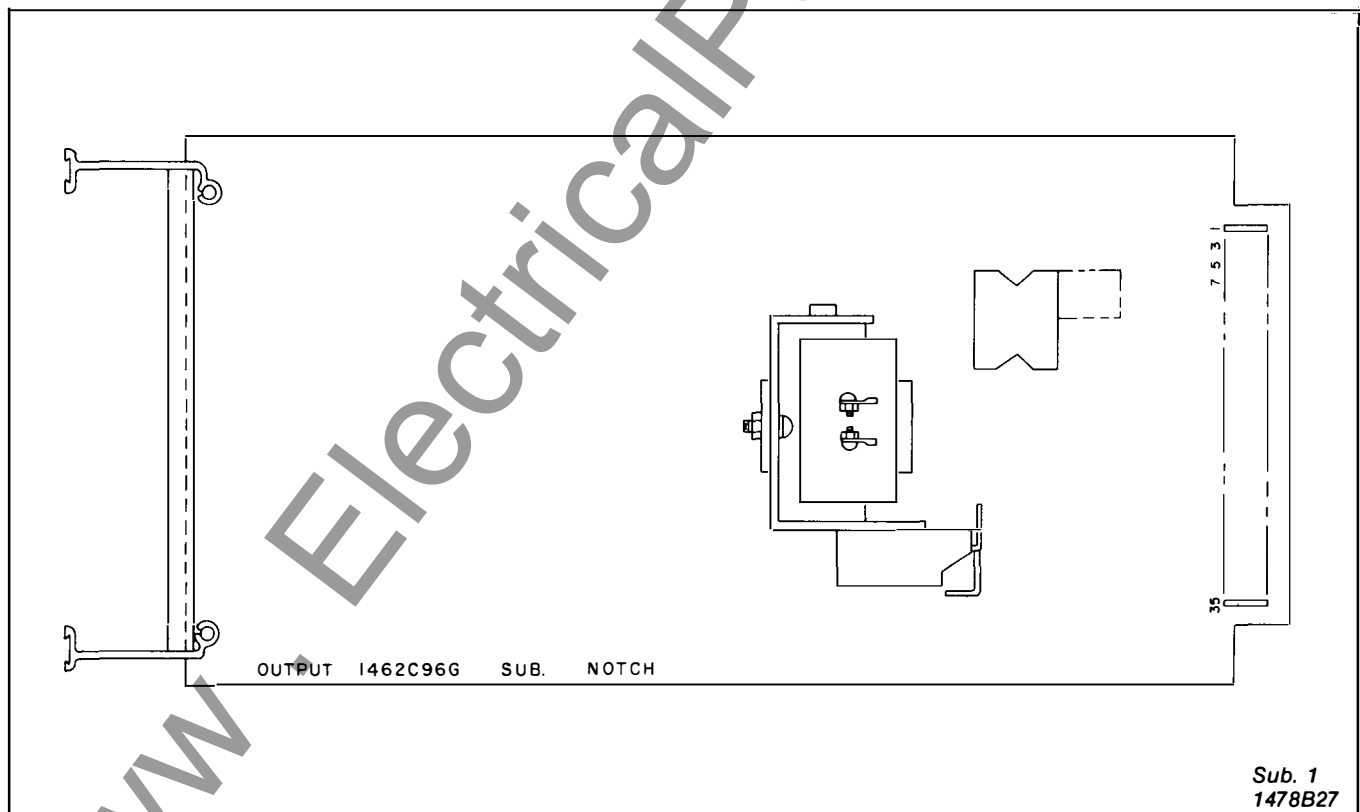
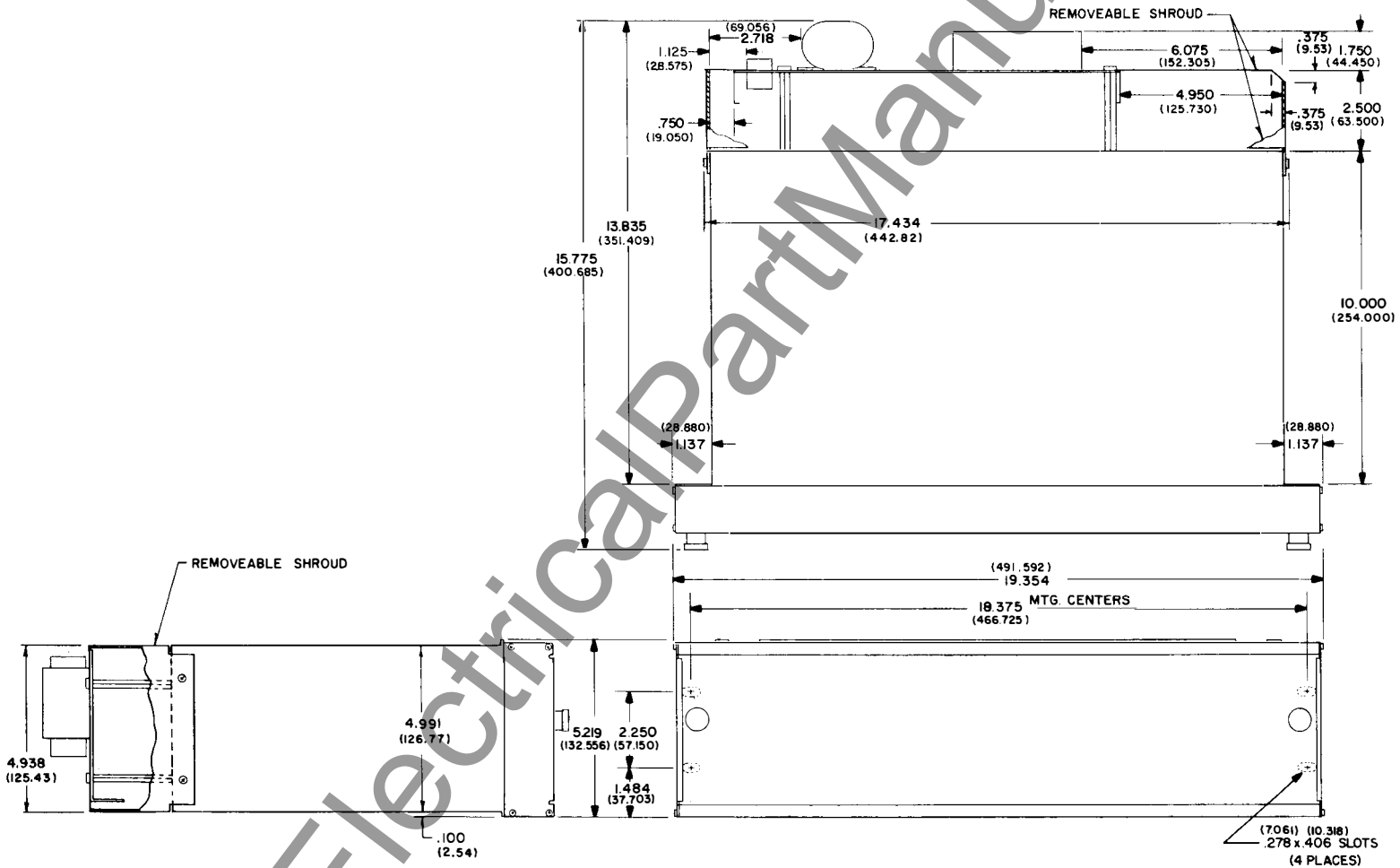
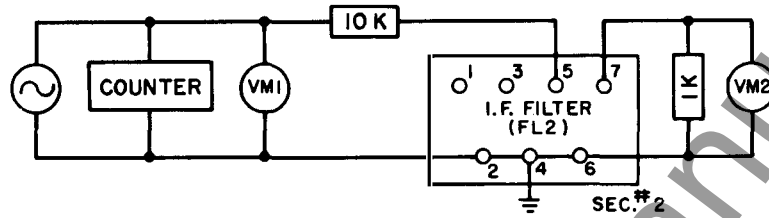
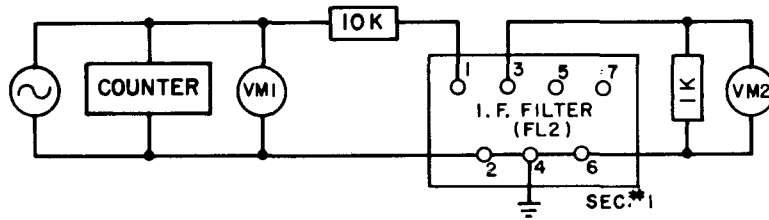


Fig. 11. Component Locations of the Output Printed Circuit Board

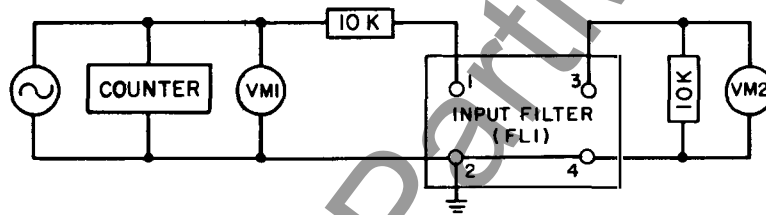
Fig. 12. Outline and Drilling for Receiver Assembly



Sub 5
1445C80



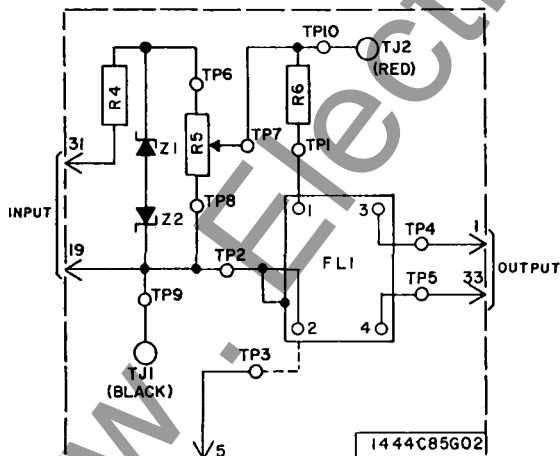
I. F. FILTER TEST CIRCUIT CONNECTIONS



INPUT FILTER TEST CIRCUIT CONNECTIONS

Sub. 1
849A109

Fig. 13. Test Currents for Frequency Shift Receiver Filters



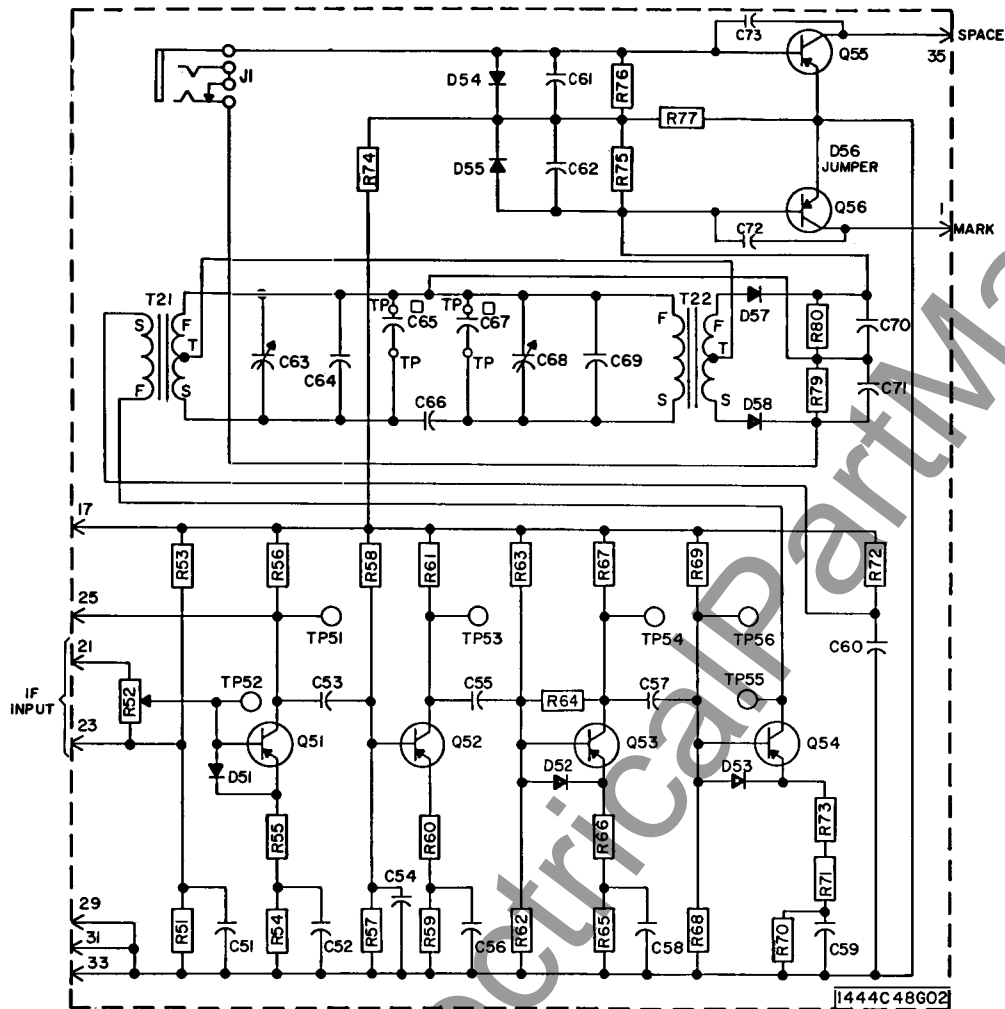
COMPONENT	DESCRIPTION	STYLE NO.
R4	RESISTOR 100.0 .50W 5%	184A763H03
R6	RESISTOR 10.0K .50W 5%	184A763H51
R5	POTENTIOMETER 10.0K 2W	185A086H10
FL1	FILTER	□
TJ1	TIP JACK BLACK	187A332H02
TJ2	TIP JACK RED	187A332H01
Z1	ZENER IN3027B	188A302H07
Z2	ZENER IN3027B	188A302H07

□ = DETERMINED BY CHANNEL FREQUENCY PER ORDER.

Sub. 1
775B712

Fig. 13 Test Circuits for Frequency Shift Receiver Filters

Fig. 16. Internal Schematic 200.5-300Hz. Oscillator and Mixer I.F. Amplifier Module



COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR .250UF 200V	187A624H02
C52	CAPACITOR .250UF 200V	187A624H02
C53	CAPACITOR .100UF 200V	187A624H01
C54	CAPACITOR 1300.000PF 500V	187A584H15
C55	CAPACITOR .100UF 200V	187A624H01
C56	CAPACITOR .250UF 200V	187A624H02
C57	CAPACITOR .100UF 200V	187A624H01
C58	CAPACITOR .250UF 200V	187A624H02
C59	CAPACITOR .250UF 200V	187A624H02
C60	CAPACITOR 1.000UF 200V	187A624H04
C61	CAPACITOR .220UF 50V	762A703H01
C62	CAPACITOR .220UF 50V	762A703H01
C63	CAPACITOR 4.5TO 100PF	762A736H02
C64	CAPACITOR 9100.000PF 200V	187A624H16
C65	CAPACITOR SEE NOTE	187A624H16
C66	CAPACITOR 100.000PF 500V	187A684H08
C67	CAPACITOR SEE NOTE	
C68	CAPACITOR 4.5TO 100PF	762A736H02
C69	CAPACITOR 9100.000PF 200V	187A624H16
C70	CAPACITOR .220UF 50V	762A703H01
C71	CAPACITOR .220UF 50V	762A703H01
C72	CAPACITOR 330.000PF 200V	880A397H02
C73	CAPACITOR 330.000PF 200V	880A397H01
D51	DIODE 1N457A	184A855H07
D52	DIODE 1N457A	184A855H07
D53	DIODE 1N457A	184A855H07
D54	DIODE 1N457A	184A855H07
D55	DIODE 1N457A	184A855H07
D56	DIODE 1N457A	184A855H07
D57	DIODE 1N628	184A855H12
D58	DIODE 1N628	184A855H12
R51	RESISTOR 4700.0 .50W 5%	184A763H43
R53	RESISTOR 27.0K .50W 5%	184A763H61
R54	RESISTOR 2200.0 .50W 5%	184A763H35
R55	RESISTOR 27.0 .50W 5%	187A290H11
R56	RESISTOR 10.0K .50W 5%	184A763H51
R57	RESISTOR 4700.0 .50W 5%	184A763H43
R58	RESISTOR 27.0K .50W 5%	184A763H61
R59	RESISTOR 1500.0 .50W 5%	184A763H31
R60	RESISTOR 180.0 .50W 5%	184A763H09
R61	RESISTOR 4700.0 .50W 5%	184A763H43
R62	RESISTOR 2200.0 .50W 5%	184A763H35
R63	RESISTOR 33.0K .50W 5%	184A763H63
R64	RESISTOR 2700.0 .50W 5%	184A763H37
R65	RESISTOR 680.0 .50W 5%	184A763H23
R66	RESISTOR 68.0 .50W 5%	187A290H21
R67	RESISTOR 4700.0 .50W 5%	184A763H43
R68	RESISTOR 2700.0 .50W 5%	184A763H37
R69	RESISTOR 18.0K .50W 5%	184A763H57
R70	RESISTOR 220.0 .50W 5%	184A763H11
R71	RESISTOR 68.0 .50W 2%	629A531H04
R72	RESISTOR 330.0 .50W 5%	184A763H15
R73	RESISTOR 56.0 .50W 2%	629A531H02
R74	RESISTOR 12.0K .50W 5%	184A763H53
R75	RESISTOR 3000.0 .50W 5%	184A763H38
R76	RESISTOR 3000.0 .50W 5%	184A763H38
R77	RESISTOR 220.0 .50W 5%	184A763H11
R79	RESISTOR 2200.0 .50W 5%	184A763H35
R80	RESISTOR 2200.0 .50W 5%	184A763H35
R52	POT 1.0K .50W	629A645H04
Q51	TRANSISTOR 2N4249	849A441H03
Q52	TRANSISTOR 2N4249	849A441H03
Q53	TRANSISTOR 2N4249	849A441H03
Q54	TRANSISTOR 2N4249	849A441H03
Q55	TRANSISTOR 2N3645	849A441H01
Q56	TRANSISTOR 2N3645	849A441H01
T21	TRANSFORMER	606B533G01
T22	TRANSFORMER	606B533G02
J1	TELEPHONE JACK	187A606H01

□ ONE OR TWO CAPACITORS USED; VALUES DETERMINED IN TEST.

Fig. 17. Internal Schematic Amplifier and Limiter Discriminator Module

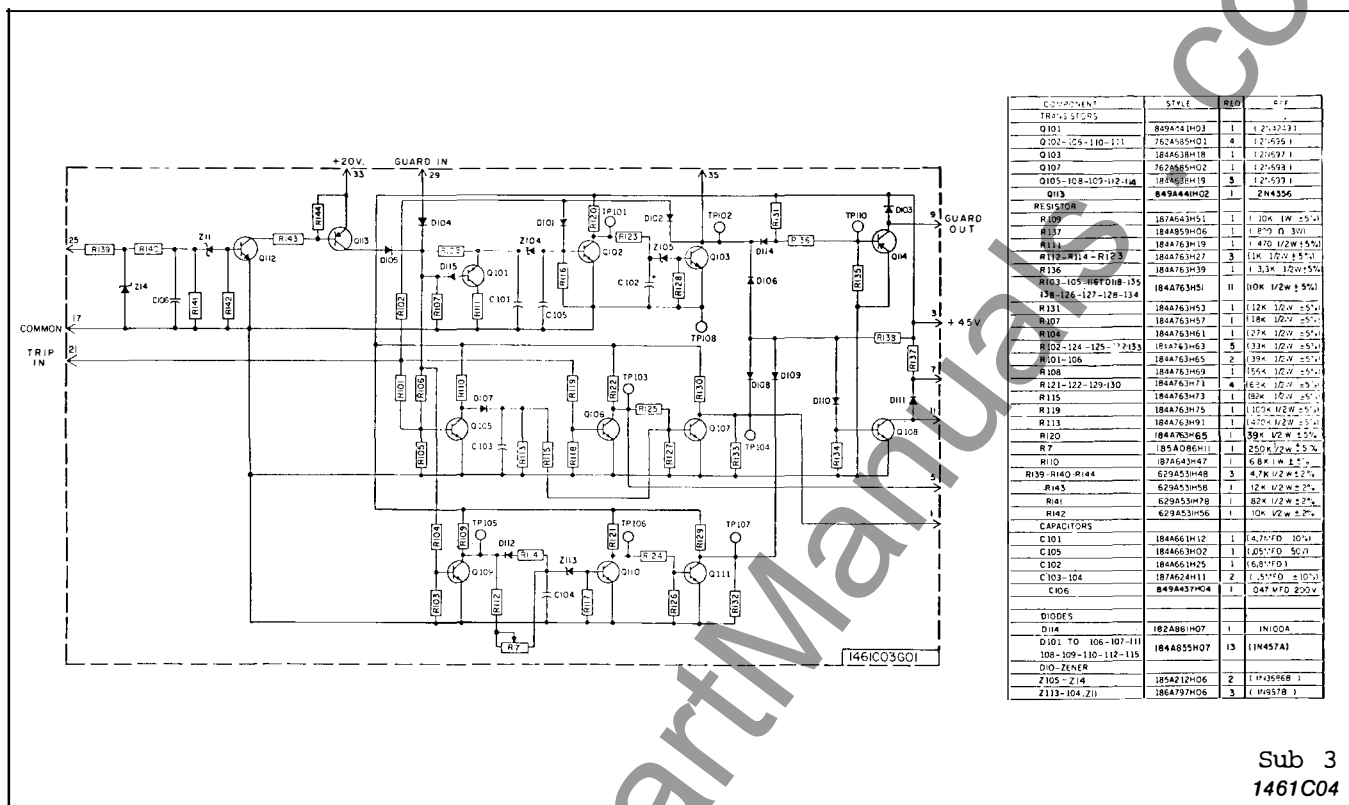


Fig. 18. Internal Schematic Logic Board for Transfer Trip Module

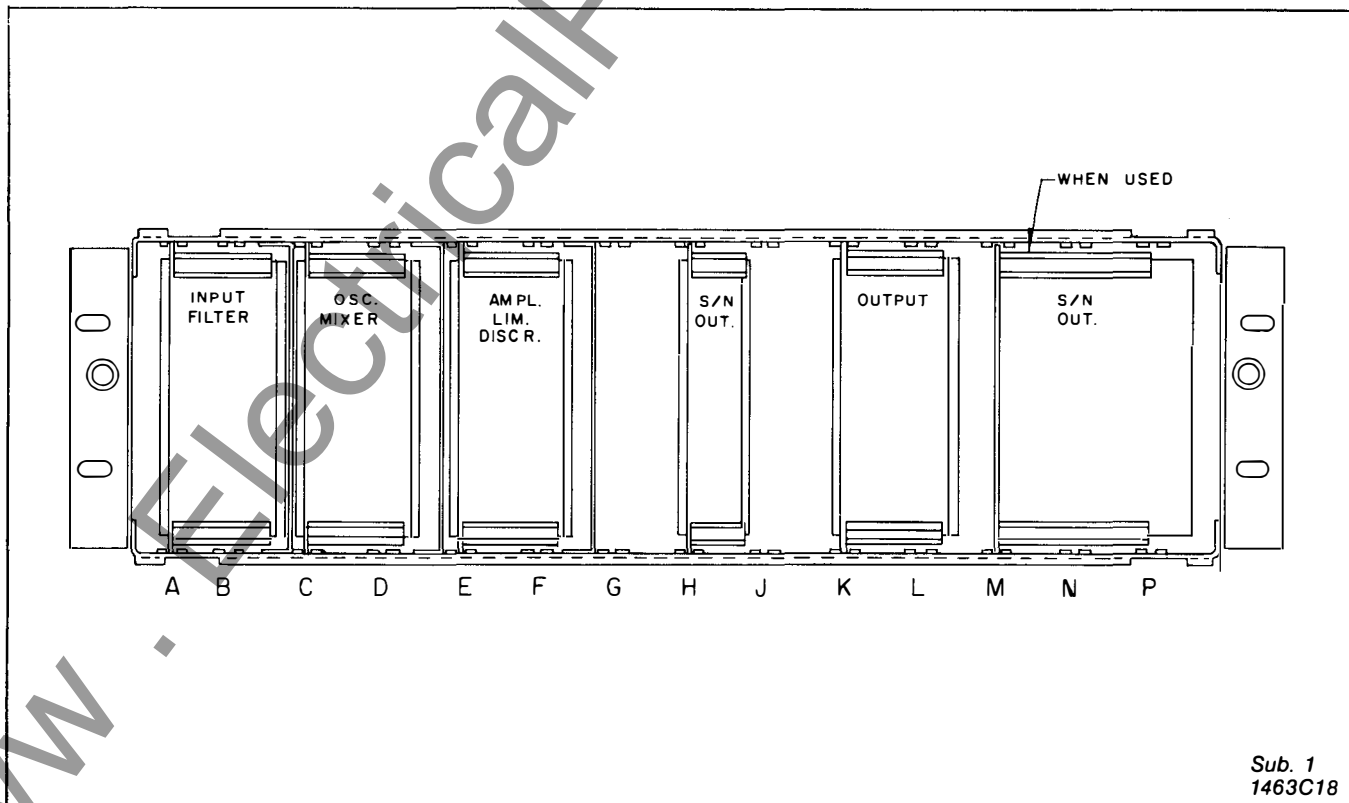


Fig. 19. Module Location

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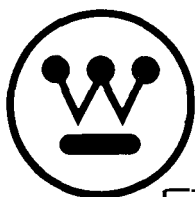
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INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT RECEIVER EQUIPMENT STU-UNBLOCK—WIDE BAND WITH DC/DC CONVERTER POWER SUPPLY

CAUTION: It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet and in the system instruction leaflet before energizing the system. Printed circuit modules should not be removed or inserted when energized. Failure to observe this precaution can result in an undesired tripping output and cause component damage.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF-10 frequency-shift receiver equipment as adapted for STU-Unblock applications responds to carrier-frequency signals transmitted from the distant end of a power line and carried on the power line conductors. The block signal is transmitted continuously when conditions are normal. Its reception indicates that the channel is operative and that there is no fault in the protected equipment. The block frequency is 100 hertz above the center frequency of the channel. When a fault occurs at the distant end of the power line, protective relays switch the transmitter located there to an unblock frequency, 100 hertz below the center frequency, and also increases the power output of the transmitter (from 1 watt to 10 watts).

CONSTRUCTION

The TCF receiver unit for STU Unblock applications is mounted on a standard 19-inch wide chassis 5 1/4 inches high (3 rack units) with edge

slots for mounting on a standard relay rack. An input attenuator and a jack for metering the discriminator output current, are accessible from the front of the chassis.

All of the circuitry that is suitable for mounting on printed circuit boards is contained on printed circuit modules that plug into the chassis from the front and are readily accessible by removing the transparent cover on the front of the chassis. The power supply components and external connectors are located at the rear of the chassis as shown in Figure 6. Reference to the internal schematic connections of Figure 1 will show the location of these components in the circuit.

The printed circuit modules slide into position in slotted guides at the top and bottom of the chassis, and the module terminals engage a terminal block at the rear of the chassis. A handle on the front of each module is labeled to identify its function, and also identify adjustments and indicating lights if any are available at the front of the module. Of particular significance, is the input attenuator contained on the front of the filter module which is used in adjusting the input receiver signal during initial field installation.

A module extender (Style No. 1447C86G01) is available for facilitating circuit measurements or major adjustments. After withdrawing any one of the circuit modules, the extender is inserted in that position. The module is then inserted into the terminal block on the front of the extender. This restores all circuit connections and renders all components and test points on the module readily accessible.

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

The receiver operates from a regulated +12V and -12V supply derived from a self-contained DC to DC converter. The power supply module containing the DC to DC converter has links which enable it to operate from either 48 volts or 125 volts dc.

External connections to the receiver are made through a 36-terminal receptacle, J3. The r-f input connection to the receiver is made through a coaxial cable jack J2. (See Figures 1, 2, or 3).

OPERATION

INPUT MODULE

The input module contains the input control and the input filter. The signals to which the TCF-10 receiver responds are fed through a coaxial cable connected to jack J2 at the rear of the chassis to the input module. The input control R5, accessible at the front of the input module, attenuates the signal to a level suitable for the best operating range of the receiver.

A scale on the panel is graduated in dB. While this scale is typical rather than individually calibrated, it is accurate within several dB and is useful in setting approximate levels. Settings should be made more accurately utilizing a suitable ac voltmeter with a dB scale when possible.

LC FILTER (WIDE BAND RECEIVERS)

From the attenuator, the signal passes through a bandpass LC filter, FL 201. This filter has a passband of approximately 1600Hz which is relatively wide in comparison to the IF filter which has a passband of approximately 500Hz. Still, frequencies several kHz above or below the center frequency (f_c) of the channel are greatly attenuated. Figure 5a shows a typical curve for the LC filter as well as a characteristics curve for the IF (intermediate frequency) filter, FL2, and the discriminator output. This apparently wide bandwidth for the input filter in relation to the IF filter is necessary to both achieve high speed data transmission and to achieve proper operation of the noise clamp by sampling noise in the frequency band surrounding the IF band.

This is generally recommended in STU-Unblock applications. However, if the frequency spectrum is too crowded to permit the use of the wide band channel and a slower response time can be tolerated, then the narrowband receiver using a crystal filter is recommended. This operation is described below.

CRYSTAL FILTER— NARROW BAND RECEIVERS ONLY (SHOWN FOR COMPARISON ONLY)

From the attenuator, the signal passes through a crystal filter, FL1. This filter has a narrow pass band, and frequencies several hundred cycles above or below the center frequency (f_c) of the channel are greatly attenuated. Figure 5b shows a typical curve for the crystal filter, as well as a characteristic curve for the intermediate frequency filter, FL2 and for the discriminator output. The narrow pass band of FL2 permits close spacing of channel frequencies and reduces the possibility of false operation caused by spurious signals such as may result from arcing disconnects or corona discharge. This narrow input filter does not permit the use of the same type of noise clamp as the wide band filter.

OSCILLATOR, MIXER, AND IF AMPLIFIER MODULE

From the input filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20kHz above the channel center frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of filter FL1 is impressed on the emitter-collector circuit of Q11. As a result of mixing these two frequencies, the primary of transformer will contain frequencies of 20kHz, $2f_c + 20\text{kHz}$, $f_c + 20\text{kHz}$, and f_c .

The output from the secondary of T12 is amplified by Q31 in the intermediate frequency (IF) stage, and is impressed on FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. Since its pass band is narrower than that of the input filter, it eliminates the frequencies present at its

input that are substantially higher than 20kHz. The output of this filter is the IF output which is fed to both the amplifier-limiter and the S/N Detection module. The output from the secondary of transformer T11, the RF output, is also fed to the S/N Detection module.

AMPLIFIER LIMITER AND DISCRIMINATOR MODULE

AMPLIFIER AND LIMITER

The output from the second section of the IF amplifier stage is fed to potentiometer R52 at the input of the amplifier and limiter stage. Sufficient input is taken from R52 so that with minimum input signal (16 mv.) at J2 and with R5 set for zero attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

DISCRIMINATOR

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at $f_c - 25$ hertz. The adjustment for zero output at $f_c - 25$ hertz is made by capacitor C68. C63 also is adjusted to obtain a maximum voltage reading across R80 when the current output is zero. Maximum current output, of opposite polarities, will be obtained when the frequency is 100 hertz above or below the center frequency. This separation of 200 hertz between the current peaks is affected by the value of C66, (the actual value of which may be changed slightly from its typical value in factory calibration if required).

The purpose of offsetting the zero output frequency of the discriminator by 25 hertz in the unblock direction is to reduce the band of noise-generated trip frequencies (between the discriminator center frequency and the skirt of the FL1 filter), and to similarly increase the band of noise-generated frequencies on the block side of the discriminator center. It should be observed that although block frequency is $f_c + 100$ hertz, after leaving the mixer stage and as seen by the discriminator the block frequency is 20 kHz-100 hertz. Similarly, the unblock frequency is 20 kHz + 100 hertz. The intermediate frequency at which the discriminator has zero output then is 20.025 kHz.

For use with a three frequency transmitter and a second receiver for transfer trip, the discriminator is adjusted opposite in sense to that described above for the standard STU-Unblock. That is, the discriminator is adjusted so that the block output is at 125 hertz below the zero output frequency instead of 125 hertz above while the unblock output is at 75 hertz above the zero output frequency. This is shown in Figure 5c. Since the channel center frequency, f_c , is at 100 hertz below the block frequency, the discriminator is thus adjusted for block output at $f_c + 100$ hertz and unblock at $f_c + 300$ hertz with zero output at $f_c + 225$ hertz. Because of this requirement, the STU-Unblock receiver for three frequency operation can only be used with a wide band filter, FL201.

The discriminator output is connected to the bases of transistors Q55 and Q56 in such a manner that transistor Q56 is made conductive when current flows, from the discriminator output, in the forward direction of diode D54, (which occurs with trip output) and Q55 is made conductive when current flows in the forward direction of diode D55 (which occurs with guard output). Consequently, terminal 35 is at a potential of approximately +12 volts at guard (block) frequency and terminal 1 is at +12 volts at trip (unblock) frequency.

LOGIC CIRCUITS

The block diagram of the logic circuits is shown in Figure 4. Note that the logic involves three modules; the unblock logic module, the S/N output module, and the S/N detection module.

When the discriminator receives block signal, its output terminal 35 supplies positive potential to block AND #2 and 200/0 timer on the logic board. At the same time, if there is good signal level into the receiver, there will be a good signal input into AND #2 from the CL1 on the S/N detection module. This will result in an input to the 120/0 timer on the logic board which consists of R2, C1, and Z1. Capacitor C1 will charge in approximately 120 milliseconds to the breakdown voltage of Z1, and block OR #1 will receive an input #1. OR #1 consists of diodes D2, D3, and Q2. The function of Q1 is not indicated on the block diagram, but it discharges C1 quickly when Guard (block) signal disappears, so that the full 120 milliseconds delay is

obtained on closely repetitive appearances of Guard signal. This avoids cancellation of a loss-of-channel alarm by noise-produced Guard signal.

When OR #1 receives input #1 or input #2, Q2 is made conductive and capacitor C3 receives no charge. This capacitor along with Z2 and Q3 represents the 0/150 timer on the block diagram. Note that the absence of an input into the 0/150 timer represents an input #1 into AND #1. However, an input #2 which is a no input from AND #2 is required for AND #1 to put out a trip unblock signal. If guard (block) signal should disappear but be followed promptly by appearance of trip (unblock) signal, the unblock input fed through AND #3 and OR #1, will prevent the 0/150 timer from operating and input #1 will still be presented to AND #1. However, the loss of guard signal will be a no input for input #2 of AND #1, and there will be an immediate trip unblock output out of AND #1. This trip unblock output is fed through a buffer output on the S/N output board to the protective relaying system. However, if guard (block) signal disappears and unblock signal does not appear in approximately 150 milliseconds, then capacitor C3 of the 0/150 millisecond timer will change to the breakdown point of Z2, making Q3 conductive in effect removing input #1 to AND #1. This makes Q5 of AND #1 non-conducting and Q7 of AND #1 conducting thus removing the trip unblock output after 150 milliseconds loss of both guard and trip unblock signals. This bit of logic accounts for the receiver putting out a trip unblock signal for 150 milliseconds upon loss of channel.

The output of 0/150 timer is also fed through OR #2 to AND #3. OR #2 consists of D10, D11, and Q10 while AND #3 consists of D13, D14, D15, D16, and Q9. AND #3 assures that as long as you have good signal, no signal to noise clamp, a trip unblock signal, and have not timed out to 0/150 timer, you will put out a trip unblock signal to the relaying system. However, if the 0/150 timer has timed out because you did not receive a trip signal within 150 milliseconds of losing the guard (unblock) signal, then the system will lock out and not trip for any subsequent trip signal unless it has been preceded by a guard signal for at least 120 milliseconds.

The logic comprising AND #4, 1000/0 timer, 200/0 timer, FLIP-FLOP, and OR #2 is to insure trip unblock on open breaker keying even if the channel is lost for 150 milliseconds after receiving trip. It contains a link which can be removed by the customer if it is desired not to use this feature. Without this logic, if the receiver is receiving trip unblock under open breaker keying of the transmitter and the channel is lost for 150 milliseconds so that the 0/150 timer times out, then the receiver will lock out unless a guard (block) signal is received for 120 milliseconds. This is guard return. However, with this logic in, if the receiver has been receiving trip for over 1000 milliseconds, then if the channel is lost for over 150 milliseconds, the channel will not require a guard return but instead will go to trip immediately upon receipt of trip signal.

With the receipt of trip, input #1 is satisfied into AND #4. Also at this time, if the 0/150 timer has not timed out, (signifying a receipt of trip within 150 milliseconds of lost of guard) input #2 is also satisfied into AND #4. Thus, there will then be an input into the 1000/0 timer. After 1000 milliseconds of continuous receipt of trip, this timer will put out an input into the flip-flop setting the flip-flop. This output is fed back to AND #3 where it is used in place of the trip signal to prevent the 0/150 timer from timing out so that a lost of trip for over 150 milliseconds will not lock out the receiver and necessitate a guard return signal. This flip-flop output through OR #2 is also fed back to AND #4 to lock in the setting of the flip-flop. Now if a guard signal comes in and lasts for over 200 milliseconds, the 200/0 timer will time out and reset the flip-flop so that it again will take 1000 milliseconds of trip signal to set the flip-flop. AND #4 consists of D12, D17, and Q11; 1000/0 timer consists of R40, C4, Z5, and Q12; 200/0 timer consists of D20, Q15, C5, R51, Z6, and Q16; while the flip-flop consists of R46, D18, D19, R47, Q13, Q14 and associated resistors.

The checkback trip output is used for checking channel operation. It signifies a receipt of trip frequency. It is only supervised by the S/N clamp of the detection board. It will put out a checkback trip upon receipt of trip as long as there is no signal to noise clamp. It utilizes AND #5 composed of D77, R171, and Q65 of the S/N output module.

Please note also that it takes a good signal to noise ratio to prevent the 0/150 timer from timing out when receiving trip regardless of the CL1 condition or the flip-flop condition. However, a noise burst at the instant of sending trip will not delay trip unblock as the trip unblock is derived from the loss of guard (block) signal and not the receiving of the trip unblock signal.

It should also be noted that when a trip power boost in the order of 10 dB is used when sending trip, this sudden A.M. increase in power could momentarily activate the S/N clamp as this sudden increase in power level does generate A.M. sidebands which, after all, is noise. However, as noted above, it does neither delay nor effect trip as trip unblock is derived from the loss of guard signal. It manifests itself as only a momentary blip of the S/N noise clamp LED light and should be of no concern.

S/N DETECTION MODULE

The S/N detection module has three basic functions; first to determine the in-band signal to noise ratio and provide clamping output at the desired level of signal-to-noise ratio, second to measure incoming in band signal level and provide both an output to a carrier level indicating instrument and to a clamping circuit in the output module for clamping at the desired low level of signal, and third to provide a clamping output when the desired signal level exceeds the normal received level by a substantial amount, typically 25dB.

The method of determining signal to noise ratio utilizes the measurement of signal level in two different bandwidths, that of the input filter which is 1600 hertz, and that of the IF filter which is 500 hertz. The total signal plus noise in the 500 hertz bandwidth is subtracted from the signal plus noise in the 1600 hertz bandwidth and this difference is then compared with the signal plus noise in the 500 hertz bandwidth to arrive at a true in-band signal-to-noise ratio using logarithmic circuits. See Figure 29.

If the ratio of signal to noise is less than the value selected, typically 10dB, then there will be a +6V out of IC13 (TP75 and terminal 27). This is a high noise condition and this voltage is used as a clamp to prevent erroneous interpretation of data

being received due to high noise conditions. Under normal low noise conditions, typically signal to noise ratio greater than 10dB, the voltage out of IC13 (TP75) is -6V and no clamping is done.

The wide band signal of 1600 hertz bandwidth called the RF signal is fed into the S/N detection board through isolation transformer T31. Operational amplifiers IC1 and IC2 along with their associated components, R82 through R92 and C81 through C90, constitute a 4 pole low pass filter which passes the mixed band of frequencies in the bandwidth of 1600 Hz centered about the 20kHz IF frequency, and blocks all the higher multiples such as in the IF amplifier. Operational amplifier IC3 and associated components amplifies the signal for feeding into the RMS circuit composed of IC4 and IC5 with adjustable potentiometer R94 controlling the amount of amplification. This latter circuit converts the signals into a dc voltage proportional to the RMS value of the ac signals. Operational amplifier IC6A and associated components is used for inversion and isolation of this dc voltage before being fed into the summation amplifier IC6B.

The narrow-band signal of 500 hertz bandwidth called the IF is fed into the S/N detection board through isolation transformer T32. The amount of signal fed into the board is adjustable by means of potentiometer R111. The circuit composed of operational amplifiers IC7 and IC8 and associated components is an RMS circuit which converts the signals into a dc voltage proportional to the RMS value of the ac signals present in the IF bandwidth. The output of this circuit is also then fed into the summation amplifier IC6B.

The summation amplifier takes the difference between the RMS values of the IF signal and the RF signal and feeds it into one half of the logarithmic amplifier composed of IC9 and associated components. At the same time, the RMS value of the IF signal is fed into the other half of this logarithmic amplifier. The logarithmic amplifier takes the logarithmic difference between these two signals (which is equivalent to IF divided by (RF-IF) from the summer). The constants of the circuits are set up so that the output of the logarithmic amplifier is positive when the ratio of the signal to noise ratio in these bandwidths is greater than

10dB, and is negative when the signal to noise ratio is less than 10dB. (Note: The point at which the change in polarity occurs can be altered to other than 10dB signal to noise ratio by altering the adjustments of R94 and R111). In addition, the output of the logarithmic amplifier is also negative when the signal level is approximately 25dB above normal for high level clamping.

The output of the logarithmic amplifier is fed through networks consisting of IC10A and IC13A to the level detector circuit IC13B which has a fast pickup and slow dropout when it receives a signal from the logarithmic amplifier indicating a lower than desired signal to noise ratio (lower than 10dB is initially set when shipped). This will put out a +6 volts out of terminal 27 for this condition. For high signal to noise ratio this output will be -6 volts. This circuit will also put out +6 volts out of terminal 27 for very high signal levels. This is a high signal clamp and occurs for signal levels approximately plus 25dB above normal level.

The output of the IF RMS circuit is also fed to the logarithmic circuit composed of IC11A, IC12A, and IC11B which puts out a dc signal level linearly proportional to signal level in dB for feeding an external microammeter calibrated with a linear dB scale with 10dB equal to 33-1/3 microamperes.

OUTPUT MODULE

The output module provides four buffered outputs to the relay system. They are block, unblock, S/N level, and not low signal with red indicating light emitting diodes for these outputs and a yellow indicating light emitting diode for normal level (satisfactory signal level). In addition, the output module has logic which will prevent either a +12V block or +12V unblock output whenever the S/N level drops to an unsatisfactory level or the received signal level drops to an unsatisfactory level.

The higher frequency output of plus 12 volts (when present) from the discriminator is fed into the output module through terminal 25 into the "and" gate consisting of diodes D71, D72, D73, and D74, transistors Q62 and Q63, and associated components R163, R164, R165, R166, R167, R168, D88, D75, and Z22. If there is no low level signal or low signal to noise ratio signal to prevent transistor

Q62 from becoming conducting, then transistor Q62 becomes conducting, causing Q63 to become conducting and a plus 12 volts signal to appear out of terminal 29 from which it is fed to the outside world. In a similar manner, the lower frequency output of plus 12 volts when present from the discriminator is fed into the output module through terminal 15 into the "and" gate built around transistors Q65 and Q66. Just as in the case of the higher frequency output, the lower frequency output of plus 12 volts will appear out of terminal 27 for feeding to the data acquisition equipment if there is no low level clamp or low signal to noise ratio clamp. If there is a clamp, both of these outputs will be clamped to minus 12 volts output.

The low-signal-level clamp operates off the carrier level signal of the S/N detection module which is basically the same signal level fed to the CL1 instrument.

It is fed through terminal 7 into the voltage comparator circuit built around operational amplifier IC21B. This comparator compares this signal level with the voltage reference from IC21A, and if the signal level is greater than the low level at which clamping is desired, the output of IC21B will be negative causing the yellow LED to glow indicating OK level and there will consequently be no low signal clamping. If the signal level is below the level at which clamping is desired, then the output of IC21B will be positive causing the red LED to glow indicating low level. In addition, both transistors Q67 and Q64 will become conducting. Transistor Q64 conducting will prevent plus 12 volt signals from appearing on the outputs going to the outside world by preventing transistors Q65 and Q62 from conducting. Transistor Q67 conducting causes Q68 to become non-conducting and thus removes the not low signal output from terminal 1. Under good or OK signal level, this not low signal output at terminal 1 of this module is plus 12 volts.

The S/N clamp output from the S/N detection module is fed into terminal 35 of this module. At low signal-to-noise ratio level, this +6 volt signal will cause transistors Q70 and Q61 to conduct. Transistor Q70 conducting will cause both the red LED to glow indicating low S/N and transistor Q71 to conduct supplying plus 12 volts out of terminal 13 to the outside world. Transistor Q61

conducting will prevent both transistors Q62 and Q65 from conducting, and thus prevent plus 12 volt signals from appearing at their respective outputs to the outside world. It should be noted that the S/N clamp also operates for a high signal level of approximately plus 25dB above normal when set to operate at 10dB signal to noise ratio.

OUTPUT MODULE—CONTACT OUTPUT

The output module-contact output performs two functions; alarming on low signal level using a telephone relay with two form C contacts, and indicating signal level with its self-contained CL1 instrument.

The alarm circuit consists of all components associated with IC1, IC2, Q1, Q2, Q3, and relay AL. The signal level from the S/N detection module is fed into a level detector consisting of IC1B and resistors R6, R7, R8, and R9. An adjustable reference for the level detector consisting of IC1A and R1, R2, R17, R3, R4, and R5 is also fed into the level detector. As long as the signal level exceeds the value set by the reference, there will be approximately plus 12 volts out of the level detector into the photo-optical isolator. This causes Q1 to become non-conducting and thus transistors Q2 followed by transistor Q3 to become conducting. As a consequence, the alarm relay AL is picked up on signal levels above the alarm level. When the signal level drops below the alarm level set by the reference, the output of the level detector will be minus 12 volts causing Q1 to become conducting and Q2 and Q3 to become non-conducting and drop out the alarm relay AL. The alarm relay has a delay of approximately 40 milliseconds on dropout to prevent undesirable alarming on short temporary loss of signal. Note that the level of alarm is set by adjusting alarm level R17, accessible from front of module, independent of the low signal level output from the output module (which is set by L.L. ADJ. R178). Also both of these outputs operate on total signal level within the passband of the receiver.

The CL1 instrument operates directly on signal level received from the S/N detection module. It measures signal level in the entire bandwidth of the receiver and thus closely correlates with the low level clamp (L.L. ADJ.) and the low signal alarm

AL (alarm level). It thus can be used in setting both of these adjustments.

POWER SUPPLY

The +12 volt dc, -12 volt dc, and the +45 volt dc supply voltages for the receiver are derived from the power supply module and R3, R7, and Z1 mounted in rear of chassis.

The +12 volt dc supply and the -12 volt dc supply are both derived from the DC to DC converter and are regulated for input voltages to the regulator of from 42 volts to 56 volts. For nominal 48 volt input units, the DC to DC converter has sufficient range so that the preregulator consisting of R3, R7, and Z1 is not necessary and is omitted. In this case, then, the +45 volt supply is derived directly from the input supply voltage and is not regulated.

For nominal 125 volt input units, the pre-regulator consisting of R3, R7, and Z1 is necessary and is supplied. In this case, then, the +45 volt supply is derived from this pre-regulator and is regulated.

The LED's D1 and D2 indicate when the power supply is energized with either 48V or 125V by the proper one glowing. Since this module is always supplied with 48V, the 48V diode will light. A 48V supply can be converted to a 125V supply simply by adding R3, R7, and Z1 jumpers. Similarly, a 125V supply can be converted to a 48V supply by removing R3, R7, and Z1. Capacitor C1 and C2 bypass rf or transient voltages to ground. Choke L1 with capacitor C3 form a trap to isolate the receiver from transient voltages in the 20kHz range that may appear on the dc supply and which could affect the receiver.

CHARACTERISTICS

Frequency Range 30kHz – 300kHz

Sensitivity
(noise-free
channel)

For crystal filter (narrow band)
0.005 volt = 65dB
below 1 watt for limiting
For L-C filter (wide band)
0.015 volt = 55dB
below 1 watt for limiting

Input Impedance	5000 ohms minimum
Bandwidth	Crystal filter (narrow band) Down <3dB at 220 Hz B.W. Down >60dB at 1000 Hz B.W. L-C filter (wide band) Down <3dB at 600 Hz B.W. Down >40dB at 2000 Hz B.W.
Discriminator	Set for 200 Hertz shift from block to unblock frequency. Offset 25 Hertz to favor block.
Operating Time	Narrow Band 9 ms channel (Transmitter and Receiver) Wide Band 4 ms channel (Transmitter and Receiver)
Frequency spacing	
A. For two or more signals over a one-way channel	Narrow Band 500 Hertz minimum Wide Band 1000 Hertz minimum
B. For two-way channel	Narrow Band 1000 Hertz minimum Wide Band 2000 Hertz minimum
Signal-to-noise ratio clamp setting	10dB SNR (as shipped) Nominal for wide band receivers
Ambient Temperature Range	-20° C to +55° C
Battery Voltage Variations	
Nominal 48V dc	42V dc-56V dc
Nominal 125V dc	105V dc-140V dc
Battery Drain	0.25 Amperes
Dimensions	Panel Height = 5 1/4 inches (3RU) Panel Width = 19 inches
Weight	13 pounds
CLI Accuracy	±2dB between -15dB and 0dB.

INSTALLATION

The TCF-10 receiver is generally supplied in a cabinet or a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. In particular equipment which generates excessive heat such as power supplies should not be mounted directly beneath the TCF-10. Heat rising will tend to raise the ambient temperature immediately around the chassis above acceptable levels. The maximum ambient temperature around the chassis must not exceed 55° C. In addition, sudden fluctuations in ambient temperature caused by these power supplies due to variations in load can cause variations in performance due to uneven heating of the receiver introducing abnormal temperature variations in the receiver.

ADJUSTMENTS

All factory adjustments of the TC-10 receiver have been carefully made and should not be altered unless there is evidence of damage or malfunctioning. Such adjustments are: frequency and output level of the oscillator and mixer; input to the amplifier and limiter; frequency spacing and magnitude of discriminator output peaks; pickup of alarm relay; and pickup of low signal level clamp. The adjustment that must be made at time of installation is the setting of input attenuator R5. The input attenuator adjustment is made by a knob on the front of the panel of the input module.

The receiver should not be set with a greater margin of sensitivity than is needed to assure correct operation with the maximum expected variation to attenuation of the transmitter signal. In the absence of data on this, the receiver may be set to operate on a signal that is 15dB below the maximum expected signal. After installation of the receiver and the corresponding transmitter, and with a normal space signal level being received, input attenuator R5 should be adjusted to the position at which the receiver low signal clamp operates. The attenuator R5 should then be readjusted to increase the voltage supplied to the receiver by 15dB. The scale markings for R5 permit approximate settings to be made, but it is preferable to make this setting by means of the dB scales of an ac VTVM connected across the terminals indicated at

the front panel of the input module. The red terminal is connected to the wiper arm of R5 and the black terminal is connected to ground. With this setting, a 15dB drop in signal will cause a low signal level clamp operation which will lock the output of the receiver into neither an unblock nor a low signal output at the point at which the receiver just drops out of limiting.

The only other adjustment which may be necessary at the time of initial installation is the adjustment of the CL1 instrument to correspond to proper variation of signal level from normal. This may be necessary if the instrument was not supplied with the receiver and was not adjusted by the factory. If this instrument was supplied and adjusted by the factory, then it could be used in adjusting R5. In this case, it would be necessary only to adjust R5 with a normal signal being received so that the instrument indicates 0dB.

If the instrument was not previously adjusted by the factory, then the following procedure should be used in adjusting the instrument. (Note: When CL1 instrument is supplied within the chassis, this is factory adjusted).

1. Set incoming level into receiver at +10dB above normal level.
2. Adjust span adjustment, R147, so that the voltage at TP72 with respect to TP62 (common) is +3.000 volts.
3. Reducing incoming signal into receiver by 30dB.
4. Adjust full scale adjustment, R153, so that instrument now reads -20dB. (This is approximately 0 microamperes).
5. Increase signal to +10dB level. (This is 100 microamperes).
6. Adjust slope adjustment R155 to read +10dB on instrument.
7. Reduce signal to normal level. Instrument should read 0dB. If desired, instrument could be adjusted to read 0dB with R155 with sacrifice in reading accuracy for +10dB.

FACTORY ADJUSTMENTS

In case the factory adjustments have been altered or there is suspicion of improper adjustments or malfunctioning, then the following procedures can be used.

In addition, alterations to the settings used by the factory for low signal level clamping and low signal-to-noise ratio clamping can be made using these procedures if desired.

Potentiometer R12 in the oscillator and mixer should be set for 0.3 volts, measured with a VTVM connected between TP11 and terminal 33 on the circuit board (ground terminal of voltmeter). A frequency counter can be connected to the same points for a check on the frequency which should be 20kHz above the channel center frequency. The frequency is fixed by the crystal used, except that it may be changed a few cycles by the value of capacitor C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that assures reliable starting of oscillation. The frequency at room temperature is usually several cycles above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should be connected from TP56 at the base of Q54 to terminal 33 of the limiter. With 5 millivolts of unblock frequency on the receiver input (R5 set at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting.

The adjustment of the signal to noise ratio clamp for clamping at 10dB signal to noise ratio is as follows:

1. Set the incoming signal into receiver at nominal level (28 mv).
2. Adjust IF input with R111 so that signal at TP68 of the S/N detector module is +100 mv dc (with respect to TP62).
3. Adjust RF input with R94 so that signal at TP63 is +145 mv dc (with respect to TP62).
4. Adjust log amplifier balance potentiometer R129 so that S/N clamps operates. This will be +6 volts dc at TP75. This will also appear as +12 volts at TP91 of the output board and the red S/N level indicator will light.
5. Go back and readjust RF input with R94 so that signal level at TP63 is now 74.4 mv dc.

The adjustments above are for operation of the clamp at 10dB or less signal to noise ratios. If it is desired to clamp at other than 10dB or less, the following values can be used in place of the 145 mv value in step 3.

For S/N of 0dB set TP63 to 297 mv.
5dB set TP63 to 200mv.
15dB set TP63 to 114mv.
20dB set TP63 to 97mv.

NOTE: When the SNR clamp is set to clamp at a 10dB signal to noise ratio, the receiver will also clamp at a high signal level of approximately 25dB above normal.

The low signal level clamp is set to operate at the signal level where the receiver just drops out of limiting. This is accomplished as follows:

1. With a normal unblock frequency signal being received and with an oscilloscope connected across TP56 and terminal 33 of the limited module, adjust input attenuator R5 to the point where the peaks of the oscilloscope trace just begin to flatten. (An alternate adjustment would be to set incoming signal level into receiver at 16mv with R5 set at zero which is the point at which limiting should begin.
2. Adjust the -V Ref. adjustment R178 on the output module so that the low level clamp just picks up. This will be indicated by the red low level light of the output module coming on. There also will be +12 volts at TP86 on the output module.
3. Adjust input attenuator R5 to increase signal into receiver by desired margin of operation. This normally should be 15dB. This is done by reducing the R5 attenuator setting.

The alarm level is set to alarm at a signal level 5dB above the signal where the receiver just drops out of limiting. This will result in an alarm being given at a point where the signal level has dropped 10dB from the initial nominal setting but the receiver signal level is still 5dB above limiting.

1. With a normal higher frequency signal being received and with an RF voltmeter connected across the input module input test jacks TJ1 and TJ2 (available at front on module), adjust

input attenuator R5 to where signal level is 28mv across these test jacks.

2. Adjust the alarm level R17 on the output module—contact output to the point where the alarm relay AL just drops out.
3. Adjust input attenuator R5 to increase signal level into receiver by 10dB. (This is for operation with 15dB margin. For other than 15dB margin, this value should be changed accordingly). This is done by reducing the R5 attenuator setting by 10dB.

MAINTENANCE

Periodic checks of the received carrier signal level and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenuation control, R5. A change in operating margin from the original setting can be detected by observing the change in the dial setting required to cause a low signal level clamp to operate as indicated by the red low level LED becoming lit. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal level or loss in receiver sensitivity.

All adjustable components for normal field adjustments on the printed circuit modules are accessible when the front cover on the chassis is removed. All other adjustable components on the printed circuit modules may be made entirely accessible while permitting electrical operation by using module extender style number 1447C86G01. This permits attaching instrument leads to the various test points of terminals when making voltage, oscilloscope or frequency checks.

RELAY MAINTENANCE AND ADJUSTMENT

The AL relay contacts should be cleaned periodically. A contact burnisher S #182A836H01 is recommended for this purpose. The use of abrasive material for cleaning contacts is not recommended, because of the danger of embedding small particles in the face of the soft silver and thus impairing the

contact. Care must be taken to avoid distorting the contact springs during burnishing.

These relays have been properly adjusted at the factory to insure correct operation, and under normal field conditions they should not require readjustment. If, however, the adjustments are disturbed in error, or if it becomes necessary to replace some part, the following adjustment procedure should be used.

In the AL relay the armature gap should be approximately 0.004 inch with the armature closed. This adjustment is made with the armature stop screw and locknut. The contact leaf springs should be adjusted to obtain at least 0.015 inch gap on all contacts when fully open. There should be at least 0.010 inch follow on all normally-open contacts and 0.005 inch follow on all normally-closed contacts. The relay should pick up at approximately 35 volts.

TABLE I
RECEIVER DC MEASUREMENTS

NOTE: All voltage readings taken with the negative of dc VTVM on terminal 17 (negative dc). Receiver adjusted for 15dB operating margin with space and mark signals down 50dB from 1 watt or 60dB down from 10 watts. Unless indicated otherwise, voltage will not vary appreciably whether signal is lower frequency, higher frequency, or zero.

Collector of Transistor or Test Point	Voltage (Positive)
Q11	<15
Q12 (TP12)	17 (Lower or Higher Freq.)
Q13(TP13)	17 (Lower or Higher Freq.)
Q14(TP14)	3
Q15(TP15)	3
TP11	22
TP52	19
Q51(TP51)	14
Q52(TP53)	14.5
Q53(TP54)	18
Q54(TP55)	3
TP56	19
Q55	< 1 (Lower Freq. or No Signal)
Q55	23 (Higher Freq.)
Q56	23 (Lower Freq.)
Q56	< 1 (Higher Freq. or No Signal)

NOTE: The following readings are taken with the negative of dc VTVM on terminal 3 (common of dc power supply) of either the S/N detection module or the output module.

TP61	+ 4
TP62	0
TP63	+ 0.4
TP64	+ 6
TP65	-12
TP66	0
TP67	+ 0.5
TP68	+ 0.5
TP70	- 6
TP71	+ 6
TP72	+ 1.5
TP73	+ 0.8
TP74	+ 0.3
TP81	+12 (Higher Frequency)
TP81	-12 (Lower Freq. or No Signal)
TP82	+12 (Lower Frequency)
TP82	-12 (Higher Freq. or No Signal)
TP83	+12 (Higher Frequency)
TP83	-12 (Lower Freq. or No Signal)
TP84	+12 (Lower Frequency)
TP84	-12 (Higher Freq. or No Signal)
TP85	+ 0.3
TP86	+12 (Low Level clamp)
TP86	0 (No clamp)
TP87	+ 6 (Low SNR clamp)
TP87	- 6 (No SNR clamp)
TP88	+12
TP89	-12
TP90	+12 (Good Signal Level)
TP90	-12 (Low Signal Level clamp)

TABLE II
RECEIVER RF MEASUREMENTS

NOTE: Voltmeter readings taken at any point from receiver input to stage involving transistor Q15 are neither meaningful or feasible because of either waveform variations or the effect of instrument loading on the readings. Receiver adjusted as in Table I.

Collector of Transistor or Test Point	Volts with Signal At +10dB Above Normal Level
Q15(TP15)	0.8
Q51(TP51)	0.9
Q52(TP53)	0.65
Q53(TP54)	2.2
Q54(TP55)	4.5
TP61	.013
TP67	.275

LC FILTER RESPONSE MEASUREMENTS

The LC input filter (FL201) and the IF filter (FL2) are in sealed containers, and repairs can only be made by the factory. The stability of the original response characteristics is such that in normal usage, no appreciable change in response will occur. However, the test circuits of Figure 27 can be used in case there is reason to suspect that either of the filters is not performing correctly.

Figure 5 shows the -3dB and -35dB checkpoints for the IF filter, and the -3dB checkpoints for the input filter. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Figure 5 was chosen to show the IF filter response, which permitted only a portion of the input filter curve to be shown. The checkpoints for the pass-band of each section of the IF filter are down 3dB maximum at 19.75 and 20.25 kHz , and for the stop band are down 18dB minimum at 19.00 and 21.00 kHz for each section. The signal generator voltage (Figure 27) must be held constant throughout the entire check. A value of 7.8 volts is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22dB below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only, and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16dB less than the measured difference because of the input resistance and the difference in input and output impedances of the filter.

In testing the LC filter, a value of approximately 2.45V is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency, but should not be more than 18dB below the reading of VM1. (The filter insertion loss is approximately 6dB less than the difference in readings.

CRYSTAL FILTER RESPONSE MEASUREMENTS

The input filter (FL1) and the IF filter (FL2) are in sealed containers and repairs can be made

only by the factory. The stability of the original response characteristics is such that in normal usage no appreciable change in response will occur. However, the test circuits of Figure 23 can be used in case there is reason to suspect that either of the filters has been damaged.

Figure 5 shows the -3dB and -60dB check points for the crystal filters. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Figure 5 was chosen to show the crystal filter response, which permitted only a portion of the IF filter curve to be shown. The check points for the pass band of each section of the latter are "down 3dB maximum at 19.75 and 20.25 kHz , and for the stop band are "down 18dB minimum at 19.00 and 21.00 kHz . The signal generator voltage must be held constant throughout the entire check. A value of 20dB (7.8 volts) is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22dB below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16dB less than the measured difference because of the input resistor and the difference in input and output impedances of the filter.

Because of the extreme frequency sensitivity of the crystal filter, the oscillator used in its test circuit should have very good frequency stability and a close vernier control. The oscillators used for factory testing have special modifications for this use. A value of approximately 10dB (2.45 volts) is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency but should not be more than 11dB below the reading of VM1. (The filter insertion loss is approximately 6dB less than the difference in readings).

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a TCF-10 receiver for operating at a different channel frequency consist of a new LC input filter (FL201), a

new local oscillator crystal (Y11) and probably a different feedback capacitor (C12). There are two ways of effecting this change. The easiest and preferred method is to order a new input filter module and a new oscillator mixer module for the new frequencies from the factory. The new modules would then just have to be plugged in as replacements for the original modules. The second method would involve ordering just replacement filter, FL201, and new local oscillator crystal for the new frequencies and making the substitution on the modules. These substitutions on the modules are not difficult as the crystal plugs in and the filter has five leads to be soldered. However, testing of the local oscillator for easy starting will have to be made, and the value of C12 chosen to assure this easy starting of oscillation. The whole receiver should then be checked out for correct performance.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation

- a. AC Vacuum Tube Voltmeter (VTVM). Voltage range 0.003 to 30 volts, frequency range 60 hertz to 330 kHz, input impedance 7.5 megohms.
- b. DC Vacuum Tube Voltmeter (VTVM). Voltage range: 1.5 to 300 volts
Input impedance: 7.5 megohms
- c. CLI Microammeter, range 0-100 μ A, style number 606B592A26, (if receiver has carrier level indicator)

II. Desirable Test Equipment for Apparatus Maintenance

- a. All items listed in I.
- b. Signal Generator
Output Voltage: up to 8 volts
Frequency Range: 20kHz to 330kHz
- c. Oscilloscope
- d. Frequency counter
- e. Ohmmeter
- f. Capacitor checker
- g. Milliammeter, 0-1.5 or preferably 1.5-0-1.5 range, for checking discriminator.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

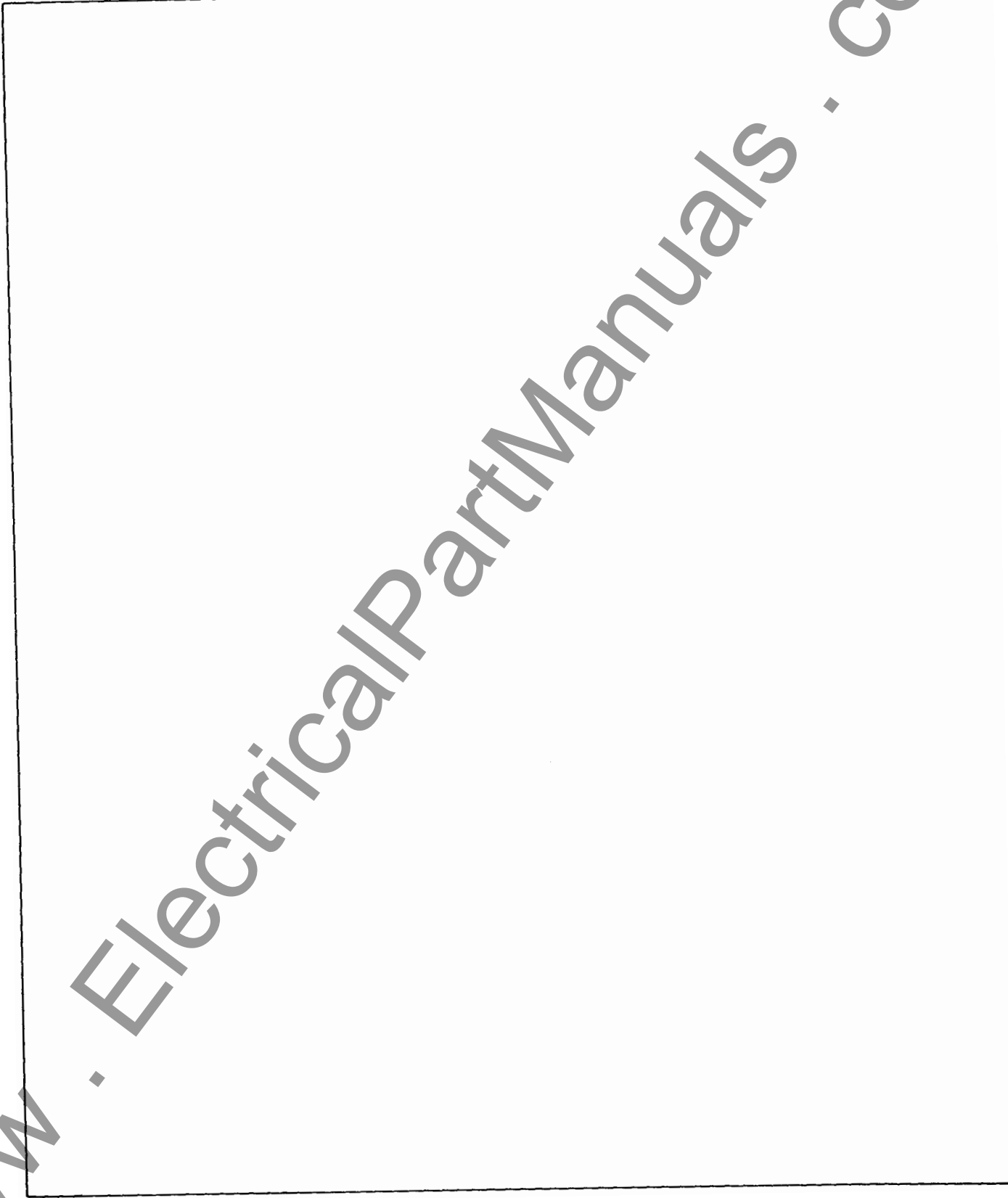


Fig. 1b. Internal Schematic

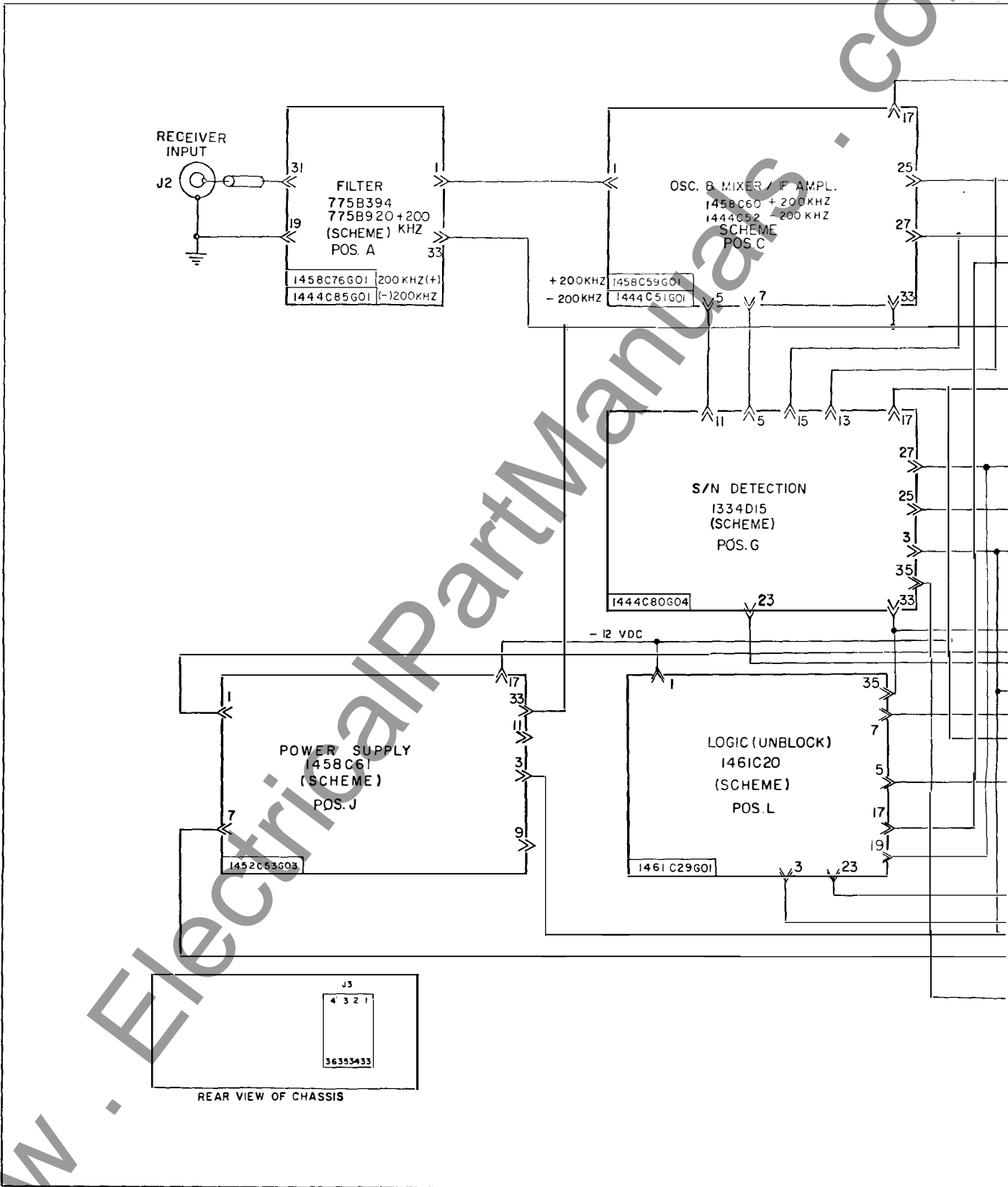
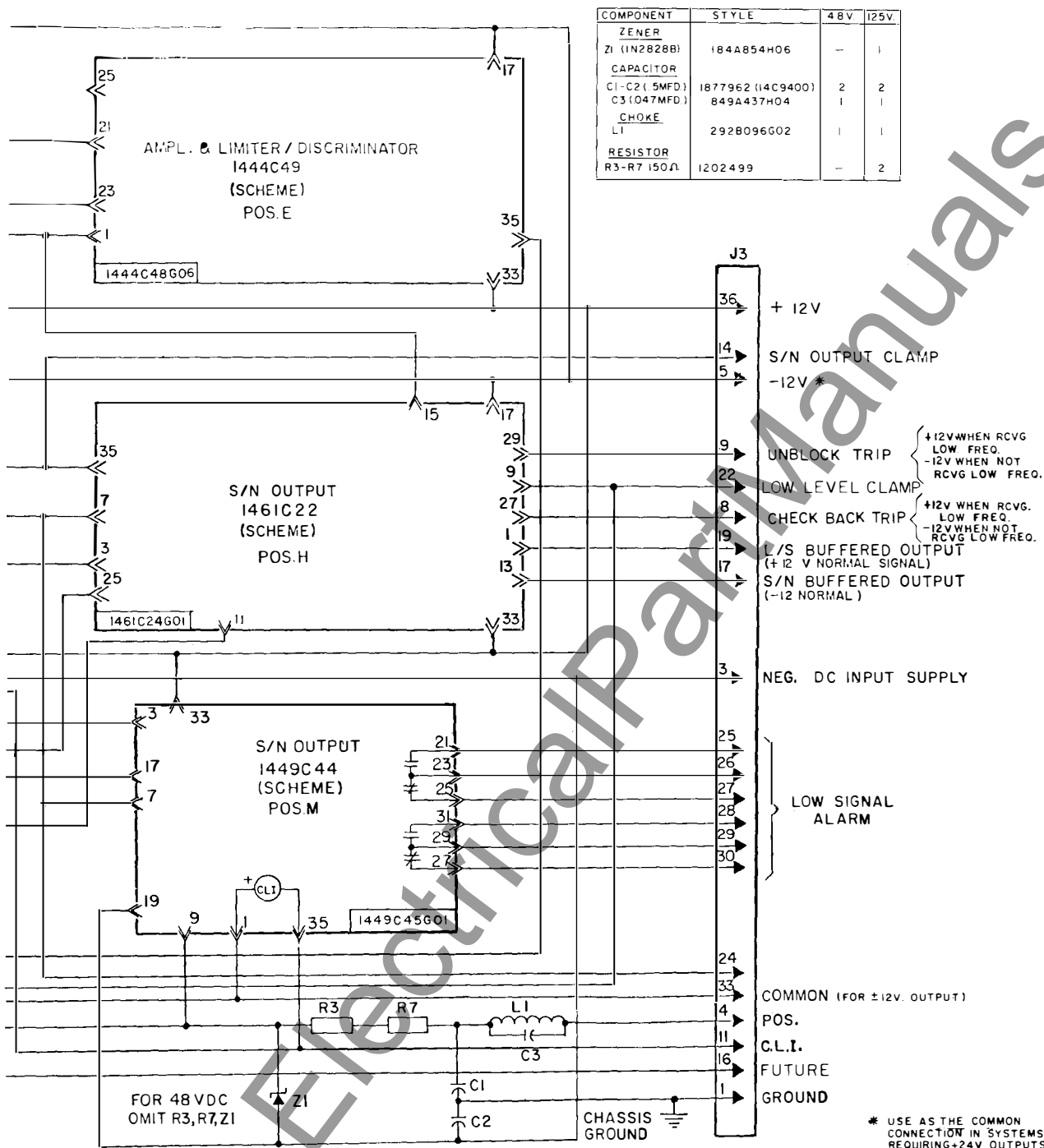
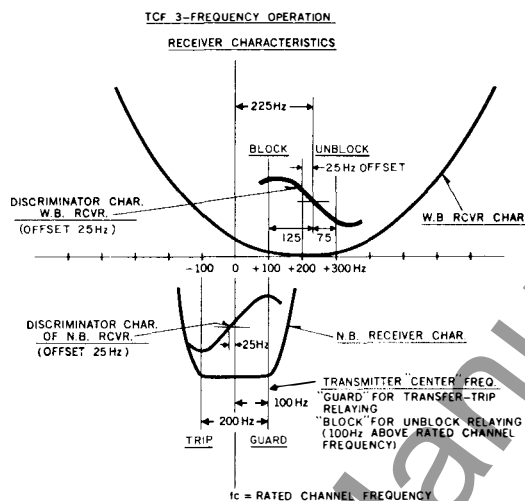


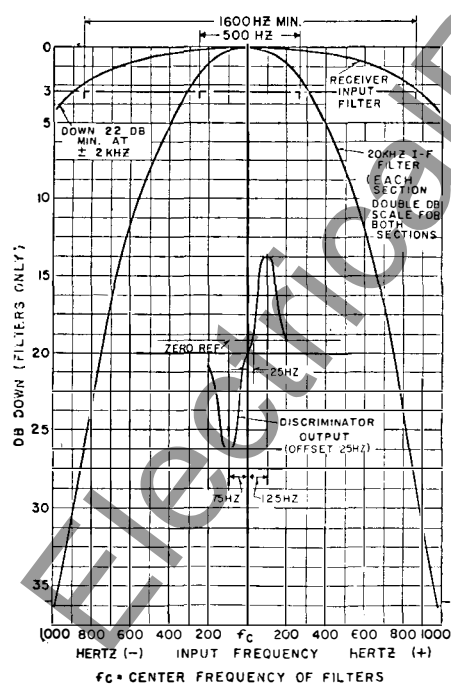
Fig. 2. Internal Schematic S



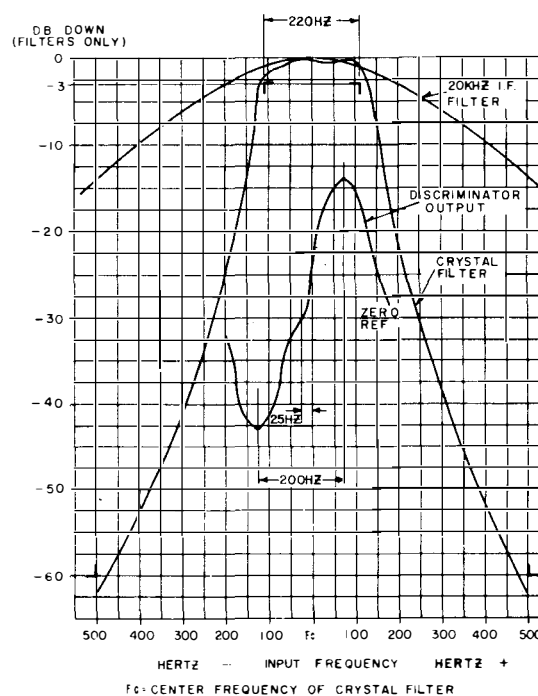
Sub. 6
1333D02



C-3 FREQUENCY RECEIVER 880A986

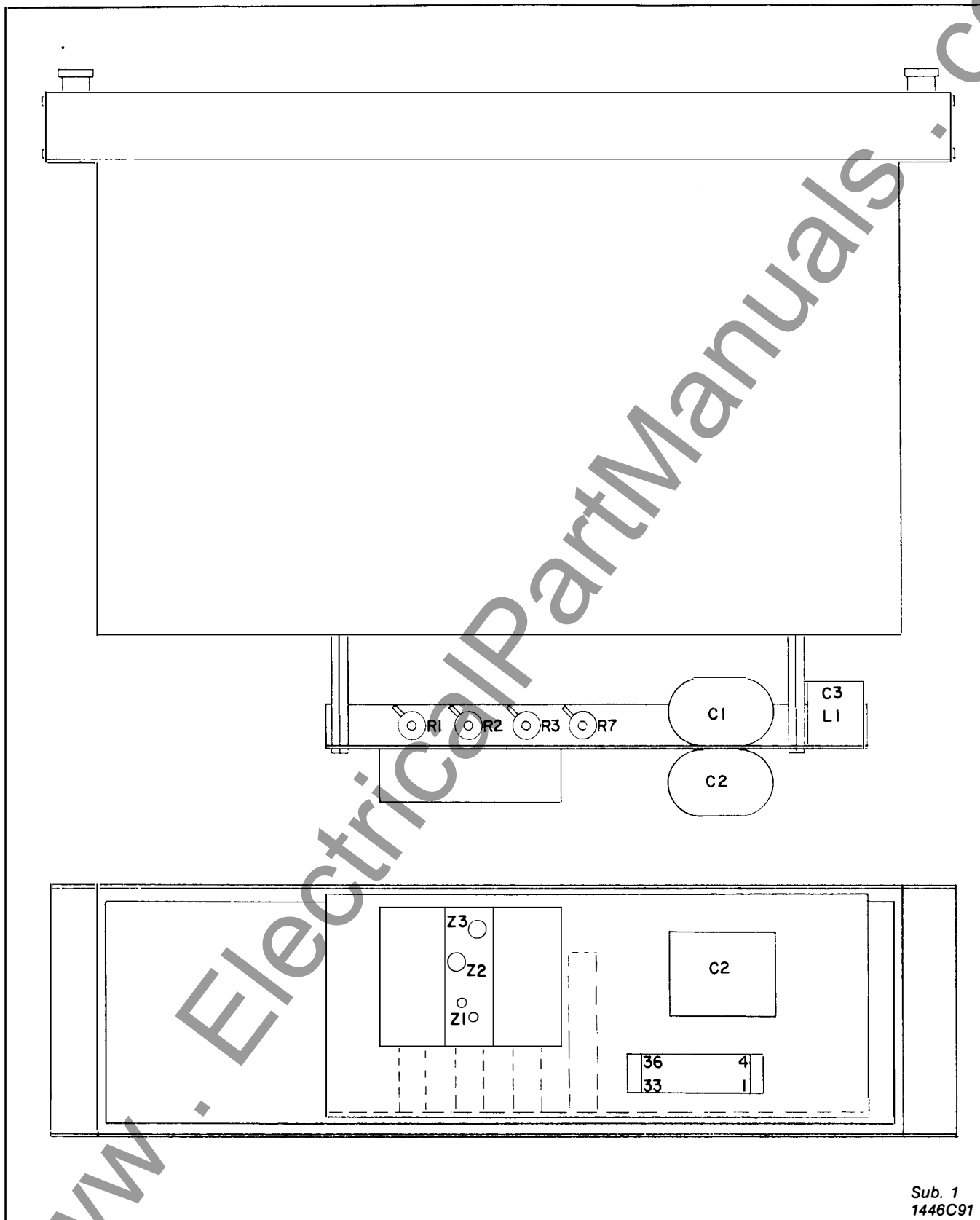


A-WIDE BAND RECEIVER 3499A90



B-NARROW BAND RECEIVER 836A932

Fig. 5. Filter and Discriminator Characteristics



Sub. 1
1446C91

Fig. 6. Component Location

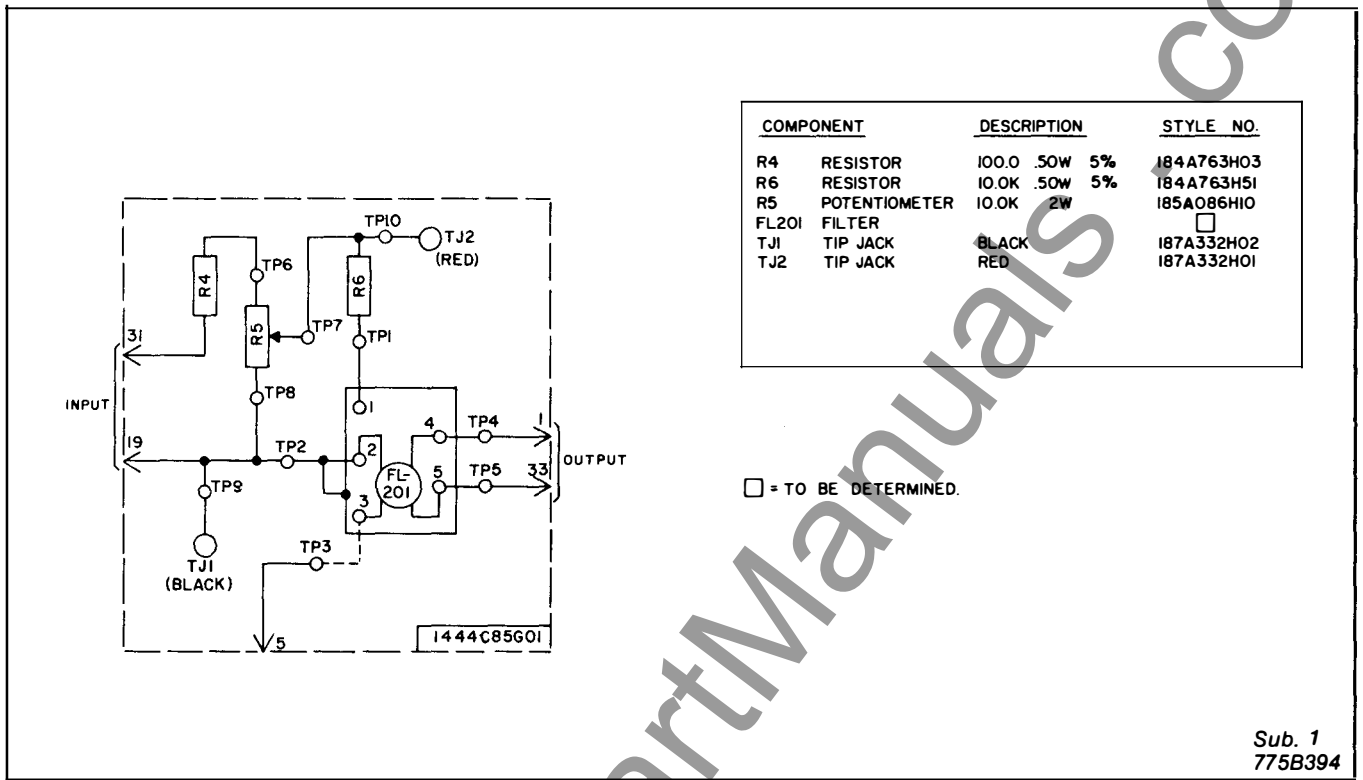


Fig. 7. Internal Schematic Filter Module 30-200 KHz

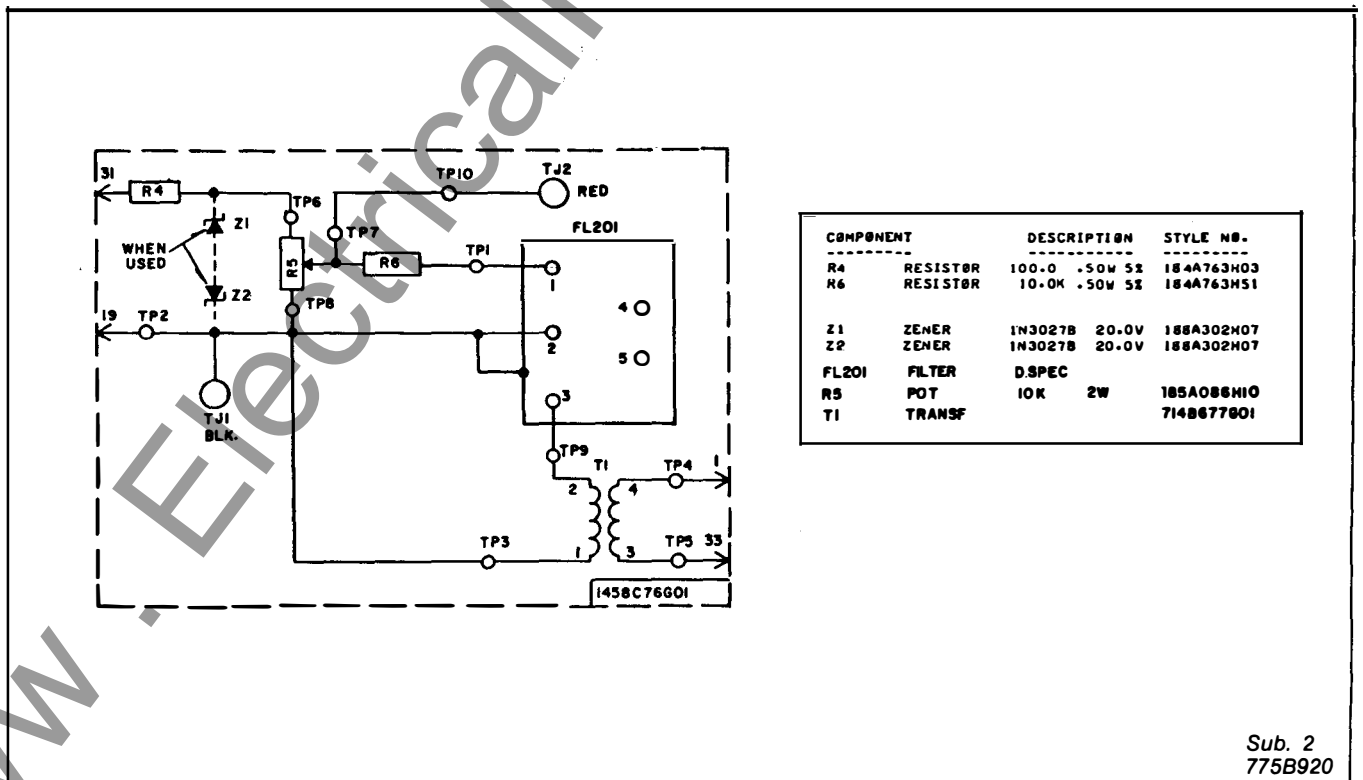


Fig. 8. Internal Schematic Filter Module 200.5-300 KHz

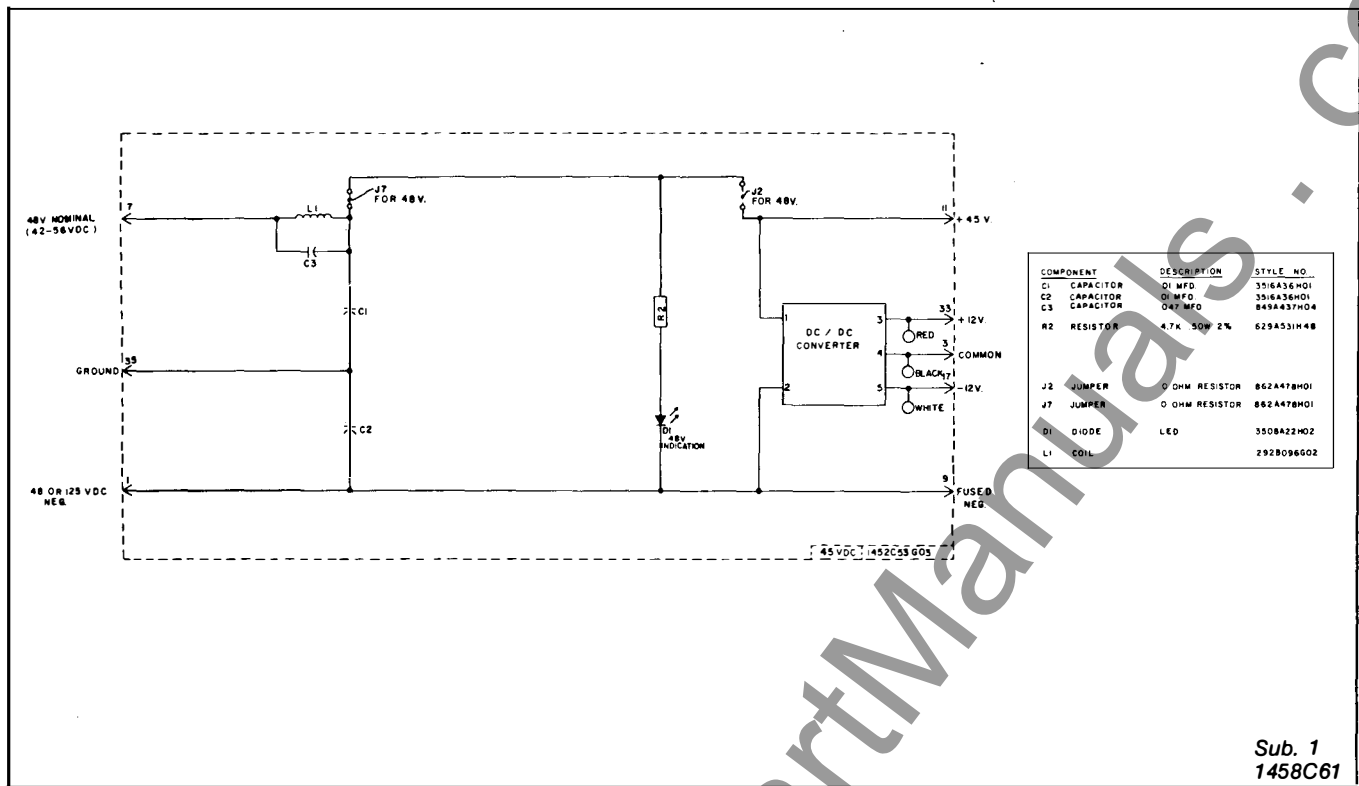


Fig. 9. Power Supply Module

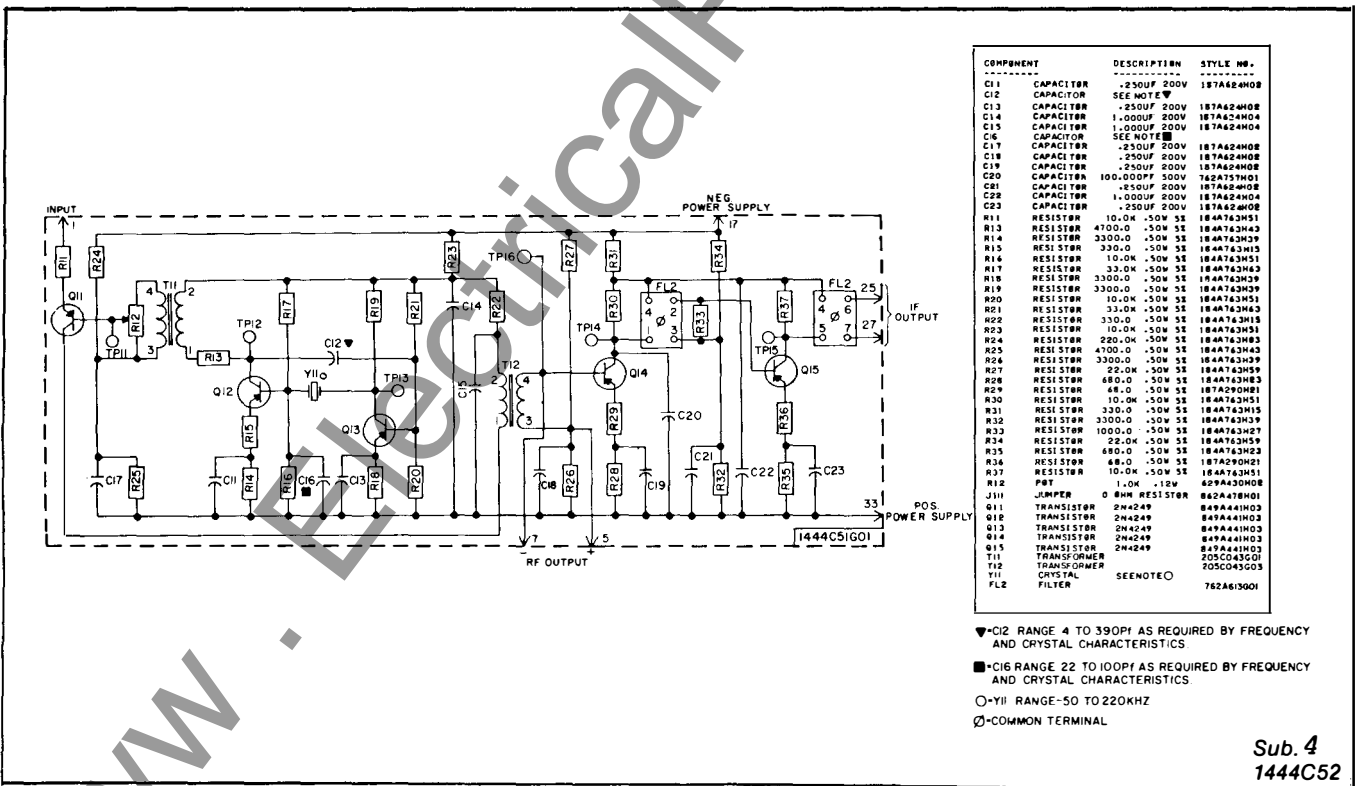


Fig. 10. Internal Schematic 30-200 KHz Oscillator & Mixer

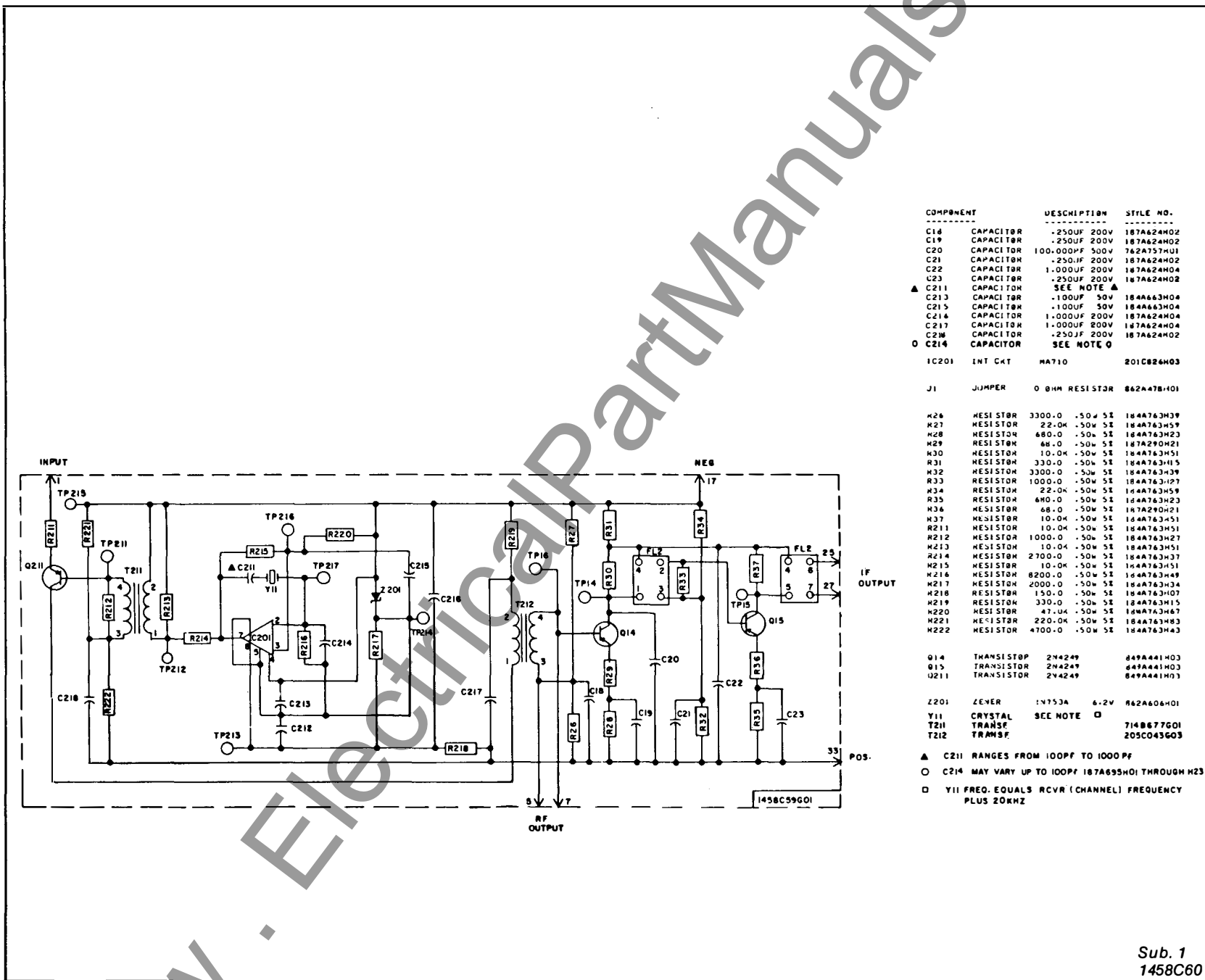
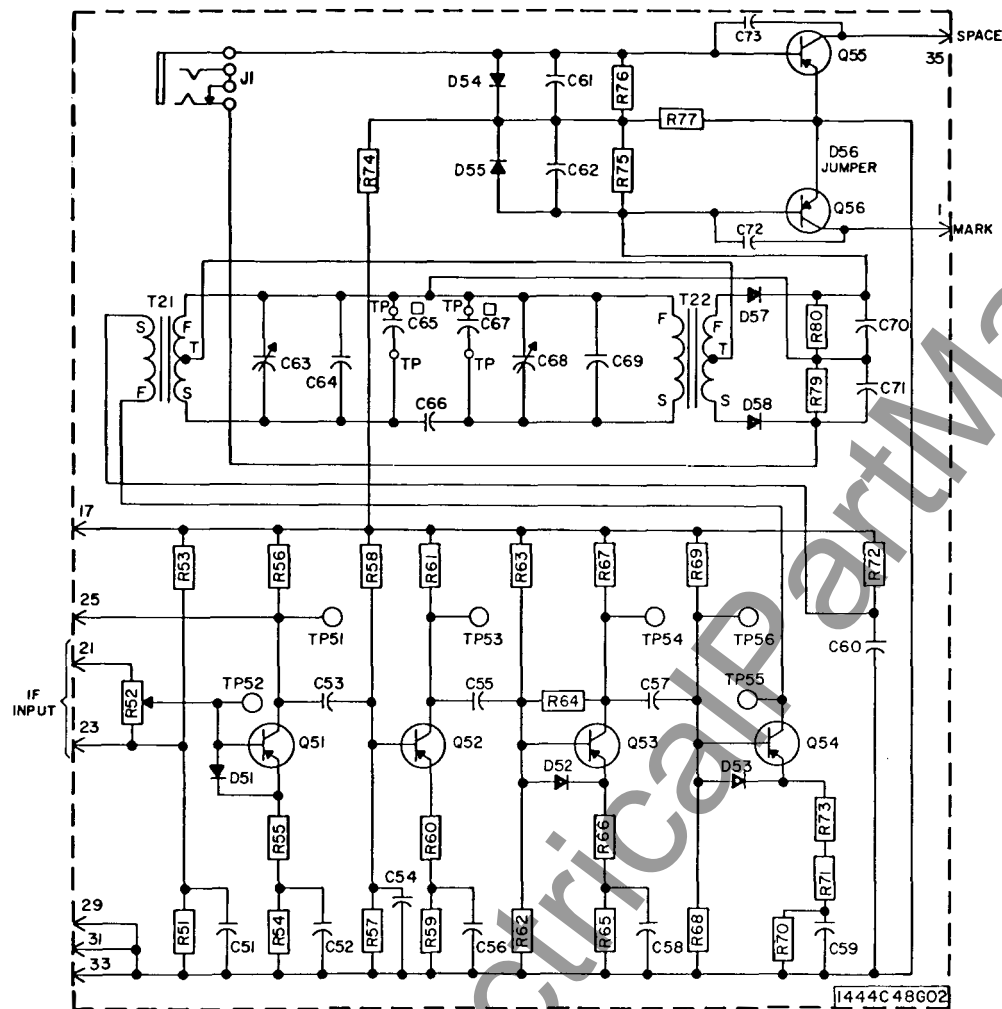


Fig. 11. Internal Schematic 200.5-300 KHz Oscillator & Mixer



COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR .250UF 200V	187A624H02
C52	CAPACITOR .250UF 200V	187A624H02
C53	CAPACITOR .100UF 200V	187A624H01
C54	CAPACITOR 1300.000PF 500V	187A584H15
C55	CAPACITOR .100UF 200V	187A624H01
C56	CAPACITOR .250UF 200V	187A624H02
C57	CAPACITOR .100UF 200V	187A624H01
C58	CAPACITOR .250UF 200V	187A624H02
C59	CAPACITOR .250UF 200V	187A624H02
C60	CAPACITOR 1.000UF 200V	187A624H04
C61	CAPACITOR .220UF 50V	762A703H01
C62	CAPACITOR .220UF 50V	762A703H01
C63	CAPACITOR 4.5TO .100PF	187A624H16
C64	CAPACITOR 9100.000PF 200V	187A624H08
C65	CAPACITOR SEE NOTE □	
C66	CAPACITOR 100.000PF 500V	187A624H08
C67	CAPACITOR SEE NOTE □	
C68	CAPACITOR 4.5TO .100PF	762A736H02
C69	CAPACITOR 9100.000PF 200V	187A624H16
C70	CAPACITOR .220UF 50V	762A703H01
C71	CAPACITOR .220UF 50V	762A703H01
C72	CAPACITOR 330.000PF 200V	880A397H01
C73	CAPACITOR 330.000PF 200V	880A397H01
D51	DIODE 1N437A	184A855H07
D52	DIODE 1N437A	184A855H07
D53	DIODE 1N437A	184A855H07
D54	DIODE 1N437A	184A855H07
D55	DIODE 1N437A	184A855H07
D56	DIODE 1N437A	184A855H07
D57	DIODE 1N628	184A855H12
D58	DIODE 1N628	184A855H12
R51	RESISTOR 4700.0 .50W 5%	184A763H43
R52	RESISTOR 27.0K .50W 5%	184A763H61
R53	RESISTOR 2200.0 .50W 5%	184A763H35
R54	RESISTOR 27.0 .50W 5%	187A290H11
R55	RESISTOR 10.0K .50W 5%	184A763H51
R56	RESISTOR 4700.0 .50W 5%	184A763H43
R57	RESISTOR 27.0K .50W 5%	184A763H61
R58	RESISTOR 1500.0 .50W 5%	184A763H31
R59	RESISTOR 180.0 .50W 5%	184A763H09
R60	RESISTOR 4700.0 .50W 5%	184A763H43
R61	RESISTOR 2200.0 .50W 5%	184A763H35
R62	RESISTOR 33.0K .50W 5%	184A763H63
R63	RESISTOR 2700.0 .50W 5%	184A763H37
R64	RESISTOR 680.0 .50W 5%	184A763H23
R65	RESISTOR 68.0 .50W 5%	187A290H21
R66	RESISTOR 4700.0 .50W 5%	184A763H43
R67	RESISTOR 2700.0 .50W 5%	184A763H37
R68	RESISTOR 18.0K .50W 5%	184A763H57
R69	RESISTOR 220.0 .50W 5%	184A763H11
R70	RESISTOR 68.0 .50W 2%	629A531H04
R71	RESISTOR 330.0 .50W 5%	184A763H15
R72	RESISTOR 56.0 .50W 2%	629A531H02
R73	RESISTOR 12.0K .50W 5%	184A763H53
R74	RESISTOR 3000.0 .50W 5%	184A763H38
R75	RESISTOR 3000.0 .50W 5%	184A763H36
R76	RESISTOR 220.0 .50W 5%	184A763H11
R77	RESISTOR 2200.0 .50W 5%	184A763H35
R78	RESISTOR 2200.0 .50W 5%	184A763H35
R79	RESISTOR 2200.0 .50W 5%	184A763H35
R80	POT 1.0K .50W	629A645H04
Q51	TRANSISTOR 2N4249	849A441H03
Q52	TRANSISTOR 2N4249	849A441H03
Q53	TRANSISTOR 2N4249	849A441H03
Q54	TRANSISTOR 2N4249	849A441H03
Q55	TRANSISTOR 2N3645	849A441H01
Q56	TRANSISTOR 2N3645	849A441H01
T21	TRANSFORMER	606B533G01
T22	TRANSFORMER	606B533G02
J1	TELEPHONE JACK	187A606H01

□ - ONE OR TWO CAPACITORS USED; VALUES DETERMINED IN TEST.

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1444C49

Fig. 12. Internal Schematic Amplifier and Limiter

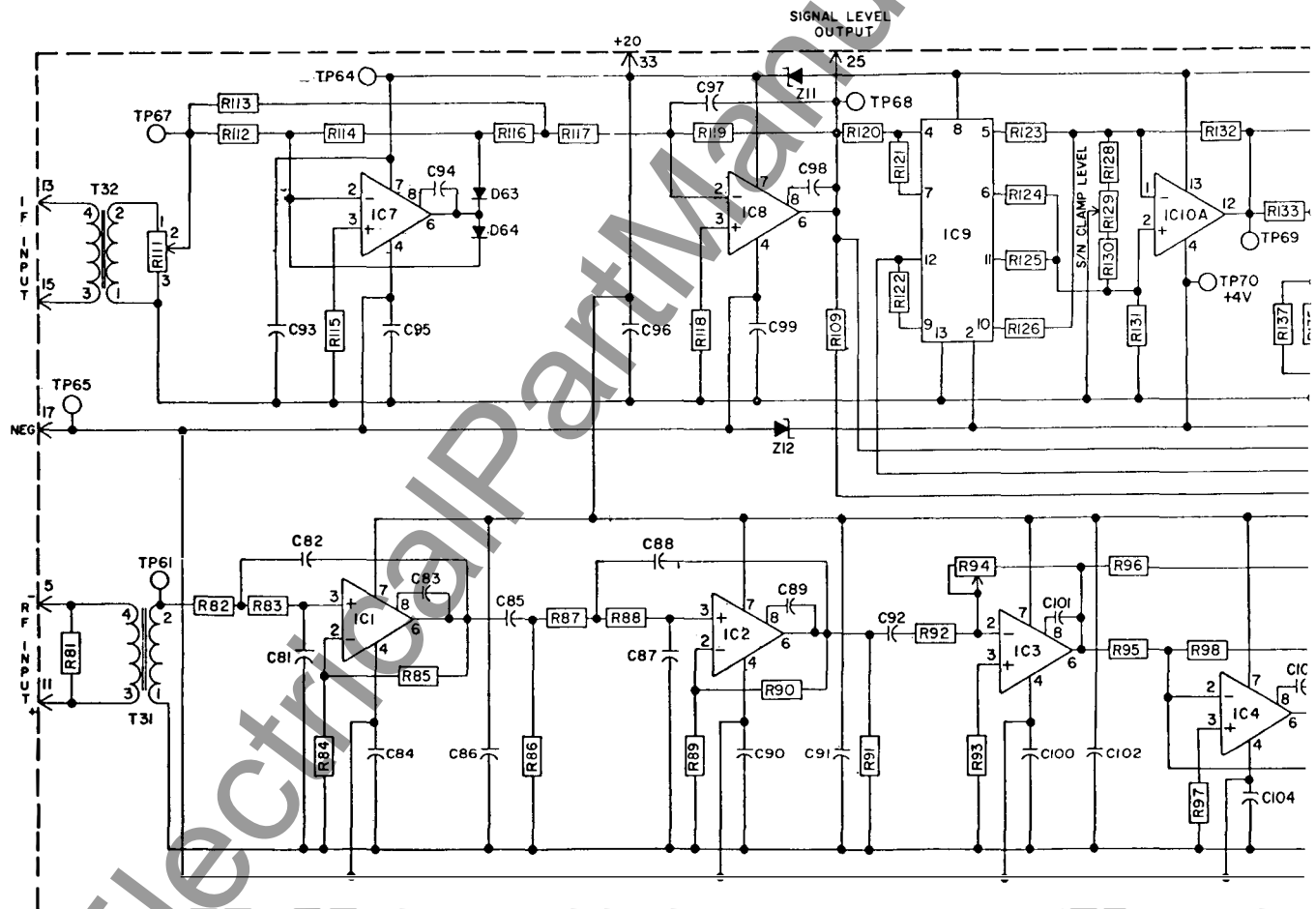
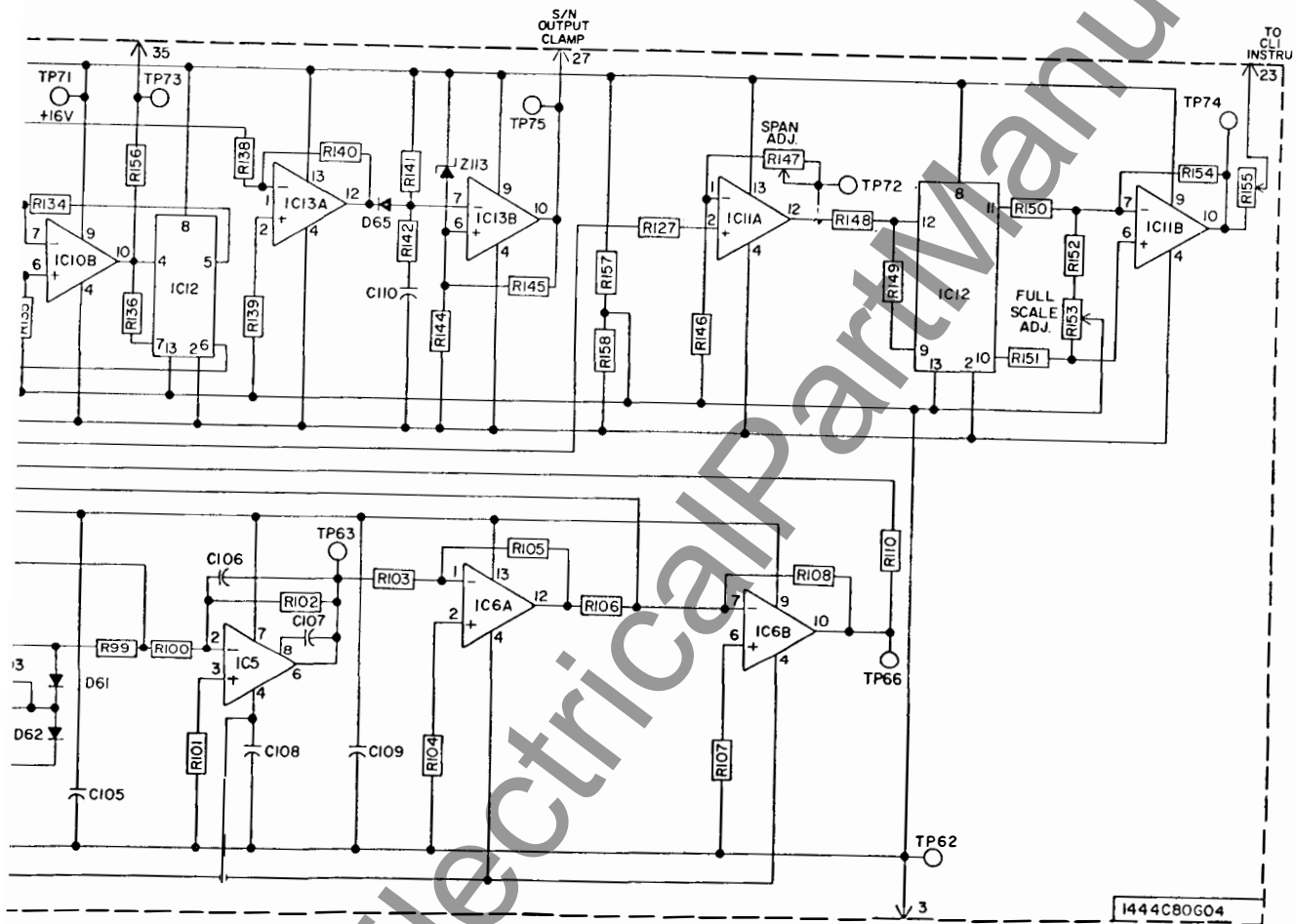
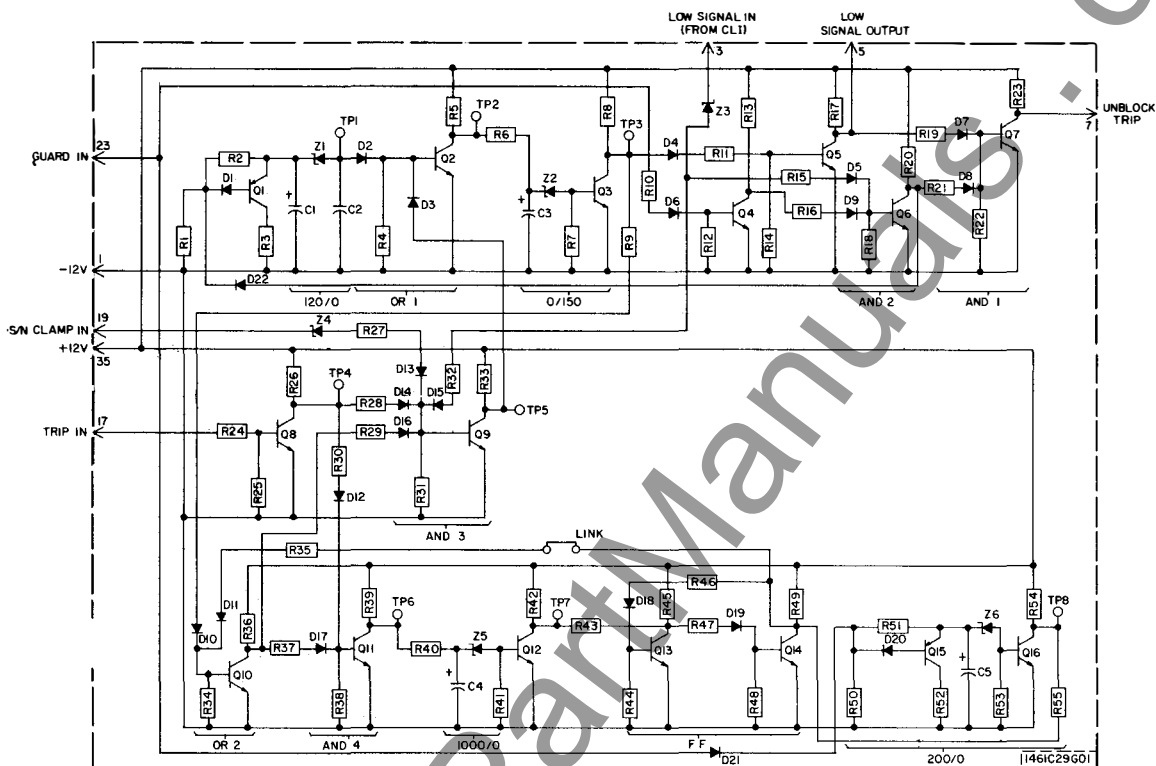


Fig. 13. Internal Schematic



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1334D15

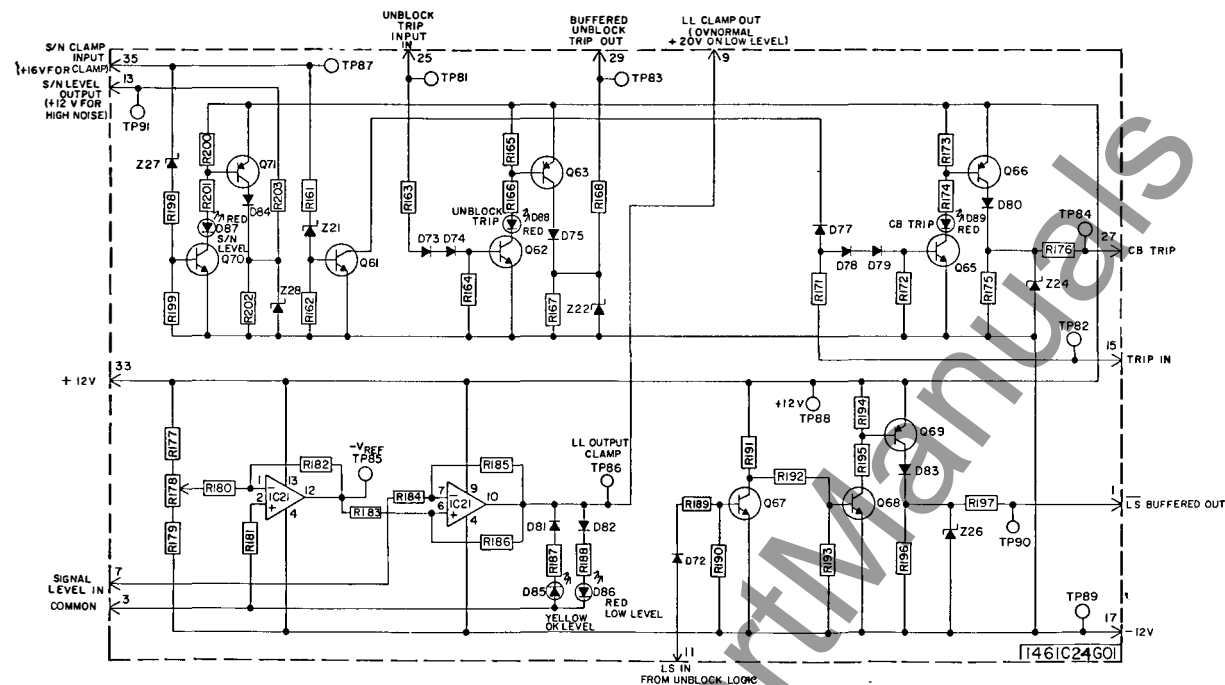


COMPONENT	DESCRIPTION	STYLE NO.
C1	CAPACITOR 4.000UF 50V	862A17TH07
C2	CAPACITOR .050UF 50V	18A4663H02
C3	CAPACITOR 22.000UF 15V	18A4661H13
C4	CAPACITOR 47.000UF 15V	187A505H12
C5	CAPACITOR 22.000UF 15V	18A4661H13
D1	DIODE 1N457A	18A4855H07
D2	DIODE 1N457A	18A4855H07
D3	DIODE 1N457A	18A4855H07
D4	DIODE 1N457A	18A4855H07
D5	DIODE 1N457A	18A4855H07
D6	DIODE 1N457A	18A4855H07
D7	DIODE 1N457A	18A4855H07
D8	DIODE 1N457A	18A4855H07
D9	DIODE 1N457A	18A4855H07
D10	DIODE 1N457A	18A4855H07
D11	DIODE 1N457A	18A4855H07
D12	DIODE 1N457A	18A4855H07
D13	DIODE 1N457A	18A4855H07
D14	DIODE 1N457A	18A4855H07
D15	DIODE 1N457A	18A4855H07
D16	DIODE 1N457A	18A4855H07
D17	DIODE 1N457A	18A4855H07
D18	DIODE 1N457A	18A4855H07
D19	DIODE 1N457A	18A4855H07
D20	DIODE 1N457A	18A4855H07
D21	DIODE 1N457A	18A4855H07
D22	DIODE 1N457A	18A4855H07
R1	RESISTOR 18.0K .50W 5%	18A4763H57
R2	RESISTOR 5600.0 .50W 5%	18A4763H45
R3	RESISTOR 470.0 .50W 5%	18A4763H19
R4	RESISTOR 10.0K .50W 5%	18A4763H51
R5	RESISTOR 22.0K .50W 5%	18A4763H59
R6	RESISTOR 1000.0 .50W 5%	18A4763H27
R7	RESISTOR 10.0K .50W 5%	18A4763H51
R8	RESISTOR 12.0K .50W 5%	18A4643H53
R9	RESISTOR 5600.0 .50W 5%	18A4763H45
R10	RESISTOR 10.0K .50W 5%	18A4763H51
R11	RESISTOR 10.0K .50W 5%	18A4763H51
R12	RESISTOR 10.0K .50W 5%	18A4763H51
R13	RESISTOR 12.0K .50W 5%	18A4643H53
R14	RESISTOR 10.0K .50W 5%	18A4763H51
R15	RESISTOR 10.0K .50W 5%	18A4763H51
R16	RESISTOR 10.0K .50W 5%	18A4763H51
R17	RESISTOR 12.0K .50W 5%	18A4643H53
R18	RESISTOR 10.0K .50W 5%	18A4763H51
R19	RESISTOR 10.0K .50W 5%	18A4763H51
R20	RESISTOR 12.0K .50W 5%	18A4643H53
R21	RESISTOR 33.0K .50W 5%	18A4763H63
R22	RESISTOR 10.0K .50W 5%	18A4763H51
R23	RESISTOR 12.0K .50W 5%	18A4643H53
R24	RESISTOR 10.0K .50W 5%	18A4763H51
R25	RESISTOR 10.0K .50W 5%	18A4763H51
R26	RESISTOR 12.0K .50W 5%	18A4643H53
R27	RESISTOR 10.0K .50W 5%	18A4763H51

COMPONENT	DESCRIPTION	STYLE NO.
R28	RESISTOR 10.0K .50W 5%	18A4763H51
R29	RESISTOR 10.0K .50W 5%	18A4763H51
R30	RESISTOR 10.0K .50W 5%	18A4763H51
R31	RESISTOR 10.0K .50W 5%	18A4763H51
R32	RESISTOR 10.0K .50W 5%	18A4763H51
R33	RESISTOR 12.0K .50W 5%	18A4643H53
R34	RESISTOR 10.0K .50W 5%	18A4763H51
R35	RESISTOR 10.0K .50W 5%	18A4763H51
R36	RESISTOR 12.0K .50W 5%	18A4643H53
R37	RESISTOR 10.0K .50W 5%	18A4763H51
R38	RESISTOR 10.0K .50W 5%	18A4763H51
R39	RESISTOR 33.0K .50W 5%	18A4763H63
R40	RESISTOR 1000.0 .50W 5%	18A4763H27
R41	RESISTOR 10.0K .50W 5%	18A4763H51
R42	RESISTOR 22.0K .50W 5%	18A4763H59
R43	RESISTOR 1000.0 .50W 5%	18A4763H27
R44	RESISTOR 10.0K .50W 5%	18A4763H51
R45	RESISTOR 12.0K .50W 5%	18A4643H53
R46	RESISTOR 56.0K .50W 5%	18A4763H49
R47	RESISTOR 10.0K .50W 5%	18A4763H51
R48	RESISTOR 10.0K .50W 5%	18A4763H51
R49	RESISTOR 12.0K .50W 5%	18A4643H53
R50	RESISTOR 18.0K .50W 5%	18A4763H57
R51	RESISTOR 56.0K .50W 5%	18A4763H49
R52	RESISTOR 470.0 .50W 5%	18A4763H19
R53	RESISTOR 10.0K .50W 5%	18A4763H51
R54	RESISTOR 22.0K .50W 5%	18A4763H59
R55	RESISTOR 1000.0 .50W 5%	18A4763H27
Q1	TRANSISTOR 2N4249	849A41H03
Q2	TRANSISTOR 2N696	762A585H01
Q3	TRANSISTOR 2N697	18A638H18
Q4	TRANSISTOR 2N696	762A585H01
Q5	TRANSISTOR 2N696	762A585H01
Q6	TRANSISTOR 2N696	762A585H01
Q7	TRANSISTOR 2N696	762A585H01
Q8	TRANSISTOR 2N696	762A585H01
Q9	TRANSISTOR 2N696	762A585H01
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Q11	TRANSISTOR 2N696	762A585H01
Q12	TRANSISTOR 2N697	18A638H18
Q13	TRANSISTOR 2N696	762A585H01
Q14	TRANSISTOR 2N696	762A585H01
Q15	TRANSISTOR 2N4249	849A41H03
Q16	TRANSISTOR 2N696	762A585H01
Z1	ZENER 1N578 6.8V	18A4797H06
Z2	ZENER 1N750A 5.6V	18A6797H12
Z3	ZENER 1N578 6.8V	18A4797H06
Z4	ZENER 1N578 6.8V	18A4797H06
Z5	ZENER 1N578 6.8V	18A4797H06
Z6	ZENER 1N750A 4.7V	837A398H03

Fig. 14. Internal Schematic Unblock Module

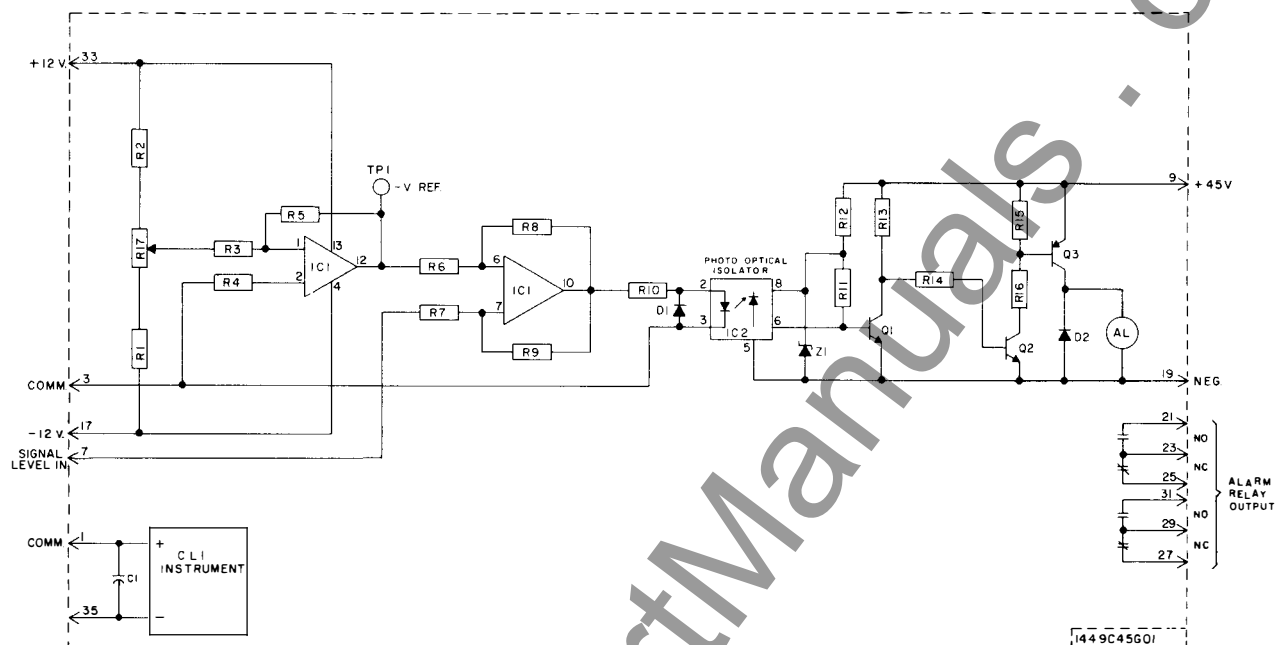
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COMPONENT	DESCRIPTION	STYLE NO.	COMPONENT	DESCRIPTION	STYLE NO.
Q61	DIODE	837A592H03	R187	RESISTOR	1600.0 .50W 1% 849A819H68
Q72	DIODE	1N4645A	R188	RESISTOR	1600.0 .50W 1% 849A819H68
Q73	DIODE	1N4645A	R189	RESISTOR	33.0K .50W 5% 184A753H53
Q74	DIODE	1N4645A	R190	RESISTOR	68.0K .50W 5% 184A753H71
Q75	DIODE	1N4645A	R191	RESISTOR	68.0K .50W 5% 184A753H71
Q76	DIODE	1N4645A	R192	RESISTOR	33.0K .50W 5% 184A753H53
Q77	DIODE	1N4645A	R193	RESISTOR	150.0K .50W 5% 184A753H73
Q78	DIODE	1N4645A	R194	RESISTOR	10.0K .50W 5% 184A753H51
Q79	DIODE	1N4645A	R195	RESISTOR	18.0K .50W 5% 184A753H57
Q80	DIODE	1N4645A	R196	RESISTOR	92.0K .50W 5% 184A753H73
Q81	DIODE	1N4645A	R197	RESISTOR	150.0 3.00W 5% 762A679H01
Q82	DIODE	1N4645A	R198	RESISTOR	33.0K .50W 5% 184A753H53
Q83	DIODE	1N4645A	R199	RESISTOR	68.0K .50W 5% 184A753H71
Q84	DIODE	1N4645A	R200	RESISTOR	4700.0 .50W 5% 184A753H43
Q85	DIODE	1N4645A	R201	RESISTOR	2400.0 .50W 5% 184A753H36
Q86	DIODE	1N4645A	R202	RESISTOR	82.0K .50W 5% 184A753H73
Q87	DIODE	1N4645A	R203	RESISTOR	150.0 3.00W 5% 762A679H01
Q88	DIODE	1N4645A			
Q89	DIODE	1N4645A			
IC21	INT. CKT.	7475H	1461C24601		
J121	JUMPER	0.00H RESISTOR	862A478H01		
J122	JUMPER	0.00H RESISTOR	862A478H01		
J123	JUMPER	0.00H RESISTOR	862A478H01		
J124	JUMPER	0.00H RESISTOR	862A478H01		
R178	PST	2.5K .25W	639A645H07		
R181	RESISTOR	10.0K .50W 5%	184A753H51		
R182	RESISTOR	10.0K .50W 5%	184A753H77		
R183	RESISTOR	33.0K .50W 5%	184A753H53		
R184	RESISTOR	170.0K .50W 5%	184A753H77		
R185	RESISTOR	4700.0 .50W 5%	184A753H43		
R186	RESISTOR	2400.0 .50W 5%	184A753H36		
R187	RESISTOR	82.0K .50W 5%	184A753H73		
R188	RESISTOR	150.0 3.00W 5%	762A679H01		
R189	RESISTOR	150.0K .50W 5%	184A753H51		
R190	RESISTOR	10.0K .50W 5%	184A753H77		
R191	RESISTOR	10.0K .50W 5%	184A753H53		
R192	RESISTOR	33.0K .50W 5%	184A753H77		
R193	RESISTOR	4700.0 .50W 5%	184A753H43		
R194	RESISTOR	2400.0 .50W 5%	184A753H36		
R195	RESISTOR	82.0K .50W 5%	184A753H73		
R196	RESISTOR	150.0 3.00W 5%	762A679H01		
R197	RESISTOR	150.0K .50W 5%	184A753H51		
R198	RESISTOR	10.0K .50W 5%	184A753H77		
R199	RESISTOR	10.0K .50W 5%	184A753H53		
R200	RESISTOR	33.0K .50W 5%	184A753H77		
R201	RESISTOR	4700.0 .50W 5%	184A753H43		
R202	RESISTOR	2400.0 .50W 5%	184A753H36		
R203	RESISTOR	82.0K .50W 5%	184A753H73		
R204	RESISTOR	150.0 3.00W 5%	762A679H01		
R205	RESISTOR	150.0K .50W 5%	184A753H51		
R206	RESISTOR	10.0K .50W 5%	184A753H77		
R207	RESISTOR	10.0K .50W 5%	184A753H53		
R208	RESISTOR	33.0K .50W 5%	184A753H77		
R209	RESISTOR	4700.0 .50W 5%	184A753H43		
R210	RESISTOR	2400.0 .50W 5%	184A753H36		
R211	RESISTOR	82.0K .50W 5%	184A753H73		
Z21	ZENER	1N9518	10.0V	186A797H07	
Z22	ZENER	1N3658A	24.0V	562A285H01	
Z23	ZENER	1N3658A	24.0V	562A285H01	
Z24	ZENER	1N3658A	24.0V	562A285H01	
Z25	ZENER	1N3658A	24.0V	562A285H01	
Z26	ZENER	1N3658A	24.0V	562A285H01	
Z27	ZENER	1N3658A	24.0V	562A285H01	
Z28	ZENER	1N3658A	24.0V	562A285H01	

Sub. 3
1461C22

Fig. 15. Internal Schematic S/N Output Module



COMPONENT	DESCRIPTION	STYLE NO.
R1	RESISTOR 10K .50W 5%	184A763H51
R2	RESISTOR 10K .50W 5%	184A763H51
R3	RESISTOR 6.81K .50W 1%	848A820H29
R4	RESISTOR 4.99K .50W 1%	848A820H16
R5	RESISTOR 6.81K .50W 1%	848A820H29
R6	RESISTOR 2.0K .50W 1%	848A819H77
R7	RESISTOR 2.0K .50W 1%	848A819H77
R8	RESISTOR 562K .25W 1%	848A822H15
R9	RESISTOR 511K .50W 1%	848A822H11
R10	RESISTOR 3.3K .50W 2%	629A531H44
R11	RESISTOR 15K .50W 2%	629A531H60
R12	RESISTOR 120K .50W 2%	629A531H82
R13	RESISTOR 13.3K .50W 1%	848A820H57
R14	RESISTOR 15K .50W 2%	629A531H60
R15	RESISTOR 6.8K .50W 2%	629A531H52
R16	RESISTOR 6.8K .50W 2%	629A531H52
R17	POT 2.5K .25W 10%	629A645H07
J1	JUMPER 0 OHM RESISTOR	862A478H01
D1	DIODE 1N645A	837A692H03
D2	DIODE 1N645A	837A692H03
Z1	ZENER 1N957B	186A797H06
Q1	TRANSISTOR 2N3417	848A851H02
Q2	TRANSISTOR 2N699	184A638H19
Q3	TRANSISTOR 2N3645	849A441H01
IC1	INT. CKT. 747DM	1443C52H01
IC2	INT. CKT. 5082-4371	7758621H01
C1	CAPACITOR .25 MFD. 200VDC	187A625H02
CL1	INSTRUMENT	6068592H26
AL	RELAY	408C062H07

Sub. 5
1449C44

Fig. 16. Internal Schematic S/N Output (Contact) Module

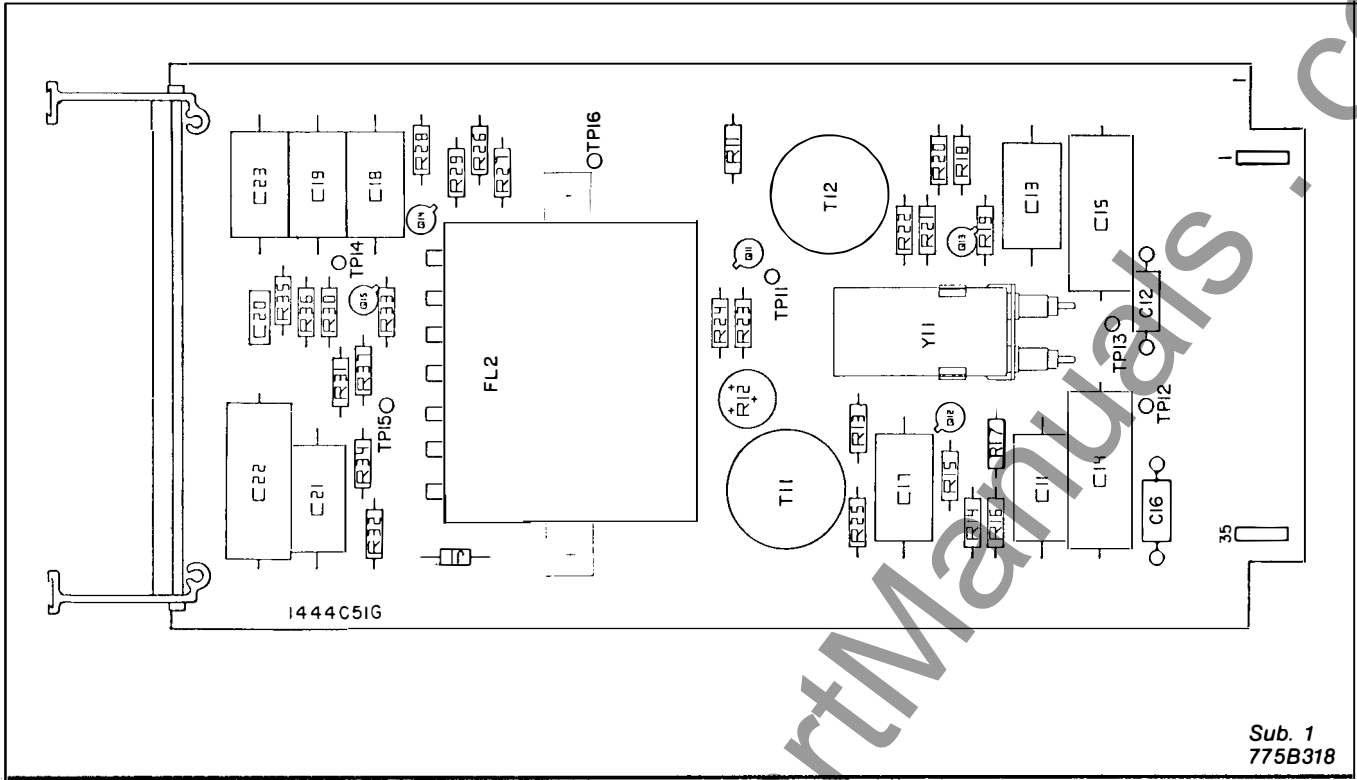


Fig. 17. Component Location 30-200 KHz Oscillator & Mixer

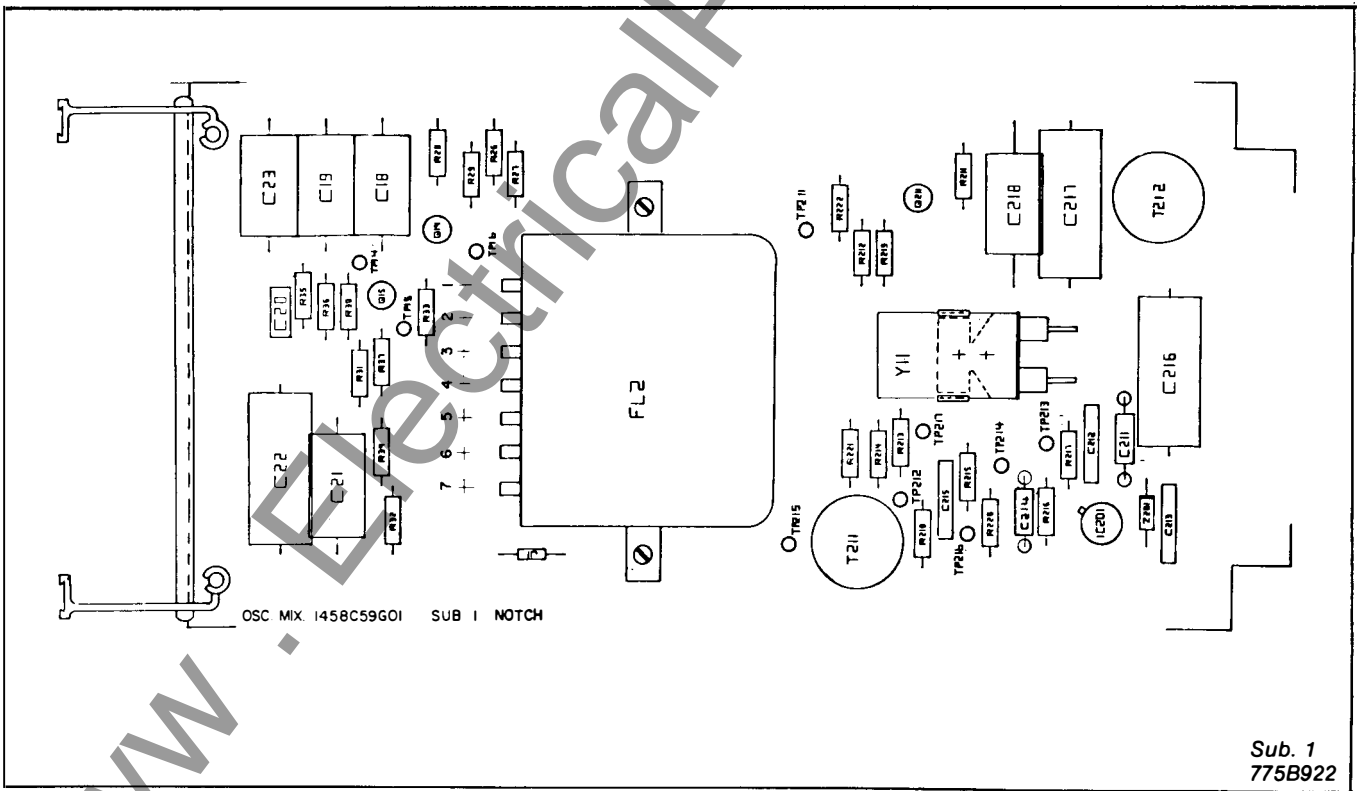


Fig. 18. Component Location 200.5-300 KHz Oscillator & Mixer

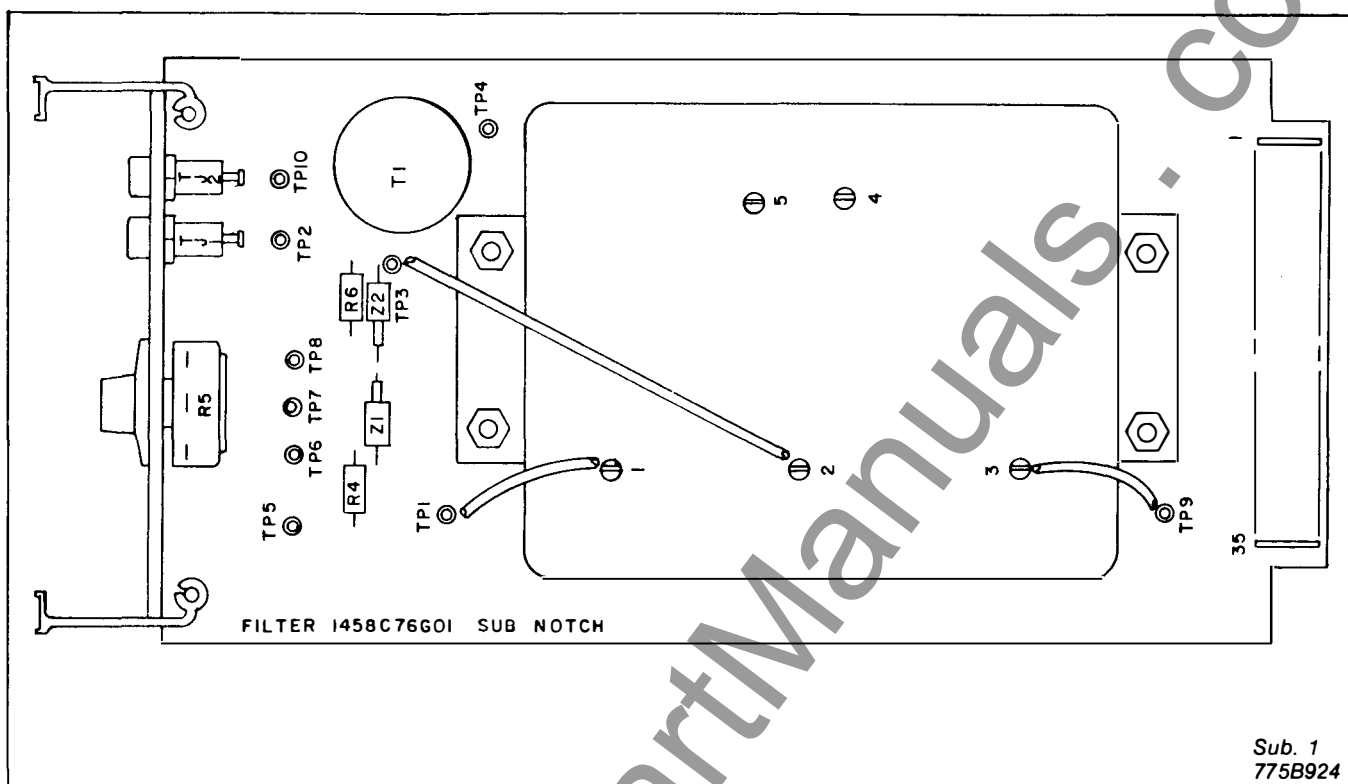


Fig. 19. Component Location Filter Module 200.5-300 KHz

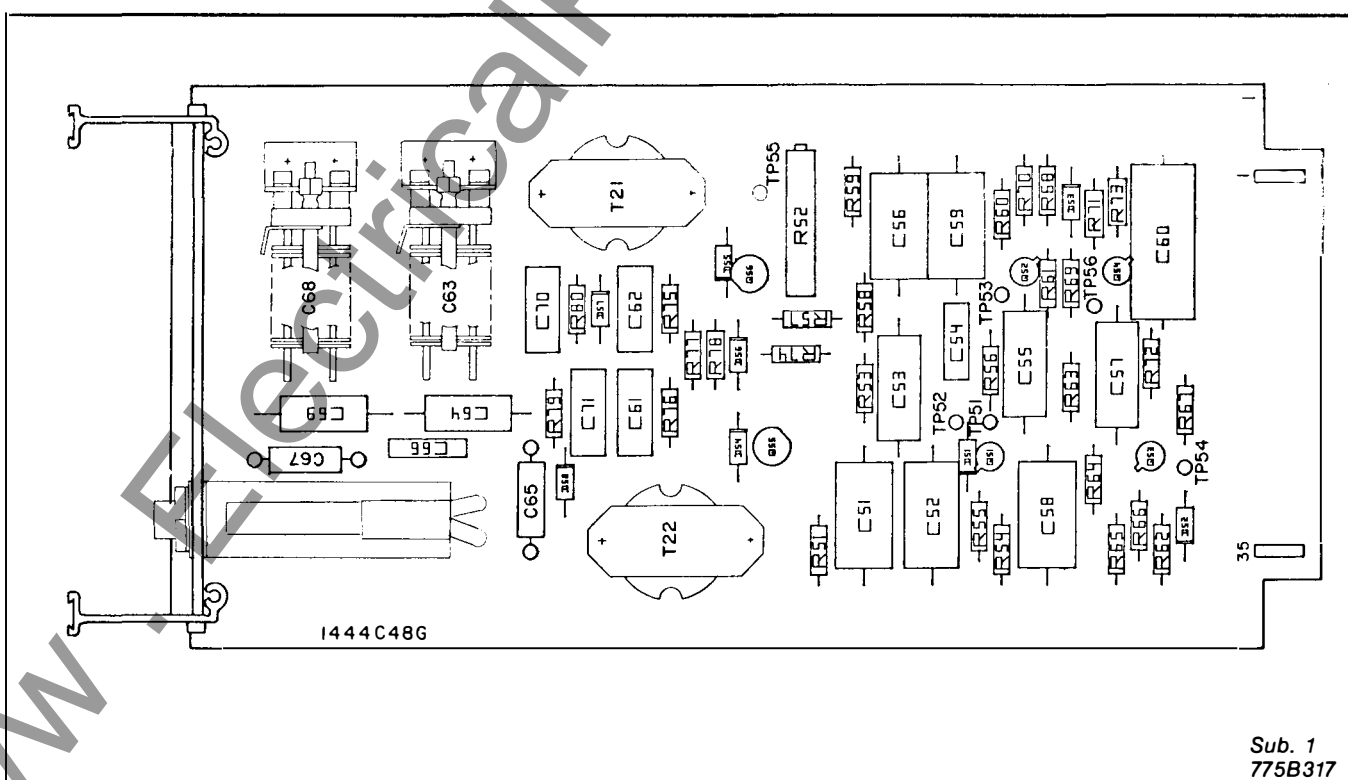


Fig. 20. Component Location Amplifier and Limiter

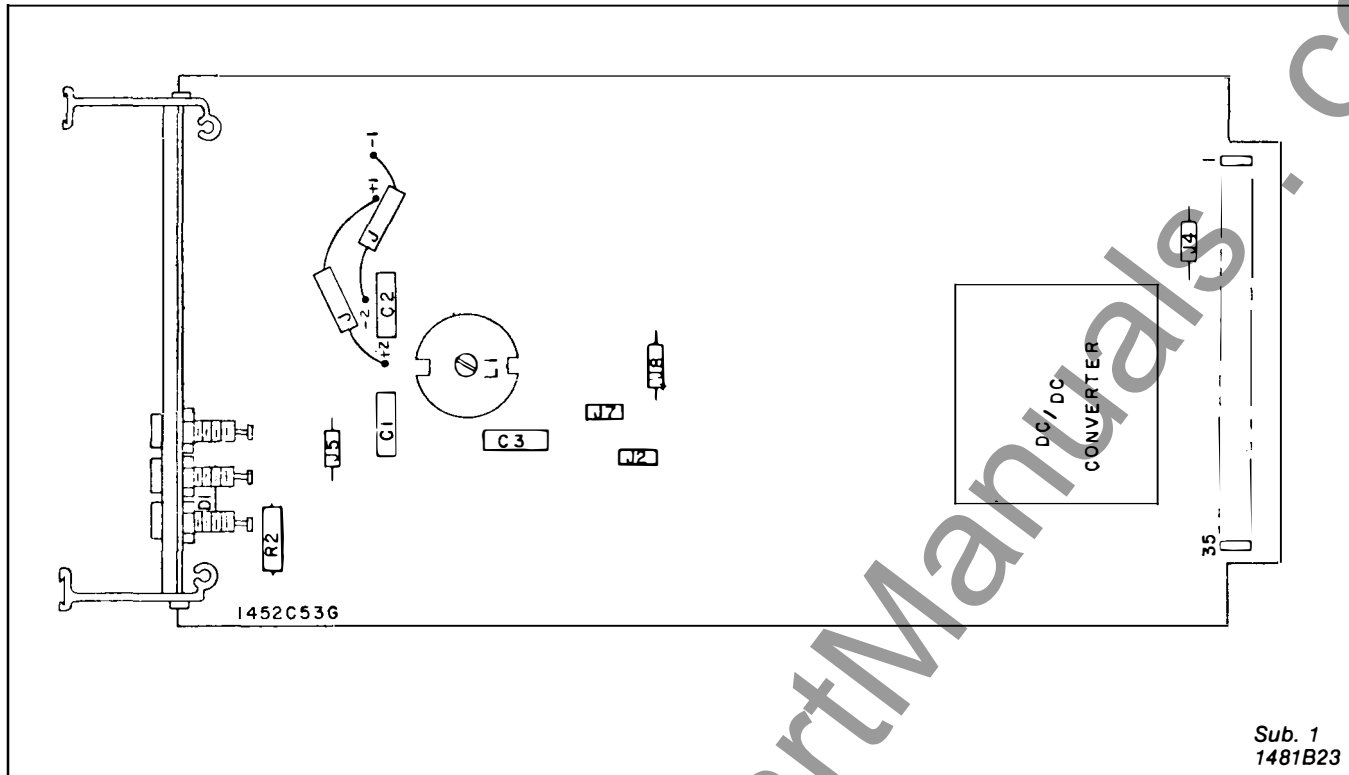


Fig. 21. Component Location Discriminator—Power Supply Module

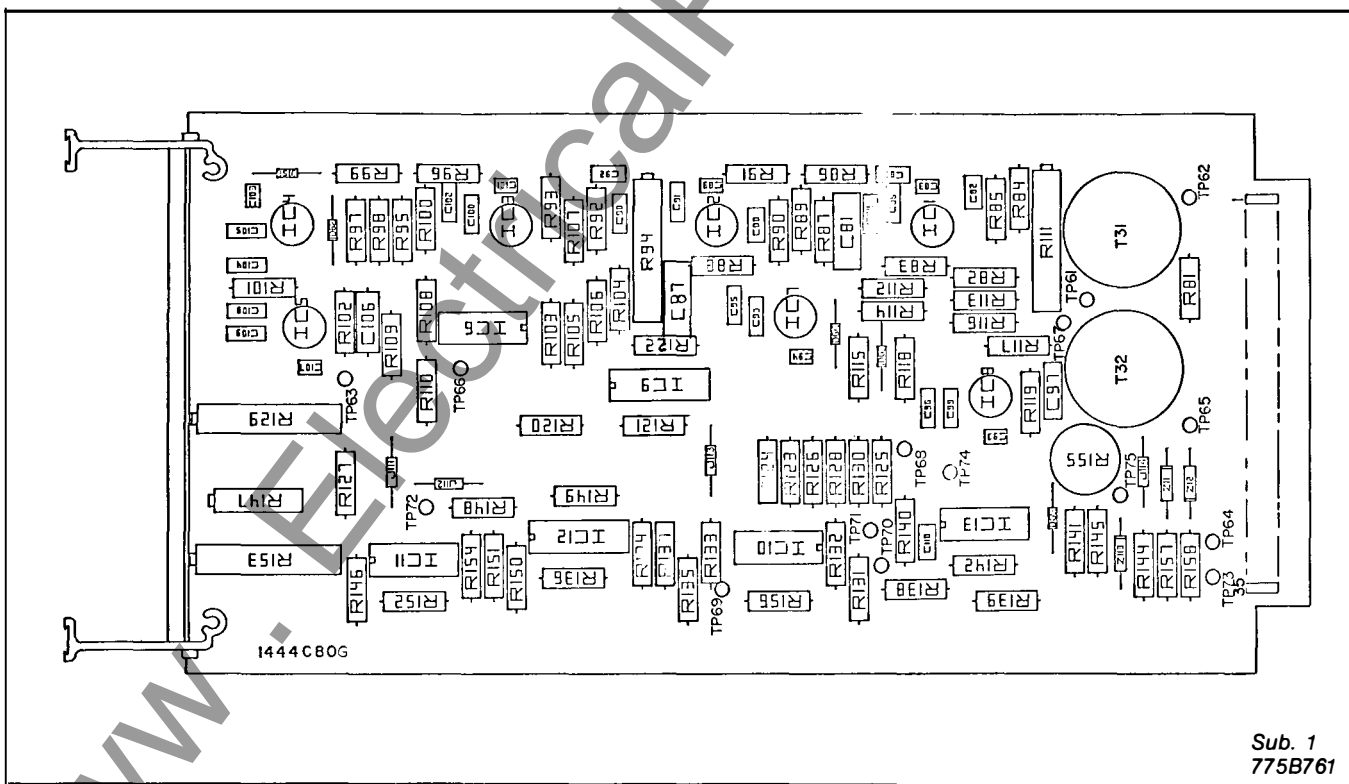
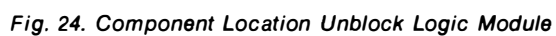
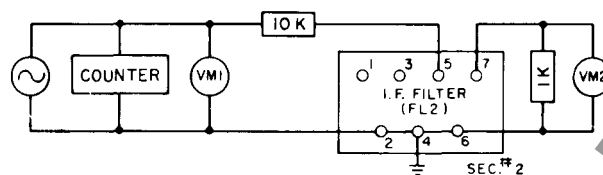
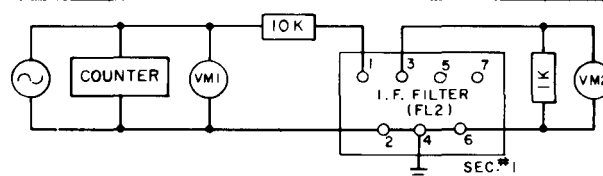
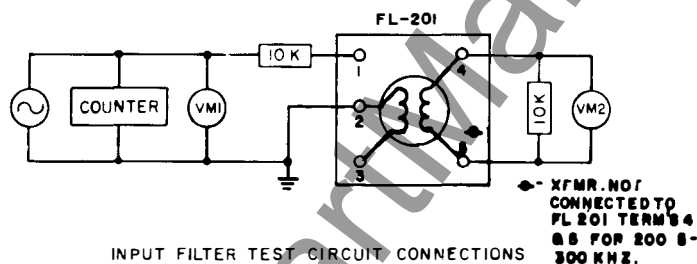


Fig. 22. Component Location S/N Detection Module

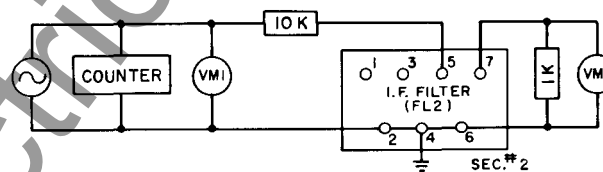
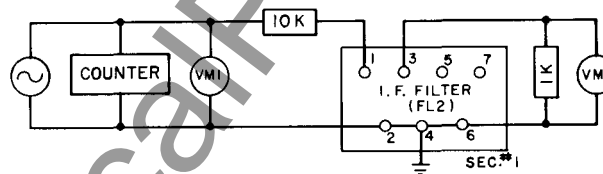




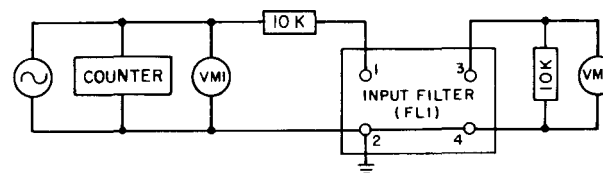
I. F. FILTER TEST CIRCUIT CONNECTIONS



INPUT FILTER TEST CIRCUIT CONNECTIONS

Sub. 2
877A794

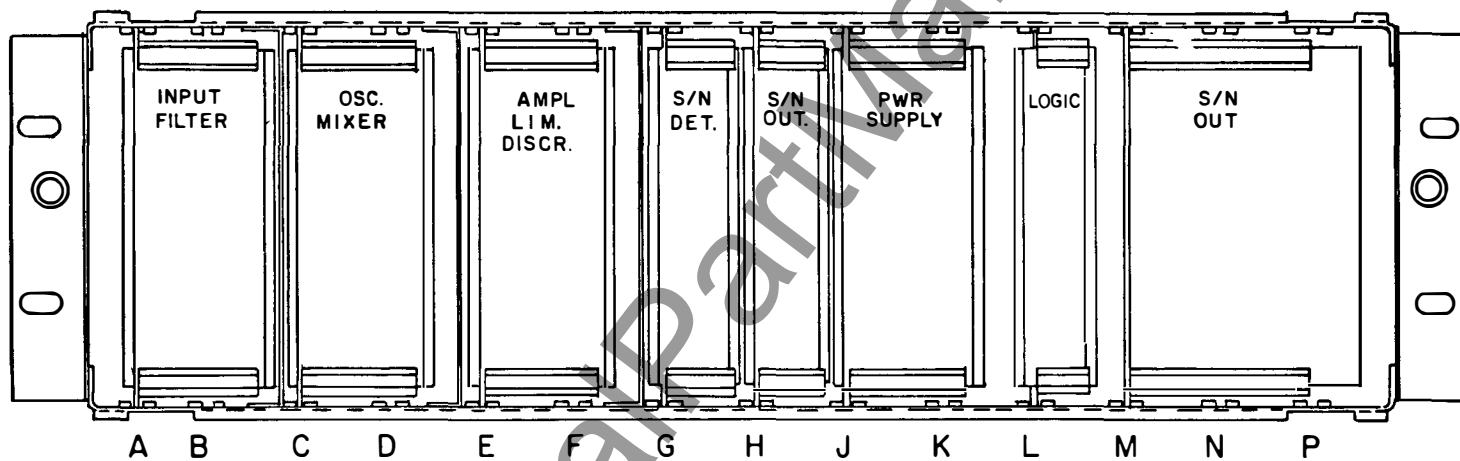
I. F. FILTER TEST CIRCUIT CONNECTIONS



INPUT FILTER TEST CIRCUIT CONNECTIONS

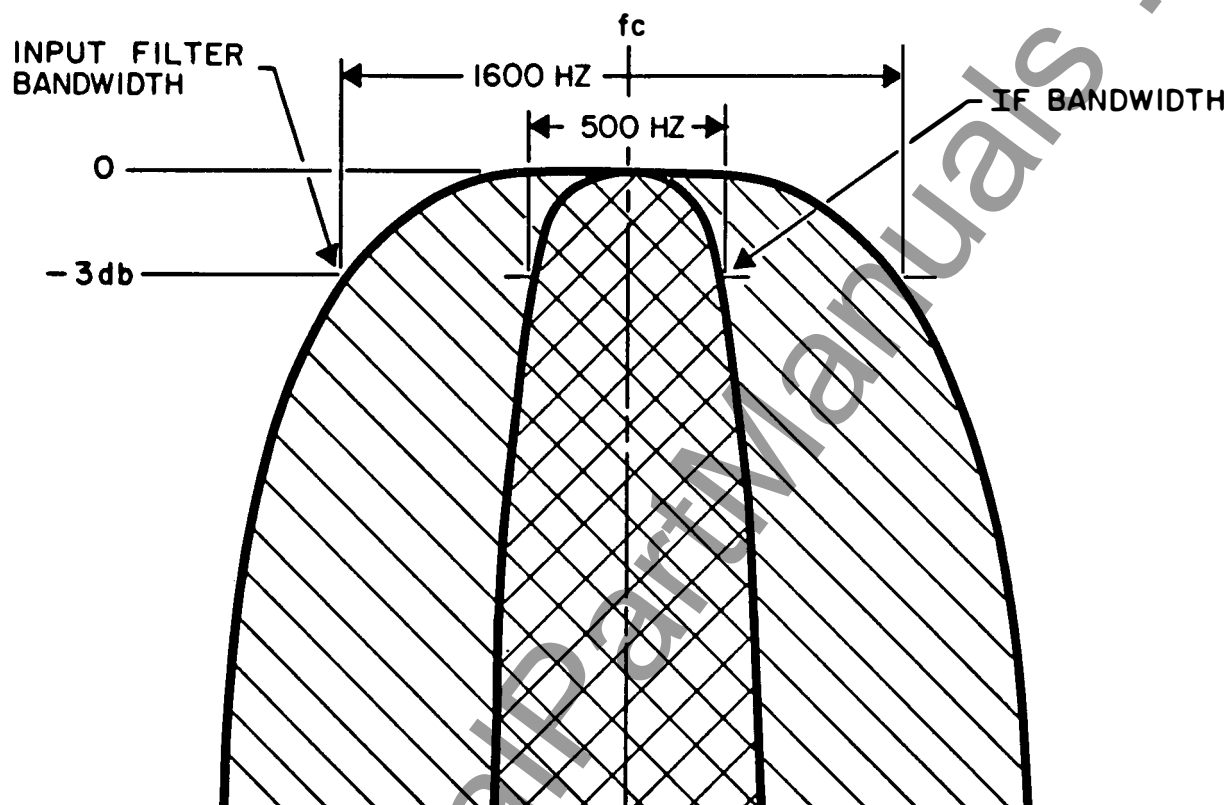
Sub. 1
849A109)

Fig. 27. Test Circuits for TCF-10



Sub. 1
1467C56

Fig. 28. TCF-10 Circuit Board Location



= SIGNAL + NARROW BAND NOISE



= SIGNAL + WIDE BAND NOISE - (SIGNAL + NARROW BAND NOISE)
= NOISE IN SURROUNDING BAND

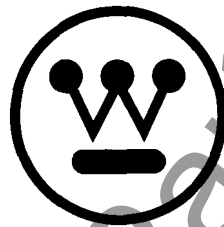
AREAS USED FOR SNR ARE $\frac{\text{Cross-hatched Area}}{\text{Diagonally hatched Area}}$ OR $\frac{\text{Narrow Band Noise Area}}{\text{Wide Band Noise Area}}$

Sub. 2
3513A90

Fig. 29. Signal/Noise Ratio Characteristics

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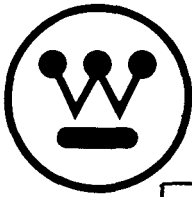
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RELAY-INSTRUMENT DIVISION

CORAL SPRINGS, FL.

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INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT TRANSMITTER EQUIPMENT 3 FREQUENCY—10 WATT/1-3.25 WATT/10 WATT—WITH VOICE

CAUTION: It is recommended that the user of this equipment become thoroughly familiar with the information in this instruction leaflet before energizing the carrier assembly. Failure to observe this precaution may result in damage to the equipment.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

A widely used high speed relaying system used for transmission line protection consists of directional-comparison unblock relaying plus a transfer-trip channel for breaker failure protection. Normally these systems of relaying require two frequency-shift channels, wideband for unblocking and narrowband for transfer trip. A saving in channel spectrum can be affected by using a three frequency transmitter for the two relaying functions and two separate receivers, one for each function, as shown in Figures 10 and 11.

SYSTEM OPERATION

The three frequency TCF-10 carrier transmitter provides for the transmission of any of three closely controlled discrete frequencies, all within the equivalent spacing of a single wideband channel. The center frequency of the channel can vary from 30 kHz to 300 kHz in 0.5 kHz steps. The transmitter normally operates at a frequency that is 100 Hz above the channel center frequency (f_c). This frequency serves as the "guard" frequency for

the transfer-trip receiver and as the "block" frequency for the unblock receiver. Note that the discriminator characteristic in the unblock receiver in this case is reversed from the normal unblock receiver used with the standard two frequency transmitter. This "guard" "block" frequency is transmitted continuously when conditions are normal. It indicates at the receiving end of the line that the channel is operative and serves to prevent false operation of the receiver by line noise. The lowest frequency, which is 100 Hz less than f_c is the "transfer trip" frequency and is transmitted as a signal that an operation (such as tripping a circuit breaker) should be performed at the receiving end of the line. The highest frequency, which is 300 Hz above f_c , is the "unblock" frequency and is transmitted as an unblock signal for directional comparison relaying. If a subsequent transfer-trip operation is called for, the transmitter will shift to $f_c - 100$ Hz which is the "trip" frequency for the transfer trip (narrow-band receiver.)

Note that when the transmitter shifts to "unblock," the frequency is completely outside the passband of the narrow band transfer-trip receiver. Normally, this would cause a low-signal alarm output from that receiver. In order to prevent a similar alarm output in this case, the checkback output of the unblock receiver is cross-connected to the guard or block input of the transfer trip receiver (through an OR logic circuit). This logic is shown in Figure 10. The checkback output is a receiver output that indicates that a proper signal has been received without going through any time delays or other logic used for the actual relaying output.

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

With this cross-connected logic, both receivers will function when required, but will not give any incorrect output indications.

The transmitter normally operates at an output level of one watt at the "guard" "blocking" frequency, but increases to ten watts for either "trip" or "unblock" output. An interlock is provided in the transmitter keying circuit to give transfer-trip preference. This means that even while the transmitter is shifted to the "unblock" frequency, if the transfer-trip keying circuit is energized, the transmitter will shift to the "trip" frequency without delay.

The transmitter can also be amplitude modulated at 3.25 watts to provide a voice channel.

CONSTRUCTION

The 10 watt/1-3.25 watt/10 watt TCF-10 transmitter unit is mounted on a standard 19-inch wide chassis 5 1/4 inches (3 rack units) high with edge slots for mounting on a standard relay rack. See Fig. 8. All of the circuitry that is suitable for printed circuit board mounting is on four such boards, as shown in Fig. 15. The components mounted on each printed circuit board or other sub-assembly are shown enclosed by dotted lines on the internal schematic, Fig. 1. The location of components on the four printed circuit boards are shown on separate illustrations, Fig. 3, 4, 5, & 6.

External connections to the assembly are made through a 36-circuit receptacle, J3. The r.f. output connection to the assembly is made through a coaxial cable jack, J2.

OPERATION

The transmitter is made up of four main stages and two filters. The stages include two crystal oscillators operating at frequencies that differ by the desired channel center frequency, a mixer and buffer amplifier, a driver stage and a power amplifier. The interstage filter is located between the driver and the power amplifier. The output filter removes harmonics that may be generated by distortion in the power amplifier.

A single crystal designed for oscillation in the

30 kHz to 300 kHz range cannot be forced to oscillate away from its natural frequency by as much as ± 100 hz. In order to obtain this desired frequency shift, it is necessary to use crystals in the 2 MHz range. The crystals are Y1 and Y2 of Fig. 1. The frequency of Y2 is 2.00 MHz when operated with a specified amount of series capacity, and the frequency of Y1 is 2.00 MHz plus the channel center frequency, or 2.03 MHz for 30 kHz center frequency. Capacitor C55 and crystal Y2 in series are connected between the positive side of the supply voltage and the base of transistor Q51 which operates in the emitter following mode. The emitter is coupled to the base through C57. With Y2 removed the base of Q51 would be held at approximately the midpoint of the supply voltage by R51 and R52. The crystal serves as a series-resonant circuit with very high inductance and low capacitance. The circuit can be made to oscillate at other than the natural frequency of the crystal by varying the series capacitor, C55. Increasing C55 will lower the frequency of oscillations and reducing C55 will raise the frequency.

Capacitor C79 (in parallel with C78) is not effective until D59 is biased in the forward direction and becomes conductive. It is biased in the reverse direction until the keying control for unblock is closed which places 45V. dc at terminal 12 of the printed circuit board. With D57 conducting, C79 and C78 are placed in parallel with C55 and C73. The adjustment of C79 will reduce the frequency of the Y2 circuit by 200 hz. Since Y2 is the lower of the two frequencies derived from Y1 and Y2, the difference frequency, which is the frequency transmitted, is now increased by 200 hz. Thus the frequency transmitted is now 200 hz above the guard frequency or 300 hz above the center frequency.

Crystal Y1 is connected in a circuit that is similar except for the addition of C53 and diodes D51 and D52. By adjustment of C52 this circuit is made to oscillate at 100 hz above its marked frequency. Capacitors C53 and C71 are not effective until D51 is biased in the forward direction and becomes conductive. It is biased in the reverse direction until the keying control is closed, which places 45 V. dc at terminal 1 of the printed circuit board. With D51 conducting, C53 and C71 are effectively in parallel with C52 and C72. The adjustment of C53 will reduce the frequency by 200 hz.

The crystals taken individually have a greater variation of frequency with temperature than would be acceptable. However, by proper matching of the two crystals, the variation in their difference frequency can be kept within limits that permit holding the frequency stability of the overall transmitter to ± 10 Hz over a temperature range of -20 to $+55^{\circ}\text{C}$.

The frequencies produced by the two oscillators are coupled to the base of mixer transistor Q53 through C62 and C63. The sum of the two frequencies is so high that a negligible amount appears on the secondary of transformer T51, but the difference frequency is accepted and amplified by Q53 and Q54.

When the keying control is closed, it increases the output power from 1 watt to 10 watts as well as changing the frequency from Guard to Transfer or Unblock Trip. This is effected by reducing the emitter resistance of buffer-amplifier transistor Q54. When the keying control is open, transistor Q55 receives no base current and is non-conducting. Emitter resistor R70 therefore is effectively open-circuited. The level of output power is adjusted to 1 watt by means of R64. When Q55 is made conductive by closing the keying control circuit, R70 is placed in parallel with R68 and the amount of emitter resistance unbypassed by C66 can be adjusted as required to obtain a 10-watt output level.

Note in the keying board logic there is that interlocking logic between the keying for "unblock" and the keying for "transfer trip". This logic permits the "transfer trip" keying to take preference over the "unblock" keying. That is, even if we have "unlock" keying and then get "transfer trip" keying, the "transfer trip" will take immediate preference over the "unblock" keying. This is accomplished by the "transfer trip" keying causing transistor Q1 to conduct which in turn shunts out the keying voltage input to transistor Q3 through diode D9. Thus while Q1 becomes conducting and consequently Q2, effecting "transfer trip" keying, this conduction of Q1 also prevents Q3 from becoming conducting and prevents "unblocking" keying.

As is shown on the Internal Schematic, Fig. 1, the voltage for the keying circuit is obtained from

the 45-volt regulated supply in the transmitter.

The driver stage consists of transistors Q56 and Q57 connected in a conventional push-pull circuit with input supplied from the collector of Q54 through transformer T52.

The driver filter, FL101, consists of a series-resonant inductor and capacitor connected between the driver and power amplifier stages by appropriate transformers T1 and T2. This filter greatly improves the waveform of this signal applied to the power amplifier.

The power amplifier uses two series-connected power transistors, Q101 and Q102, operating as a class B push-pull amplifier with single-ended output. Diodes D101 and D103 provide protection for the base-emitter junctions of the power transistors. Zener diodes Z105 and Z106 protect the collector-emitter junctions from surges that might come in from the power line through the coaxial cable.

The output transformer T3 couples the power transistors to the output filter FL102. The output filter includes two trap circuits (L102, CB and L103, CC) which are factory tuned to the second and third harmonics of the transmitter frequency. Capacitor CD approximately cancels the inductive reactance of the two trap circuits at the operating frequency. Protective gap G1 is a small lightning arrester to limit the magnitude of switching surges or other line disturbances reaching the carrier set through the line turner and coaxial cable. Auto-transformer T4 matches the filter impedance to coaxial cable of 50, 60, or 70 ohms.

The series resonant circuit composed of L105, and CE is tuned to the transmitter frequency, and aids in providing resistive termination for the output stage. Jack J102 is mounted on the rear panel of FL102 and is used for measuring the r.f. output current of the transmitter into the coaxial cable. It should be noted that the filter contains no shunt reactive elements, thus providing a reverse impedance that is free of possible "across-the-line" resonances.

The power supply is a series-type transistorized dc voltage regulator which has a very low stand-by current drain when there is no output current de-

mand. The Zener diode Z1 holds a constant base-to-negative voltage on the series-connected power darlington transistor Q1. Depending on the load current, the dc voltage drop through transistor Q1 and resistor R1 and R2 varies to maintain a constant output voltage. The Zener diode Z2 serves to drop the 100v regulated supply to 45v for use with both the keying circuit and the external TCF voice adapter. It is placed in series so that it does not draw current unless called upon by the external voice adapter. Capacitor C3 provides a low carrier-frequency impedance across the dc output voltage. Capacitors C1 and C2 by pass across the dc output voltage. Capacitors C1 and C2 by pass r.f. or transient voltages to ground, thus preventing damage to the transistor circuit.

When keyed for voice by the voice adapter, transistor Q55 is keyed into class A operation so that its conduction can be modulated by the voice input from the voice adapter. Potentiometer R82 is adjusted so that the nominal output of carrier is 3.25 watts (14 volts across 60 ohms). The voice input modulates the carrier through this transistor by varying the amount of conduction of Q55 so that the output power of carrier varies with the voice amplitude following the voice frequency components. Since with Q55 completely nonconducting, R64 has been set to produce a 1 watt output, maximum modulation on the side to shut off Q55 will not result in an output level of less than 1 watt carrier at any time. Also since the output level has been set at 10 watts with Q55 completely conducting by the adjustment of R70, the maximum modulation on the side of turn on of Q55 will not result in a carrier output level of greater than 10 watts at any time. Thus the modulation for voice will not result in the output carrier level dropping below 1 watt and endangering the guard frequency for relaying purposes.

The buffer keying board in addition to providing proper buffering, also contains logic for the proper keying of both frequency and output level in regards to protective relaying operation, voice adapter operation, and 52b contact operation.

It should be remembered that protective relaying operation has first priority. If the protective relay operates and puts a voltage input into any of the three input points labeled carrier auxiliary key-

ing, the transmitter will both frequency shift to trip frequency and full 10 watts output whether voice is called for or not.

The operation of the 52b contact will remove the 10 watt keying output and permit the voice adapter to key to 3.2 watts output for AM voice modulation. This allows voice modulation on unblock frequency after the 52b contact has operated.

CHARACTERISTICS

Frequency Range Output	30-300 kHz, 1 watt guard—10 watts trip—(both transfer and unblock)—3.2 watts voice (into 50 to 70 ohm resistive load) at nominal rated input voltage (48 V. or 125 v.d.c.)
Frequency Stability	±10 Hz from -20°C to +55°C.
Frequency Spacing	Two-way channel,—See Voice Adapter Instruction Leaflet. [41-945.6]
Harmonics	Down 55 db (min.) from output level.
Input Voltage	48 or 125 v.d.c.
Supply Voltage Variation	42-56v. for nom. 48v. supply. 105-140v. for nom. 125v. supply.
Battery Drain	0.5 A. guard } 48 v.d.c. 1.15 A. trip }
	0.2 A. guard } 125 v.d.c. 0.4 A. trip }
Keying Circuit Current	4 mA.
Temperature Range	-20 to +55°C. around chassis.
Dimensions	Chassis height—5 1/4 or 3 r.u. Chassis width—19"
Weight	12 lbs.

INSTALLATION

TYPE TCF-10 transmitter is generally supplied in a cabinet or on a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. The maximum ambient temperature around the chassis must not exceed 55°C.

ADJUSTMENTS

TYPE TCF-10 10W/1-3.2W/10W 3 Frequency transmitter is shipped with the power output controls R64, R82 and R70, set for outputs of 1 watt, 3.2 watts and 10 watts into a 60 ohm load. If it is desired to check the adjustments or if repairs have made readjustment necessary, the coaxial cable should be disconnected from the assembly terminals and replaced with a 50 to 70 ohm non-inductive resistor of at least a 10 watt rating. Use the value of the expected input impedance of the coaxial cable and line tuner. If this is not known, assume 60 ohms. Connect the T4 output lead to the corresponding tap. Connect an ac vacuum tube voltmeter (VTVM) across the load resistor. Turn power output control R64 to minimum (full counter-clockwise). Turn on the power switch on the panel and note the dc voltage across terminals 3 and 7 of J3. If this is in the range of 42 to 46 volts, rotate R64 clockwise to obtain 4 or 5 volts across the load resistor used. At this point check the adjustment of the series output tuning coil L105 by loosening the knurled shaft-locking nut and moving the adjustable core in and out a small amount from its initial position. Leave it at the point of maximum voltage across the load resistor used. Then rotate R64 farther clockwise to obtain the correct voltage for 1 watt in the load resistor, as shown in the following table.

Then change to Trip frequency by connecting together terminals 7 and 12 of the transmitter connector J3, and rotate R70 until the voltage across the load resistor is as shown in the following table for a 10 watt output. Recheck the adjustment of L105 for maximum output voltage and readjust R70 for a 10 watt output if necessary. Tighten the locking nut on L105. Open the power switch and remove the jumper used to key the transmitter to the 10 watt level. Key for voice by opening any connection terminal to 10 of J3. Turn the power

back on. Adjust R82 for a 3.2 watt output across the load resistor (14V across 60 ohms). Open the power switch, reconnect connection to terminal 10 of J3, remove the load resistor, and reconnect the coaxial cable circuit to the transmitter. Note on frequencies above 200 KHZ, L105 adjustment is a screw-driver adjustment. There is no knurled shaft-locking nut.

VOLTAGE FOR

T106 TAP	1 WATT OUTPUT	3.2 WATTS OUTPUT	10 WATTS OUTPUT
50	7.1	12.7	22.4
60	7.8	14	24.5
70	8.4	15	26.5

Follow the procedure outlined in the line tuner instructions for its adjustment.

Normally the output filter (FL102) will require no readjustment except as noted above. It is factory tuned for maximum second and third harmonic rejection, and for series resonance (maximum output at the fundamental frequency) with a 60-ohm load. A small amount of reactance in the transmitter output load circuit may be tuned out by readjustment of the movable core of L105. This may be necessary with some types of line coupling equipment. The adjustable cores of L102 and L103 have been set for maximum harmonic rejection and no change should be made in these settings unless suitable instruments are available for measuring the second and third harmonic present in the transmitter output.

The operating frequencies of crystals Y1 and Y2 have been carefully adjusted at the factory and good stability can be expected. If it is desired to check the frequencies of the individual crystals, this can be done by turning the matched pair 180° and inserting a crystal in its proper socket with the other crystal unconnected. A sensitive frequency counter with a range of at least 2.3 MHz can be connected from TP51 to TP54. (Connection to TP54 rather than to TP53 provides a better signal to the counter and avoids some error from the effect of the counter input capacitance on the oscillator circuit.) While measurement of the oscillator crystals individually is necessary for the initial adjustment of the oscillators, generally any subsequent checks may be made

with a lower range counter connected at the transmitter output. If any minor adjustment of the Guard and Trip frequencies should be needed, the Guard adjustment should be made with capacitor C52, the Transfer Trip Adjustment with C53, and the unblock frequency with C79.

MAINTENANCE

Periodic checks of the transmitter Guard and Trip power outputs will detect impending failure so that the equipment can be taken out of service for correction. At regular maintenance intervals, any accumulated dust should be removed, particularly from the heat sinks. It is also desirable to check the transmitter power output at such times, making any necessary readjustments to return the equipment to its initial settings.

Voltage values should be recorded after adjustment in order to establish reference values which will be useful when checking the apparatus. The readings will remain fairly constant over an indefinite period unless a failure occurs. However, if transistors are changed, there may be considerable difference in these readings without the overall performance being affected.

Typical voltage values are given in the following tables. Voltages should be measured with a VTVM. Readings may vary as much as $\pm 20\%$.

TABLE I
TRANSMITTER DC MEASUREMENTS

Note: All voltages are positive with respect to Neg. (TP51). All voltages read with dc VTVM.

Test Point	Voltage at 1 Watt Output		Voltage at 10 Watts Output		Voltage at 3.2 Watts Output (For voice)	
	48V units	125V units	48V units	125V units	48V units	125V units
TP52	20	20	20	20	20	20
TP53	5.4		5.4		5.4	
TP54	3.4		3.4		3.4	
TP55	21	20	18.5	18.5	—	—
TP56	21	20	18.5	18.5	—	—
TP57	<1.0		<1.0		—	—
TP58	44.3	100	44.1	100	—	—
TP59	<1.0		<1.0		—	—
TP101	0	0	0	0	—	—
TP103	21 \pm 2	50	21 \pm 2	50	—	—
TP105	44.3	100	44.0	100	—	—

TABLE II
TRANSMITTER RF MEASUREMENTS

Note: Voltages taken with transmitter set to indicated output across 60 ohms. These voltages subject to variations, depending upon frequency and transistor characteristics. T51-3 = Terminal 3 of transformer T51. Other transformer terminals identified similarly. All read with a-c VTVM.

Test Point	Voltage at 1 watt Output		Voltage at 10 watts Output		Voltage at 3.2 watts Output (For Voice)	
	48V	125V	48V	125V	48V	125V
TP54 to TP51	0.015-0.03		0.015-0.03		—	—
TP57 to TP51	0.05 -0.09		0.3 -1.2		—	—
TP59 to TP51	0.05 -0.09		0.3 -1.2		—	—
T1-1 to TP51	1.65		5.6		—	—
T1-3 to TP51	1.45		4.9		—	—
T1-4 to Gnd.	.6		2.0		—	—
T2-1 to Gnd.	.57		1.85		—	—
TP101-TP103	5.2		17.0		—	—
TP103 to TP105	5.2		17.0		—	—
T3-4 to Gnd.	35	35	112	112	—	—
T4-2 to Gnd.	31	31	110	110	—	—
TP109 to Gnd.	9.8	9.8	31	31	—	—
J102 to Gnd.	7.8	7.8	24.5	24.5	14	

CONVERSION OF TRANSMITTER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a 1W/10W TCF transmitter for operation on a different channel frequency consist of a pair of matched crystals for the new channel frequency, new capacitors C103 and C104 on the power amplifier circuit board if the old and new frequencies are not in the same frequency group (see table on internal schematic drawing) and, in general, new or modified filters FL101 and FL102. Inductors L101, L102 and L103 in these filters are adjustable over a limited range, but forty-two combinations of capacitors and inductors are required to cover the frequency range of 30 to 300 kHz. The widths of the frequency groups vary from 1.5 kHz at the low end of the channel frequency range to 13 kHz at the upper end. A particular assembly can be adjusted over a somewhat wider range than the width of its as-

signed group since some overlap is necessary to allow for component tolerances. The nominal kHz adjustment ranges of the group are:

30.0-31.5	61.0- 64.0	113.0-119.5	207.1-214.0
32.0-33.5	64.5- 68.0	120.0-127.0	214.1-222.0
34.0-36.0	68.5- 72.0	127.5-135.0	222.1-230.0
36.5-38.5	72.5- 76.0	135.5-143.0	230.1-240.0
39.0-41.0	76.5- 80.0	143.5-151.0	240.1-250.0
41.5-44.0	80.5- 84.5	151.5-159.5	250.1-262.0
44.5-47.0	85.0- 89.0	160.0-169.5	262.1-274.0
47.5-50.0	89.5- 94.5	170.0-180.0	274.1-287.0
50.5-53.5	95.0-100.0	180.5-191.5	287.1-300.0
54.0-57.0	100.5-106.0	192.0-200.0	
57.5-60.5	106.5-112.5	200.1-207.0	

If the new frequency lies within the same frequency group as the original frequency, the filters can be readjusted. If the frequencies are in different groups, it is possible that changes only in the fixed capacitors may be required. In general, however, it is desirable to order complete filter assemblies adjusted at the factory for the specified frequency. Since all the modules are plug in modules frequency change is simply a matter of plugging in these new filters.

A signal generator, a frequency counter and a vacuum tube voltmeter are required for readjustment of FL101. The signal generator and the counter should be connected across terminals 4 and 5 of transformer T1 and the voltmeter across terminals 1 and 2 of transformer T2. The signal generator should be set at the channel center frequency and at 2 to 3 volts output. The core screw of the small inductor should be turned to the position that gives a true *maximum* reading on the VTVM. Turning the screw to either side of this position should definitely reduce the reading. The change in inductance with core position is less at either end of the travel than when near the center and consequently the effect of core screw rotation on the VTVM reading will be less when the resonant inductance occurs near the end of core travel.

The procedure for readjustment of the 2nd and 3rd harmonic traps of filter FL102 is somewhat similar. A signal generator and a counter should be connected to terminals 3 and 4 of transformer T3,

and a 500 ohm resistor and a VTVM to the terminals of protective gap G1. The ground or shield lead of all instruments should be connected to the grounded terminal of the transformer. Set the signal generator at exactly twice the channel center frequency and at 5 to 10 volts output. Turn the core screw of the large inductor, L102, to the position that gives a definite *minimum* reading on the VTVM. Similarly, with the signal generator set at exactly three times the channel center frequency and 5 to 10 volts output, set the core screw of the small inductor, L103, to the position that gives a definite *minimum* reading on the VTVM. Then remove the instruments and the 500 ohm resistor.

After the new pair of matched crystals have been adjusted, as described under "ADJUSTMENTS", the transmitter can be operated with a 50 to 70 ohm load (depending on which tap of T4 is used) connected to its output, and inductor L105 can be readjusted for maximum output at the changed channel frequency by the procedure described in the same section.

If a frequency-sensitive voltmeter is available, the 2nd and 3rd harmonic traps may be adjusted without using an oscillator as a source of double and triple the channel frequency. Connect the frequency-sensitive voltmeter from TP109 to ground and adjust the transmitter for rated output into the selected load resistor, set the voltmeter at twice the channel frequency and, using the tuning dial and dB range switch, obtain a maximum on-scale reading of the 2nd harmonic. Then vary the core position of L102 until a minimum voltmeter reading is obtained. Similarly, tune the voltmeter to the third harmonic and adjust L103 for minimum voltmeter reading. Although the transmitter frequency will differ from the channel center frequency by 100 Hz, the effect of this difference on the adjustment of the harmonic traps will be negligible. It should be noted that the true magnitude of the harmonics cannot be measured in this manner because of the preponderance of the fundamental frequency at the voltmeter terminals. Accurate measurement of the harmonics requires use of a filter between TP109 and the voltmeter that provides high rejection of the fundamental. The insertion losses of this filter for the 2nd and 3rd harmonics must be measured and taken into account.

RECOMMENDED TEST EQUIPMENT

- I. Minimum Test Equipment for Installation.
 - a. 60-ohm 10-watt non-inductive resistor.
 - b. AC Vacuum Tube Voltmeter (VTVM). Voltage range 0.003 to 30 volts, frequency range 60 hz to 330-kHz; input impedance 7.5 megohms.
 - c. DC Vacuum Tube Voltmeter (VTVM).
Voltage Range: 1.5 to 300 volts
Input Impedance: 7.5 megohms.
- II. Desirable Test Equipment for Apparatus Maintenance.
 - a. All items listed in I.
 - b. Signal Generator
Output Voltage: up to 8 volts.
Frequency Range: 20-kHz to 330-kHz.
 - c. Oscilloscope
 - d. Frequency counter
 - e. Ohmmeter
 - f. Capacitor checker.

Some functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data and identify the part by its designation on the Internal Schematic drawing.

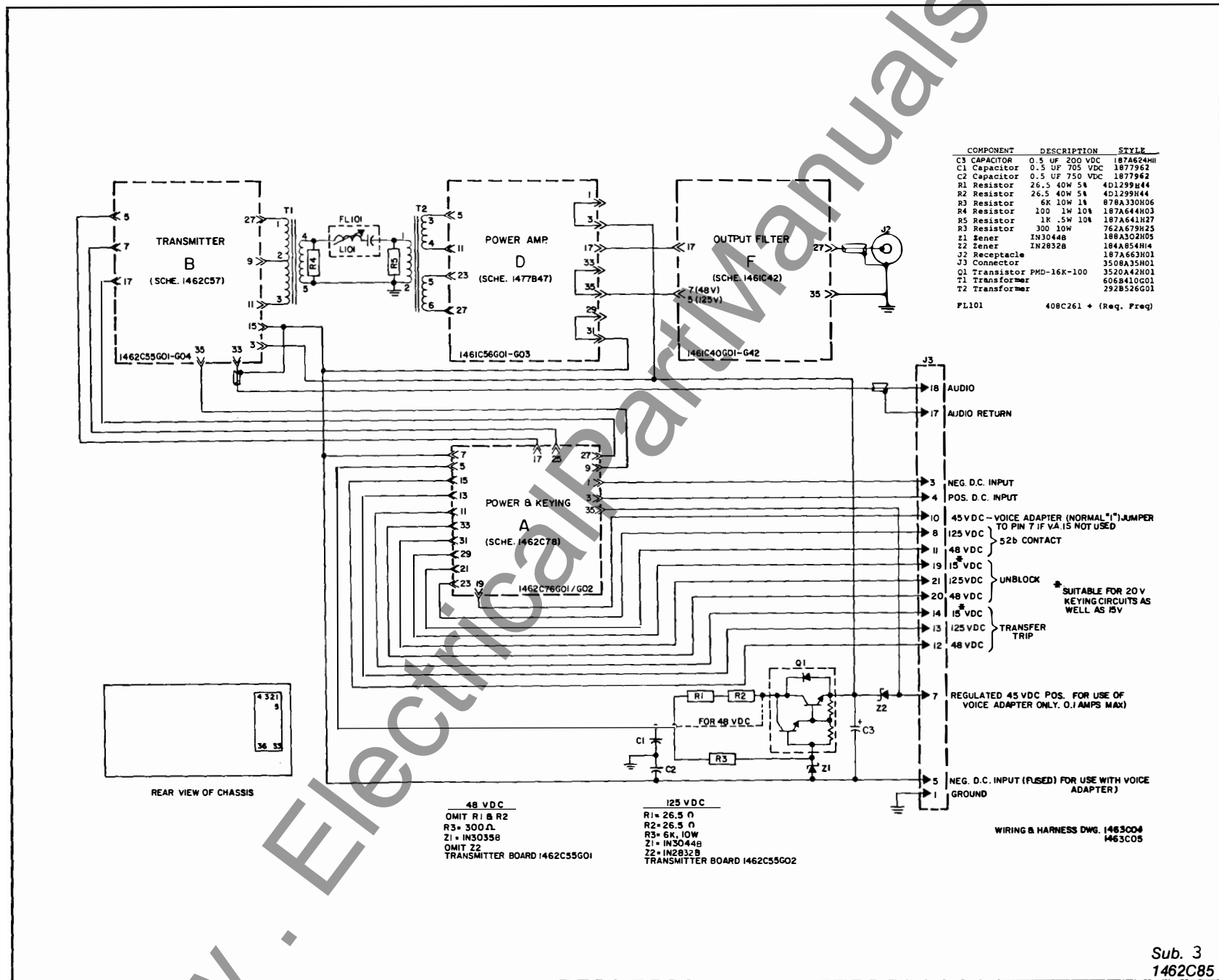


Fig. 1 Internal Schematic of Transmitter

Sub. 3
1462C85

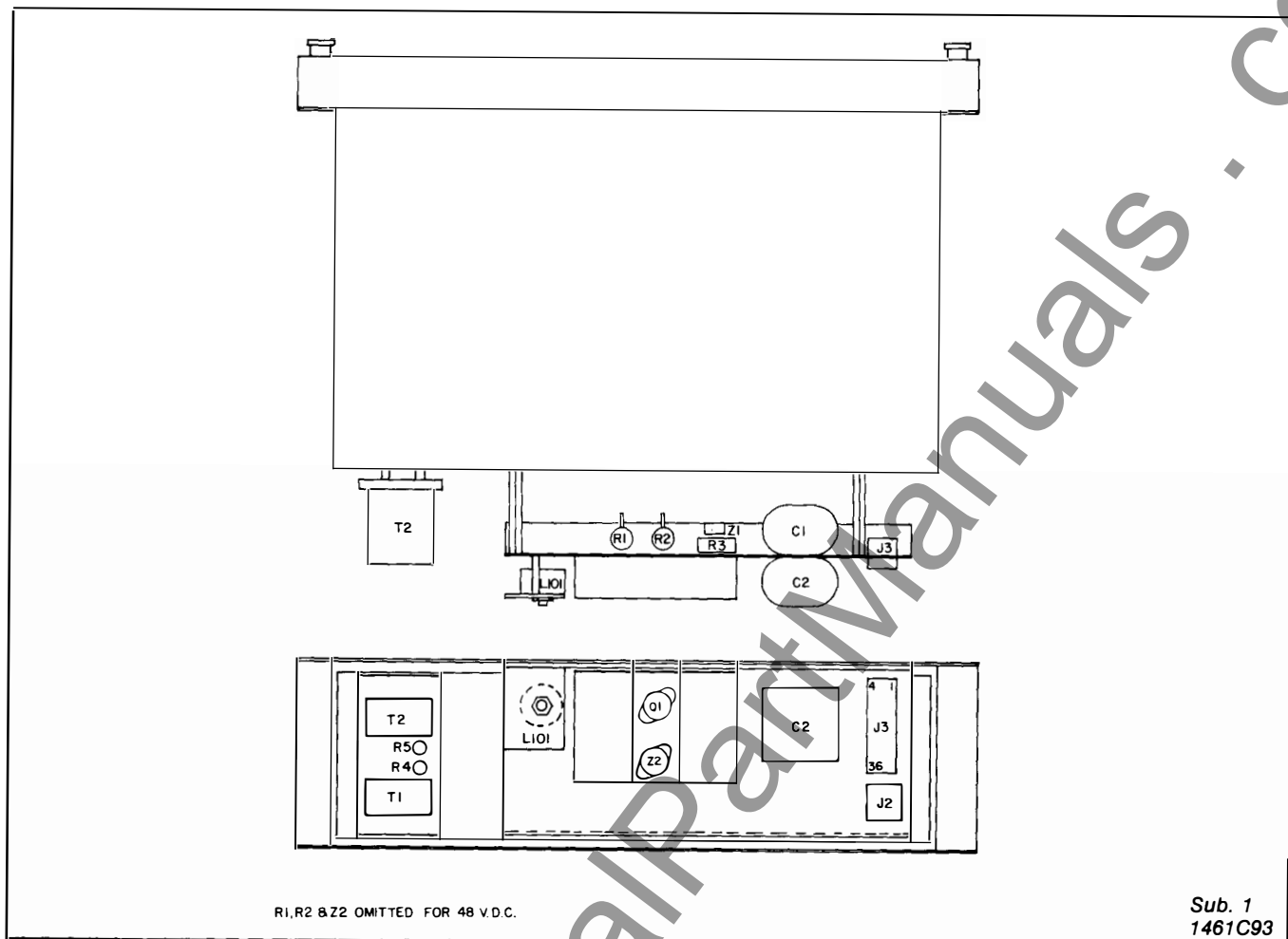


Fig. 2 Component Location Transmitter Assembly

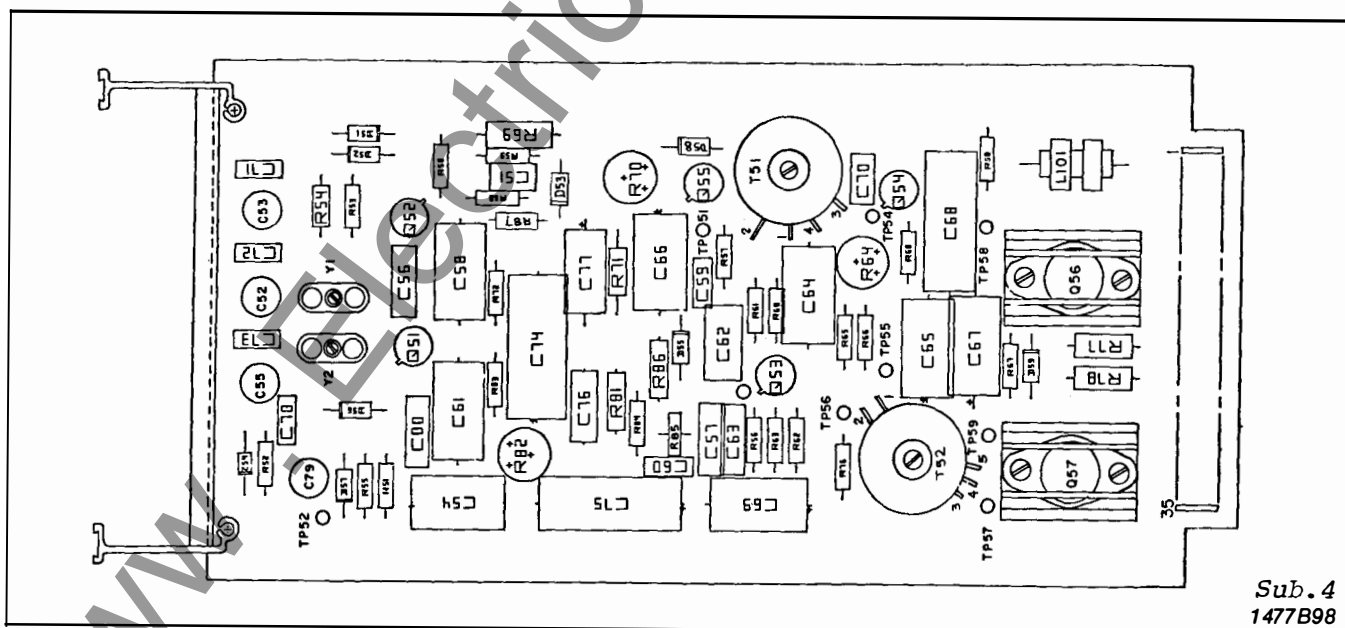


Fig. 3 Component Location Transmitter Module

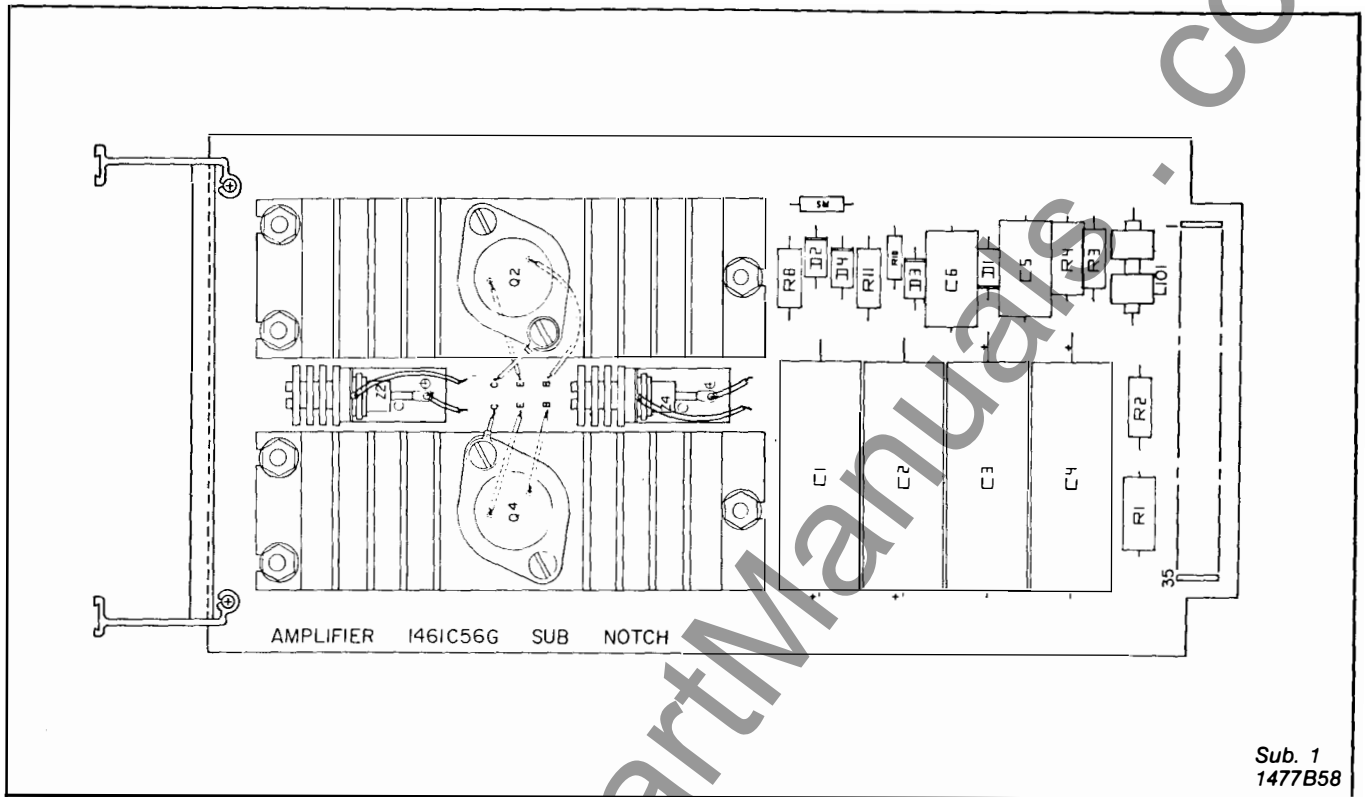


Fig. 4 Component Location Power Amplifier Module

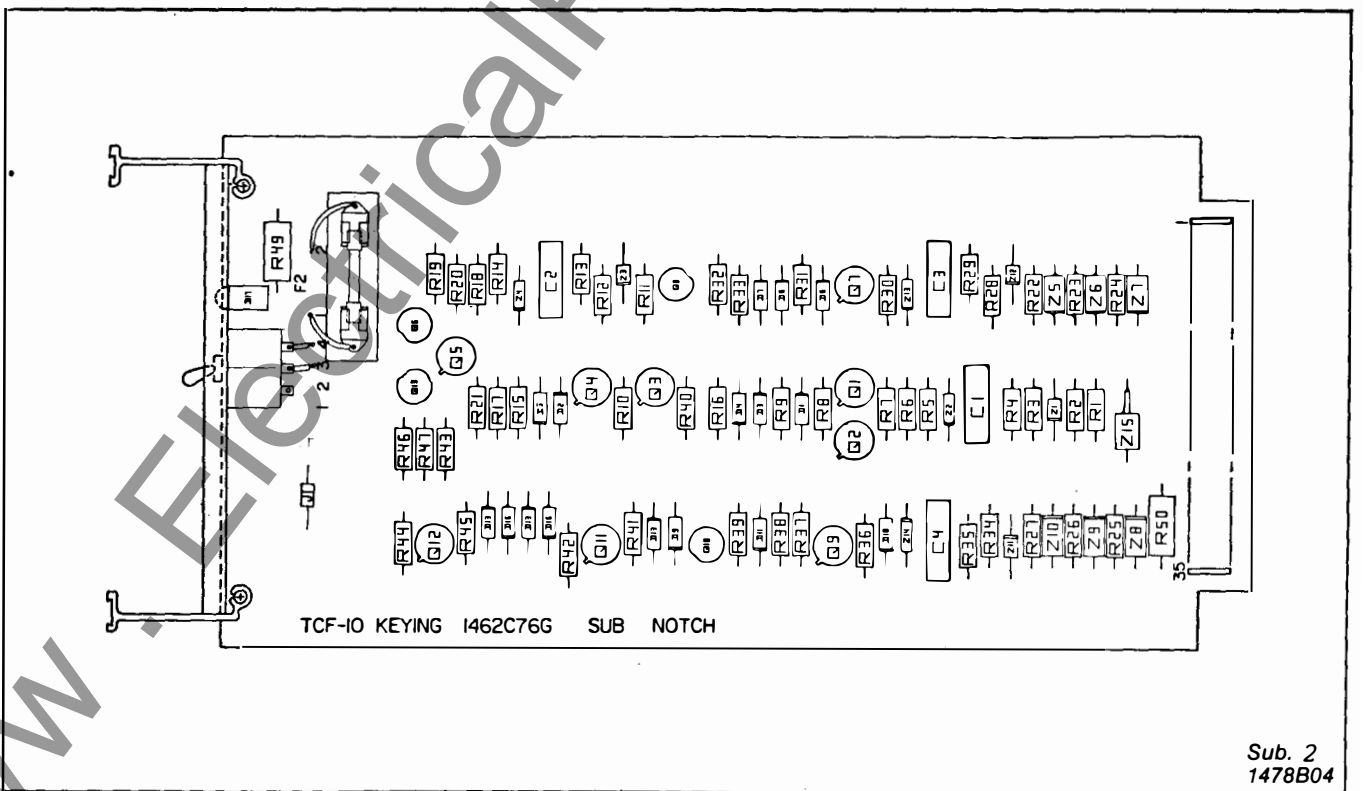
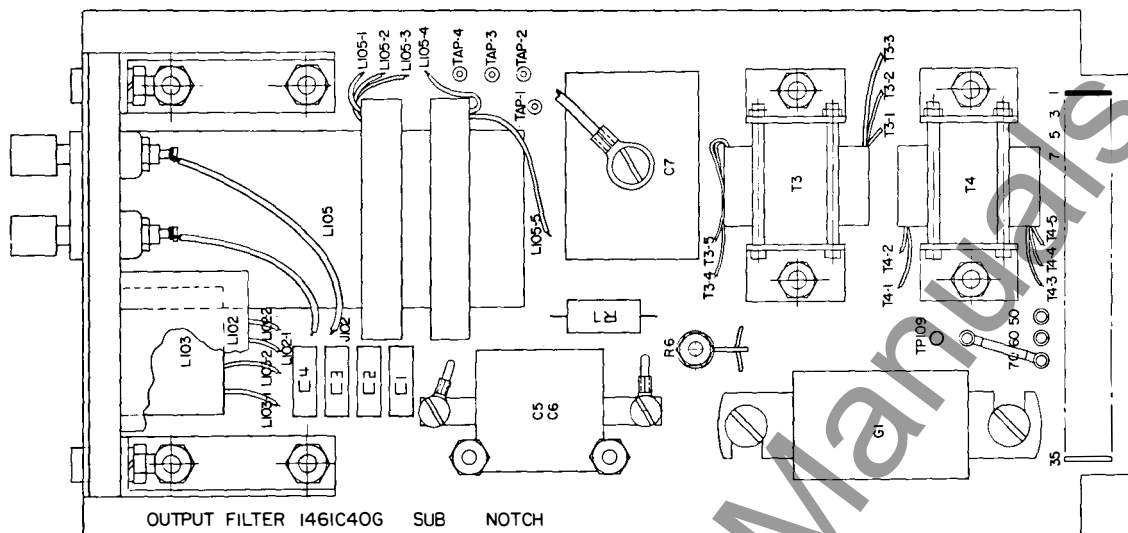
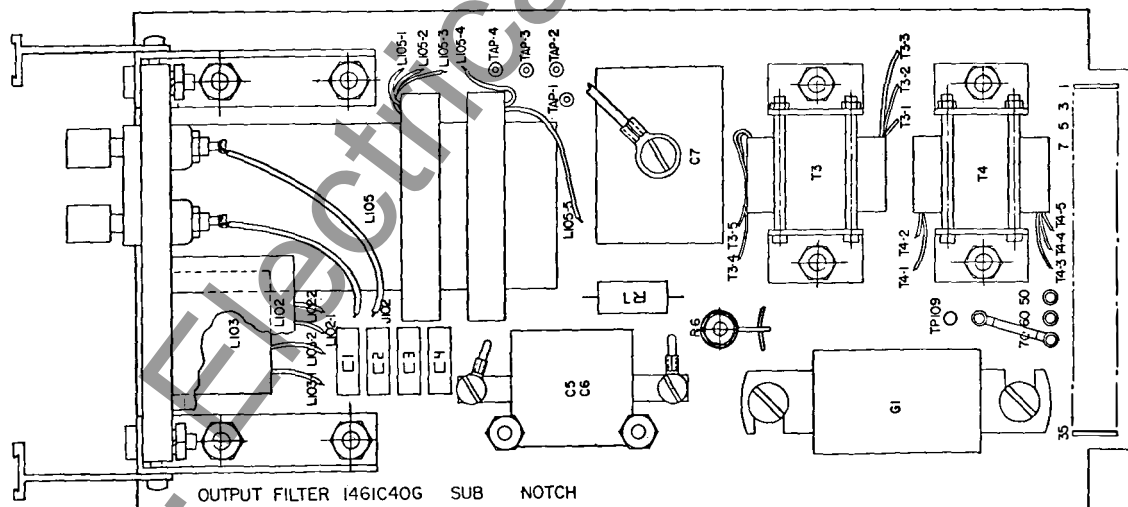


Fig. 5 Component Location Power Amplifier Keying Module



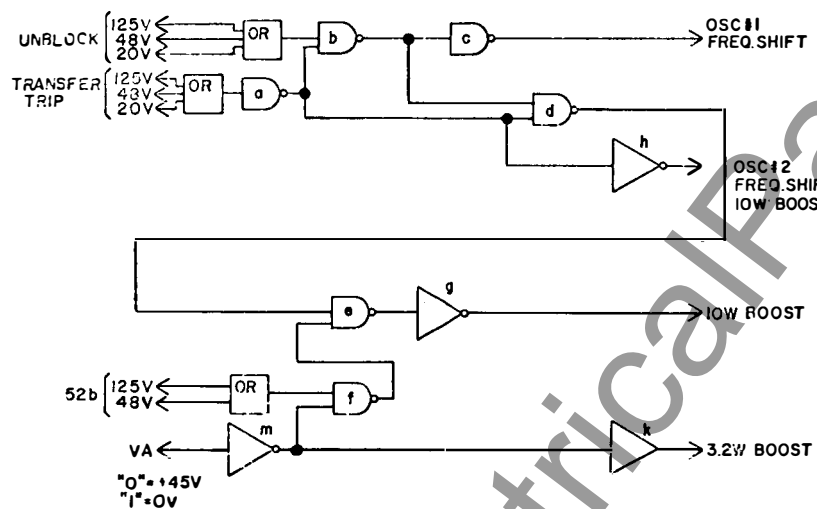
Sub. 3
1477B28



Sub. 1
1479B33

Fig. 6 Component Location Output Filter Module

LOGIC FOR 3 FREQ. WITH VOICE

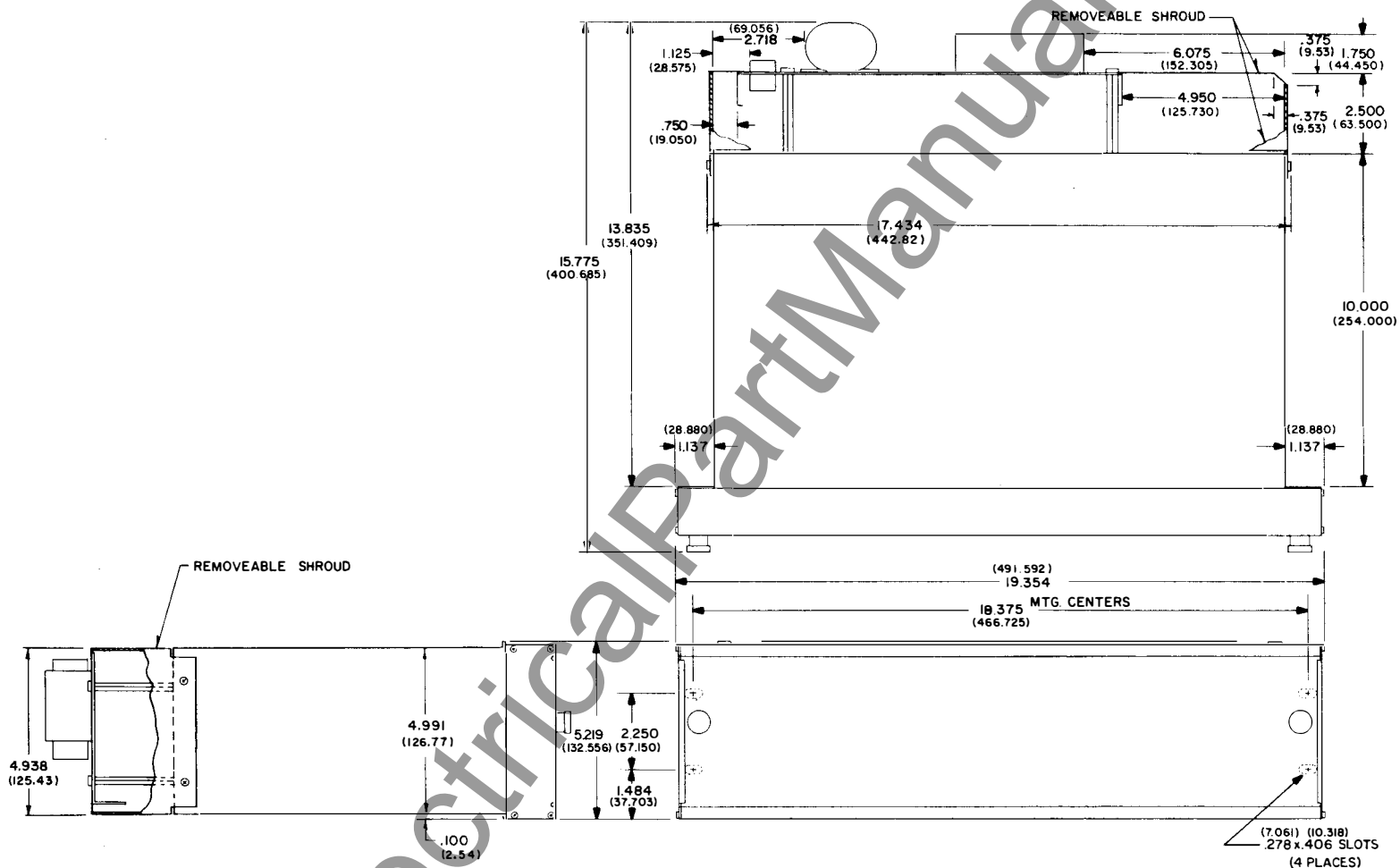


TRUTH TABLE-3 FREQ. WITH VOICE

INPUT KEYING				OUTPUTS			
UN	TT	52b	VA	TT FREQ SHIFT	UN FREQ SHIFT	3.2W BOOST	10W BOOST
0	0	0	0	0	0	0	0
1	0	0	0	0	1	0	1
1	1	0	0	1	0	0	1
1	0	1	0	0	1	0	1
1	0	0	1	0	1	0	1
1	1	1	0	1	0	0	1
1	0	1	1	0	1	1	1
1	1	0	1	1	0	0	1
1	1	1	1	1	0	1	1
0	1	0	0	1	0	0	1
0	1	1	0	1	0	0	1
0	1	0	1	1	0	0	1
0	1	1	1	1	0	1	1
0	0	1	0	0	1	0	1
0	0	1	1	0	1	0	1
0	0	0	1	0	1	0	1
0	0	0	0	0	0	0	0

* = STU RELAY AFTER 180MS OPERATION OF 52b WILL KEY TO UNBLOCK. IN THIS CASE, THE UNBLOCK KEYING IS NOT DONE BY THE LOGIC REPRESENTED BY THESE LOGIC BOARDS.

Fig. 7 Logic for 3 Frequency With Voice



Sub. 5
1445C80

Fig. 8 Outline & Drilling for Transmitter Assembly

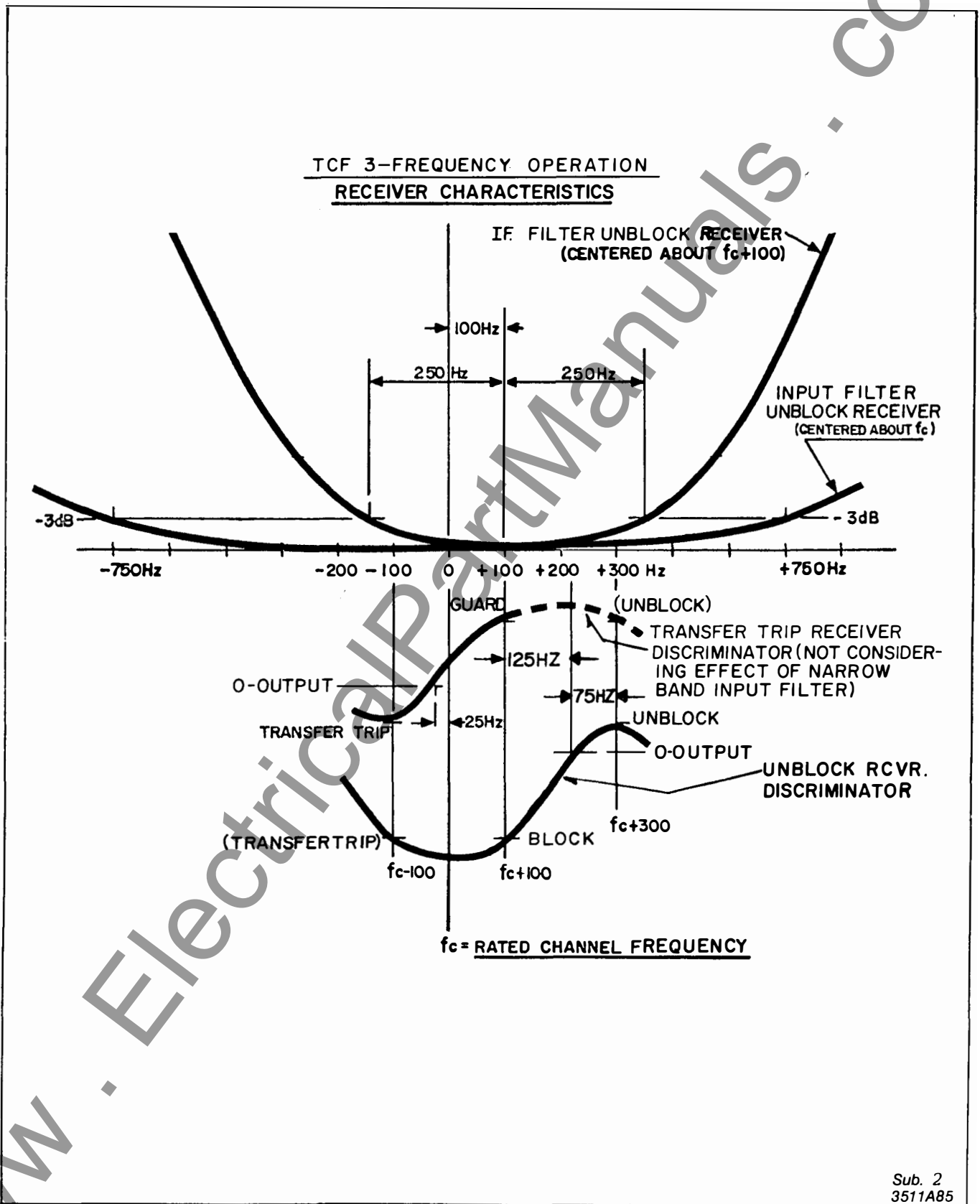
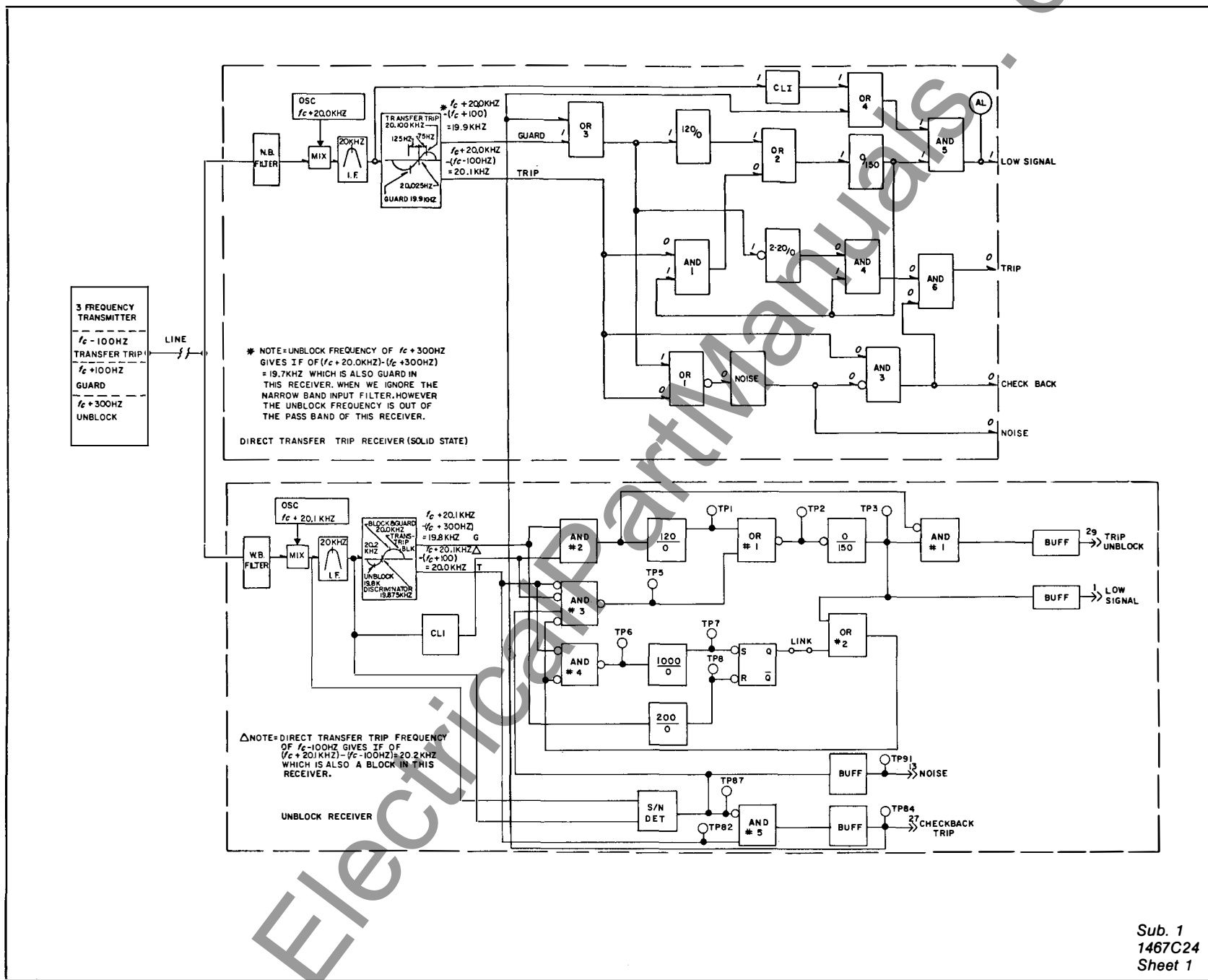
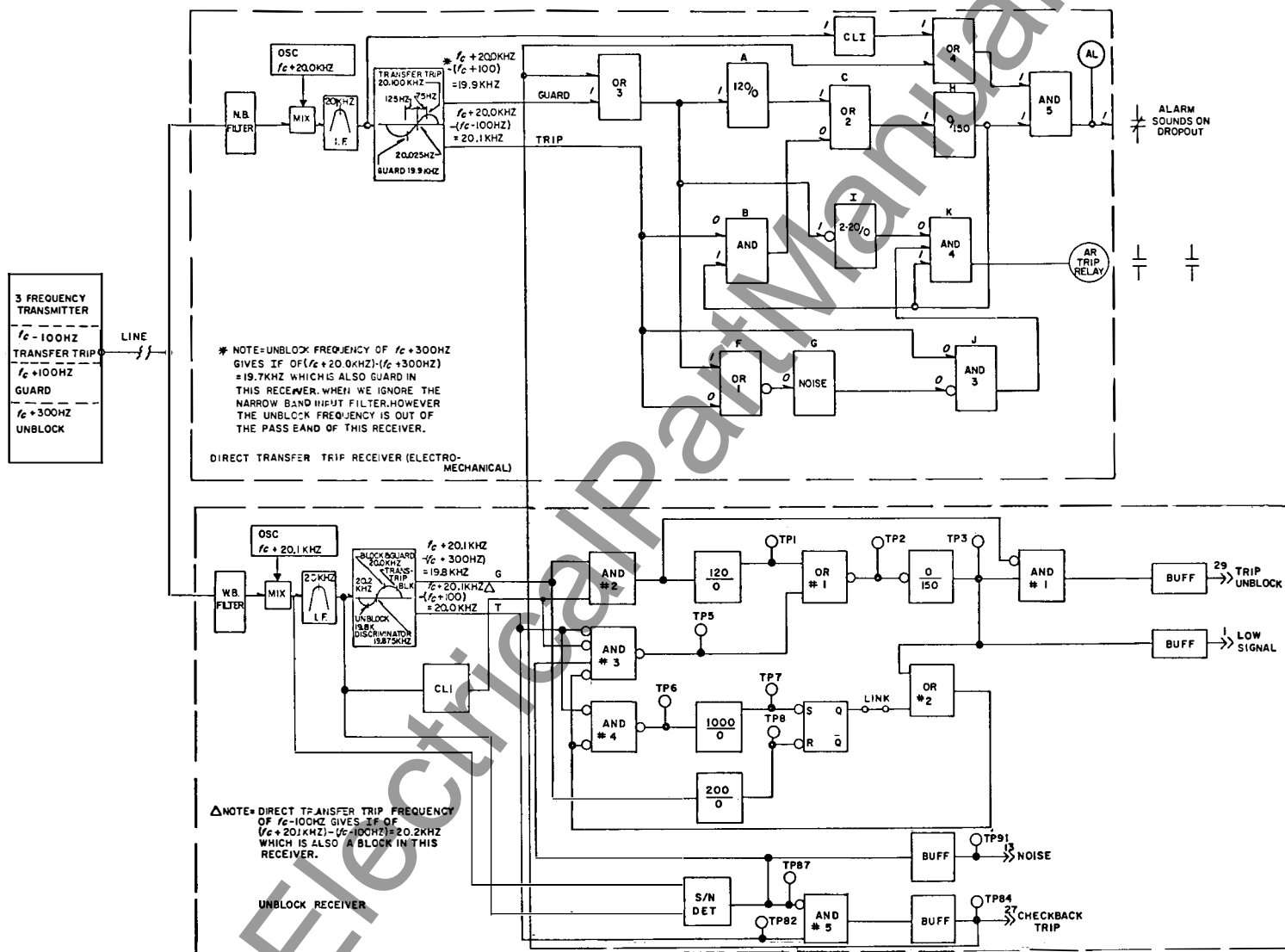
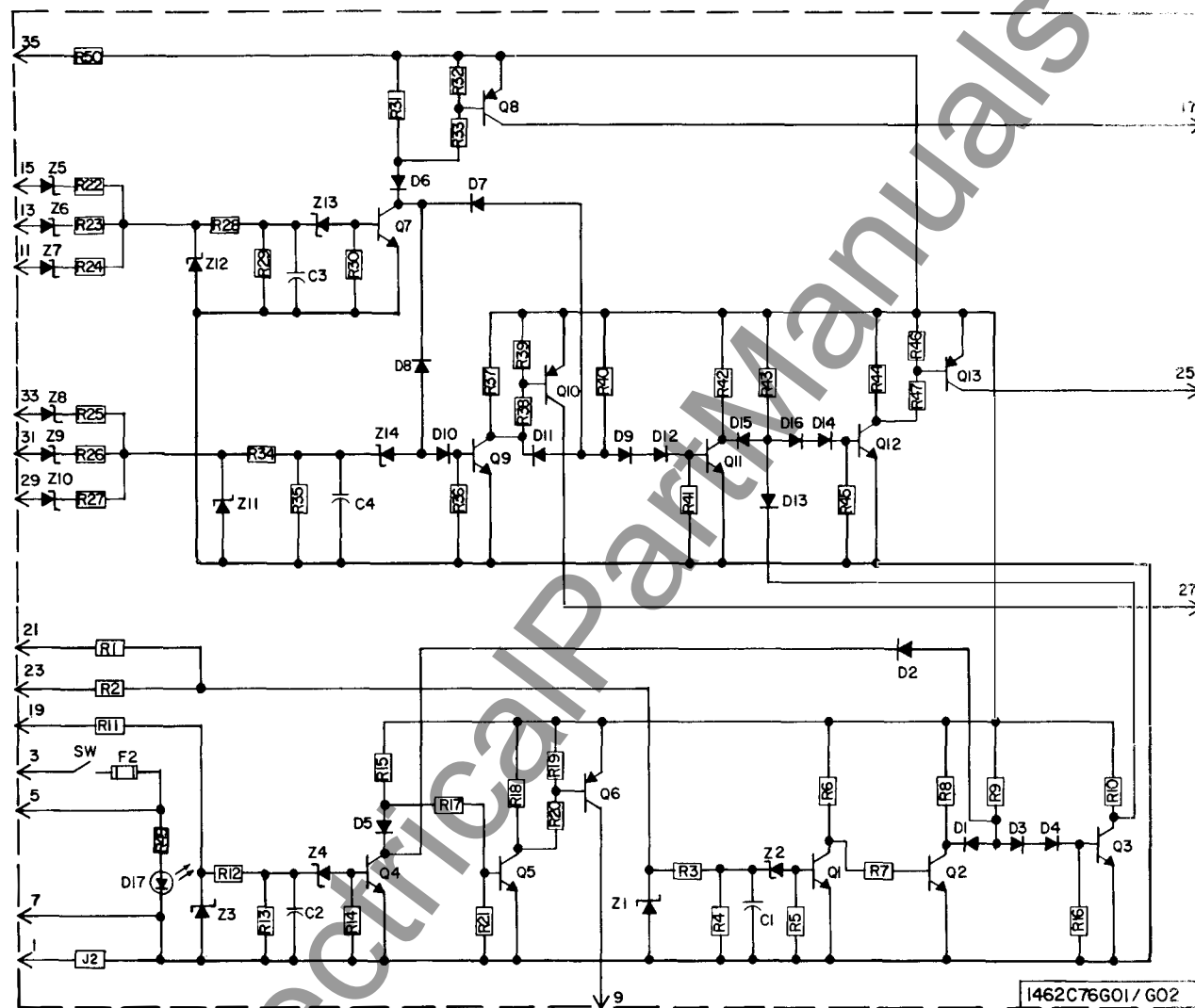


Fig. 9 Three Frequency Operation—Receiver Characteristics

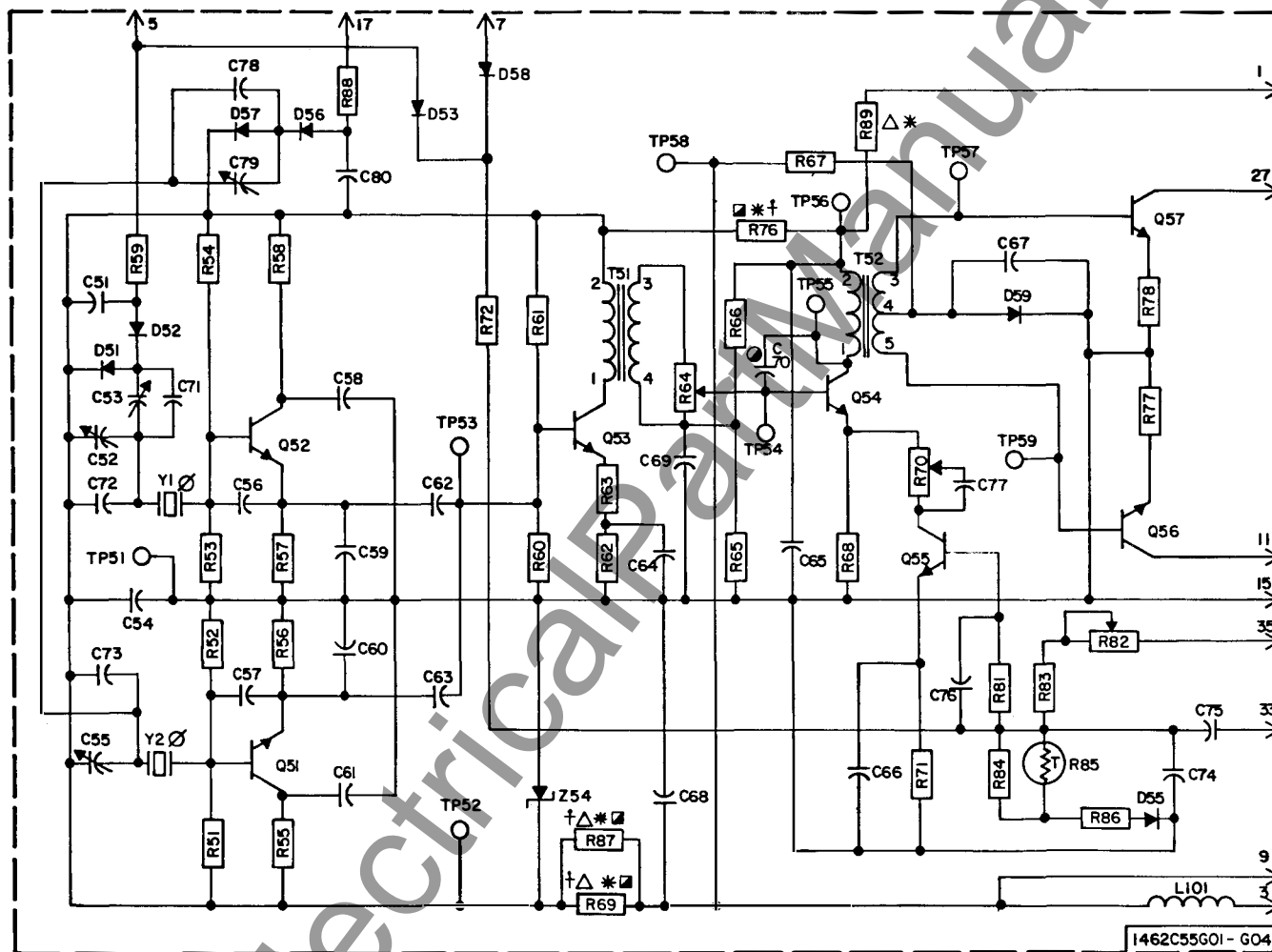






Sub. 3
1462C78

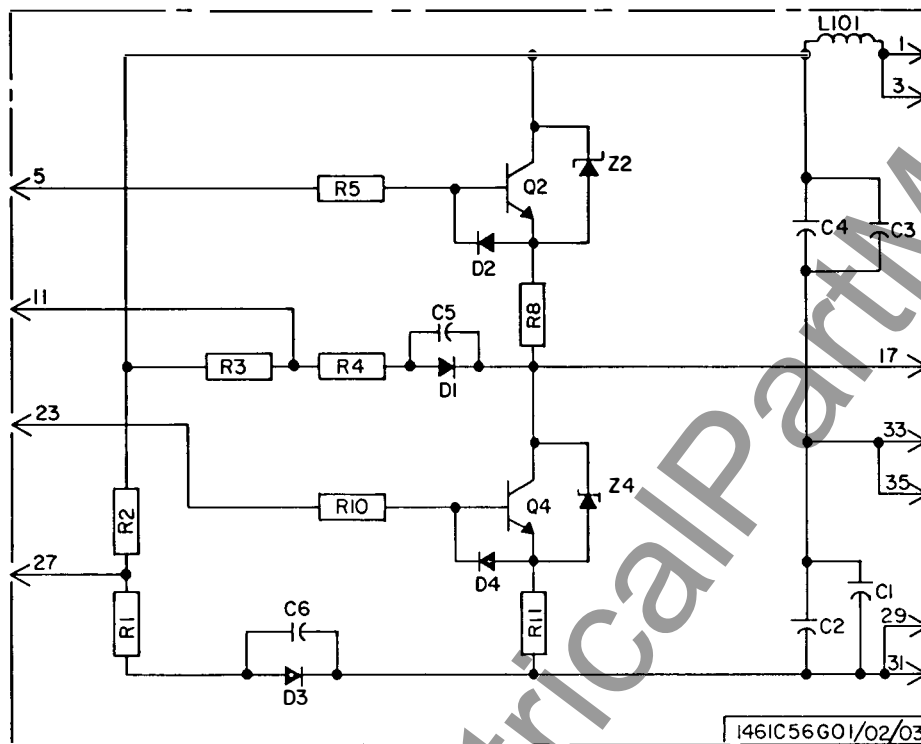
Fig. 11 Internal Schematic Power & Keying Module



- * - G01 (48 V.D.C.) USE R69 (OMIT R87 & R89)
 Δ - G02 (125 V.D.C.) USE R69 & R87 (OMIT R89)
 (ON-OFF MODE) □ - G03 (48 V.D.C.) USE R69 (OMIT R87 & R76)
 (ON-OFF MODE) + - G04 (125 V.D.C.) USE R69 & R87 (OMIT R76)
 ○ - REMOVE FOR VOICE ABOVE 60 KHZ

Fig. 12 Internal Schematic Transmitter Module

Sub. 5
1462C57



COMPONENT	DESCRIPTION	STYLE NO.
C1	CAPACITOR .470UF 400V	188A293H01
C2	CAPACITOR .470UF 400V	188A293H01
C3	CAPACITOR .470UF 400V	188A293H01
C4	CAPACITOR .470UF 400V	188A293H01
C5	CAPACITOR .250UF 200V	187A624H02
C6	CAPACITOR .250UF 200V	187A624H02
D1	DIODE 1N4822	188A342H11
D2	DIODE 1N4822	188A342H11
D3	DIODE 1N4822	188A342H11
D4	DIODE 1N4822	188A342H11
Z2	ZENER IN2009C	184A617H14
Z4	ZENER IN2009C	184A617H14
R1	RESISTOR 2.7 1W 0%	629A371H24
R2	RESISTOR 100K 1.00W 5%	187A644H75
R3	RESISTOR 51K 1.00W 5%	187A644H75
R4	RESISTOR 2.7 1W 0%	629A371H24
R5	RESISTOR 10.0 .50W 5%	187A290H01
R8	RESISTOR .27 1.00W 10%	184A636H13
R10	RESISTOR 10.0 .50W 5%	187A290H01
R11	RESISTOR .27 1.00W 10%	184A636H13
Q2, Q4	TRANSISTOR 2N6341 (MATCHED PAIR)	3508A21H04

G01 - FOR 30-70 KHZ USE C1, C2, C3, C4 = .47 UF.
 G02 - FOR 70-150 KHZ USE C2, C4 = .47 UF OMIT C1 & C3.
 G03 - FOR 150 TO 300 KHZ USE C2, C4 = .22 UF OMIT C1 & C3.

Sub. 6
 1477B47

Fig. 13 Internal Schematic Power Amplifier Module

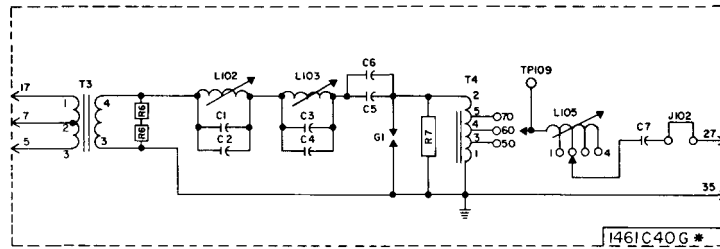


FIG. 1
30 TO 200 KC

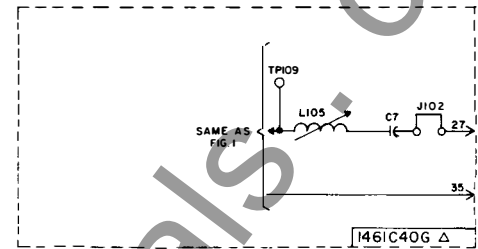


FIG. 2 (OTHERWISE SAME AS FIG. 1)
2001 TO 300 KC

* -G01 THRU G32
G43 THRU G74
Δ - G33 THRU G42
G75 THRU G84

ASSEMBLY - 146IC40
COMP LOC. - 147B28
PC B. - 146IC41

Sub. 5
146IC42
Sheet 1

Fig. 14 Internal Schematic Output Filter

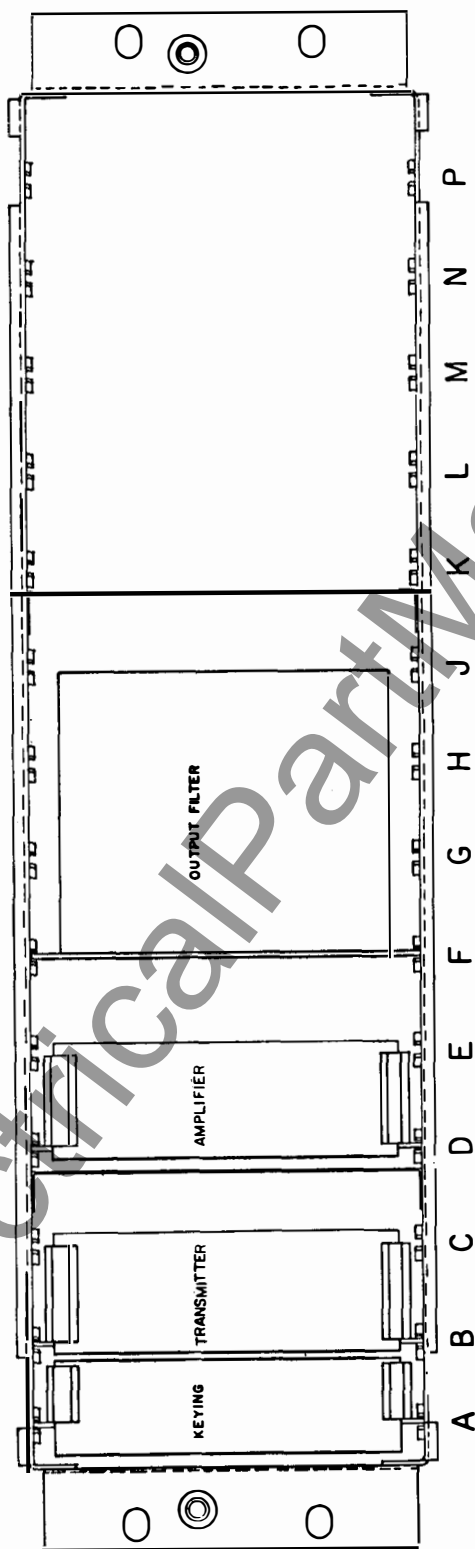
PARTS LIST

146IC40G01G43			146IC40G02G44			146IC40G03G45			146IC40G04G46		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	2500 MMF 500V	861A846H20	C1	CAPACITOR	2500 MMF 500V	861A846H20	C1	CAPACITOR	2000 MMF 500V	187A584H01
C2	CAPACITOR	2700 MMF 500V	861A846H21	C2	CAPACITOR	2000 MMF 500V	187A584H01	C2	CAPACITOR	2000 MMF 500V	187A584H01
C3	CAPACITOR	1500 MMF 500V	762A757H03	C3	CAPACITOR	1000 MMF 500V	762A757H02	C3	CAPACITOR	390 MMF 500V	762A757H15
C4	CAPACITOR	3300 MMF 500V	187A584H26	C4	CAPACITOR	3300 MMF 500V	187A584H26	C4	CAPACITOR	3300 MMF 500V	187A584H26
C5	CAPACITOR	4000 MMF 1200V	187A705H15	C5	CAPACITOR	2500 MMF 1200V	187A705H13	C5	CAPACITOR	2500 MMF 1200V	187A705H13
C6	CAPACITOR	4000 MMF 1200V	187A705H15	C6	CAPACITOR	5000 MMF 1200V	187A705H16	C6	CAPACITOR	4000 MMF 1200V	187A705H15
C7	CAPACITOR	7000 PF 3000V	203C872H25	C7	CAPACITOR	6000 PF 3000V	203C872H26	C7	CAPACITOR	5500 PF 3000V	203C872H27
L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04
L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06
L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03
R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01
146IC40G05G47			146IC40G06G48			146IC40G07G49			146IC40G08G50		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	3000 MMF 500V	187A584H06	C1	CAPACITOR	2500 MMF 500V	861A846H20	C1	CAPACITOR	2000 MMF 500V	187A584H09
C2	CAPACITOR	2700 MMF 500V	187A584H01	C2	CAPACITOR	150 MMF 500V	861A846H25	C2	CAPACITOR	300 MMF 500V	187A584H01
C3	CAPACITOR	820 MMF 500V	762A757H22	C3	CAPACITOR	150 MMF 500V	861A846H25	C3	CAPACITOR	180 MMF 500V	762A757H10
C4	CAPACITOR	2000 MMF 500V	187A584H01	C4	CAPACITOR	2000 MMF 500V	187A584H01	C4	CAPACITOR	2000 MMF 500V	187A584H01
C5	CAPACITOR	2500 MMF 1200V	187A705H13	C5	CAPACITOR	200 MMF 1200V	187A705H04	C5	CAPACITOR	500 MMF 1200V	187A705H11
C6	CAPACITOR	2500 MMF 1200V	187A705H13	C6	CAPACITOR	4000 MMF 1200V	187A705H15	C6	CAPACITOR	2000 MMF 1200V	187A705H12
C7	CAPACITOR	4200 PF 3000V	203C872H25	C7	CAPACITOR	3500 PF 3000V	203C872H23	C7	CAPACITOR	3200 PF 3000V	203C872H22
L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04
L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06
L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03
R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01
146IC40G09G51			146IC40G10G52			146IC40G11G53			146IC40G12G54		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	300 MMF 500V	187A584H09	C1	CAPACITOR	82 MMF 500V	762A209H23	C1	CAPACITOR	1000 MMF 500V	762A757H02
C2	CAPACITOR	180 MMF 500V	762A757H03	C2	CAPACITOR	1500 MMF 500V	762A757H03	C2	CAPACITOR	390 MMF 500V	762A757H15
C3	CAPACITOR	180 MMF 500V	762A757H03	C3	CAPACITOR	1500 MMF 500V	762A757H03	C3	CAPACITOR	1000 MMF 500V	762A757H02
C4	CAPACITOR	1500 MMF 500V	762A757H03	C4	CAPACITOR	1500 MMF 500V	762A757H03	C4	CAPACITOR	180 MMF 500V	762A757H10
C5	CAPACITOR	2000 MMF 1200V	187A705H15	C5	CAPACITOR	3000 MMF 1200V	187A705H14	C5	CAPACITOR	3000 MMF 1200V	187A705H06
C7	CAPACITOR	2200 PF 3000V	203C872H17	C7	CAPACITOR	3500 PF 3000V	203C872H23	C7	CAPACITOR	2800 PF 3000V	203C872H20
L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04	L102	POT CORE	670B133G04
L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06	L103	POT CORE	670B133G06
L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01	L105	COIL	292B086G01
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03
R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% BW (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01	G1	LIGHTNING ARRESTER	877A16H01

1461C40G33,G75			1461C40G34,G76			1461C40G35,G77			1461C40G36,G78		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	MMF 500V	763A209H9	C1	CAPACITOR	MMF 500V	861A846H25	C1	CAPACITOR	MMF 500V	763A209H20
C2	CAPACITOR	MMF 500V	762A757H2	C2	CAPACITOR	MMF 500V	861A846H25	C2	CAPACITOR	MMF 500V	762A757H11
C3	CAPACITOR	MMF 500V	762A757H11	C3	CAPACITOR	MMF 500V	861A846H25	C3	CAPACITOR	MMF 500V	763A209H20
C4	CAPACITOR	MMF500V	763A209H12	C4	CAPACITOR	MMF 500V	763A209H19	C4	CAPACITOR	MMF 500V	762A757H07
C5	CAPACITOR	MMF1200 V	187A705H04	C5	CAPACITOR	MMF 1200 V	187A705H08	C5	CAPACITOR	MMF1200 V	187A705H08
C6	CAPACITOR	MMF1200 V	187A705H09	C6	CAPACITOR	MMF1200 V	187A705H04	C6	CAPACITOR	MMF1200 V	187A705H04
C7	CAPACITOR	PF 3000V	203C872H09	C7	CAPACITOR	PF 3000V	203C872H09	C7	CAPACITOR	PF 3000V	203C872H08
LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09
LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08
LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03
R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01

1461C40G37,G79			1461C40G38,G80			1461C40G39,G81			1461C40G40,G82			
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	
C2	CAPACITOR	MMF 500V	861A846H11	C1	CAPACITOR	MMF 500V	763A209H12	C1	CAPACITOR	MMF 500V	763A209H44	
C3	CAPACITOR	MMF 500V	861A846H25	C2	CAPACITOR	MMF 500V	762A757H11	C2	CAPACITOR	MMF 500V	861A846H25	
C4	CAPACITOR	MMF 500V	763A209H07	C3	CAPACITOR	MMF 500V	762A757H07	C3	CAPACITOR	MMF 500V	762A757H01	
C6	CAPACITOR	MMF1200 V	187A705H09	C4	CAPACITOR	MMF 500V	763A209H12	C4	CAPACITOR	MMF500V	763A209H12	
C7	CAPACITOR	PF 3000V	203C872H07	C6	CAPACITOR	MMF1200 V	187A705H09	C5	CAPACITOR	MMF1200 V	187A705H08	
LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	C7	CAPACITOR	PF 3000V	203C872H03
LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI02	POT CORE	670B133G09	
LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI03	POT CORE	670B133G08	
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	LI05	POT CORE	670B133G09	
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T3	TRANSFORMER	292B526G04	
R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	
GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	T4	TRANSFORMER	292B526G03	
GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	T4	TRANSFORMER	292B526G03	

1461C40G41,G83			1461C40G42,G84			1461C40G43,G85			1461C40G44,G86		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	MMF 500V	763A209H07	C1	CAPACITOR	MMF 500V	861A846H25	C2	CAPACITOR	MMF 500V	861A846H25
C2	CAPACITOR	MMF 500V	861A846H25	C2	CAPACITOR	MMF 500V	762A757H01	C3	CAPACITOR	MMF 500V	763A209H23
C3	CAPACITOR	MMF 500V	762A757H01	C3	CAPACITOR	MMF 500V	763A209H07	C4	CAPACITOR	MMF 500V	763A209H12
C4	CAPACITOR	MMF 500V	763A209H07	C4	CAPACITOR	MMF 500V	763A209H12	C5	CAPACITOR	MMF 500V	763A209H12
C5	CAPACITOR	MMF1200 V	187A705H08	C5	CAPACITOR	MMF1200 V	187A705H08	C5	CAPACITOR	MMF1200 V	187A705H08
C7	CAPACITOR	PF 3000V	203C872H02	C7	CAPACITOR	PF 3000V	203C872H01	C7	CAPACITOR	PF 3000V	203C872H01
LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09	LI02	POT CORE	670B133G09
LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08	LI03	POT CORE	670B133G08
LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09	LI05	POT CORE	670B133G09
T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04	T3	TRANSFORMER	292B526G04
T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03	T4	TRANSFORMER	292B526G03
R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01
GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01	GI	LIGHTNING ARRESTER	877A116H01



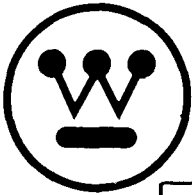
Sub. 1
1461089

Fig. 15 Module Location

WESTINGHOUSE ELECTRIC CORPORATION
RELAY-INSTRUMENT DIVISION

CORAL SPRINGS, FL.

Printed in U.S.A.



INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT TRANSMITTER EQUIPMENT 1 WATT/10 WATT FOR KEYED AND VOICE APPLICATIONS

CAUTION: It is recommended that the user of this equipment become thoroughly familiar with the information in this instruction leaflet before energizing the carrier assembly. Failure to observe this precaution may result in damage to the equipment.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The Type TCF-10 carrier transmitter equipment provides for the transmission of either of two closely controlled discrete frequencies, both within a narrow-band channel, over high-voltage transmission lines. The center frequency of the channel can vary from 30 to 300 KHz in 0.5 KHz steps. The two frequencies transmitted are separated by 200 Hz, one being at center frequency (f_c) plus 100 Hz and the others at center frequency minus 100 Hz. The higher frequency, termed the Guard frequency, is transmitted continuously when conditions are normal. It indicates at the receiving end of the line that the channel is operative and it also serves to prevent false operation of the receiver by line noise. The lower frequency, termed the Trip frequency, is transmitted as a signal that an operation (such as tripping a circuit breaker) should be performed at the receiving end of the line.

When frequency shift carrier is used in protective relaying applications, it is recommended that the trip frequency be transmitted at a higher power level to increase reliability of the system under

conditions of abnormally high channel losses or line noise. The frequency is shifted from Guard to Trip by the closing of a protective relay contact, and the same contact also shifts the transmitter from a 1-watt to a 10-watt output level.

When electro-mechanical relays are used for keying from guard to trip frequency, the contact used is connected to the high voltage input of a buffering keying board. This board buffers the input so that random noise does not key the circuits. When solid state relays are used, the 20 V D.C. voltage used for keying is connected to the low voltage input of the buffering keying board.

CONSTRUCTION

The 1 watt/10 watt TCF-10 transmitter unit is mounted on a standard 19-inch wide chassis 5 1/4 inches (3 rack units) high with edge slots for mounting on a standard relay rack. Fuses, a pilot light, and a power switch are accessible from the front of the panel. See Fig. 6. All of the circuitry that is suitable for printed circuit board mounting is on four such boards, as shown in Fig. 13. The components mounted on each printed circuit board or other sub-assembly are shown enclosed by dotted lines on the internal schematic. Fig. 2. The location of components on the four printed circuit boards are shown on separate illustrations, Fig. 3, 4, 5, & 6.

External connections to the assembly are made through a 36-circuit receptacle, J3. The r.f. output connection to the assembly is made through a coaxial cable jack, J2.

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

A module extender test card, S#1447C86G01 is available to facilitate testing.

OPERATION

The transmitter is made up of four main stages and two filters. The stages include two crystal oscillators operating at frequencies that differ by the desired channel frequency, a mixer and buffer amplifier, a driver stage and a power amplifier. One filter is located between the driver and the power amplifier and the second filter removes harmonics that may be generated by distortion in the power amplifier.

A single crystal designed for oscillation in the 30 KHz to 300 KHz range cannot be forced to oscillate away from its natural frequency by as much as ± 100 Hz. In order to obtain this desired frequency shift, it is necessary to use crystals in the 2 MHz range. The crystals are Y1 and Y2 of Fig.10. The frequency of Y2 is 2.00 MHz when operated with a specified amount of series capacity, and the frequency of Y1 is 2.00 MHz plus the channel frequency, or 2.03 MHz. Capacitor C55 and crystal Y2 in series are connected between the positive side of the supply voltage and the base of transistor Q51, which operates in the emitter follower mode. The emitter is coupled to the base through C57, and with Y2 removed the base of Q51 would be held at approximately the midpoint of the supply voltage by R51 and R52. The crystal serves as a series-resonant circuit with very high inductance and low capacitance. The circuit can be made to oscillate at other than the natural frequency of the crystal by varying the series capacitor, C55. Increasing C55 will lower the frequency of oscillations and reducing C55 will raise the frequency.

Crystal Y1 is connected in a circuit that is similar except for the addition of C53 and diodes D51 and D52. By adjustment of C52 this circuit is made to oscillate at 100 Hz above its marked frequency. Capacitor C53 is not effective until D51 is biased in the forward direction and becomes conductive. It is biased in the reverse direction until the relay control contact is closed, which places 45 V.D.C. at terminal 3 of the printed circuit board. With D51 conducting, C53 is effectively in parallel with C52, and adjustment of C53 will reduce the

frequency by 200 Hz. The crystals taken individually have a greater variation of frequency with temperature than would be acceptable. However, by proper matching of the two crystals, the variation in their difference frequency can be kept within limits that permit holding the frequency stability of the overall transmitter to ± 10 Hz over a temperature range of -20 to $\pm 60^\circ\text{C}$.

The frequencies produced by the two oscillators are coupled to the base of mixer transistor Q53 through C62 and C63. The sum of the two frequencies is so high that a negligible amount appears on the secondary of transformer T51, but the difference frequency is accepted and amplified by Q53 and Q54.

When the relay control, or keying, contact is closed, it increases the output power from 1 watt to 10 watts as well as changing the frequency from Guard to Trip. This is effected by reducing the emitter resistance of buffer-amplifier transistor Q54. When the keying contact is open, transistor Q55 receives no base current and is non-conducting. Emitter resistor R70 therefore is effectively open-circuited. The level of output power is adjusted to 1 watt by means of R64. When Q55 is made conductive by closing the keying contact. R70 is placed in parallel with R68 and the amount of emitter resistance not bypassed by C66 can be adjusted as required to obtain a 10-watt output level.

As is shown on the Internal Schematic, Fig. 1, the voltage for the keying circuit is obtained from the 45-volt regulated supply in the transmitter, and opening the single power switch deenergizes both the transmitter and the keying circuit.

The driver stage consists of transistors Q56 and Q57 connected in a conventional push-pull circuit with input supplied from the collector of Q54 through transformer T52.

The driver filter, FL101, consists of a series-resonant inductor and capacitor connected between the driver and power amplifier stages by appropriate transformers T1 and T2. This filter greatly improves the waveform of the signal applied to the power amplifier.

The power amplifier uses two series-connected power transistors, Q2 and Q4 operating as a class B push-pull amplifier with single-ended output. Diodes D2 and D4 provide protection for the base-emitter junctions of the power transistors. Zener diodes Z2 and Z4 protect the collector-emitter junctions from surges that might come in from the power line through the coaxial cable.

The output transformer T3 couples the power transistors to the output filter FL102. The output filter includes two trap circuits (L102, C_B and L103, C_C) which are factory tuned to the second and third harmonics of the transmitter frequency. Capacitor C_B approximately cancels the inductive reactance of the two trap circuits at the operating frequency. Protective gap G1 is a small lightning arrester to limit the magnitude of switching surges or other line disturbances reaching the carrier set through the line tuner and coaxial cable. Auto-transformer T4 matches the filter impedance to coaxial cables of 50, 60, or 70 ohms.

The series resonant circuit composed of L105 and C_E is tuned to the transmitter frequency, and aids in providing resistive termination for the output stage. Jack J102 is mounted on the front panel of the filter module and is used for measuring the r.f. output current of the transmitter into the coaxial cable. It should be noted that the filter contains no shunt reactive elements, thus providing a reverse impedance that is free of possible "across-the-line" resonances.

The power supply is a series-type transistorized dc voltage regulator which has a very low stand-by current drain when there is no output current demand. The Zener diode Z1 holds a constant base-to-negative voltage on the series-connected power transistor Q1. Depending on the load current, the dc voltage drop through transistor Q1 and resistors R1 and R2 varies to maintain a constant output voltage. Capacitor C3 provides a low carrier-frequency impedance across the dc output voltage. Capacitors C1 and C2 bypass r.f. or transient voltages to ground, thus preventing damage to the transistor circuits.

When keyed for voice by the voice adapter, transistor Q55 is keyed into class A operation so that its conduction can be modulated by the voice

input from the voice adapter. Potentiometer R82 is adjusted so that the nominal output of carrier is 3.25 watts (14 volts across 60 ohms). The voice input modulates the carrier through this transistor by varying the amount of conduction of Q55 so that the output power of carrier varies with the voice amplitude following the voice frequency components. Since with Q55 completely non-conducting, R64 has been set to produce a 1-watt output, maximum modulation on the side to shut off Q55 will not result in an output level of less than 1-watt carrier at any time. Also since the output level has been set at 10 watts with Q55 completely conducting by the adjustment of R70, the maximum modulation on the side of turn on of Q55 will not result in a carrier output level of greater than 10 watts at any time. Thus the modulation for voice will not result in the output carrier level dropping below 1 watt and endangering the guard frequency for relaying purposes.

The buffer keying board in addition to providing proper buffering, also contains logic for the proper keying of both frequency and output level in regards to protective relaying operation, voice adapter operation, and 52b contact operation.

It should be remembered that protective relaying operation has first priority. If the protective relay operates and puts a voltage input into any of the three input points labeled carrier auxiliary keying, the transmitter will both frequency shift to trip frequency and full 10 watts output whether voice is called for or not.

The operation of the 52b contact will remove the 10 watt keying output and permit the voice adapter to key to 3.2 Watts output for AM voice modulation. This allows voice modulation on the trip frequency after the 52b contact has operated.

CHARACTERISTICS

Frequency Range	30-300 kHz
Output	1 watt guard—10 watts trip—3.2 watts voice (into 50 to 70 ohm resistive load)
Frequency Stability	±10 Hz from -20°C to +55°C.

Frequency Spacing	Two-way channel,—See Voice Adapter Instruction Leaflet.	
Harmonics	Down 55 db (min.) from output level.	
Input Voltage	48 or 125 v.d.c.	
Supply Voltage Variation	42-56v. for nom. 48v. supply. 105-140v. for nom. 125v. supply.	
Battery Drain	0.5 a. guard	48 v.d.c.
	1.15a. trip	
	0.25 a. guard	125 v.d.c.
Keying Circuit Current	0.5 a. trip	
	4 ma.	
Temperature Range	-20 to +55°C. around chassis.	
Dimensions	Panel height—5 1/4" or 3 r.u. Panel width—19"	
Weight	12 lbs.	

INSTALLATION

The TCF-10 transmitter is generally supplied in a cabinet or on a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. The maximum ambient temperature around the chassis must not exceed 55°C.

ADJUSTMENTS

The TCF-10 1W/10W transmitter is shipped with the power output controls R64, R82 and R70, set for outputs of 1 watt, 3.2 watts and 10 watts into a 60 ohm load. If it is desired to check the adjustments or if repairs have made readjustment necessary, the coaxial cable should be disconnected from the assembly terminals and replaced with a 50 to 70 ohm non-inductive resistor of at least a 10 watt rating. Use the value of the expected input impedance of the coaxial cable and line tuner. If this is not known, assume 60 ohms. Connect the T4 out-

put lead to the corresponding tap. Connect an ac vacuum tube voltmeter (VTVM) across the load resistor. Turn power output control R64 to minimum (full counter-clockwise). Turn on the power switch on the panel and note the dc voltage across terminals 5 and 7 of J3. If this is in the range of 42 to 46 volts, rotate R64 clockwise to obtain 4 or 5 volts across the load resistor used. At this point check the adjustment of the series output tuning coil L105 by loosening the knurled shaft-locking nut and rotating the adjustable core in and out a small amount from its initial position. Leave it at the point of maximum voltage across the load resistor used. Then rotate R64 farther clockwise to obtain the correct voltage for 1 watt in the load resistor, as shown in the following table.

Then change to Trip frequency by connecting together terminals 7 and 12 of J3), and rotate R70 until the voltage across the load resistor is as shown in the following table for a 10 watt output. Recheck the adjustment of L105 for maximum output voltage and readjust R70 for a 10 watt output if necessary. Tighten the locking nut on L105. Open the power switch and remove the jumper used to key the transmitter to the 10 watt level. Key for voice by opening connection between terminals 12 and 7 of J3. This is done by removing handset from telephone hook switch of corresponding voice adapter.

Turn the power back on Adjust R82 for a 3.2 watt output across the load resistor (14V across 60 ohms). Open the power switch, remove the jumper, remove the load resistor, and reconnect the coaxial cable circuit to the transmitter.

T106 TAP	VOLTAGE FOR		
	1 WATT OUTPUT	3.2 WATTS OUTPUT	10 WATTS OUTPUT
50	7.1	12.7	22.4
60	7.8	14	24.5
70	8.4	15	26.5

Follow the procedure outlined in the line tuner instructions for its adjustment.

Normally the output filter (FL102) will require

no readjustment except as noted above. It is factory tuned for maximum second and third harmonic rejection, and for series resonance (maximum output at the fundamental frequency) with a 60-ohm load. A small amount of reactance in the transmitter output load circuit may be tuned out by readjustment of the movable core of L105. This may be necessary with some types of line coupling equipment. The adjustable cores of L102 and L103 have been set for maximum harmonic rejection and no change should be made in these settings unless suitable instruments are available for measuring the second and third harmonic present in the transmitter output.

The operating frequencies of crystals Y1 and Y2 have been carefully adjusted at the factory and good stability can be expected. If it is desired to check the frequencies of the individual crystals, this can be done by turning the matched pair 180° and inserting a crystal in its proper socket with the other crystal unconnected. A sensitive frequency counter with a range of at least 2.2 MHz can be connected from TP51 to TP54. (Connection to TP54 rather than to TP53 provides a better signal to the counter and avoids some error from the effect of the counter input capacitance on the oscillator circuit.) While measurement of the oscillator crystals individually is necessary for the initial adjustment of the oscillators, generally any subsequent checks may be made with a lower range counter connected at the transmitter output. If any minor adjustment of the Guard and Trip frequencies should be needed, the Guard adjustment should be made with capacitor C52 and the Trip Adjustment with C53.

MAINTENANCE

Periodic checks of the transmitter Guard and Trip power outputs will detect impending failure so that the equipment can be taken out of service for correction. At regular maintenance intervals, any accumulated dust should be removed, particularly from the heat sinks. It is also desirable to check the transmitter power output at such times, making any necessary readjustments to return the equipment to its initial settings.

Voltage values should be recorded after adjustment in order to establish reference values which will be useful when checking the apparatus. The readings will remain fairly constant over an indefinite period unless a failure occurs. However, if transistors are changed, there may be considerable difference in these readings without the overall performance being affected.

Typical voltage values are given in the following tables. Voltages should be measured with a VTVM. Readings may vary as much as $\pm 20\%$.

TABLE I
TRANSMITTER DC MEASUREMENTS

Note: All voltages are positive with respect to Neg. 45 V. TP51). All voltages read with dc VTVM.

Test Point	Voltage at 1 Watt Output	Voltage at 10 Watts Output	Voltage at 3.2 Watts Output		
	48V	125V	48V	125V (For Voice)	
TP52	20	20	20	20	20
TP53	5.4	5.4	5.4	5.4	5.4
TP54	3.4	3.4	3.4	3.4	3.4
TP55	21	21	18.5	18.5	—
TP56	21	21	18.5	18.5	—
TP57	* <1.0	1.0	* <1.0	1.0	—
TP58	44.3	100	44.1	100	—
TP59	* <1.0	1.0	* <1.0	1.0	—
TERM 1	0	0	0	0	—
TERM 17	21 \pm 2	50V	21 \pm 2	50V	—
TERM 31	44.3	100	44.0	100	—

TABLE II
TRANSMITTER RF MEASUREMENTS

Note: Voltages taken with transmitter set to indicated output across 60 ohms. These voltages subject to variations, depending upon frequency and transistor characteristics. T51 - 3 = Terminal 3 of transformer T51. Other transformer terminals identified similarly. All read with ac VTVM.

Test Point	Voltage at 1 watt Output	Voltage at 10 watts Output	Voltage at 3.2 Watts Output (For Voice)
TP54 to TP51	0.015 – 0.03	0.015 – 0.03	—
TP57 to TP51	0.05 – 0.09	0.3 – 1.2	—
TP59 to TP51	0.05 – 0.09	0.3 – 1.2	—
T1-1 to TP51	1.65	5.6	—
T1-3 to TP51	1.45	4.9	—
T1-4 to Gnd.	.6	2.0	—
T2-1 to Gnd.	.57	1.85	—
TERM 1 TERM 17 } <i>POWER</i>	5.2	17.0	—
TERM 17 TERM 31 } <i>AMP</i>	5.2	17.0	—
			—
T3-4 to Gnd.	35	112	—
T4-2 to Gnd.	31	110	—
TP109 to Gnd.	9.8	31	—
J102 to Gnd.	7.8	24.5	14

CONVERSION OF TRANSMITTER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a 1W/10W TCF-10 transmitter for operation on a different channel frequency consist of a pair of matched crystals for the new channel frequency, new capacitors C103 and C104 on the power amplifier circuit board if the old and new frequencies are not in the same frequency group (see table on internal schematic drawing) and, in general, new or modified filters FL101 and FL102. Inductors L101, L102 and L103 in these filters are adjustable over a limited range, but forty-two combinations of capacitors and inductors are required to cover the frequency range of 30 to 300 kHz. The widths of the frequency groups vary from 1.5 kHz at the low end of the channel frequency range to 13 kHz at the upper end. A particular assembly can be adjusted over a somewhat wider range than the width of its assigned group since some overlap is necessary to allow for component tolerances. The nominal kHz adjustment ranges of the group are:

30.0-31.5	61.0-64.0	113.0-119.5	207.1-214.0
32.0-33.5	64.5-68.0	120.0-127.0	214.1-222.0
34.0-36.0	68.5-72.0	127.5-135.0	222.1-230.0
36.5-38.5	72.5-76.0	135.5-143.0	230.1-240.0
39.0-41.0	76.5-80.0	143.5-151.0	240.1-250.0
41.5-44.0	80.5-84.5	151.5-159.5	250.1-262.0
44.5-47.0	85.0-89.0	160.0-169.5	262.1-274.0
47.5-50.0	89.5-94.5	170.0-180.0	284.1-287.0
50.5-53.5	95.0-100.0	180.5-191.5	287.1-300.0
54.0-57.0	100.5-106.0	192.0-200.0	
57.5-60.5	106.5-112.5	200.1-207.0	

If the new frequency lies within the same frequency group as the original frequency, the filters can be readjusted. If the frequencies are in different groups, it is possible that changes only in the fixed capacitors may be required. In general, however, it is desirable to order complete filter assemblies adjusted at the factory for the specified frequency.

A signal generator, a frequency counter and a vacuum tube voltmeter are required for readjustment of FL101. The signal generator and the counter should be connected across terminals 4 and 5 of transformer T1 and the voltmeter across terminals 1 and 2 of transformer T2. The signal generator should be set at the channel center frequency and at 2 to 3 volts output. The core screw of the small inductor should be turned to the position that gives a true *maximum* reading on the VTVM. Turning the screw to either side of this position should definitely reduce the reading. The change in inductance with core position is less at either end of the travel than when near the center and consequently the effect of core screw rotation on the VTVM reading will be less when the resonant inductance occurs near the end of core travel.

The procedure for readjustment of the 2nd and 3rd harmonic traps of filter FL102 is somewhat similar. A signal generator and a counter should be connected to terminals 3 and 4 of transformer T3, and a 500 ohm resistor and a VTVM to the terminals of protective gap G1. The ground or shield lead of all instruments should be connected to the grounded terminal of the transformer. Set the signal generator at exactly twice the channel center frequency and at 5 to 10 volts output. Turn the core screw of the large inductor L102, to the position that gives a definite *minimum* reading on the VTVM. Similarly, with the signal generator set at exactly three times the channel center frequency and 5 to 10 volts output, set the core screw of the small inductor, L103, to the position that gives a definite *minimum* reading on the VTVM. Then remove the instruments and the 500 ohm resistor.

After the new pair of matched crystals have been adjusted, as described under "ADJUSTMENTS", the transmitter can be operated with a 50 to 70 ohm load (depending on which tap of T4 is used) connected to its output, and inductor L105

can be readjusted for maximum output at the changed channel frequency by the procedure described in the same section.

If a frequency-sensitive voltmeter is available, the 2nd and 3rd harmonic traps may be adjusted without using an oscillator as a source of double and triple the channel frequency. Connect the frequency-sensitive voltmeter from TP109 to ground and adjust the transmitter for rated output into the selected load resistor. Set the voltmeter at twice the channel frequency and, using the tuning dial and db range switch, obtain a maximum on-scale reading of the 2nd harmonic. Then vary the core position of L102 until a minimum voltmeter reading is obtained. Similarly, tune the voltmeter to the third harmonic and adjust L103 for minimum voltmeter reading. Although the transmitter frequency will differ from the channel center frequency by 100 Hz, the effect of this difference on the adjustment of the harmonic traps will be negligible. It should be noted that the true magnitude of the harmonics cannot be measured in this manner because of the preponderance of the fundamental frequency at the voltmeter terminals. Accurate measurement of the harmonics requires use of a filter between TP109 and the voltmeter that provides high rejection of the fundamental. The insertion losses of this filter for the 2nd and 3rd harmonics must be measured and taken into account.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation.

- a. 60-ohm 10-watt non-inductive resistor.
- b. AC vacuum Tube Voltmeter (VTVM) or equivalent. Voltage range 0.003 to 30 volts, frequency range 60 hz to 330 kHz; impedance 7.5 megohms.
- c. DC Vacuum Tube Voltmeter (VTVM) or equivalent.
- d. Module Extender Test Card S 1447C86G01
- II. Desirable Test Equipment for Apparatus Maintenance.
 - a. All items listed in I.
 - b. Signal Generator
Output Voltage: up to 8 volts.
Frequency Range: 20-kHz to 900 kHz
 - c. Oscilloscope
 - d. Frequency counter
 - e. Ohmmeter
 - f. Capacitor checker.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data and identify the part by its designation on the Internal Schematic drawing.

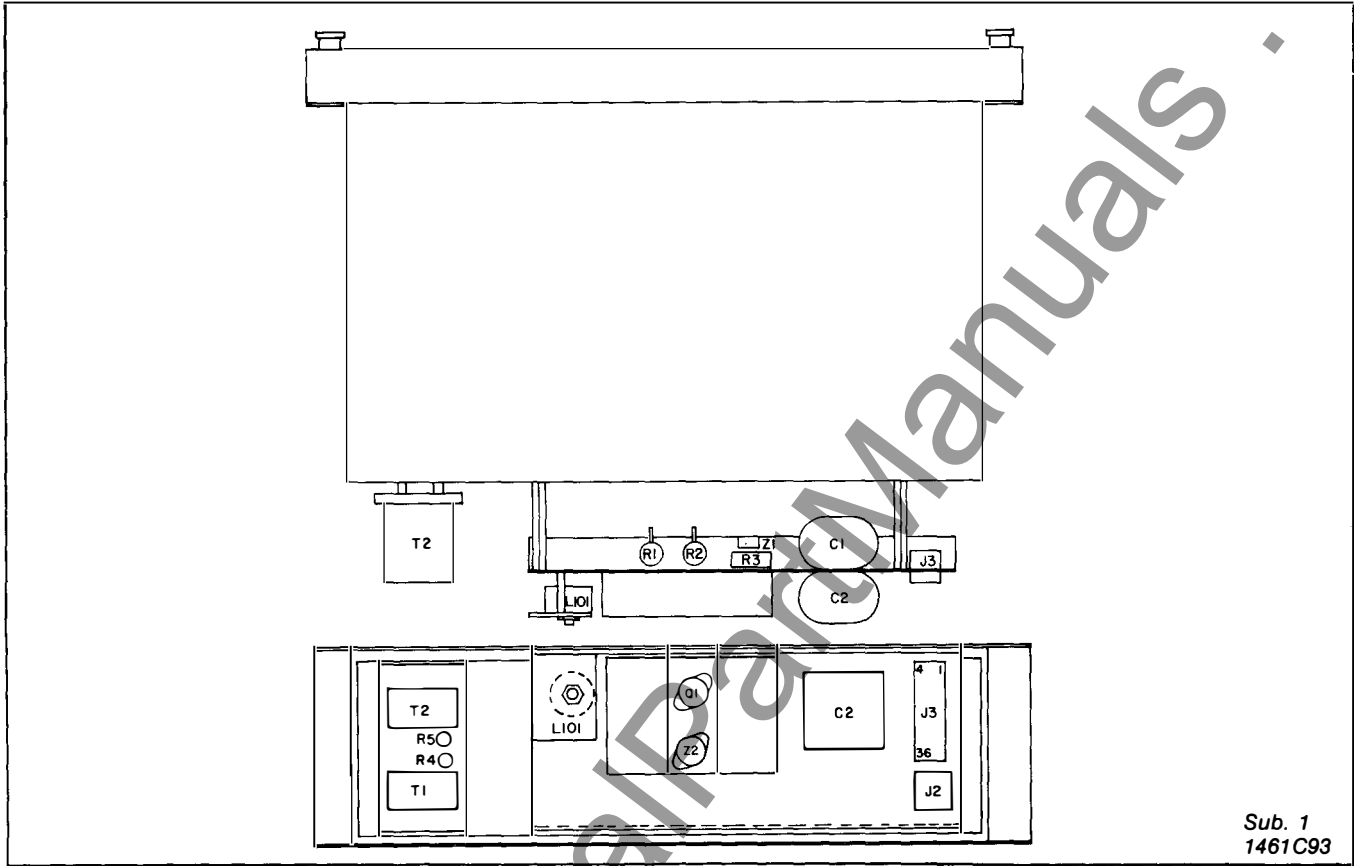


Fig. 1. Component Location of Assembly

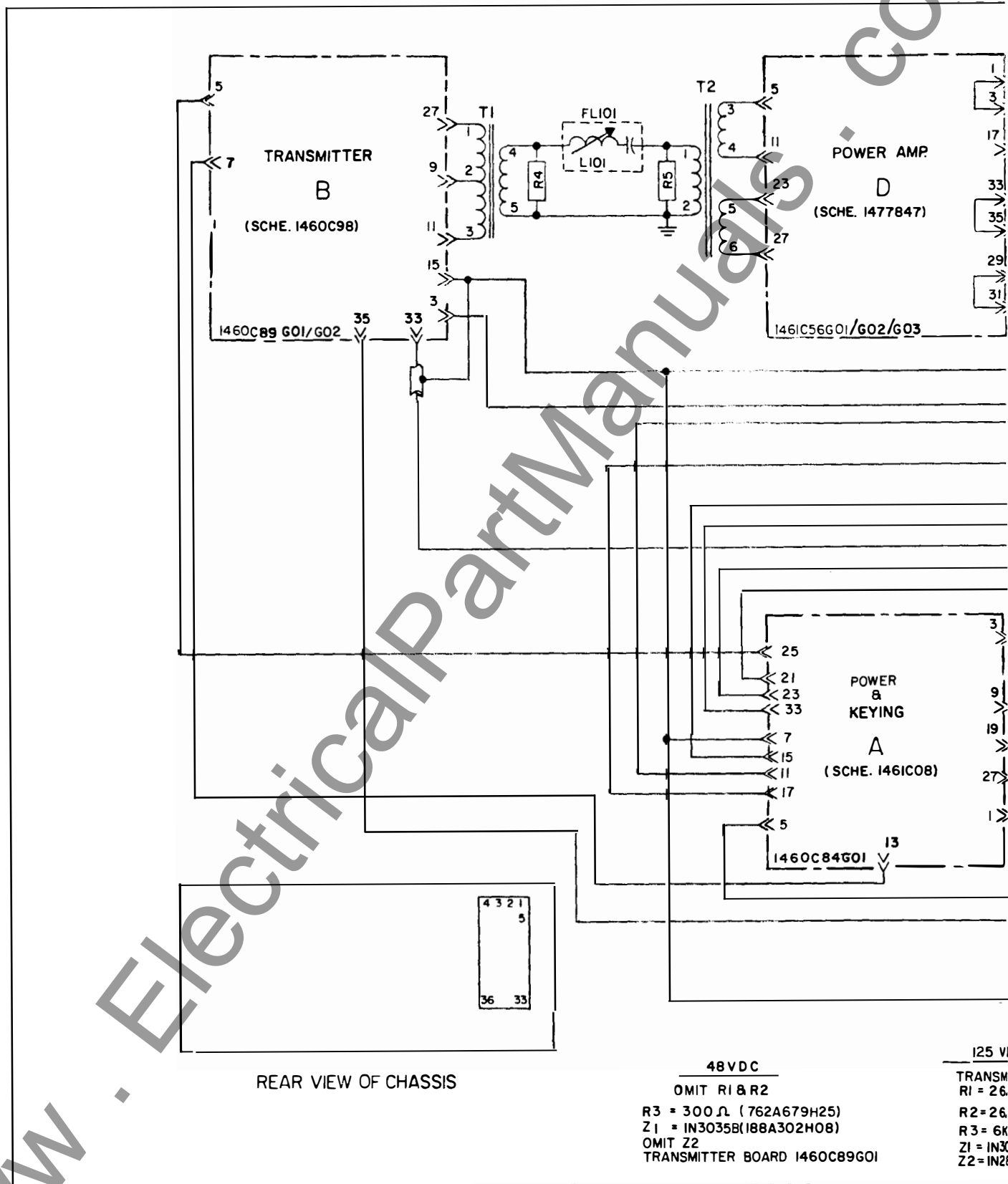
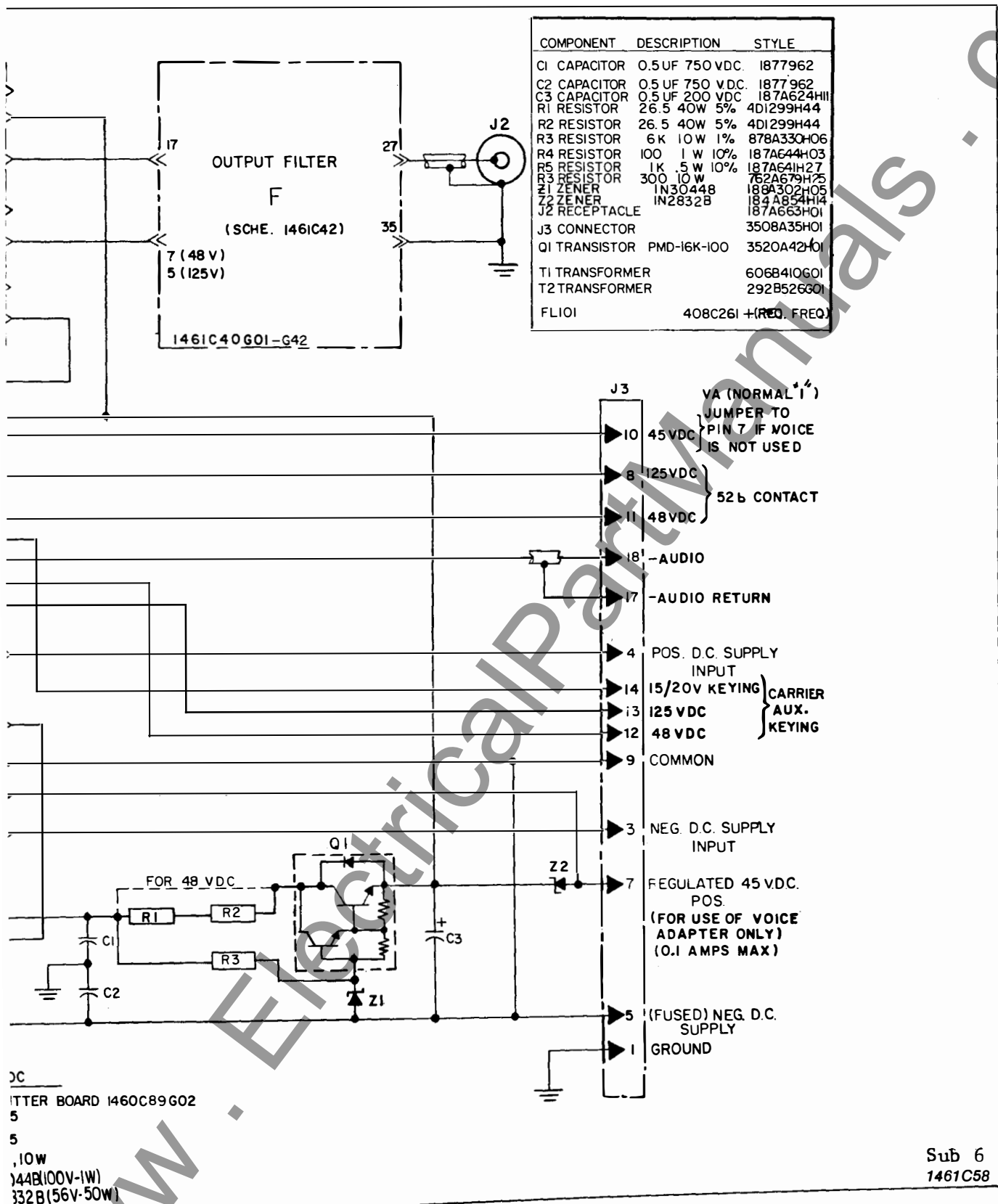
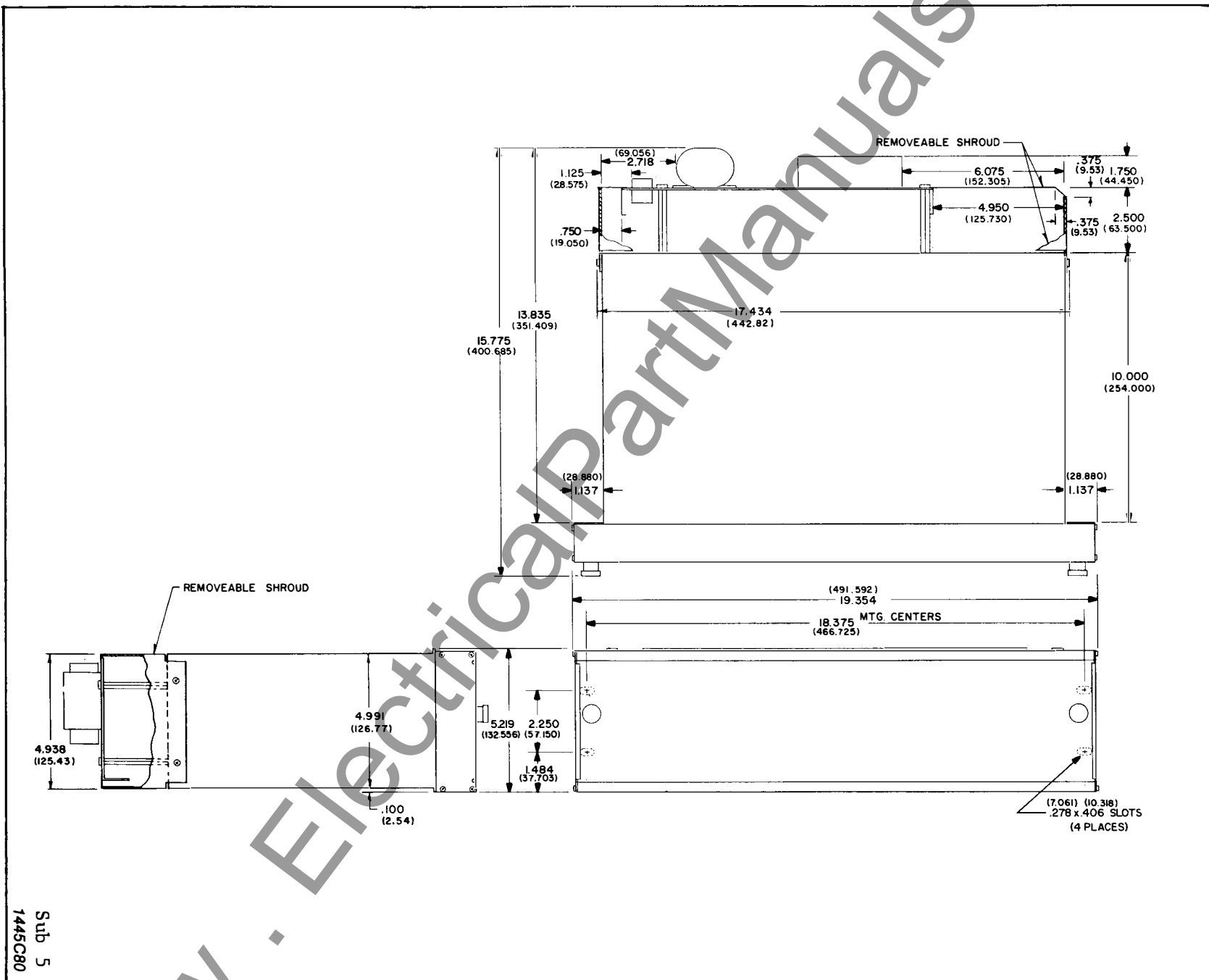


Fig. 2. Internal Schematic of Transmitter



for Keyed and Voice Applications

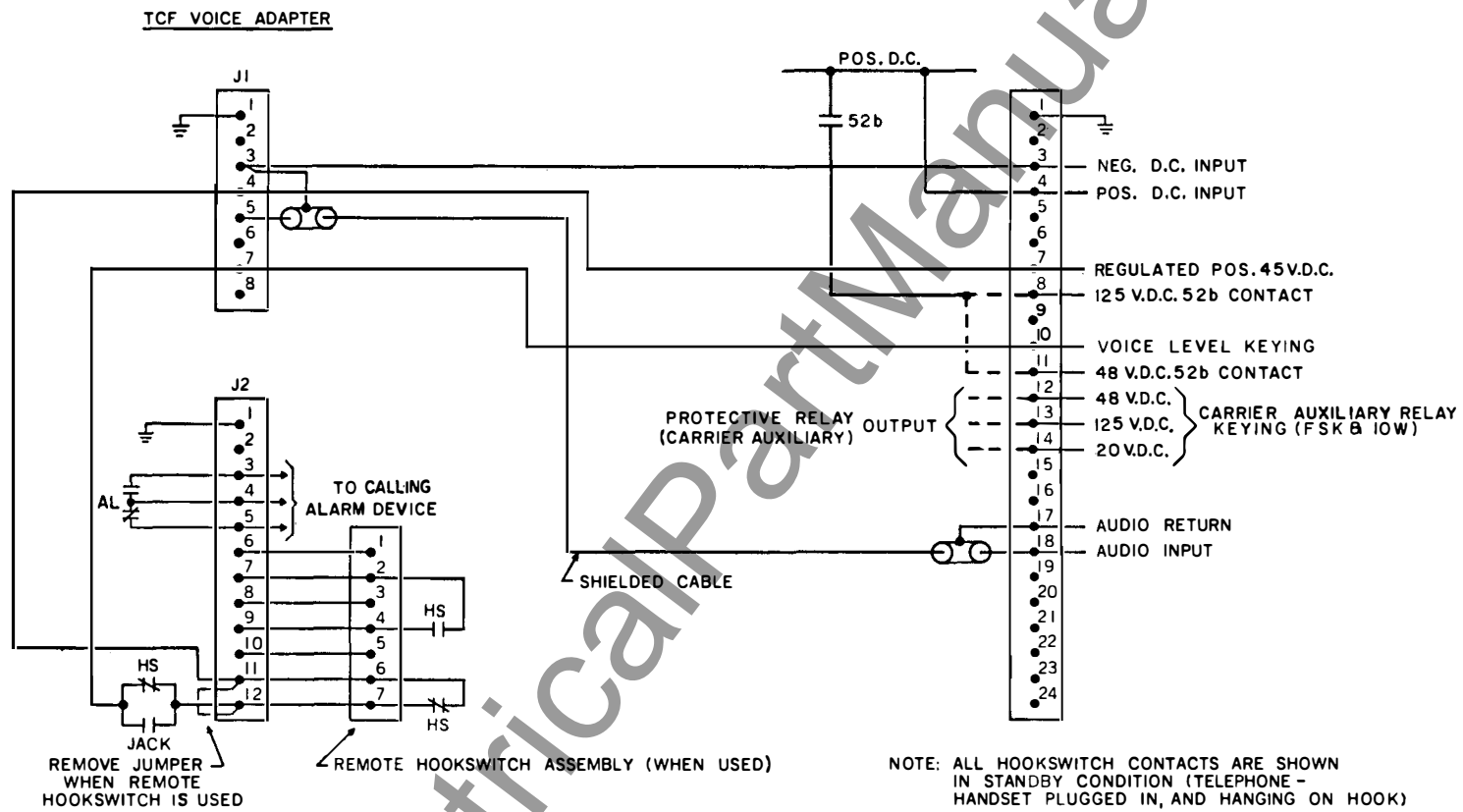
Fig. 7. Outline & Drilling for Transmitter Assembly



Sub 5
1445C80

I.L. 41-945.71

Fig. 8. Voice Adapter, Relaying & Transmitter Interconnections



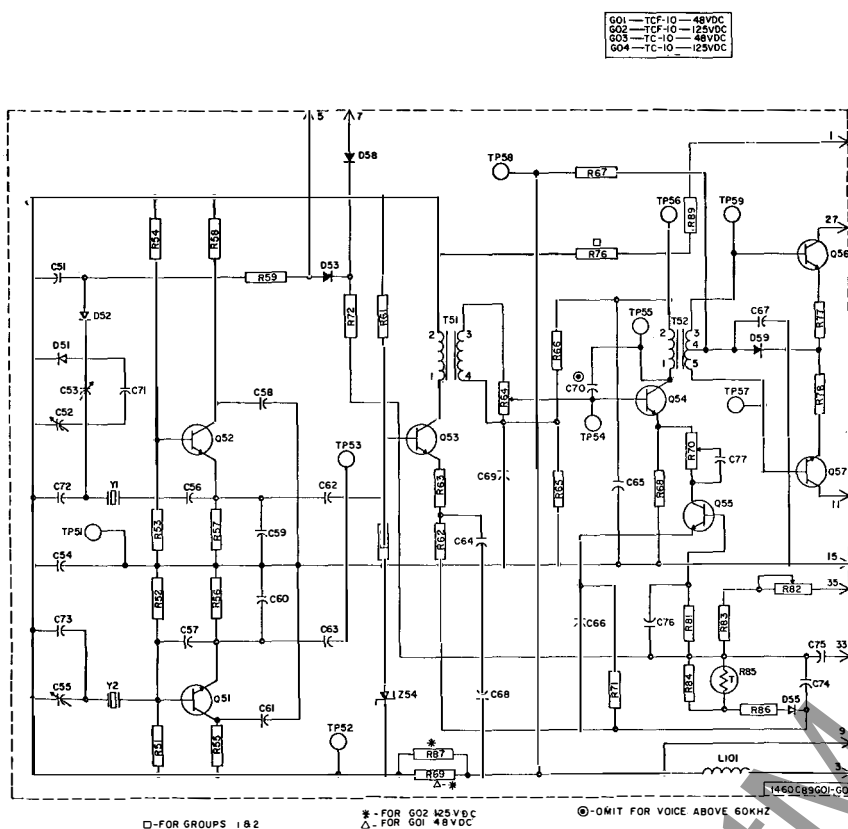
1460C84601/G02

GOI FOR 48V
G02 FOR 125V

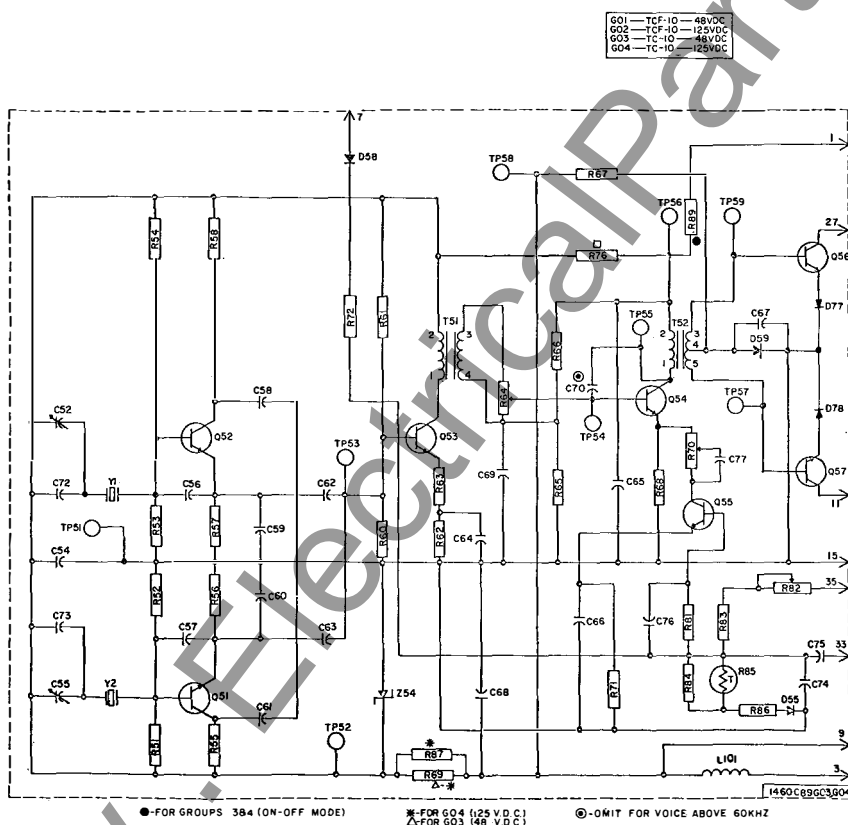
COMPONENT	
C1	CAPACI
C2	CAPACI
C3	CAPACI
D1	DIODE
D2	DIODE
D3	DIODE
D4	DIODE
D5	DIODE
D6	DIODE
J1	JU-4PER
J2	JU-4PER
R1	RESIST
R2	RESIST
R3	RESIST
R4	RESIST
R5	RESIST
R6	RESIST
R7	RESIST
R8	RESIST
R9	RESIST
R10	RESIST
R11	RESIST
R12	RESIST
R13	RESIST
R14	RESIST
R15	RESIST
R16	RESIST
R17	RESIST
R18	RESIST
R19	RESIST
R20	RESIST
R21	RESIST
R22	RESIST
R23	RESIST
R24	RESIST
R25	RESIST
R26	RESIST
R27	RESIST
R28	RESIST
R29	RESIST
R30	RESIST
R31	RESIST
R32	RESIST
R33	RESIST
R34	RESIST
R35	RESIST
Q1	TRANSI
Q2	TRANSI
Q3	TRANSI
Q4	TRANSI
Q5	TRANSI
Q6	TRANSI
Q7	TRANSI
Q8	TRANSI
Q9	TRANSI
Z1	ZENER
Z2	ZENER
Z3	ZENER
Z4	ZENER
Z5	ZENER
Z6	ZENER
F1	FUSE
F2	FUSE
S1	SWITCH

COMPONENT	DESCRIPTION	STYLE NO.
C1	CAPACITOR .047UF 200V	84Y4A31404
C2	CAPACITOR .047UF	84A1A431404
C3	CAPACITOR .047UF 200V	84Y4A14104
D1	DIODE 1N457A	184A855H07
D2	DIODE 1N645A	837A629H03
D3	DIODE 1N645A	837A629H03
D4	DIODE 1N457A	184A855H07
D5	DIODE 1N457A	184A855H07
D6	DIODE LEO	3508A22H02
J1	JUMPER 0 OHM RESISTOR	862A478H01
J2	JUMPER 0 OHM RESISTOR	862A478H01
R1	RESISTOR 18.0K .50W .25	62Y4531H62
R2	RESISTOR 51.0K .50W .25	62Y4531H73
R3	RESISTOR 1800.0 .50W .25	62Y4531H3B
R4	RESISTOR 18.0K .50W .25	62Y4531H62
R5	RESISTOR 51.0K .50W .25	62Y4531H73
R6	RESISTOR 18.0K .50W .25	62Y4531H62
R7	RESISTOR 1500.0 .50W .25	62Y4531H3B
R8	RESISTOR 6200.0 .50W .25	62Y4531H51
R9	RESISTOR 6200.0 .50W .25	62Y4531H51
R10	RESISTOR 1500.0 .50W .25	62Y4531H3B
R11	RESISTOR 6200.0 .50W .25	62Y4531H51
R12	RESISTOR 1500.0 .50W .25	62Y4531H3B
R13	RESISTOR 10.0K .50W .25	62Y4531H56
R14	RESISTOR 10.0K .50W .25	62Y4531H56
R15	RESISTOR 12.0K .50W .25	62Y4531H56
R16	RESISTOR 27.0K .50W .25	62Y4531H66
R17	RESISTOR 12.0K .50W .25	62Y4531H56
R18	RESISTOR 27.0K .50W .25	62Y4531H66
R19	RESISTOR 27.0K .50W .25	62Y4531H66
R20	RESISTOR 10.0K .50W .25	62Y4531H56
R21	RESISTOR 10.0K .50W .25	62Y4531H56
R22	RESISTOR 12.0K .50W .25	62Y4531H56
R23	RESISTOR 4.7K .50W .25	62Y4531H48
R24	RESISTOR 12.0K .50W .25	62Y4531H56
R25	RESISTOR 12.0K .50W .25	62Y4531H56
R26	RESISTOR 27.0K .50W .25	62Y4531H66
R27	RESISTOR 12.0K .50W .25	62Y4531H56
R28	RESISTOR 10.0K .50W .25	62Y4531H56
R29	RESISTOR 4.7K .50W .25	62Y4531H48
R30	RESISTOR 12.0K .50W .25	62Y4531H56
R31	RESISTOR 12.0K .50W .25	62Y4531H56
R32	RESISTOR 10.0K .50W .25	62Y4531H56
R33	RESISTOR 12.0K .50W .25	62Y4531H56
R34	RESISTOR 4.7K .50W .25	62Y4531H48
R35	RESISTOR 12.0K .50W .25	62Y4531H56
R35	RESISTOR 27.5K 3.00W .5%	763A126H60
Q1	TRANSISTOR 2N699	184A638H19
Q2	TRANSISTOR 2N699	184A638H19
Q3	TRANSISTOR 2N3645	84Y4A41H01
Q4	TRANSISTOR 2N699	184A638H19
Q5	TRANSISTOR 2N699	184A638H19
Q6	TRANSISTOR 2N699	184A638H19
Q7	TRANSISTOR 2N3645	84Y4A41H01
Q8	TRANSISTOR 2N699	184A638H19
Q9	TRANSISTOR 2N3645	84Y4A41H01
Z1	ZENER 1N3668B 20.0V	185A212H06
Z2	ZENER 1N3668B 20.0V	185A212H06
Z3	ZENER 1N3668B 20.0V	185A212H06
Z4	ZENER 1N3668B 20.0V	185A212H06
Z5	ZENER 1N957B 6.8V	186A797H06
Z6	ZENER 1N957B 6.8V	186A797H06
F1	FUSE 1.5 AMP	183A98BH23
F2	FUSE 1.5 AMP	183A98BH23
S1	SWITCH	84Y4A29H93

GO1 FOR 48V
GO2 FOR 125V



COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR 1500.000PF 500V	762A75TH03
C54	CAPACITOR 100UF 200V	187A624H01
C56	CAPACITOR 2000.000PF 500V	187A584H01
C57	CAPACITOR 2000.000PF 500V	187A584H01
C58	CAPACITOR 250UF 200V	187A624H02
C59	CAPACITOR 100.000PF 500V	762A75TH01
C60	CAPACITOR 100.000PF 500V	762A75TH01
C61	CAPACITOR 250UF 200V	187A624H02
C62	CAPACITOR 1000.000PF 500V	762A75TH04
C63	CAPACITOR 1000.000PF 500V	762A75TH02
C64	CAPACITOR 250UF 200V	187A624H02
C65	CAPACITOR 250UF 200V	187A624H02
C66	CAPACITOR 250UF 200V	187A624H02
C67	CAPACITOR 250UF 200V	187A624H02
C68	CAPACITOR 500UF 200V	187A624H11
C69	CAPACITOR 250UF 200V	187A624H02
C70	CAPACITOR 300.000PF 500V	187A584H09
C71	CAPACITOR 3.000PF 500V	861A846H03
C72	CAPACITOR 1.000UF 200V	187A624H04
C73	CAPACITOR 500UF 200V	187A624H02
C74	CAPACITOR 1.000UF 200V	187A624H04
C75	CAPACITOR 500UF 200V	187A624H02
C76	CAPACITOR 100UF 600V	764A278H10
C77	CAPACITOR 470UF 200V	187A624H01
C52	TRIMMER 5.5-18PF	875A814H01
C53	TRIMMER 5.5-18PF	875A814H01
D52	DIODE 1N457A	184A855H07
D53	DIODE 1N457A	184A855H07
D54	DIODE 1N457A	184A855H07
D55	DIODE 1N457A	184A855H07
D56	DIODE 1N457A	184A855H07
D57	DIODE 1N457A	184A855H07
D58	DIODE 1N457A	184A855H07
D59	DIODE 1N457A	184A855H07
Y1	CRYSTAL 184A855H07	184A855H07
Y2	CRYSTAL 184A855H07	184A855H07
L101	CHOKER 507.5% 3000A27H01	3000A27H01
R51	RESISTOR 2000.0 50W 5% 187A734H14	187A734H14
R52	RESISTOR 1.0K 12V 629A43H02	629A43H02
R53	RESISTOR 1.0K 12V 629A43H02	629A43H02
R54	RESISTOR 25.0K 50W 5% 629A43H02	629A43H02
R55	RESISTOR 7.5K 3W 5% 763A126H55	763A126H55
R56	RESISTOR 7.5K 3W 5% 763A126H55	763A126H55
R57	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R58	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R59	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R60	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R61	RESISTOR 100.0 50W 5% 184A734H15	184A734H15
R62	RESISTOR 3600.0 50W 5% 184A734H15	184A734H15
R63	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R64	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R65	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R66	RESISTOR 15.0K 50W 5% 184A734H15	184A734H15
R67	RESISTOR 200.0 50W 5% 629A43H02	629A43H02
R68	RESISTOR 230.0 50W 5% 184A734H15	184A734H15
R69	RESISTOR 80.0 3.00W 5% 184A734H15	184A734H15
R70	RESISTOR 1.0K 12V 629A43H02	629A43H02
R71	RESISTOR 5600.0 50W 5% 184A734H15	184A734H15
R72	RESISTOR 2000.0 50W 5% 184A734H15	184A734H15
R73	RESISTOR 2.7 1.00W 5% 629A43H02	629A43H02
R74	RESISTOR 1000.0 50W 5% 184A734H15	184A734H15
R75	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R76	RESISTOR 27.0 50W 5% 184A734H15	184A734H15
R77	RESISTOR 10.0 50W 5% 184A734H15	184A734H15
T51	TRANSFORMER 2N697	2N697
T52	TRANSFORMER 2N697	2N697
T53	TRANSFORMER 2N697	2N697
T54	TRANSFORMER 2N697	2N697
T55	TRANSFORMER 2N697	2N697
T56	TRANSFORMER 2N697	2N697
T57	TRANSFORMER 2N697	2N697
T58	TRANSFORMER 2N697	2N697
T59	TRANSFORMER 2N697	2N697
T60	TRANSFORMER 2N697	2N697
T61	TRANSFORMER 2N697	2N697
T62	TRANSFORMER 2N697	2N697
T63	TRANSFORMER 2N697	2N697
T64	TRANSFORMER 2N697	2N697
T65	TRANSFORMER 2N697	2N697
T66	TRANSFORMER 2N697	2N697
T67	TRANSFORMER 2N697	2N697
T68	TRANSFORMER 2N697	2N697
T69	TRANSFORMER 2N697	2N697
T70	TRANSFORMER 2N697	2N697
T71	TRANSFORMER 2N697	2N697
T72	TRANSFORMER 2N697	2N697
T73	TRANSFORMER 2N697	2N697
T74	TRANSFORMER 2N697	2N697
T75	TRANSFORMER 2N697	2N697
T76	TRANSFORMER 2N697	2N697
T77	TRANSFORMER 2N697	2N697
T78	TRANSFORMER 2N697	2N697
T79	TRANSFORMER 2N697	2N697
T80	TRANSFORMER 2N697	2N697
T81	TRANSFORMER 2N697	2N697
T82	TRANSFORMER 2N697	2N697
T83	TRANSFORMER 2N697	2N697
T84	TRANSFORMER 2N697	2N697
T85	TRANSFORMER 2N697	2N697
T86	TRANSFORMER 2N697	2N697
T87	TRANSFORMER 2N697	2N697
T88	TRANSFORMER 2N697	2N697
T89	TRANSFORMER 2N697	2N697
T90	TRANSFORMER 2N697	2N697
T91	TRANSFORMER 2N697	2N697
T92	TRANSFORMER 2N697	2N697
T93	TRANSFORMER 2N697	2N697
T94	TRANSFORMER 2N697	2N697
T95	TRANSFORMER 2N697	2N697
T96	TRANSFORMER 2N697	2N697
T97	TRANSFORMER 2N697	2N697
T98	TRANSFORMER 2N697	2N697
T99	TRANSFORMER 2N697	2N697
T100	TRANSFORMER 2N697	2N697



COMPONENT	DESCRIPTION	STYLE NO.
C54	CAPACITOR 100UF 200V	187A624H01
C56	CAPACITOR 2000.000PF 500V	187A584H01
C57	CAPACITOR 2000.000PF 500V	187A584H01
C58	CAPACITOR 250UF 200V	187A624H02
C59	CAPACITOR 100.000PF 500V	762A75TH01
C60	CAPACITOR 100.000PF 500V	762A75TH01
C61	CAPACITOR 250UF 200V	187A624H02
C62	CAPACITOR 1000.000PF 500V	762A75TH04
C63	CAPACITOR 1000.000PF 500V	762A75TH02
C64	CAPACITOR 250UF 200V	187A624H02
C65	CAPACITOR 250UF 200V	187A624H02
C66	CAPACITOR 250UF 200V	187A624H02
C67	CAPACITOR 250UF 200V	187A624H02
C68	CAPACITOR 500UF 200V	187A624H11
C69	CAPACITOR 250UF 200V	187A624H02
C70	CAPACITOR 300.000PF 500V	187A584H09
C72	CAPACITOR 3.000PF 500V	861A846H03
C73	CAPACITOR 1.000UF 200V	187A624H04
C74	CAPACITOR 500UF 200V	187A624H02
C75	CAPACITOR 1.000UF 200V	187A624H04
C76	CAPACITOR 500UF 200V	187A624H02
C77	CAPACITOR 470UF 200V	187A624H01
C52	TRIMMER 5.5-18PF	875A814H01
C53	TRIMMER 5.5-18PF	875A814H01
D55	DIODE 1N457A	184A855H07
D56	DIODE 1N457A	184A855H07
D57	DIODE 1N457A	184A855H07
D58	DIODE 1N457A	184A855H07
D59	DIODE 1N457A	184A855H07
Y1	CRYSTAL 184A855H07	184A855H07
Y2	CRYSTAL 184A855H07	184A855H07
L101	CHOKER 507.5% 3000A27H01	3000A27H01
R51	RESISTOR 2000.0 50W 5% 187A734H14	187A734H14
R52	RESISTOR 1.0K 12V 629A43H02	629A43H02
R53	RESISTOR 1.0K 12V 629A43H02	629A43H02
R54	RESISTOR 25.0K 50W 5% 629A43H02	629A43H02
R55	RESISTOR 7.5K 3W 5% 763A126H55	763A126H55
R56	RESISTOR 7.5K 3W 5% 763A126H55	763A126H55
R57	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R58	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R59	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R60	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R61	RESISTOR 100.0 50W 5% 184A734H15	184A734H15
R62	RESISTOR 3600.0 50W 5% 184A734H15	184A734H15
R63	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R64	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R65	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R66	RESISTOR 15.0K 50W 5% 184A734H15	184A734H15
R67	RESISTOR 200.0 50W 5% 629A43H02	629A43H02
R68	RESISTOR 230.0 50W 5% 184A734H15	184A734H15
R69	RESISTOR 80.0 3.00W 5% 184A734H15	184A734H15
R70	RESISTOR 1.0K 12V 629A43H02	629A43H02
R71	RESISTOR 5600.0 50W 5% 184A734H15	184A734H15
R72	RESISTOR 2000.0 50W 5% 184A734H15	184A734H15
R73	RESISTOR 2.7 1.00W 5% 629A43H02	629A43H02
R74	RESISTOR 1000.0 50W 5% 184A734H15	184A734H15
R75	RESISTOR 10.0K 50W 5% 184A734H15	184A734H15
R76	RESISTOR 27.0 50W 5% 184A734H15	184A734H15
R77	RESISTOR 10.0 50W 5% 184A734H15	184A734H15
T51	TRANSFORMER 2N697	2N697
T52	TRANSFORMER 2N697	2N697
T53	TRANSFORMER 2N697	2N697
T54	TRANSFORMER 2N697	2N697
T55	TRANSFORMER 2N697	2N697
T56	TRANSFORMER 2N697	2N697
T57	TRANSFORMER 2N697	2N697
T58	TRANSFORMER 2N697	2N697
T59	TRANSFORMER 2N697	2N697
T60	TRANSFORMER 2N697	2N697
T61	TRANSFORMER 2N697	2N697
T62	TRANSFORMER 2N697	2N697
T63	TRANSFORMER 2N697	2N697
T64	TRANSFORMER 2N697	2N697
T65	TRANSFORMER 2N697	2N697
T66	TRANSFORMER 2N697	2N697
T67	TRANSFORMER 2N697	2N697
T68	TRANSFORMER 2N697	2N697
T69	TRANSFORMER 2N697	2N697
T70	TRANSFORMER 2N697	2N697
T71	TRANSFORMER 2N697	2N697
T72	TRANSFORMER 2N697	2N697
T73	TRANSFORMER 2N697	2N697
T74	TRANSFORMER 2N697	2N697
T75	TRANSFORMER 2N697	2N697
T76	TRANSFORMER 2N697	2N697
T77	TRANSFORMER 2N697	2N697
T78	TRANSFORMER 2N697	2N697
T79	TRANSFORMER 2N697	2N697
T80	TRANSFORMER 2N697	2N697
T81	TRANSFORMER 2N697	2N697
T82	TRANSFORMER 2N697	2N697
T83	TRANSFORMER 2N697	2N697
T84	TRANSFORMER 2N697	2N697
T85	TRANSFORMER 2N697	2N697
T86	TRANSFORMER 2N697	2N697
T87	TRANSFORMER 2N697	2N697
T88	TRANSFORMER 2N697	2N697
T89	TRANSFORMER 2N697	2N697
T90	TRANSFORMER 2N697	2N697
T91	TRANSFORMER 2N697	2N697
T92	TRANSFORMER 2N697	2N697
T93	TRANSFORMER 2N697	2N697
T94	TRANSFORMER 2N697	2N697
T95	TRANSFORMER 2N697	2N697
T96	TRANSFORMER 2N697	2N697
T97	TRANSFORMER 2N697	2N697
T98	TRANSFORMER 2N697	2N697
T99	TRANSFORMER 2N697	2N697
T100	TRANSFORMER 2N697	2N697

Fig. 10. Internal Schematic Transmitter Module

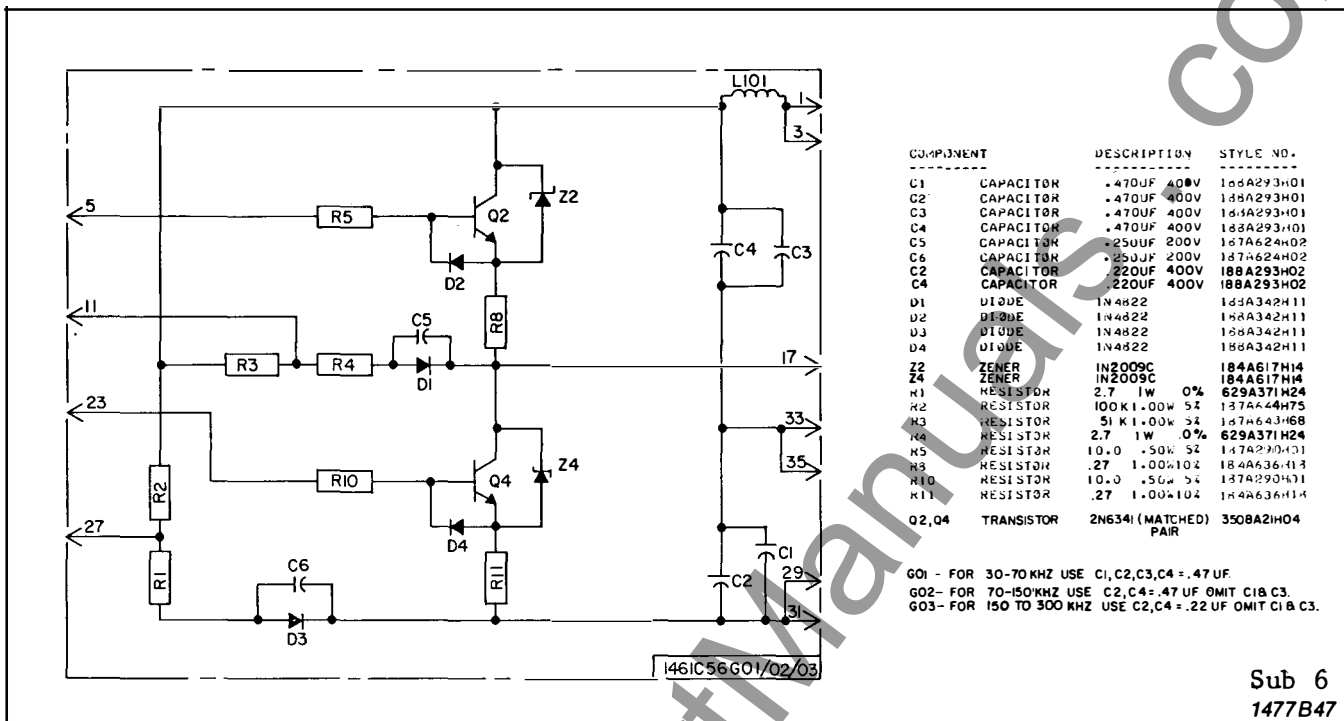


Fig. 11. Internal Schematic Power Amplifier Module

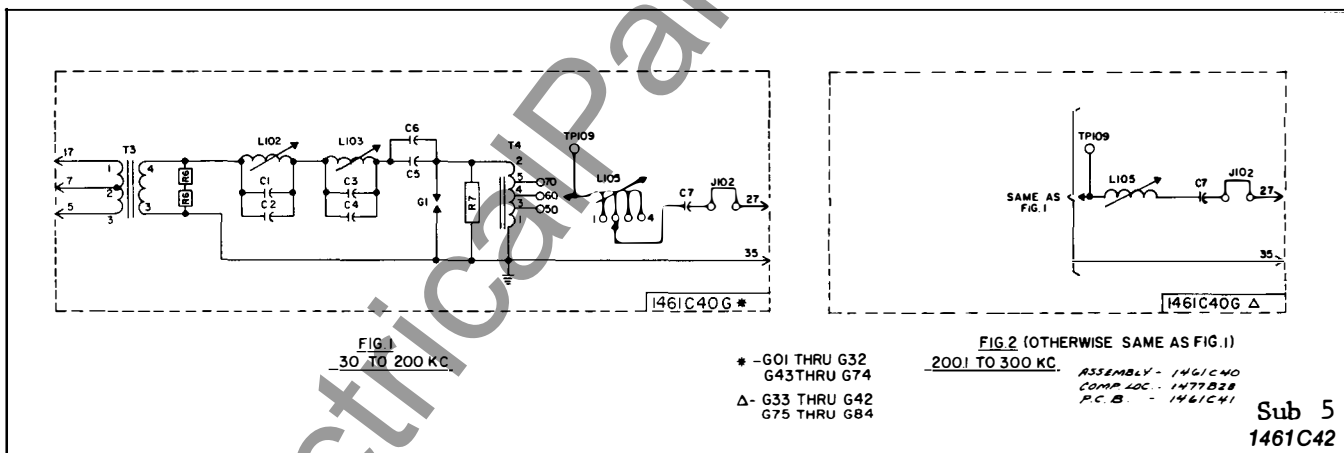
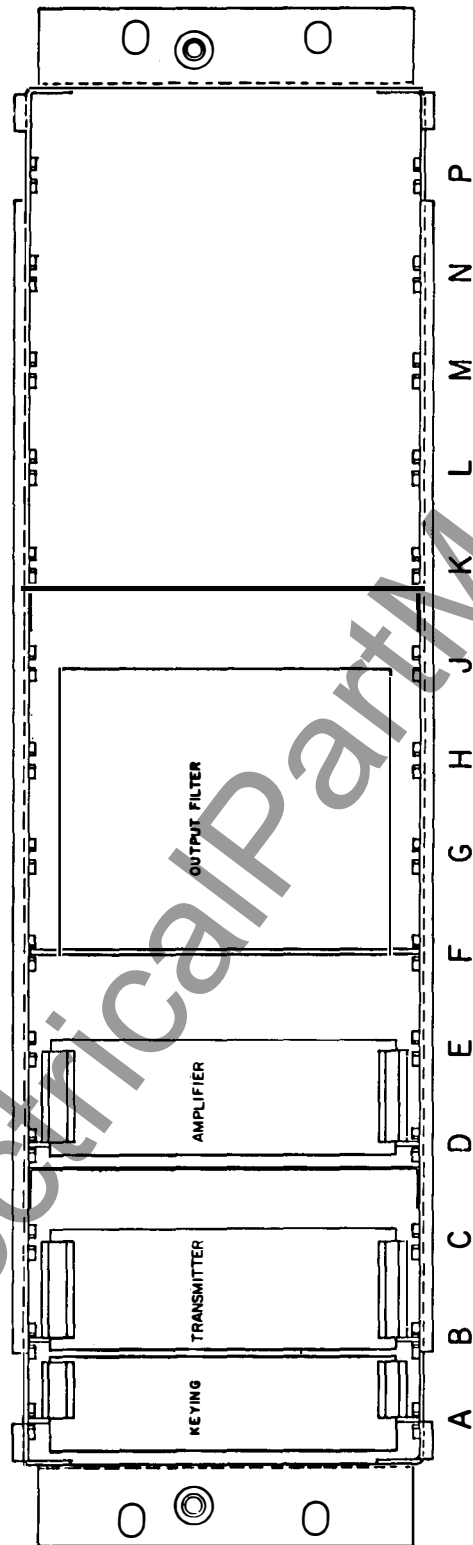


Fig. 12. Internal Schematic Output Filter Module

PARTS LIST

1461C40G01,G43			1461C40G02,G44			1461C40G03,G45			1461C40G04,G46		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1	CAPACITOR	2500 MMF 500V	861A846H20	C1	CAPACITOR	2500 MMF 500V	861A846H20	C1	CAPACITOR	2000 MMF 500V	187A584H01
C2	CAPACITOR	2700 MMF 500V	861A846H21	C2	CAPACITOR	2000 MMF 500V	187A584H01	C2	CAPACITOR	2000 MMF 500V	187A584H01
C3	CAPACITOR	1500 MMF 500V	762A757H03	C3	CAPACITOR	1000 MMF 500V	762A757H02	C3	CAPACITOR	390 MMF 500V	762A757H05
C4	CAPACITOR	3300 MMF 500V	187A584H26	C4	CAPACITOR	3300 MMF 500V	187A584H26	C4	CAPACITOR	3300 MMF 500V	187A584H26
C5	CAPACITOR	4000 MMF 1200V	187A705H15	C5	CAPACITOR	2500 MMF 1200V	187A705H13	C5	CAPACITOR	2500 MMF 1200V	187A705H13
C6	CAPACITOR	4000 MMF 1200V	187A705H15	C6	CAPACITOR	5000 MMF 1200V	187A705H16	C6	CAPACITOR	4000 MMF 1200V	187A705H13
C7	CAPACITOR	7000 PF 3000V	202C872H25	C7	CAPACITOR	6000 PF 3000V	202C872H28	C7	CAPACITOR	5500 PF 3000V	203C872H27
L102	POT CORE	670B133G04		L102	POT CORE	670B133G04		L102	POT CORE	670B133G04	
L103	POT CORE	670B133G06		L103	POT CORE	670B133G06		L103	POT CORE	670B133G06	
L105	COIL	292B086G01		L105	COIL	292B086G01		L105	COIL	292B086G01	
T3	TRANSFORMER	292B526G04		T3	TRANSFORMER	292B526G04		T3	TRANSFORMER	292B526G04	
T4	TRANSFORMER	292B526G03		T4	TRANSFORMER	292B526G03		T4	TRANSFORMER	292B526G03	
R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01	R6	RESISTOR	3K ± 5% 8W (2 REQ)	188A317H01
R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55	R7	RESISTOR	15K 10% 2W	187A642H55
G1	LIGHTNING ARRESTER	877A16H01		G1	LIGHTNING ARRESTER	877A16H01		G1	LIGHTNING ARRESTER	877A16H01	

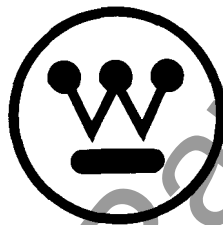
1461C40G29.G71			1461C40G30.G72			1461C40G31.G73			1461C40G32.G74		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1 CAPACITOR	180 MMF 500V	762A757H0	C1 CAPACITOR	82 MMF 500V	763A209H23	C1 CAPACITOR	300 MMF 500V	187A584H09	C1 CAPACITOR	20 MMF 500V	763A209H07
C2 CAPACITOR	200 MMF 500V	762A757H11	C2 CAPACITOR	250 MMF 500V	861A846H11	C2 CAPACITOR	150 MMF 500V	861A846H25	C2 CAPACITOR	250 MMF 500V	861A846H11
C3 CAPACITOR	200 MMF 500V	762A757H11	C3 CAPACITOR	390 MMF 500V	762A757H15	C3 CAPACITOR	200 MMF 500V	762A757H11	C3 CAPACITOR	130 MMF 500V	762A757H07
C4 CAPACITOR	250 MMF 500V	861A846H11				C4 CAPACITOR	200 MMF 500V	187A705H04	C4 CAPACITOR	180 MMF 500V	762A757H10
C5 CAPACITOR	1500 MMF 1200V	187A705H10	C5 CAPACITOR	400 MMF 1200V	137A705H08	C5 CAPACITOR	200 MMF 1200V	187A705H10	C5 CAPACITOR	1000 MMF 1200V	187A705H10
C7 CAPACITOR	900 PF 3000V	203C872H06	C7 CAPACITOR	750 PF 3000V	203C872H04	C7 CAPACITOR	650 PF 3000V	203C872H02	C7 CAPACITOR	600 PF 3000V	203C872H02
L102 POT CORE		670B133G05	L102 POT CORE		670B133G05	L102 POT CORE		670B133G05	L102 POT CORE		670B133G05
L103 POT CORE		670B133G07	L103 POT CORE		670B133G07	L103 POT CORE		670B133G07	L103 POT CORE		670B133G07
L105 COIL		292B086G01	L105 COIL		292B086G01	L105 COIL		292B086G01	L105 COIL		292B086G01
T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04
T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03
R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01
R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55
G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01
1461C40G33.G75			1461C40G34.G76			1461C40G35.G77			1461C40G36.G78		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C1 CAPACITOR	MMF 500V	763A209H19	C1 CAPACITOR	MMF 500V	187A584H09	C1 CAPACITOR	MMF 500V	861A846H25	C1 CAPACITOR	MMF 500V	763A209H20
C2 CAPACITOR	MMF 500V	762A757H12	C2 CAPACITOR	MMF 500V	762A757H11	C2 CAPACITOR	MMF 500V	861A846H25	C2 CAPACITOR	MMF 500V	762A757H11
C3 CAPACITOR	MMF 500V	762A757H11	C3 CAPACITOR	MMF 500V	763A209H07	C3 CAPACITOR	MMF 500V	763A209H19	C3 CAPACITOR	MMF 500V	763A209H20
C4 CAPACITOR	MMF 500V	187A705H04	C4 CAPACITOR	MMF 1200V	187A705H09	C4 CAPACITOR	MMF 1200V	187A705H08	C4 CAPACITOR	MMF 500V	762A757H07
C5 CAPACITOR	MMF 1200V	187A705H04	C5 CAPACITOR	MMF 1200V	187A705H09	C5 CAPACITOR	MMF 1200V	187A705H04	C5 CAPACITOR	MMF 1200V	187A705H08
C6 CAPACITOR	MMF 1200V	187A705H09	C6 CAPACITOR	MMF 1200V	187A705H09	C6 CAPACITOR	MMF 1200V	187A705H04	C6 CAPACITOR	MMF 1200V	187A705H04
C7 CAPACITOR	PF 3000V	203C872H09	C7 CAPACITOR	PF 3000V	203C872H09	C7 CAPACITOR	PF 3000V	203C872H08	C7 CAPACITOR	PF 3000V	203C872H08
L102 POT CORE		670B133G09	L102 POT CORE		670B133G09	L102 POT CORE		670B133G09	L102 POT CORE		670B133G09
L103 POT CORE		670B133G08	L103 POT CORE		670B133G08	L103 POT CORE		670B133G08	L103 POT CORE		670B133G08
L105 POT CORE		670B133G09	L105 POT CORE		670B133G09	L105 POT CORE		670B133G09	L105 POT CORE		670B133G09
T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04
T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03
R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01
R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55
G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01
1461C40G37.G79			1461C40G38.G80			1461C40G39.G81			1461C40G40.G82		
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE
C2 CAPACITOR	MMF 500V	861A846H11	C1 CAPACITOR	MMF 500V	763A209H12	C1 CAPACITOR	MMF 500V	763A209H19	C1 CAPACITOR	MMF 500V	763A209H19
C3 CAPACITOR	MMF 500V	861A846H25	C2 CAPACITOR	MMF 500V	762A757H11	C2 CAPACITOR	MMF 500V	861A846H25	C2 CAPACITOR	MMF 500V	861A846H25
C4 CAPACITOR	MMF 500V	763A209H07	C3 CAPACITOR	MMF 500V	762A757H07	C3 CAPACITOR	MMF 500V	763A209H20	C3 CAPACITOR	MMF 500V	762A757H07
C6 CAPACITOR	MMF 1200V	187A705H09	C4 CAPACITOR	MMF 500V	763A209H12	C4 CAPACITOR	MMF 500V	763A209H23	C4 CAPACITOR	MMF 500V	763A209H12
C7 CAPACITOR	PF 3000V	203C872H07	C6 CAPACITOR	MMF 1200V	187A705H09	C5 CAPACITOR	MMF 1200V	187A705H08	C5 CAPACITOR	MMF 1200V	187A705H08
L102 POT CORE		670B133G09	C7 CAPACITOR	PF 3000V	203C872H06	C7 CAPACITOR	PF 3000V	203C872H05	C7 CAPACITOR	PF 3000V	203C872H03
L103 POT CORE		670B133G08	L102 POT CORE		670B133G09	L102 POT CORE		670B133G09	L102 POT CORE		670B133G09
L105 POT CORE		670B133G09	L103 POT CORE		670B133G08	L103 POT CORE		670B133G08	L103 POT CORE		670B133G08
T3 TRANSFORMER		292B526G04	L105 POT CORE		670B133G09	L105 POT CORE		670B133G09	L105 POT CORE		670B133G09
T4 TRANSFORMER		292B526G03	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04	T3 TRANSFORMER		292B526G04
R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03	T4 TRANSFORMER		292B526G03
R7 RESISTOR	15K 10% 2W	187A642H55	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01
G1 LIGHTNING ARRESTER		877A116H01	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55	R7 RESISTOR	15K 10% 2W	187A642H55
			G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01	G1 LIGHTNING ARRESTER		877A116H01
1461C40G41.G83			1461C40G42.G84								
COMPONENT	DESCRIPTION	STYLE	COMPONENT	DESCRIPTION	STYLE						
C1 CAPACITOR	MMF 500V	763A209H07	C2 CAPACITOR	MMF 500V	861A846H25						
C2 CAPACITOR	MMF 500V	861A846H25	C3 CAPACITOR	MMF 500V	763A209H23						
C3 CAPACITOR	MMF 500V	762A757H07	C4 CAPACITOR	MMF 500V	763A209H12						
C4 CAPACITOR	MMF 500V	763A209H07	C5 CAPACITOR	MMF 1200V	187A705H08						
C5 CAPACITOR	MMF 1200V	187A705H08	C7 CAPACITOR	PF 3000V	203C872H02						
C7 CAPACITOR	PF 3000V	203C872H02	L102 POT CORE		670B133G09						
L102 POT CORE		670B133G09	L103 POT CORE		670B133G08						
L103 POT CORE		670B133G08	L105 POT CORE		670B133G09						
L105 POT CORE		670B133G09	T3 TRANSFORMER		292B526G04						
T3 TRANSFORMER		292B526G04	T4 TRANSFORMER		292B526G03						
T4 TRANSFORMER		292B526G03	R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01						
R6 RESISTOR	3K ± 5% BW (2 REO)	188A317H01	R7 RESISTOR	15K 10% 2W	187A642H55						
R7 RESISTOR	15K 10% 2W	187A642H55	G1 LIGHTNING ARRESTER		877A116H01						
G1 LIGHTNING ARRESTER		877A116H01									



Sub. 1
1461C89

Fig. 13. Module Location

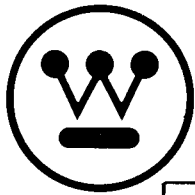
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RELAY-INSTRUMENT DIVISION

CORAL SPRINGS, FL.

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INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY SHIFT RECEIVER EQUIPMENT FOR DUAL PHASE – COMPARISON CARRIER RELAYING (SPCU, SKBU, OR SIMILAR SYSTEMS) WITH DC/DC CONVERTER

CAUTION

It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet, and in the system instruction leaflet before energizing the system.

Printed circuit modules should not be removed or inserted when the equipment is energized. Failure to observe this precaution may result in an undesired tripping output or cause component damage. Care should also be exercised when replacing modules to assure that they are replaced in the same chassis position from which they either were removed or the module they are replacing was removed.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF-10 Receiver described is for use with either the SPCU or SKBU Dual Phase Comparison relaying systems or similar systems utilizing frequency-shift keying (FSK). The TCF-10 frequency shift receiver responds to carrier-frequency signals transmitted from the distant end of a power line, and carried on the power line conductors. The space frequency (sometimes referred to as trip negative) is 100 hertz above the center frequency of the channel (which can be selected within the range of 30 kHz to 300 kHz). The mark frequency (sometimes referred to as trip positive) is 100 hertz below the channel center frequency. Generally, phase comparison information is conveyed over the channel during load current flow or fault conditions. The transmitter at each end of the channel is switched at a 60-hertz rate between space (or trip negative) and mark (or trip positive) so as to produce at the receiving end, the desired operation of the relaying system.

CONSTRUCTION

The TCF-10 receiver unit for dual phase comparison

relaying applications such as the SPCU or SKBU systems, is mounted on a standard 19 inch wide chassis 5¼ inches high (3 rack units) with edge slots for mounting on a standard relay rack.

All of the circuitry that is suitable for mounting on printed circuit boards is contained on printed circuit modules that plug into the chassis from the front and are readily accessible by removing the transparent cover on the front of the chassis. The power supply components and external connectors are located at the rear of the chassis as shown in Figure 9. Reference to the internal schematic connections of Figure 1 will show the location of these components in the circuit.

The printed circuit modules slide into position in slotted guides at the top and bottom of the chassis, and the module terminals engage a terminal block at the rear of the chassis. A handle on the front of each module is labeled to identify its function, and also identify adjustments and indicating lights if any are available at the front of the module. Of particular significance, is the input attenuator contained on the front of the filter module which is used in adjusting the input receiver signal during initial field installation.

A module extender (Style No. 1447C86G01) is available for facilitating circuit measurements or major adjustments. After withdrawing any one of the circuit modules, the extender is inserted in that position. The module is then inserted into the terminal block on the front of the extender. This restores all circuit connections and renders all components and test points on the module readily accessible. A carrier level indicator instrument, Style No. 606B592A26, with a linear dB scale is also available.

The receiver operates from a regulated +20V supply and a +10V supply operating from a regulated +45dc supply. These voltages are taken from three zener diodes mounted on a common heat sink. Variation of the resistance value between the positive side of the unregulated dc supply, and the

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

TYPE TCF-10 RECEIVER

45 volt zener adapt the receiver for operation on 48 or 125 volts dc.

External connections to the receiver are made through a 36 terminal receptacle, J3. The r-f input connection to the receiver is made through a coaxial cable jack J2.

OPERATION

INPUT MODULE

The input module contains the input control and the input filter. The signals to which the TCF-10 receiver responds are fed through a coaxial cable connected to jack J2 at the rear of the chassis to the input module. The input control R5, accessible at the front of the input module, attenuates the signal to a level suitable for the best operating range of the receiver.

A scale on the panel is graduated in dB. While this scale is typical rather than individually calibrated, it is accurate within several dB and is useful in setting approximate levels. Settings should be made more accurately utilizing a suitable ac voltmeter with a dB scale when possible.

From the attenuator, the signal passes through a band-pass LC filter, FL 201. This filter has a passband of approximately 1600Hz which is relatively wide in comparison to the IF filter which has a passband of approximately 500Hz. Still, frequencies several kHz above or below the center frequency (f_c) of the channel are greatly attenuated. Figure 15 shows a typical curve for the LC filter as well as a characteristics curve for the IF (intermediate frequency) filter, FL2, and the discriminator output. This apparently wide bandwidth for the input filter in relation to the IF filter is necessary to both achieve high speed relaying by minimizing channel delay and to achieve proper operation of the noise clamp by sampling noise in the frequency band surrounding the IF band.

OSCILLATOR, MIXER, AND IF AMPLIFIER MODULE

From the input filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20kHz above the channel center frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of filter FL201 is impressed on the emitter-collector circuit of Q11. As a result of mixing these two frequencies, the primary of transformer T12 will contain frequencies of 20kHz, $2f_c + 20$ kHz, $f_c + 20$ kHz, and f_c .

The output from the secondary of T12 is amplified by Q31 in the intermediate frequency (IF) stage, and is impressed on FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. Since its

pass band is narrower than that of the input filter, it eliminates the frequencies present at its input that are substantially higher than 20kHz. The output of this filter is the IF output which is fed to both the amplifier-limiter and the S/N Detection module. The output from the secondary of transformer T12, the RF output, is also fed to the S/N detection module.

AMPLIFIER LIMITER AND DISCRIMINATOR MODULE

The IF output signal from the IF amplifier is fed into the amplifier limiter through potentiometer R52 at the input of the amplifier limiter stage. Sufficient input is taken from R52 so that with minimum input signal (5 mv.) at J2 and with input control R5 set for zero attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at the channel center frequency, f_c . The adjustment for zero output at f_c is made by capacitor C68. In addition, C63 is adjusted for maximum voltage reading across R80 when the output current is zero. Maximum current output, of opposite polarities, will be obtained when the frequency is 100 hertz above or below the zero current output frequency. This separation of 200 hertz between the current peaks is affected by the value of C66 (the actual value of which may be changed slightly from its typical value in factory calibration if required).

It should be observed that although the space frequency is $f_c + 100$ hertz, after leaving the mixer stage, and as seen by the discriminator, the space frequency is 20kHz-100 hertz. Similarly the mark frequency as seen by the discriminator is 20kHz +100 hertz. The intermediate frequency at which the discriminator has zero output then is 20kHz. The discriminator is adjusted so that the mark and space outputs are of equal lengths for equal periods of mark and space signal frequencies.

The discriminator output is connected to the bases of transistors Q55 and Q56 in such a manner that transistor Q56 is made conductive when current flows, from the discriminator output, in the forward direction of diode D54, (which occurs with mark output) and Q55 is made conductive when current flows in the forward direction of diode D55 (which occurs with space output.) Consequently, terminal 35 is at a potential of approximately +20 volts at space frequency and terminal 1 is at +20 volts at mark frequency.

S/N DETECTION MODULE

The S/N detection module has three basic functions: first

to determine the in-band signal-to-noise ratio and provide clamping output at the desired level of signal-to-noise ratio, second to measure incoming in-band signal level and provide both an output to a carrier level indicating instrument and to a clamping circuit in the output module for clamping at the desired low level of signal, and third to provide a clamping output when the desired signal level exceeds the normal received level by a substantial amount, typically 25dB.

The method of determining signal-to-noise ratio utilizes the measurement of signal level in two different bandwidths, that of the input filter which is 1600 hertz, and that of the IF filter which is 500 hertz. The total signal plus noise in the 500 hertz bandwidth is subtracted from the signal plus noise in the 1600 hertz bandwidth and this difference is then compared with the signal plus noise in the 500 hertz bandwidth to arrive at a true in-band signal-to-noise ratio using logarithmic circuits. See Figure 21.

If the ratio of signal to noise is less than the value selected, typically 10, then there will be a +16V out of IC13 (TP75 and terminal 27). This is a high noise condition and this voltage is used as a clamp to prevent erroneous interpretation of data being received due to high noise conditions. Under normal low noise conditions, typically signal-to-noise ratio greater than 10, the voltage out of IC 13 (TP75) is +4V and no clamping is done.

The wide band signal of 1600 hertz bandwidth called the RF signal is fed into the S/N detection board through isolation transformer T31. Operational amplifiers IC1 and IC2 along with their associated components, R82 through R92 and C81 through C90, constitute a 4-pole low-pass filter which passes the mixed band of frequencies in the bandwidth of 1600 Hz centered about the 20kHz I.F. frequency, and blocks all the higher multiples such as in the I.F. amplifier. Operational amplifier IC3 and associated components amplifies the signal for feeding into the rms circuit composed of IC4 and IC5 with adjustable potentiometer R94 controlling the amount of amplification. This latter circuit converts the signals into a dc voltage proportional to the rms value of the ac signals. Operational amplifier IC6A and associated components is used for inversion and isolation of this dc voltage before being fed into the summation amplifier IC6B.

The narrow-band signal of 500 hertz bandwidth called the I.F. is fed into the S/N detection board through isolation transformer T32. The amount of signal fed into the board is adjustable by means of potentiometer R111. The circuit composed of operational amplifiers IC7 and IC8 and associated components is an rms circuit which converts the signals into a dc voltage proportional to the rms value of the ac signals present in the IF bandwidth. The output of this circuit is also then fed into the summation amplifier IC6B.

The summation amplifier takes the difference between the rms values of the IF signal and the RF signal and feeds it into one half of the logarithmic amplifier composed of IC9 and associated components. At the same time, the rms value of the IF signal is fed into the other half of this logarithmic amplifier. The logarithmic amplifier takes the logarithmic difference between these two signals (which is equivalent to IF divided by [RF-IF] from the summer). The constants of the circuits are set up so that the output of the logarithmic amplifier is positive when the ratio of the signal to noise ratio in these bandwidths is greater than 10dB, and is negative when the signal to noise ratio is less than 10dB. (Note: The point at which the change in polarity occurs can be altered to other than 10dB signal to noise ratio by altering the adjustments of R94 and R111). In addition, the output of the logarithmic amplifier is also negative when the signal level is approximately 25dB above normal for high-level clamping.

The output of the logarithmic amplifier is fed through networks consisting of IC10A and IC13A to the level detector circuit IC13B which has a fast pickup and slow dropout when it receives a signal from the logarithmic amplifier indicating a lower than desired signal-to-noise ratio (lower than 10dB is initially set when shipped). This will put out a +16 volts out of terminal 27 for this condition. For high signal-to-noise ratio this output will be +4 volts. This circuit will also put out +16 volts out of terminal 27 for very high signal levels. This is a high signal clamp and occurs for signal levels approximately plus 25dB above normal received level.

The output of the IF rms circuit is also fed to the logarithmic circuit composed of IC11A, IC12A, and IC11B which puts out a dc signal level linearly proportional to signal level in dB for feeding an external microammeter calibrated with a linear dB scale with 10dB equal to 33-1/3 microamperes.

OUTPUT MODULE

The output module provides four buffered outputs to the relaying system. They are mark (or trip positive), space (or trip negative), S/N level, and "not low signal" with red indicating light emitting diodes for these outputs and a yellow indicating light emitting diode for normal level (satisfactory signal level). In addition, the output module has logic which will prevent either a mark or space output whenever the S/N level drops to an unsatisfactory level or the received signal level drops to an unsatisfactory level.

The space output of plus 20 volts (when present) from the discriminator is fed into the output module through terminal 25 into the "and" gate consisting of diodes D71, D72, D73, and D74, transistors Q62 and Q63, and associated com-

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fixed by the crystal used, except that it may be changed a few hertz by the value of capacitor of C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that assures reliable starting of oscillation. The frequency at room temperature is usually several hertz above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should be connected from TP56 at the base of Q54 to terminal 33 of the limiter. With 16 millivolts of space frequency on the receiver input (R5 set at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting. (For greater sensitivity when required, the receiver can be set to 5 millivolts for beginning of limiting. However this makes the receiver more susceptible to locally generated noise within the cabinet and should not be used unless absolutely necessary and chassis is located in a noise free area.)

The adjustment of the signal-to-noise ratio clamp for clamping at 10dB signal-to-noise ratio is as follows:

1. Set the incoming signal into receiver at nominal level (90 mv. for 16 mv normal clipping level; 28mv. for 5 mv maximum sensitivity level).
2. Adjust I.F. input with R111 so that signal at TP68 of the S/N detector module is +100 mv dc (with respect to TP62).
3. Adjust RF input with R94 so that signal at TP63 is +145 mv dc (with respect to TP62).
4. Adjust log amplifier balance potentiometer R129 so that S/N clamps operates. This will be +6 volts dc at TP75 to TP62. This will also appear as +12 volts at TP91 of the output board with respect to board terminal 3, and the red S/N level indicator will light.
5. Go back and readjust RF input with R94 so that signal level at TP63 is now 74.4 mv dc. (with respect to TP62).

The adjustments above are for operation of the clamp at 10dB or less signal-to-noise ratios. If it is desired to clamp at other than 10dB or less, the following values can be used in place of the 145 mv value in step 3.

For S/N of 0dB set TP63 to 297mv.

5dB set TP63 to 200mv.

15dB set TP63 to 114mv.

20dB set TP63 to 97mv.

Note: When the SNR clamp is set to clamp at a 10dB signal-

to-noise ratio, the receiver will also clamp at a high signal level of approximately 25dB above normal.

The low signal level clamp is set to operate at the signal level where the receiver just drops out of limiting. This is accomplished as follows:

1. With a normal space frequency signal being received and with an oscilloscope connected across TP56 and terminal 33 of the limiter module, adjust input attenuator R5 to the point where the peaks of the oscilloscope trace just begin to flatten. (An alternate adjustment would be to set incoming signal level into receiver at 16mv with R5 set at zero which is the point at which limiting should begin).
2. Adjust the low-level (LL) adjustment R178 on the output module panel so that the low level clamp just picks up. This will be indicated by the red low level light on the output module coming on. There also will be +12 volts at TP86 on the output module.
3. Adjust input attenuator R5 to increase signal into receiver by desired margin of operation. This normally should be 15dB. This is done by reducing the R5 attenuator setting.

MAINTENANCE

Periodic checks of the received carrier signal level and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenuation control, R5. A change in operating margin from the original setting can be detected by observing the change in the dial setting required to cause a low signal level clamp to operate as indicated by the red LED becoming lit. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal level or loss in receiver sensitivity.

All adjustable components for normal field adjustments on the printed circuit modules are accessible when the front cover on the chassis is removed. All other adjustable components on the printed circuit modules may be made entirely accessible while permitting electrical operation by using module extender style number 1447C86G01. This permits attaching instrument leads to the various test points of terminals where making voltage, oscilloscope or frequency checks.

TABLE I RECEIVER D-C MEASUREMENTS

NOTE: All voltage readings taken with ground of dc VTVM on terminal 17 (negative dc). Receiver ad-

justed for 15dB operating margin with Space and Mark signals down 40dB from 1 watt or 50dB down from 10 watts. Unless indicated otherwise, voltage will not vary appreciably whether signal is mark, space or zero.

Collector of Transistor or Test Point	Voltage (Positive)
Q11	15
Q12 (TP12)	17 (Mark or Space)
Q13 (TP13)	17 (Mark or Space)
Q14 (TP14)	3
Q15 (TP15)	3
TP11	22
TP52	19
Q51 (TP51)	14
Q52 (TP53)	14.5
Q53 (TP54)	18
Q54 (TP55)	3
TP56	19
Q55	1 (Lower Freq. or No Signal)
Q55	23 (Higher Freq.)
Q56	23 (Lower Freq.)
Q56	1 (Higher Freq. or No Signal)

NOTE: The following readings are taken with the negative of dc VTVM on terminal 3 (common of dc power supply) of either the S/N detection module or the output module.

TP61	+ 4
TP62	0
TP63	+ 0.4
TP64	+ 6
TP65	- 12
TP66	0
TP67	+ 0.5
TP68	+ 0.5
TP70	- 6
TP71	+ 6
TP72	+ 1.5
TP73	+ 0.8
TP74	+ 0.3
TP81	+ 12 (Higher Frequency)
TP81	- 12 (Lower Freq. or No Signal)
TP82	+ 12 (Lower Frequency)
TP82	- 12 (Higher Freq. or No Signal)
TP83	+ 12 (Higher Frequency)
TP83	- 12 (Lower Freq. or No Signal)
TP84	+ 12 (Lower Frequency)

TP84	- 12 (Higher Freq. or No Signal)
TP85	+ 0.3
TP86	+ 12 (Low level clamp)
TP86	0 (No clamp)
TP87	+ 6 (Low SNR clamp)
TP87	- 6 (No SNR clamp)
TP88	+ 12
TP89	- 12
TP90	+ 12 (Good Signal Level)
TP90	- 12 (Low Signal Level clamp)

TABLE II
RECEIVER RF MEASUREMENTS

NOTE: Voltmeter readings taken at any point from receiver input to stage involving transistor Q15 are neither meaningful or feasible because of either waveform variations or the effect of instrument loading on the readings. Receiver adjusted as Table I.

Collector of Transistor or Test Point	Volts with Signal At +10dB Above Normal Level
Q15 (TP15)	0.8
Q51 (TP51)	0.9
Q52 (TP53)	0.65
Q53 (TP54)	2.2
Q54 (TP55)	4.5
TP61	.013
TP67	.275

FILTER RESPONSE MEASUREMENTS

The LC input filter (FL201) and the IF Filter (FL2) are in sealed containers, and repairs can only be made by the factory. The stability of the original response characteristics is such that in normal usage, no appreciable change in response will occur. However, the test circuits of Figure 16 can be used in case there is reason to suspect that either of the filters is not performing correctly.

Figure 15 shows the -3dB and -35dB checkpoints for the IF filter, and the -3dB checkpoints for the input filter. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Figure 15 was chosen to show the IF filter response, which permitted only a portion of the input filter curve to be shown. The checkpoints for the passband of each section of each section of the IF filter are down 3dB maximum at 19.75 and 20.25kHz, and for the stop band are down 18dB minimum at 19.00 and 21.00kHz for each section. The signal generator voltage (Figure 16) must be held constant throughout the entire check. A value of 7.8 volts is suitable. The reading of VM2 at the frequency of minimum attenuation should not be

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more than 22dB below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only, and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16dB less than the measured difference because of the input resistance and the difference in input and output impedances of the filter.

In testing the LC filter, a value of approximately 2.45V is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency, but should not be more than 18dB below the reading of VM1. (The filter insertion loss is approximately 6dB less than the difference in readings).

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY.

The parts required for converting a TCF receiver for operating at a different channel frequency consist of a new LC input filter (FL201), a new local oscillator crystal (Y11) and probably a different feedback capacitor (C12). There are two ways of effecting this change. The easiest and preferred method is to order a new input filter module and a new oscillator mixer module for the new frequencies from the factory. The new modules would then just have to be plugged in as replacements for the original modules. The second method would involve ordering just replacement filter, FL201, and new local oscillator crystal for the new frequencies and making the substitution on the modules. These substitutions on the modules are not difficult as the crystal plugs in and the filter has five leads to be soldered. However, testing of the local oscillator for easy starting will have to be made, and the value of C12 chosen to assure this easy starting of oscillation. The whole receiver should then be checked out for correct performance.

RECOMMENDED TEST EQUIPMENT

1. Minimum Test Equipment for Installation

- a. A-C vacuum Tube Voltmeter (VTVM). Voltage range

0.003 to 30 volts, frequency range 60Hz to 330kHz, input impedance 7.5 megohms.

- b. D-C Vacuum Tube Voltmeter (VTVM).

Voltage Range: 1.5 to 300 volts

Input Impedance: 7.5 megohms

- c. CLI Microammeter, range 0-100 μ A, style number 606B592A26, (if receiver has carrier level indicator)

II. DESIRABLE TEST EQUIPMENT FOR APPARATUS MAINTENANCE

- a. All items listed in I.

- b. Signal Generator

Output Voltage: up to 8 volts

Frequency Range: 20kHz to 330kHz

- c. Oscilloscope

- d. Frequency counter

- e. Ohmmeter

- f. Capacitor checker

- g. Milliammeter, 0-1.5 or preferably 1.5-0-1.5

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

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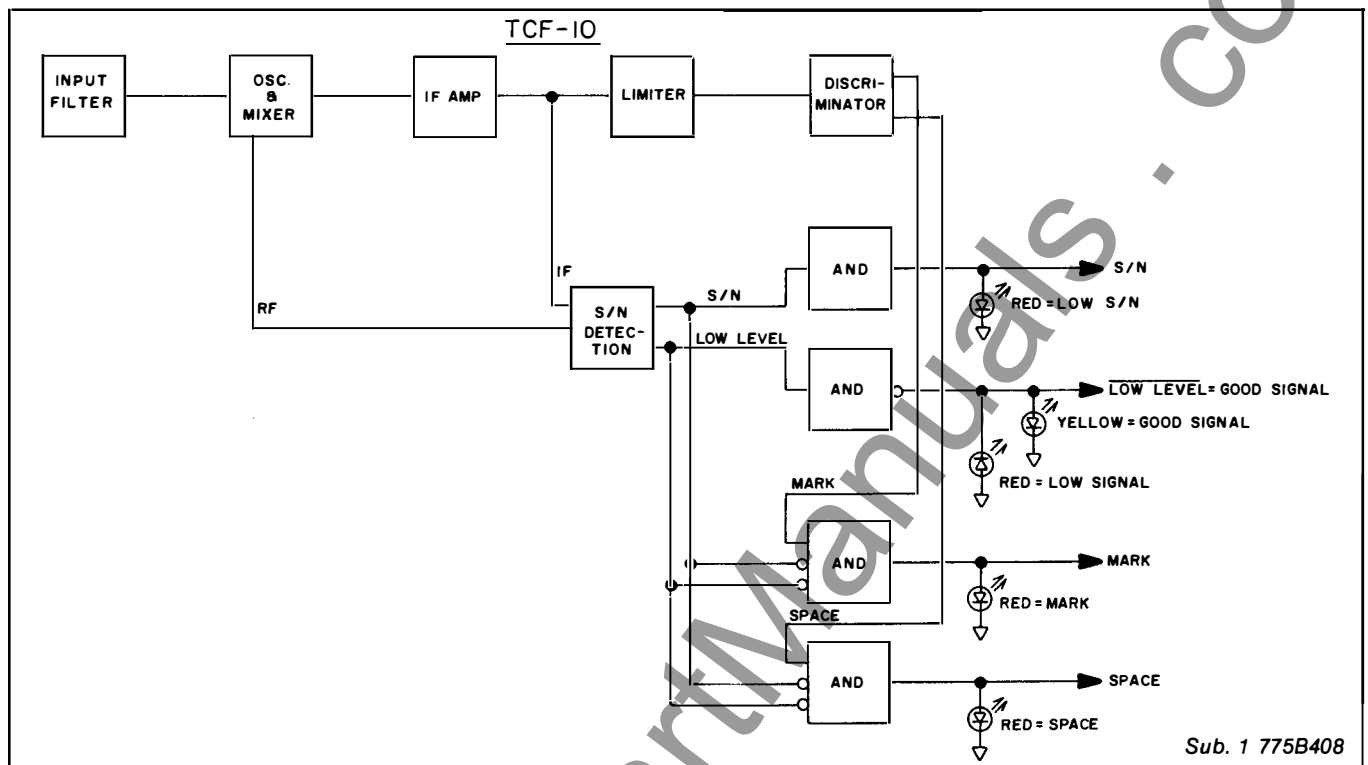


Fig. 2. Receiver Logic for Dual Phase Comparison.

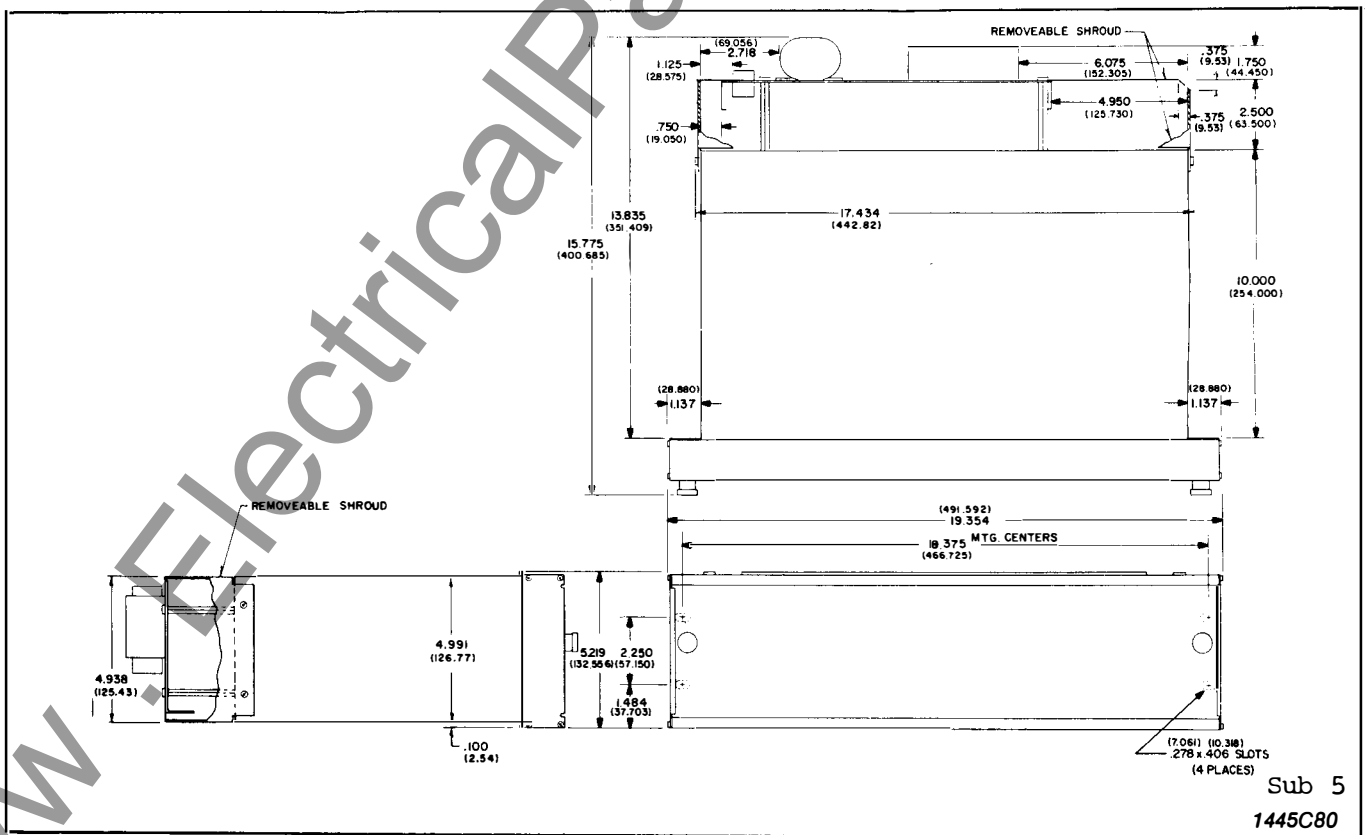


Fig. 3. Outline TCF-10 Receiver.

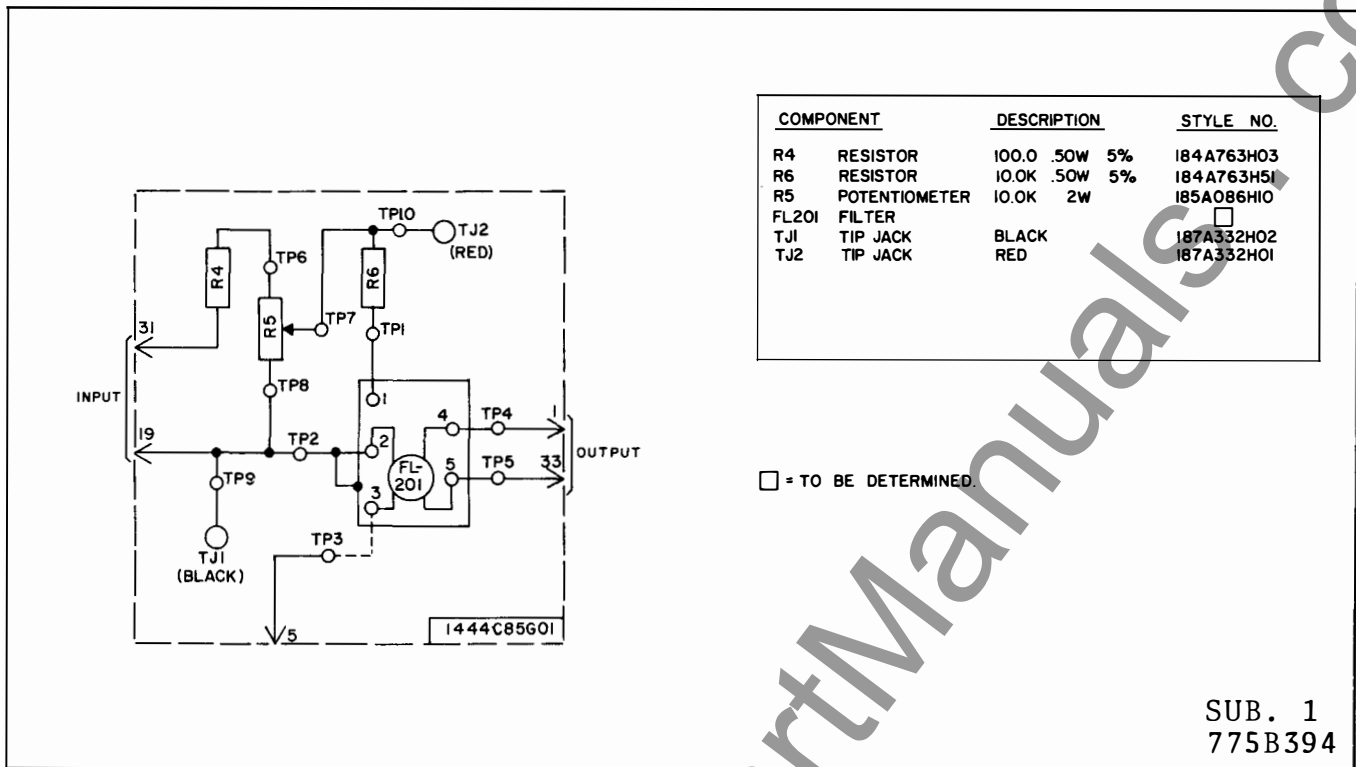


Fig. 4. Internal Schematic Input Filter Module (Below 200 kHz)

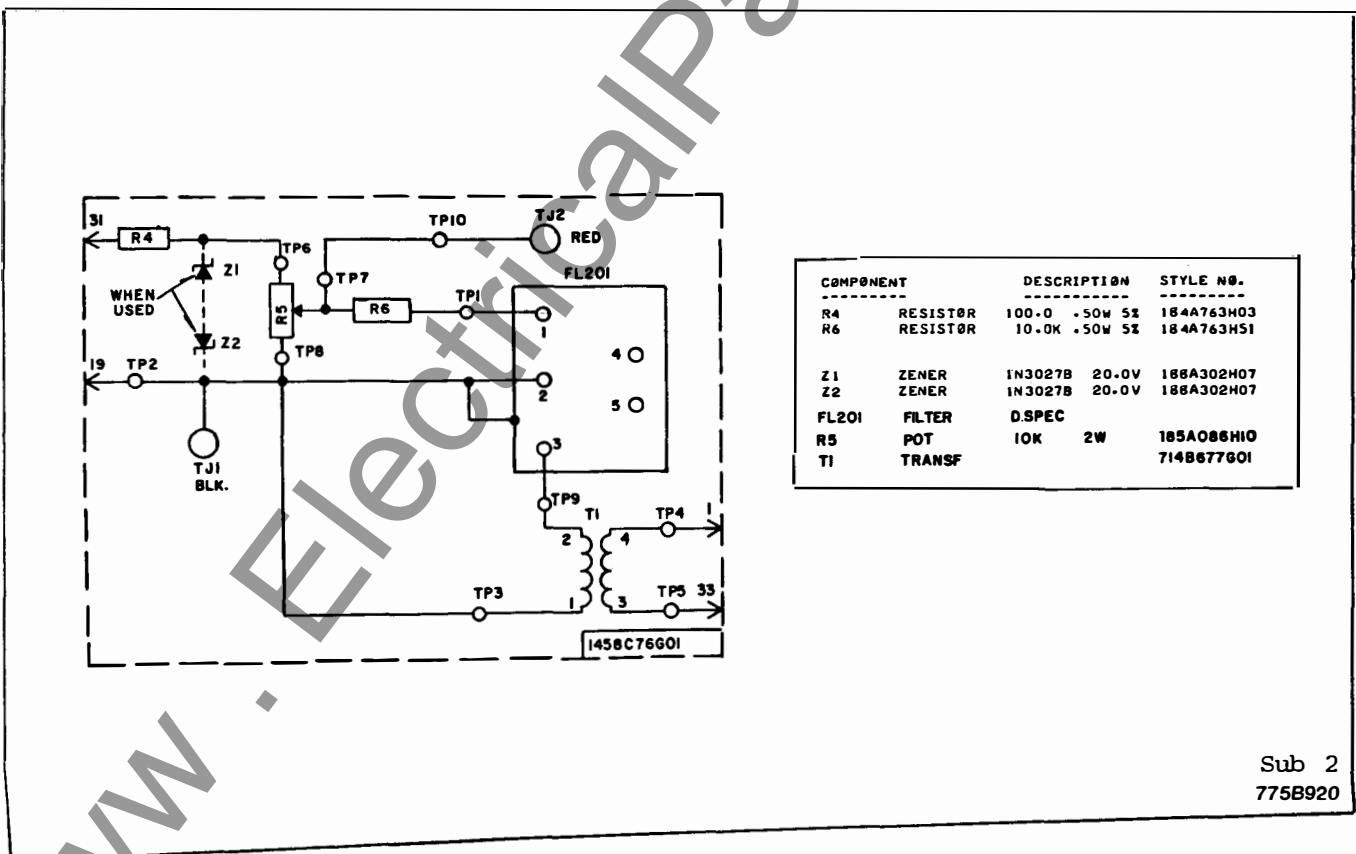
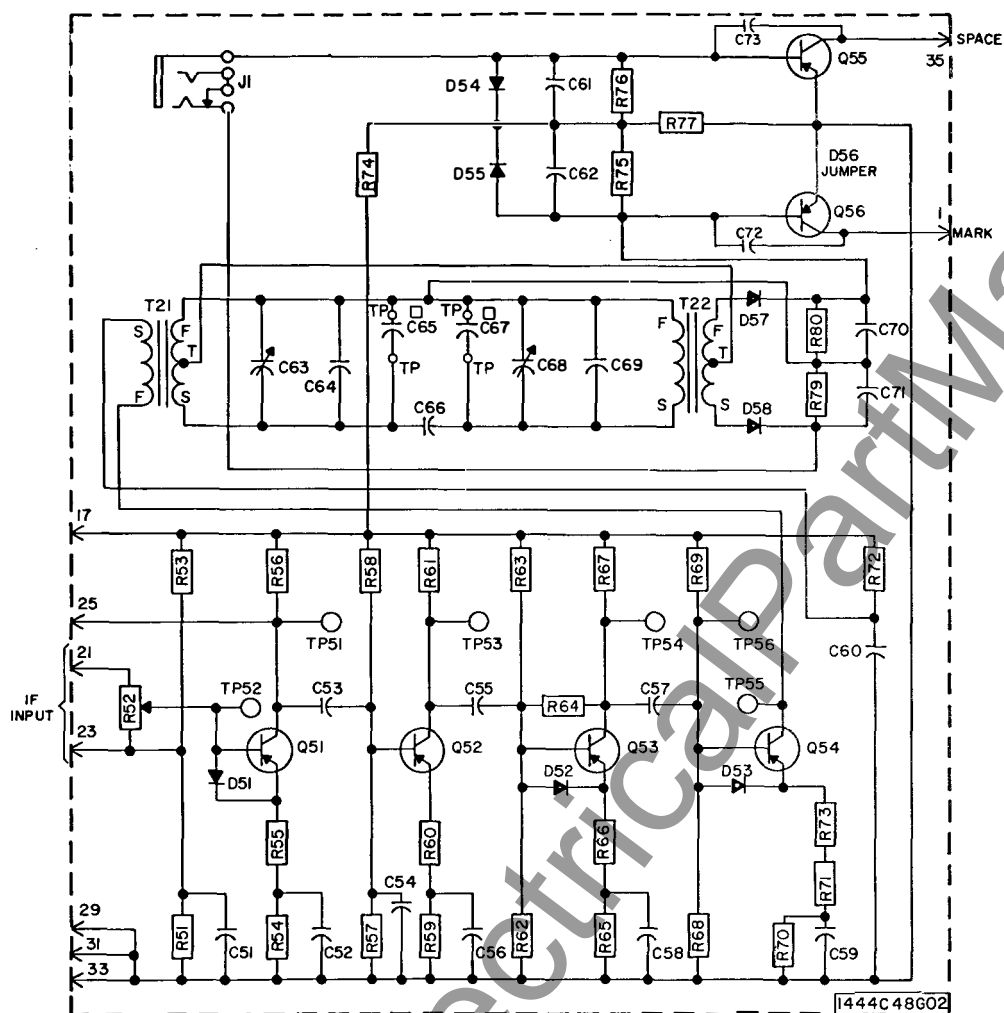


Fig. 5. Internal Schematic Input Filter Module (Above 200 kHz)





COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR .250UF 200V	187A624H02
C52	CAPACITOR .250UF 200V	187A624H02
C53	CAPACITOR .100UF 200V	187A624H01
C54	CAPACITOR 1300.000PF 500V	187A584H15
C55	CAPACITOR .100UF 200V	187A624H01
C56	CAPACITOR .250UF 200V	187A624H02
C57	CAPACITOR .100UF 200V	187A624H01
C58	CAPACITOR .250UF 200V	187A624H02
C59	CAPACITOR .250UF 200V	187A624H02
C60	CAPACITOR 1.000UF 200V	187A624H04
C61	CAPACITOR .220UF 50V	762A703H01
C62	CAPACITOR .220UF 50V	762A703H01
C63	CAPACITOR 4.5TO 100PF 50V	762A736H02
C64	CAPACITOR 9100.000PF 200V	187A624H16
C65	CAPACITOR SEE NOTE	
C66	CAPACITOR 100.000PF 500V	187A684H08
C67	CAPACITOR SEE NOTE	
C68	CAPACITOR 4.5TO 100PF	762A736H02
C69	CAPACITOR 9100.000PF 200V	187A624H16
C70	CAPACITOR .220UF 50V	762A703H01
C71	CAPACITOR .220UF 50V	762A703H01
C72	CAPACITOR 330.000PF 200V	880A397H01
C73	CAPACITOR 330.000PF 200V	880A397H01
D51	DIODE 1N457A	184A855H07
D52	DIODE 1N457A	184A855H07
D53	DIODE 1N457A	184A855H07
D54	DIODE 1N457A	184A855H07
D55	DIODE 1N457A	184A855H07
D56	DIODE 1N457A	184A855H07
D57	DIODE 1N628	184A855H12
D58	DIODE 1N628	184A855H12
R51	RESISTOR 4700.0 .50W 5%	184A763H43
R53	RESISTOR 27.0K .50W 5%	184A763H61
R54	RESISTOR 2200.0 .50W 5%	184A763H35
R55	RESISTOR 27.0 .50W 5%	187A290H11
R56	RESISTOR 10.0K .50W 5%	184A763H51
R57	RESISTOR 4700.0 .50W 5%	184A763H43
R58	RESISTOR 27.0K .50W 5%	184A763H61
R59	RESISTOR 1500.0 .50W 5%	184A763H31
R60	RESISTOR 180.0 .50W 5%	184A763H09
R61	RESISTOR 4700.0 .50W 5%	184A763H43
R62	RESISTOR 2200.0 .50W 5%	184A763H35
R63	RESISTOR 33.0K .50W 5%	184A763H63
R64	RESISTOR 2700.0 .50W 5%	184A763H37
R65	RESISTOR 680.0 .50W 5%	184A763H23
R66	RESISTOR 68.0 .50W 5%	187A290H21
R67	RESISTOR 4700.0 .50W 5%	184A763H43
R68	RESISTOR 2700.0 .50W 5%	184A763H37
R69	RESISTOR 18.0K .50W 5%	184A763H57
R70	RESISTOR 220.0 .50W 5%	184A763H11
R71	RESISTOR 68.0 .50W 2%	629A531H04
R72	RESISTOR 330.0 .50W 5%	184A763H15
R73	RESISTOR 56.0 .50W 2%	629A531H02
R74	RESISTOR 12.0K .50W 5%	184A763H53
R75	RESISTOR 3000.0 .50W 5%	184A763H38
R76	RESISTOR 3000.0 .50W 5%	184A763H36
R77	RESISTOR 220.0 .50W 5%	184A763H11
R79	RESISTOR 2200.0 .50W 5%	184A763H35
R80	RESISTOR 2200.0 .50W 5%	184A763H35
R52	PBT 1.0K .50W	629A645H04
Q51	TRANSISTOR 2N4249	849A441H03
Q52	TRANSISTOR 2N4249	849A441H03
Q53	TRANSISTOR 2N4249	849A441H03
Q54	TRANSISTOR 2N4249	849A441H03
Q55	TRANSISTOR 2N3645	849A441H01
Q56	TRANSISTOR 2N3645	849A441H01
T21	TRANSFORMER	606B53G01
T22	TRANSFORMER	606B53G02
J1	TELEPHONE JACK	187A606H01

□ - ONE OR TWO CAPACITORS USED; VALUES DETERMINED IN TEST.

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Fig. 8. Internal Schematic Amplifier Limiter-Discriminator Module

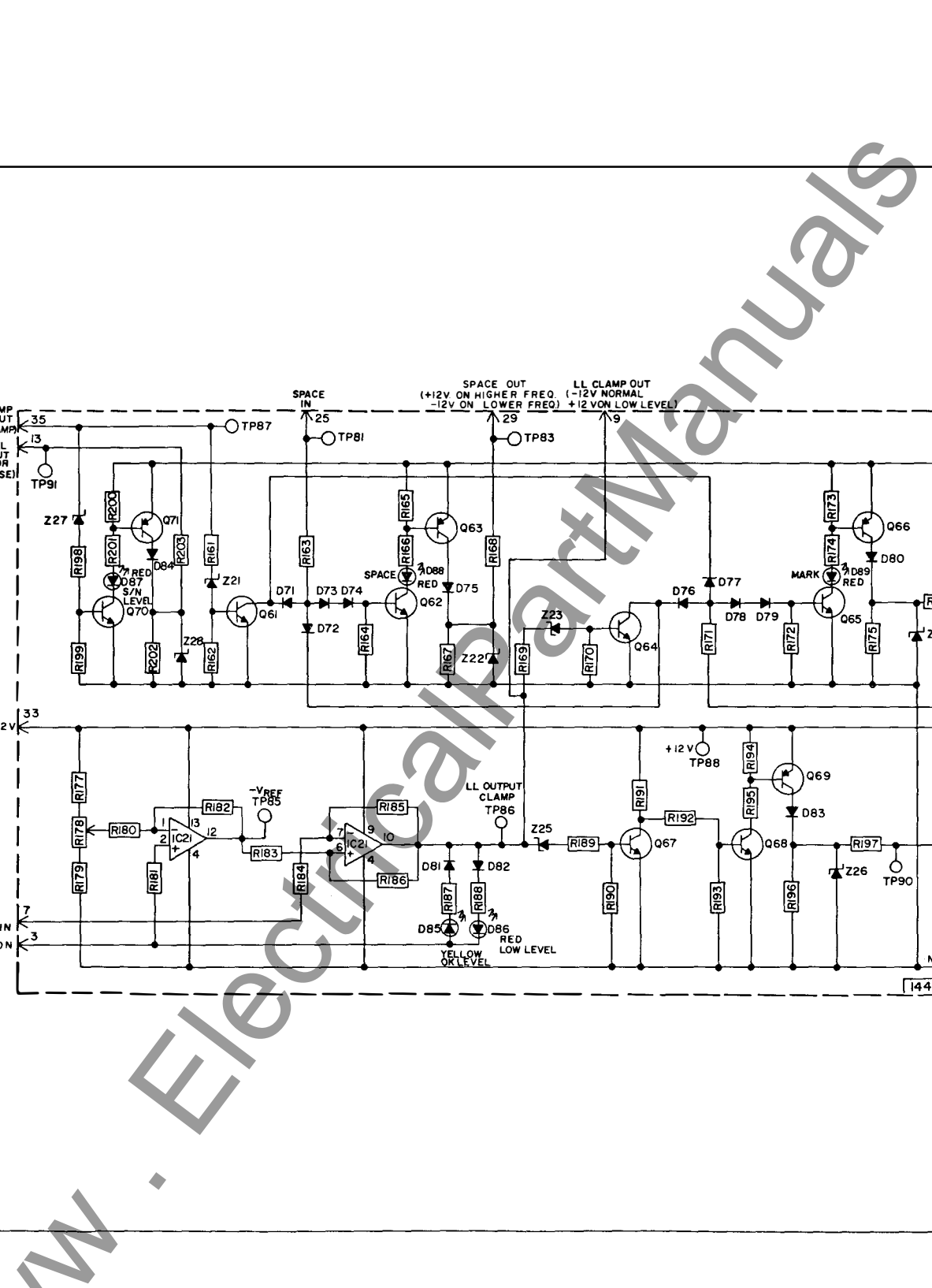
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COMPONENT		DESCRIPTION			STYLE NO.
R81	RESISTOR	1000.0	.50W	1%	848A819H48
R82	RESISTOR	2210.0	.50W	1%	848A819H81
R83	RESISTOR	10.2K	.25W	1%	848A820H46
R84	RESISTOR	10.0K	.25W	1%	848A820H45
R85	RESISTOR	56.2K	.25W	1%	848A821H18
R86	RESISTOR	10.0K	.50W	1%	848A820H45
R87	RESISTOR	2210.0	.50W	1%	848A819H81
R88	RESISTOR	10.2K	.25W	1%	848A820H46
R89	RESISTOR	10.0K	.25W	1%	848A820H45
R90	RESISTOR	82.5K	.50W	1%	848A821H34
R91	RESISTOR	10.0K	.50W	1%	848A820H45
R92	RESISTOR	6190.0	.50W	1%	848A820H25
R93	RESISTOR	4990.0	.50W	1%	848A820H16
R95	RESISTOR	4750.0	.25W	1%	848A820H14
R96	RESISTOR	4750.0	.25W	1%	848A820H14
R97	RESISTOR	4990.0	.50W	1%	848A820H16
R98	RESISTOR	15.0K	.50W	1%	848A820H62
R99	RESISTOR	4990.0	.50W	1%	848A820H16
R100	RESISTOR	4990.0	.50W	1%	848A820H16
R101	RESISTOR	4990.0	.50W	1%	848A820H16
R102	RESISTOR	10.0K	.50W	1%	848A820H45
R103	RESISTOR	10.0K	.50W	1%	848A820H45
R104	RESISTOR	10.0K	.50W	1%	848A820H45
R105	RESISTOR	10.0K	.50W	1%	848A820H45
R106	RESISTOR	10.0K	.50W	1%	848A820H45
R107	RESISTOR	10.0K	.50W	1%	848A820H45
R108	RESISTOR	100.0K	.50W	1%	848A821H42
R109	RESISTOR	10.0K	.50W	1%	848A820H45
R110	RESISTOR	1000.0	.50W	1%	848A819H48
R112	RESISTOR	4750.0	.25W	1%	848A820H14
R113	RESISTOR	4750.0	.25W	1%	848A820H14
R114	RESISTOR	15.0K	.50W	1%	848A820H62
R115	RESISTOR	4990.0	.50W	1%	848A820H16
R116	RESISTOR	4990.0	.50W	1%	848A820H16
R117	RESISTOR	4990.0	.50W	1%	848A820H16
R118	RESISTOR	4990.0	.50W	1%	848A820H16
R119	RESISTOR	10.0K	.50W	1%	848A820H45
R120	RESISTOR	1000.0	.50W	1%	848A819H48
R121	RESISTOR	15.0K	.50W	1%	848A820H62
R122	RESISTOR	15.0K	.50W	1%	848A820H62
R123	RESISTOR	10.0K	.50W	1%	848A820H45
R124	RESISTOR	10.0K	.50W	1%	848A820H45
R125	RESISTOR	10.0K	.50W	1%	848A820H45
R126	RESISTOR	10.0K	.50W	1%	848A820H45
R127	RESISTOR	2.0K	.50W	1%	848A819H77
R128	RESISTOR	9530.0	.50W	1%	848A820H43
R130	RESISTOR	9530.0	.50W	1%	848A820H43
R131	RESISTOR	10.0K	.50W	1%	848A820H45
R132	RESISTOR	10.0K	.50W	1%	848A820H45
R133	RESISTOR	10.0K	.50W	1%	848A820H45
R134	RESISTOR	10.0K	.50W	1%	848A820H45
R135	RESISTOR	10.0K	.50W	1%	848A820H45
R136	RESISTOR	15.0K	.50W	1%	848A820H62
R137	RESISTOR	10.0K	.50W	1%	848A820H45
R138	RESISTOR	10.0K	.50W	1%	848A820H45
R139	RESISTOR	10.0K	.50W	1%	848A820H45
R140	RESISTOR	475.0K	.25W	1%	848A822H08
R141	RESISTOR	200.0K	.50W	1%	848A821H71
R142	RESISTOR	150.0	.50W	1%	848A818H68
R144	RESISTOR	750.0	.50W	1%	848A819H36
R145	RESISTOR	18.7K	.50W	1%	848A820H71
R146	RESISTOR	4990.0	.50W	1%	848A820H16
R148	RESISTOR	1000.0	.50W	1%	848A819H48
R149	RESISTOR	15.0K	.50W	1%	848A820H62
R150	RESISTOR	2.0K	.50W	1%	848A819H77
R151	RESISTOR	2.0K	.50W	1%	848A819H77
R152	RESISTOR	17.8K	.25W	1%	848A820H69
R154	RESISTOR	1.0K	.50W	1%	848A819H48
R155	RESISTOR	1.0K	.25W	20%	629A430H02
R156	RESISTOR	150.0	.50W	1%	848A818H68
R157	RESISTOR	20.0K	.50W	1%	848A820H74
R158	RESISTOR	20.0K	.50W	1%	848A820H74

Component Part

COMPONENT		DESCRIPTION		STYLE NO.
R94	POT	20.0K	.50W	629A645H05
R111	POT	50.0K	.50W	629A645H12
R129	POT	2.5K	.25W	629A645H07
R147	POT	250.0K	.75W	880A526H10
R153	POT	2.5K	.25W	629A645H07
C81	CAPACITOR	2000.000PF	500V	187A584H01
C82	CAPACITOR	1000.000PF	200V	880A397H07
C83	CAPACITOR	220.000PF	200V	879A989H17
C84	CAPACITOR	.010UF	50V	184A663H01
C85	CAPACITOR	1.000UF	50V	3512A08H01
C86	CAPACITOR	.010UF	50V	184A663H01
C87	CAPACITOR	2000.000PF	500V	187A584H01
C88	CAPACITOR	1000.000PF	200V	880A397H07
C89	CAPACITOR	33.000PF	200V	879A989H07
C90	CAPACITOR	.010UF	50V	184A663H01
C91	CAPACITOR	.010UF	50V	184A663H01
C92	CAPACITOR	1.000UF	50V	3512A08H01
C93	CAPACITOR	.010UF	50V	184A663H01
C94	CAPACITOR	33.000PF	200V	879A989H07
C95	CAPACITOR	.010UF	50V	184A663H01
C96	CAPACITOR	.010UF	50V	184A663H01
C97	CAPACITOR	.470UF	50V	762A680H04
C98	CAPACITOR	33.000PF	200V	879A989H07
C99	CAPACITOR	.010UF	50V	184A663H01
C100	CAPACITOR	.010UF	50V	184A663H01
C101	CAPACITOR	33.000PF	200V	879A989H07
C102	CAPACITOR	.010UF	50V	184A663H01
C103	CAPACITOR	33.000PF	200V	879A989H07
C104	CAPACITOR	.010UF	50V	184A663H01
C105	CAPACITOR	.010UF	50V	184A663H01
C106	CAPACITOR	.047UF	50V	848A646H07
C107	CAPACITOR	33.000PF	200V	879A989H07
C108	CAPACITOR	.010UF	50V	184A663H01
C109	CAPACITOR	.010UF	50V	184A663H01
C110	CAPACITOR	.22. UF	100V	3512A08H02
IC1	INT CKT	SE531T		3512A10H01
IC2	INT CKT	SE531T		3512A10H01
IC3	INT CKT	SE531T		3512A10H01
IC4	INT CKT	SE531T		3512A10H01
IC5	INT CKT	SE531T		3512A10H01
IC6	INT CKT	747DM		1443C52H01
IC7	INT CKT	SE531T		3512A10H01
IC8	INT CKT	SE531T		3512A10H01
IC9	INT CKT	SN56502		3512A09H01
IC10	INT CKT	747DM		1443C52H01
IC11	INT CKT	747DM		1443C52H01
IC12	INT CKT	SN56502		3512A09H01
IC13	INT CKT	747DM		1443C52H01
D61	DIODE	1N4148		836A928H05
D62	DIODE	1N4148		836A928H06
D63	DIODE	1N4148		836A928H06
D64	DIODE	1N4148		836A928H06
D65	DIODE	1N4148		836A928H06
Z11	ZENER	1N825A	6.2 V	862A288H06
Z12	ZENER	1N825A	6.2 V	862A288H06
Z113	ZENER	1N825A	6.2V	862A288H06
J111	JUMPER	0 0HM RESISTOR		862A478H01
J112	JUMPER	0 0HM RESISTOR		862A478H01
J113	JUMPER	0 0HM RESISTOR		862A478H01
J114	JUMPER	0 0HM RESISTOR		862A478H01
T31	TRANSFORMER			714B677G01
T32	TRANSFORMER			714B677G01

Sub 1
1334D15

Sub 2
1463C13

COMPONENT		DESCRIPTION	STYLE NO.
D71	DIODE	1N645A	837A692H03
D72	DIODE	1N645A	837A692H03
D73	DIODE	1N645A	837A692H03
D74	DIODE	1N645A	837A692H03
D75	DIODE	1N645A	837A692H03
D76	DIODE	1N645A	837A692H03
D77	DIODE	1N645A	837A692H03
D78	DIODE	1N645A	837A692H03
D79	DIODE	1N645A	837A692H03
D80	DIODE	1N645A	837A692H03
D81	DIODE	1N457A	184A855H07
D82	DIODE	1N457A	184A855H07
D83	DIODE	1N645A	837A692H03
D84	DIODE	1N645A	837A692H03
D85	DIODE	LED	3508A22H02
D86	DIODE	LED	3508A22H01
D87	DIODE	LED	3508A22H01
R161	RESISTOR	10.0K .50W 5%	184A763H51
R162	RESISTOR	120.0K .50W 5%	184A763H77
R163	RESISTOR	33.0K .50W 5%	184A763H63
R164	RESISTOR	120.0K .50W 5%	184A763H77
R165	RESISTOR	4.7K .50W 5%	184A763H51
R166	RESISTOR	2.4K .50W 5%	184A763H57
R167	RESISTOR	10.0K .50W 1%	848A820H45
R168	RESISTOR	499.0 .50W 1%	848A819H19
R169	RESISTOR	10.0K .50W 5%	184A763H51
R170	RESISTOR	120.0K .50W 5%	184A763H77
R171	RESISTOR	33.0K .50W 5%	184A763H63
R172	RESISTOR	120.0K .50W 5%	184A763H77
R173	RESISTOR	4.7K .50W 5%	184A763H51
R174	RESISTOR	2.4K .50W 5%	184A763H57
R175	RESISTOR	10.0K .50W 1%	848A820H45
R176	RESISTOR	499.0 .50W 1%	848A819H19
R177	RESISTOR	10.0K .50W 1%	848A820H45
R179	RESISTOR	10.0K .50W 1%	848A820H45
R180	RESISTOR	68.1K .50W 1%	848A821H26
R181	RESISTOR	4990.0 .50W 1%	848A820H16
R182	RESISTOR	6810.0 .50W 1%	848A820H29
R183	RESISTOR	2.0K .50W 1%	848A819H77
R184	RESISTOR	2.0K .50W 1%	848A819H77
R185	RESISTOR	562.0K .25W 1%	848A822H15
R186	RESISTOR	511.0K .50W 1%	848A822H11
R187	RESISTOR	1620.0 .25W 1%	848A819H68
R188	RESISTOR	1620.0 .25W 1%	848A819H68
R189	RESISTOR	33.0K .50W 5%	184A763H63
R190	RESISTOR	68.0K .50W 5%	184A763H71
R191	RESISTOR	68.0K .50W 5%	184A763H71
R192	RESISTOR	33.0K .50W 5%	184A763H63
R193	RESISTOR	120.0K .50W 5%	184A763H77
R194	RESISTOR	10.0K .50W 5%	184A763H51
R195	RESISTOR	18.0K .50W 5%	184A763H57
R196	RESISTOR	10.0K .50W 1%	848A820H45
R197	RESISTOR	499.0 .50W 1%	848A819H19
R198	RESISTOR	33.0K .50W 5%	184A763H63
R199	RESISTOR	68.0K .50W 5%	184A763H71
R200	RESISTOR	4700.0 .50W 5%	184A763H43
R201	RESISTOR	2400.0 .50W 5%	184A763H36
R202	RESISTOR	10.0K .50W 1%	848A820H45
R203	RESISTOR	499.0 .50W 1%	848A819H19
Q61	TRANSISTOR	2N699	184A638H19
Q62	TRANSISTOR	2N699	184A638H19
Q63	TRANSISTOR	2N3645	849A441H01
Q64	TRANSISTOR	2N699	184A638H19
Q65	TRANSISTOR	2N699	184A638H19
Q66	TRANSISTOR	2N3645	849A441H01
Q67	TRANSISTOR	2N699	184A638H19
Q68	TRANSISTOR	2N699	184A638H19
Q69	TRANSISTOR	2N3645	849A441H01
Q70	TRANSISTOR	2N699	184A638H19
Q71	TRANSISTOR	2N3645	849A441H01
Z21	ZENER	1N961B 10.0V	186A797H07
Z22	ZENER	1N4752A 33.0V	849A515H02
Z23	ZENER	1N961B 10.0V	186A797H07
Z24	ZENER	1N4752A 33.0V	849A515H02
Z25	ZENER	1N961B 10.0V	186A797H07
Z26	ZENER	1N4752 33.0V	849A515H02
Z27	ZENER	1N961B 10.0V	186A797H07
Z28	ZENER	1N4752 33.0V	849A515H02
R178	POT	2.5K .25W	629A645H07
IC21	INT CKT	747DM	1443C52H01
J121	JUMPER	0 OHM RESISTOR	862A478H01
J122	JUMPER	0 OHM RESISTOR	862A478H01
J123	JUMPER	0 OHM RESISTOR	862A478H01
D88	DIODE	LED	3508A22H01
D89	DIODE	LED	3508A22H01

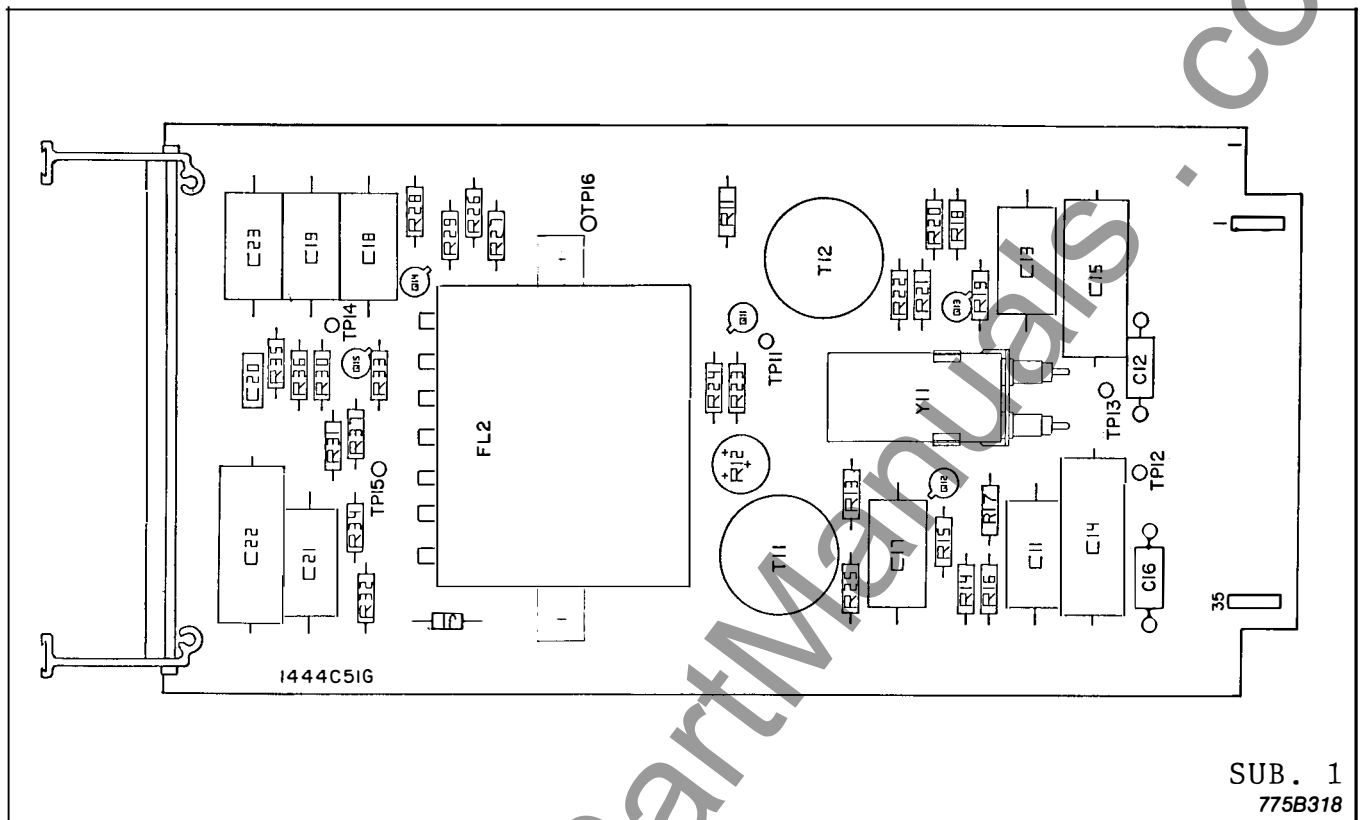


Fig. 14. Component Location Oscillator Mixer IF Amplifier Module (Below 200kHz)

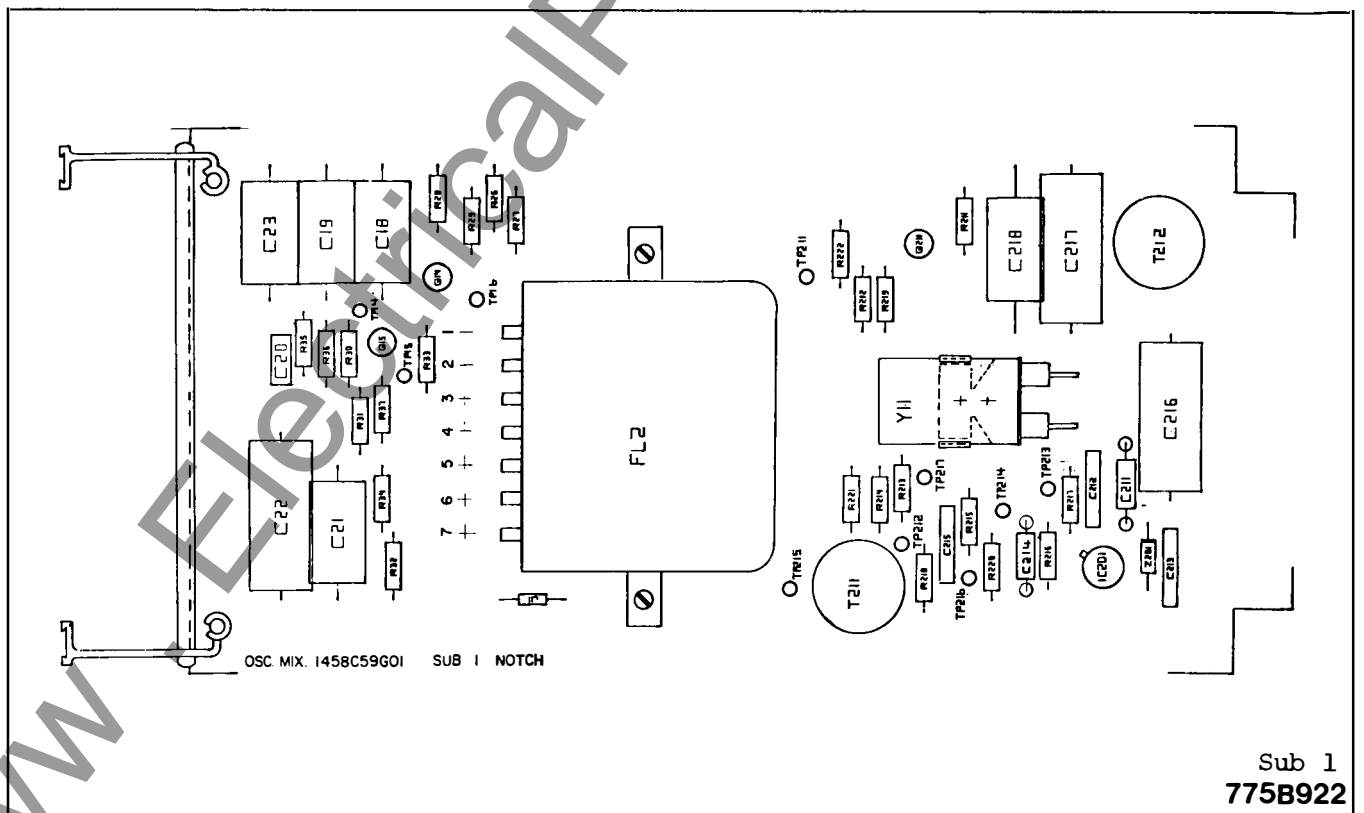


Fig. 15. Component Location Oscillator-Mixer-IF Amplifier Module (Above 200kHz)

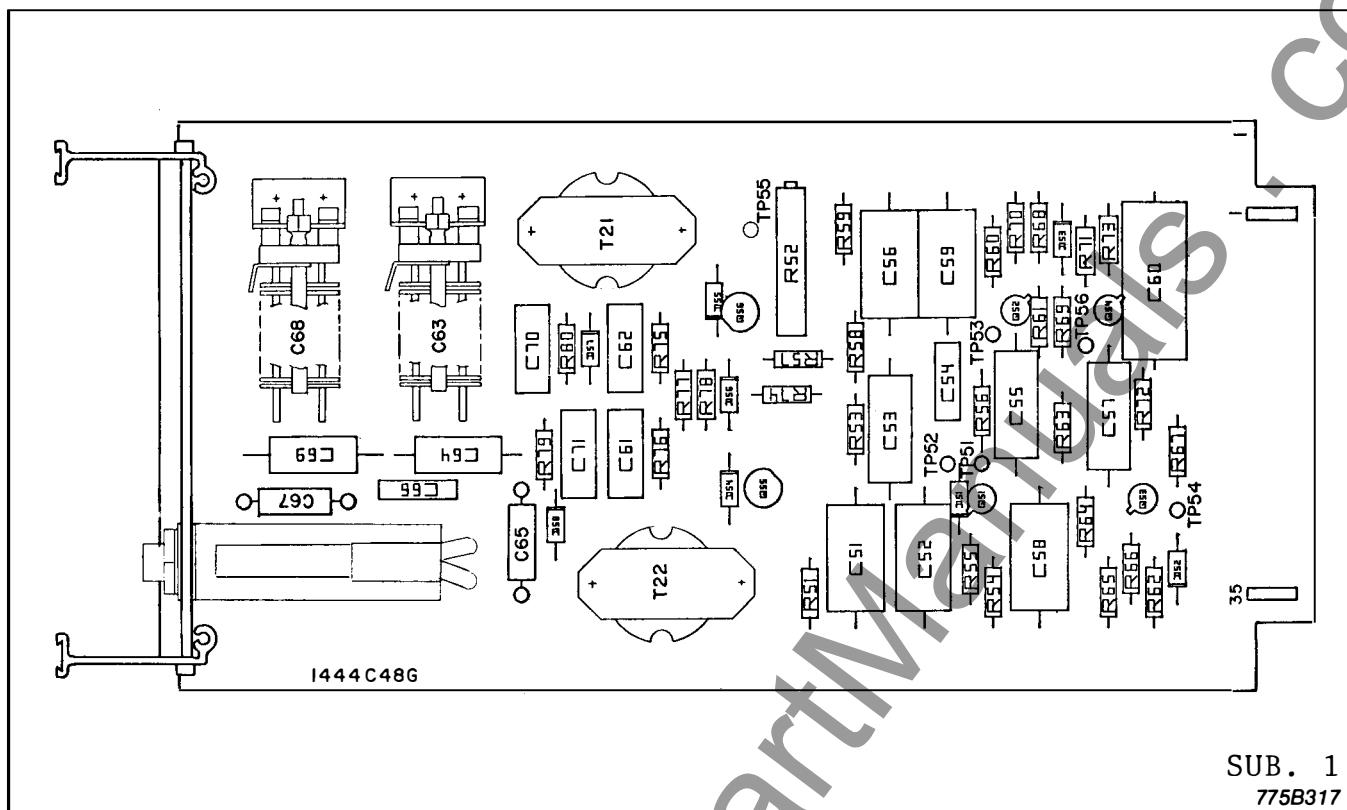


Fig. 16. Component Location Amplifier Limiter-Discriminator Module.

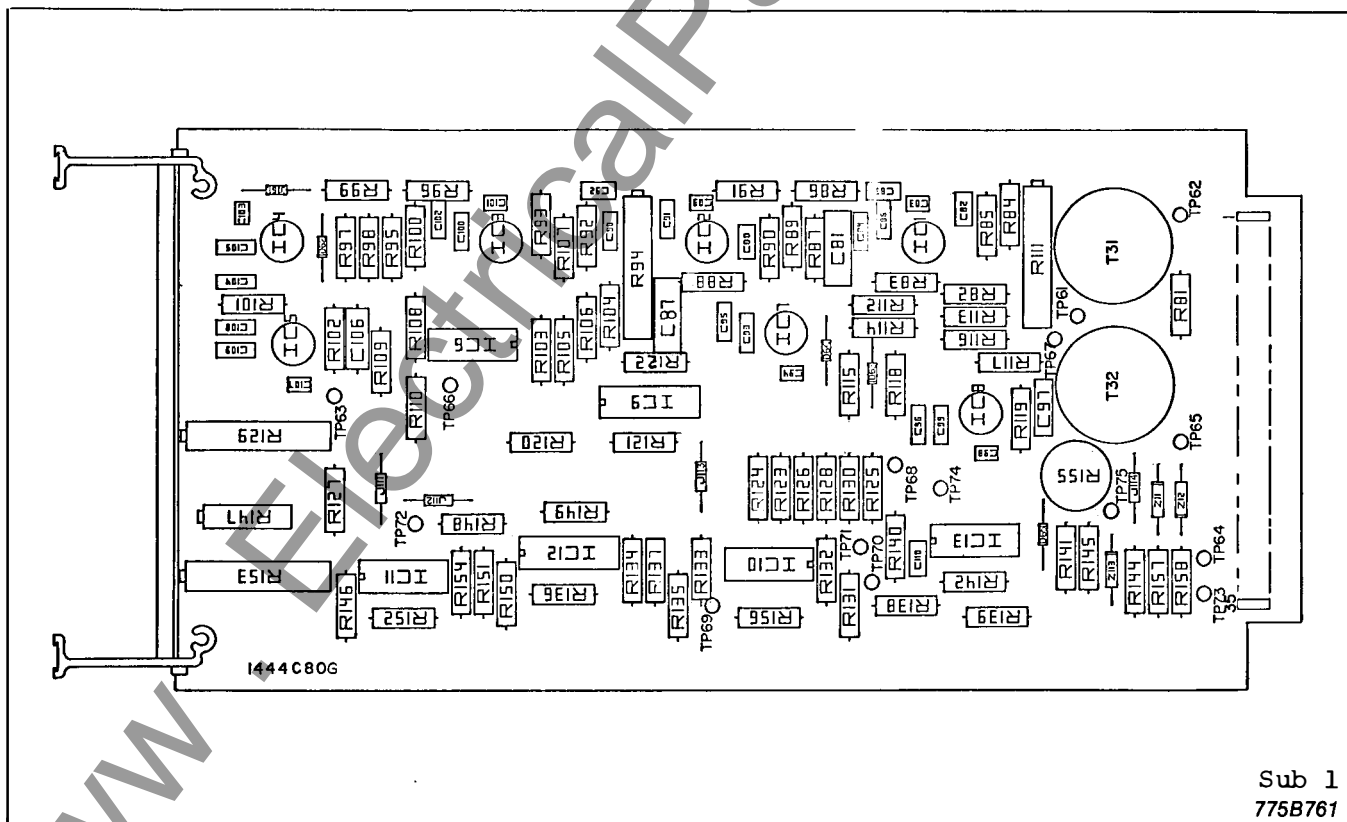


Fig. 17. Component Location SNR Detection Module.

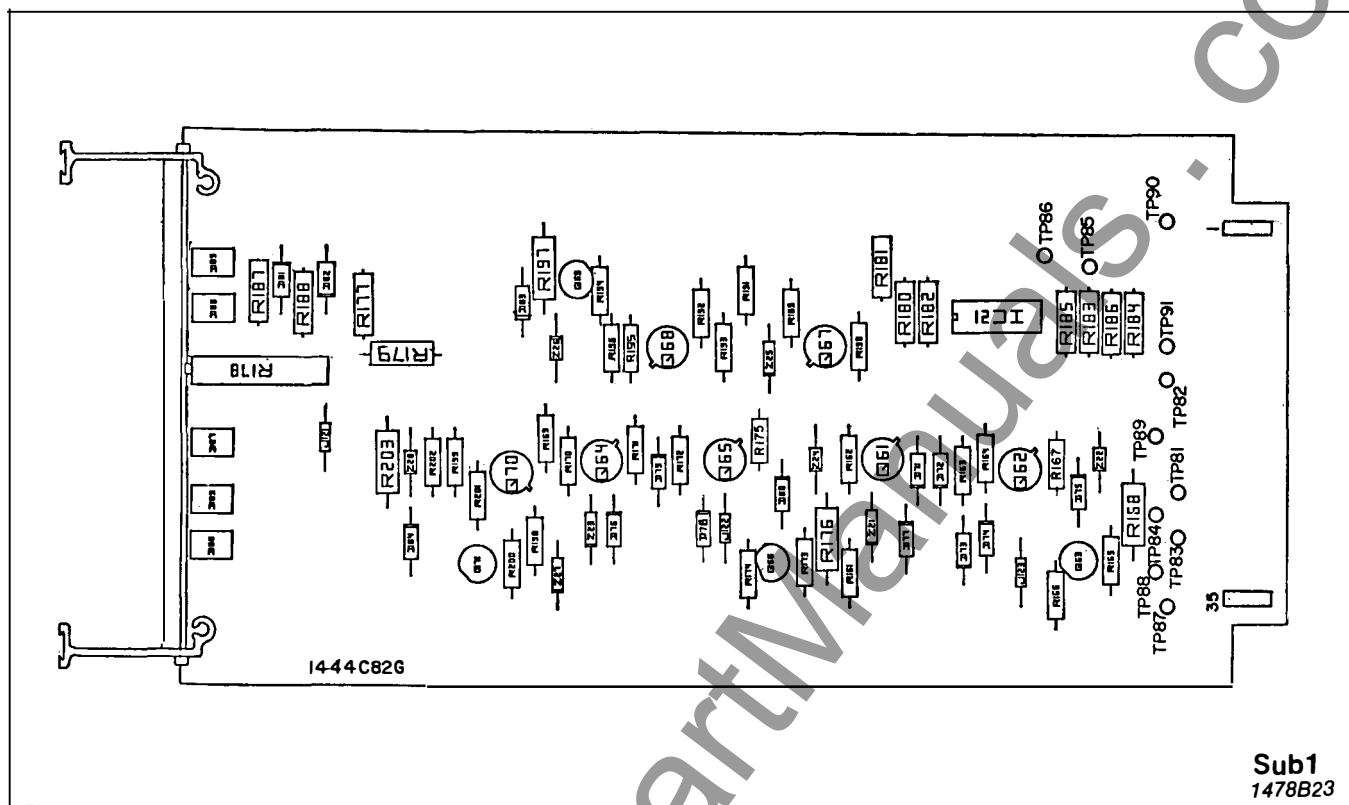
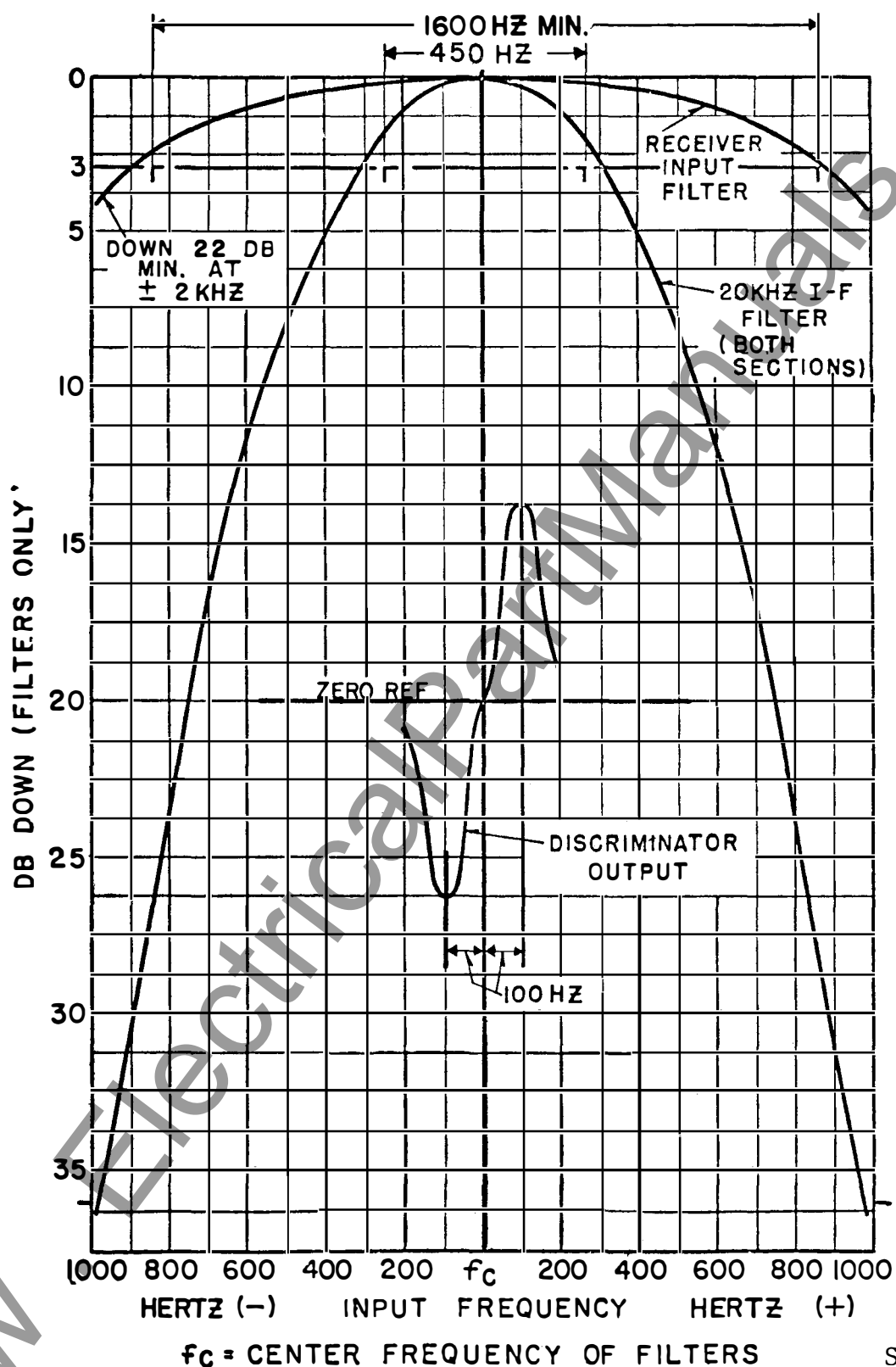


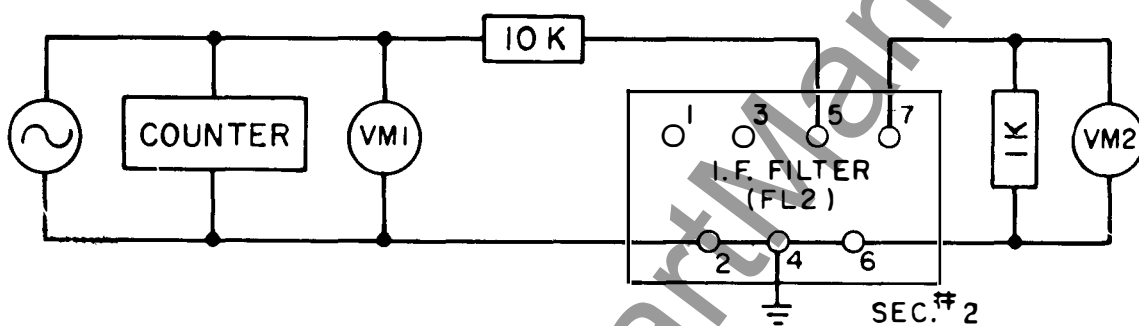
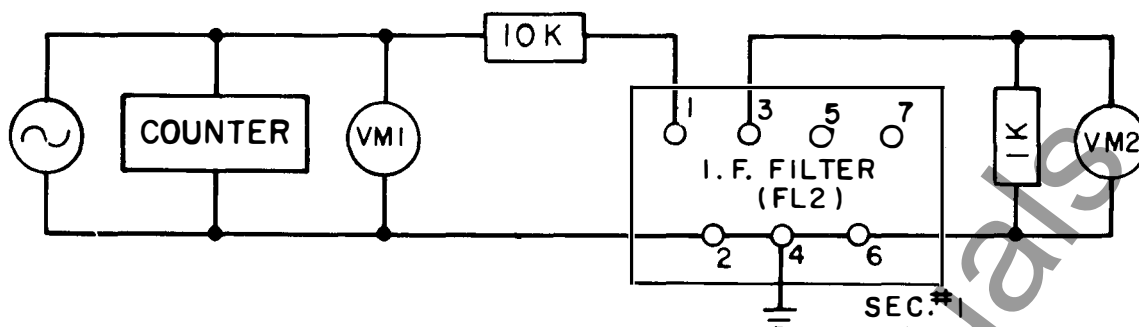
Fig. 18. Component Location Output Module.



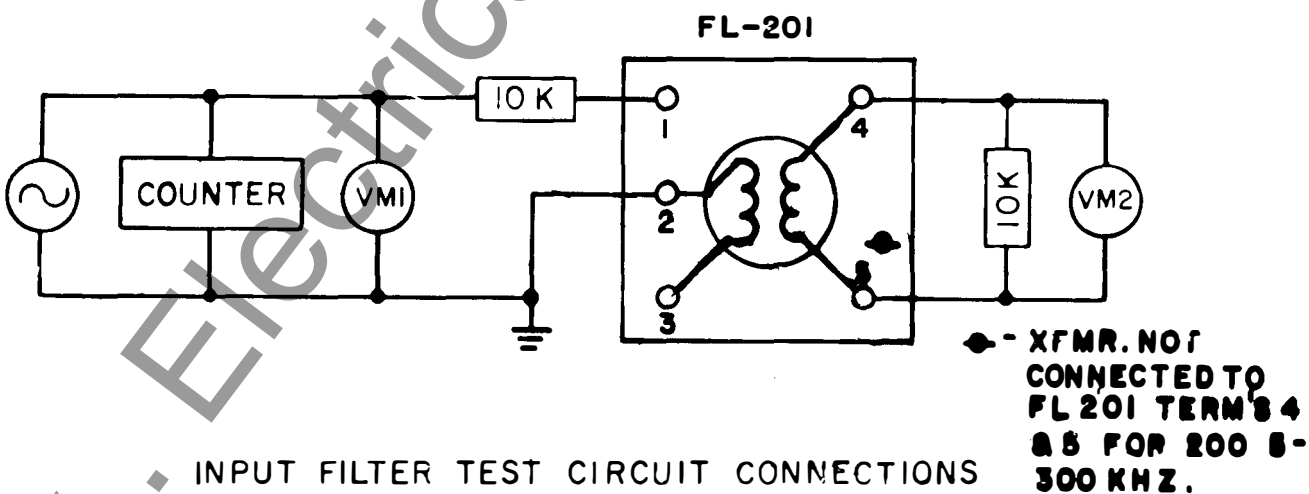
SUB. 7

849A342

Fig. 19. Filter and Discriminator Characteristics of the Type TCF-10 Receiver



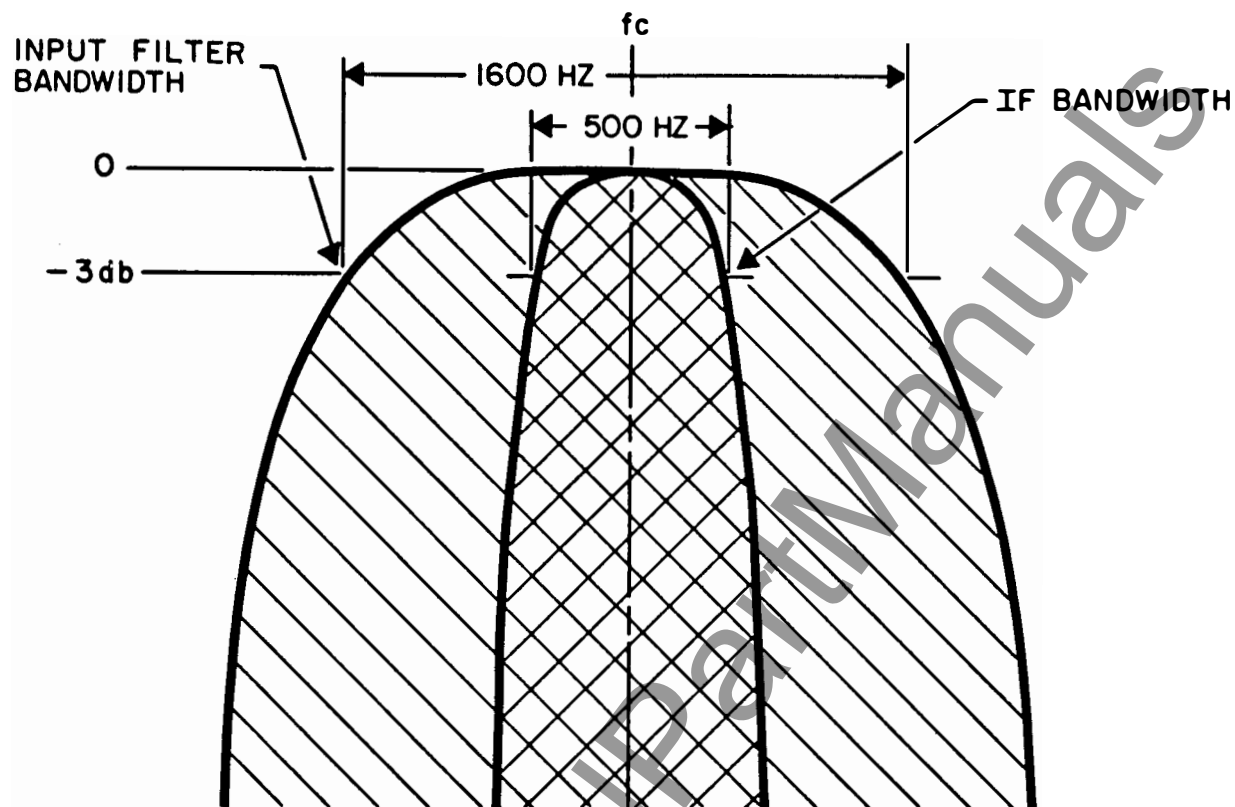
I. F. FILTER TEST CIRCUIT CONNECTIONS



INPUT FILTER TEST CIRCUIT CONNECTIONS

SUB. 2
877A794

Fig. 20. Test Circuits for TCF-10 Receiver Filters.



= SIGNAL + NARROW BAND NOISE

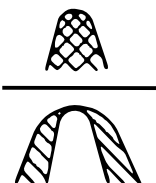


= SIGNAL + WIDE BAND NOISE - (SIGNAL + NARROW BAND NOISE)
= NOISE IN SURROUNDING BAND

AREAS USED FOR SNR ARE

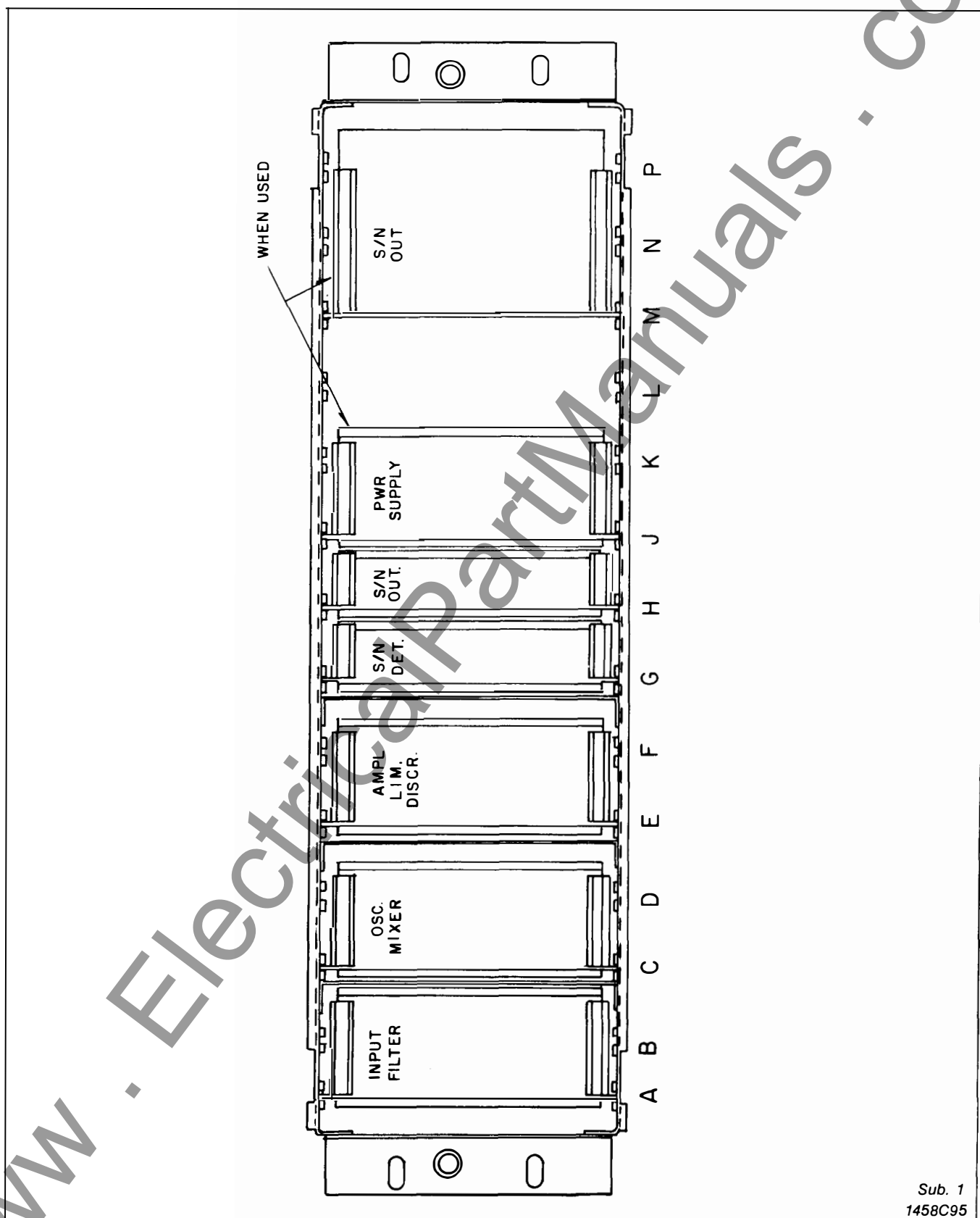


OR



Sub 2
3513A90

Fig. 21. Signal to Noise Ratio Characteristics.



Sub. 1
1458C95

Fig. 22. Type TCF-10 Receiver, Circuit Board Location.

TYPE TCF-10 RECEIVER

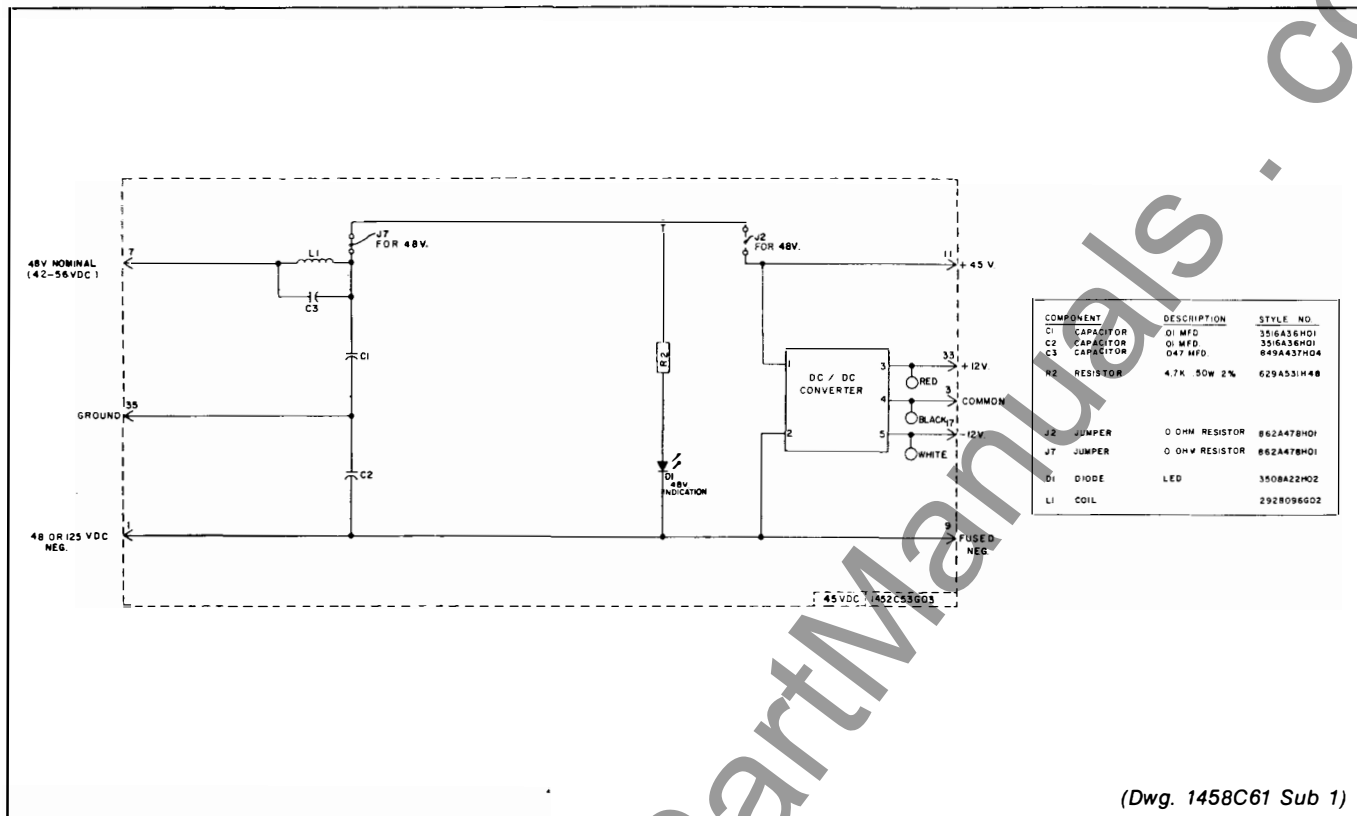


Fig. 23. Internal Schematic - Power Supply Module

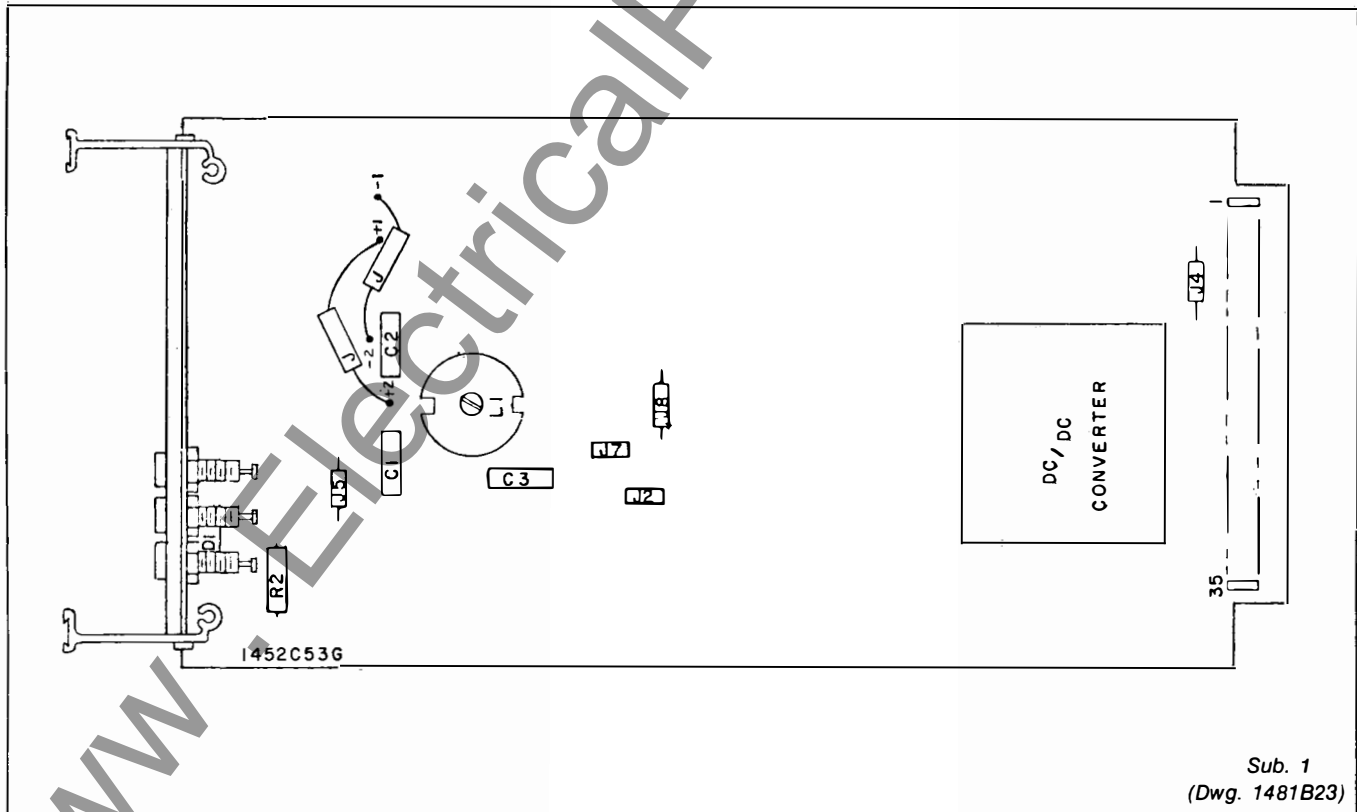
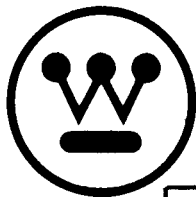


Fig. 24. Component Location - Power Supply Module



INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT RECEIVER EQUIPMENT – WITH RS232C INTERFACE FOR DATA SET APPLICATIONS

CAUTION

It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet, and in the system instruction leaflet before energizing the system.

Printed circuit modules should not be removed or inserted when the equipment is energized. Failure to observe this precaution may result in an undesired tripping output or cause component damage. Care should also be exercised when replacing modules to assure that they are replaced in the same chassis position from which they either were removed or the module they are replacing was removed.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF-10 frequency-shift receiver equipment as adapted for data set applications responds to carrier-frequency signals transmitted from the distant end of a power line and carried on the power line conductors. The Mark frequency is 100 hertz above the center frequency of the channel (which can be selected within the range of 30kHz to 300kHz), and it is transmitted continuously when conditions are normal and no information is to be conveyed over the channel. Its reception indicates that the channel is operative. The space frequency is 100 hertz below the channel center frequency. When data is to be conveyed over the channel, the transmitter at one end of the channel is switched alternately between mark and space so as to produce at the receiving end a desired number of mark and space outputs. Control of the durations of the intervals of the marks and spaces can be utilized to convey information over the channel.

CONSTRUCTION

The TCF-10 receiver is mounted on a standard 19-inch wide chassis 5¼ inches high (3 rack units) with edge slots for mounting on a standard relay rack.

All of the circuitry that is suitable for mounting on printed circuit boards is contained on printed circuit modules that plug into the chassis from the front and are readily accessible by removing the transparent cover on the front of the chassis. The external connectors are located at the rear of the chassis as shown in Figure 10. Reference to the internal schematic connections of Figure 1 will show the location of these components in the circuit.

The printed circuit modules slide into position in slotted guides at the top and bottom of the chassis, and the module terminals engage a terminal block at the rear of the chassis. A handle on the front of each module is labeled to identify its function, and also identify adjustments and indicating lights if any are available at the front of the module. Of particular significance is the input attenuator contained on the front of the filter module which is used in adjusting the input receiver signal during initial field installation.

A module extender (Style No. 1447C86G01) is available for facilitating circuit measurements or major adjustments. After withdrawing any one of

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

the circuit modules, the extender is inserted in that position. The module is then inserted into the terminal block on the front of the extender. This restores all circuit connections and renders all components and test points on the module readily accessible.

The receiver operates from a regulated +12V and -12V supply derived from a self-contained DC to DC converter. The power supply module containing the DC to DC converter has links which enable it to operate from either 48 volts or 125 volts dc.

External connections to the receiver are made through a 36-terminal receptacle, J3. The r-f input connection to the receiver is made through a coaxial cable jack J2.

OPERATION

INPUT MODULE

The input module contains the input control and the input filter. The signals to which the TCF-10 receiver responds are fed through a coaxial cable connected to jack J2 at the rear of the chassis to the input module. The input control R5, accessible at the front of the input module, attenuates the signal to a level suitable for the best operating range of the receiver.

A scale on the panel is graduated in dB. While this scale is typical rather than individually calibrated, it is accurate within several dB and is useful in setting approximate levels. Settings should be made more accurately utilizing a suitable ac voltmeter with a dB scale when possible.

From the attenuator, the signal passes through a bandpass LC filter, FL 201. This filter has a passband of approximately 1600Hz which is relatively wide in comparison to the IF filter which has a passband of approximately 500Hz. Still, frequencies several kHz above or below the center frequency (f_c) of the channel are greatly attenuated. Figure 2 shows a typical curve for the LC filter as well as a characteristics curve for the IF (intermediate frequency) filter, FL2, and the discriminator output. This apparently wide bandwidth for the input filter in relation to the IF filter is necessary to both achieve high speed data transmission and to achieve

proper operation of the noise clamp by sampling noise in the frequency band surrounding the IF band.

OSCILLATOR, MIXER, AND IF AMPLIFIER MODULE

From the input filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20kHz above the channel center frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of filter FL1 is impressed on the emitter-collector circuit of Q11. As a result of mixing these two frequencies, the primary of transformer will contain frequencies of 20kHz, $2f_c + 20\text{kHz}$, $f_c + 20\text{kHz}$, and f_c .

The output from the secondary of T12 is amplified by Q31 in the intermediate frequency (IF) stage, and is impressed on FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. Since its pass band is narrower than that of the input filter, it eliminates the frequencies present at its input that are substantially higher than 20kHz. The output of this filter is the IF output which is fed to both the amplifier-limiter and the S/N Detection module. The output from the secondary of transformer T12, the RF output, is also fed to the S/N Detection module.

AMPLIFIER LIMITER AND DISCRIMINATOR MODULE

The IF output signal from the IF amplifier is fed into the amplifier limiter through potentiometer R52 at the input of the amplifier limiter stage. Sufficient input is taken from R52 so that with minimum input signal (5 mv.) at J2 and with input control R5 set for zero attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at the

channel center frequency, f_c . The adjustment for zero output at f_c is made by capacitor C68. In addition, C63 is adjusted for maximum voltage reading across R80 when the output current is zero. Maximum current output, of opposite polarities, will be obtained when the frequency is 100 hertz above or below the zero current output frequency. This separation of 200 hertz between the current peaks is affected by the value of C66 (the actual value of which may be changed slightly from its typical value in factory calibration if required).

It should be observed that although the mark frequency is $f_c + 100$ hertz, after leaving the mixer stage, and as seen by the discriminator, the mark frequency is 20kHz-100 hertz. Similarly the space frequency as seen by the discriminator is 20kHz + 100 hertz. The intermediate frequency at which the discriminator has zero output then is 20kHz. The discriminator is adjusted so that the mark and space outputs are of equal lengths for equal periods of mark and space signal frequencies.

The discriminator output is connected to the bases of transistors Q55 and Q56 in such a manner that transistor Q56 is made conductive when current flows, from the discriminator output, in the forward direction of diode D54, (which occurs with space output) and Q55 is made conductive when current flows in the forward direction of diode D55 (which occurs with mark output.) Consequently, terminal 35 is at a potential of approximately +12 volts at mark frequency and terminal 1 is at +12 volts at space frequency.

S/N DETECTION MODULE

The S/N detection module has three basic functions; first to determine the in-band signal to noise ratio and provide clamping output at the desired level of signal-to-noise ratio, second to measure incoming in band signal level and provide both an output to a carrier level indicating instrument and to a clamping circuit in the output module for clamping at the desired low level of signal, and third to provide a clamping output when the desired signal level exceeds the normal received level by a substantial amount, typically 25dB.

The method of determining signal to noise ratio utilizes the measurement of signal level in two

different bandwidths, that of the input filter which is 1600 hertz, and that of the IF filter which is 500 hertz. The total signal plus noise in the 500 hertz bandwidth is subtracted from the signal plus noise in the 1600 hertz bandwidth and this difference is then compared with the signal plus noise in the 500 hertz bandwidth to arrive at a true in-band signal-to-noise ratio using logarithmic circuits. See Figure 21.

If the ratio of signal to noise is less than the value selected, typically 10dB, then there will be a +6V out of IC13 (TP75 and terminal 27). This is a high noise condition and this voltage is used as a clamp to prevent erroneous interpretation of data being received due to high noise conditions. Under normal low noise conditions, typically signal to noise ratio greater than 10dB, the voltage out of IC13 (TP75) is -6V and no clamping is done.

The wide band signal of 1600 hertz bandwidth called the RF signal is fed into the S/N detection board through isolation transformer T31. Operational amplifiers IC1 and IC2 along with their associated components, R82 through R92 and C81 through C90, constitute a 4 pole low pass filter which passes the mixed band of frequencies in the bandwidth of 1600 Hz centered about the 20kHz IF frequency, and blocks all the higher multiples such as in the IF amplifier. Operational amplifier IC3 and associated components amplifies the signal for feeding into the RMS circuit composed of IC4 and IC5 with adjustable potentiometer R94 controlling the amount of amplification. This latter circuit converts the signals into a dc voltage proportional to the RMS value of the ac signals. Operational amplifier IC6A and associated components is used for inversion and isolation of this dc voltage before being fed into the summation amplifier IC6B.

The narrow-band signal of 500 hertz bandwidth called the IF is fed into the S/N detection board through isolation transformer T32. The amount of signal fed into the board is adjustable by means of potentiometer R111. The circuit composed of operational amplifiers IC7 and IC8 and associated components is an RMS circuit which converts the signals into a dc voltage proportional to the RMS value of the ac signals present in the IF bandwidth. The output of this circuit is also then fed into the summation amplifier IC6B.

The summation amplifier takes the difference between the RMS values of the IF signal and the RF signal and feeds it into one half of the logarithmic amplifier composed of IC9 and associated components. At the same time, the RMS value of the IF signal is fed into the other half of this logarithmic amplifier. The logarithmic amplifier takes the logarithmic difference between these two signals (which is equivalent to IF divided by [RF-IF] from the summer). The constants of the circuits are set up so that the output of the logarithmic amplifier is positive when the ratio of the signal to noise ratio in these bandwidths is greater than 10dB, and is negative when the signal to noise ratio is less than 10dB. (Note: The point at which the change in polarity occurs can be altered to other than 10dB signal to noise ratio by altering the adjustments of R94 and R111). In addition, the output of the logarithmic amplifier is also negative when the signal level is approximately 25dB above normal for high level clamping.

The output of the logarithmic amplifier is fed through networks consisting of IC10A and IC13A to the level detector circuit IC13B which has a fast pickup and slow dropout when it receives a signal from the logarithmic amplifier indicating a lower than desired signal to noise ratio (lower than 10dB is initially set when shipped). This will put out a +6 volts out of terminal 27 for this condition. For high signal to noise ratio this output will be -6 volts. This circuit will also put out +6 volts out of terminal 27 for very high signal levels. This is a high signal clamp and occurs for signal levels approximately plus 25dB above normal level.

The output of the IF RMS circuit is also fed to the logarithmic circuit composed of IC11A, IC12A, and IC11B which puts out a dc signal level linearly proportional to signal level in dB for feeding an external microammeter calibrated with a linear dB scale with 10dB equal to 33-1/3 microamperes.

OUTPUT MODULE

The output module provides four buffered outputs to the data acquisition system. They are mark, space, S/N level, and not low signal with red indicating light emitting diodes for these outputs and a yellow indicating light emitting diode for normal

level (satisfactory signal level). In addition, the output module has logic which will prevent either a +12V mark or +12V space output whenever the S/N level drops to an unsatisfactory level or the received signal level drops to an unsatisfactory level.

The higher frequency output of plus 12 volts (when present) from the discriminator is fed into the output module through terminal 25 into the "and" gate consisting of diodes D71, D72, D73, and D74, transistors Q62 and Q63, and associated components R163, R164, R165, R166, R167, R168, D88, D75, and Z22. If there is no low level signal or low signal to noise ratio signal to prevent transistor Q62 from becoming conducting, then transistor Q62 becomes conducting, causing Q63 to become conducting and a plus 12 volts signal to appear out of terminal 29 from which it is fed to the outside world. In a similar manner, the lower frequency output of plus 12 volts when present from the discriminator is fed into the output module through terminal 15 into the "and" gate built around transistors Q65 and Q66. Just as in the case of the higher frequency output, the lower frequency output of plus 12 volts will appear out of terminal 27 for feeding to the data acquisition equipment if there is no low level clamp or low signal to noise ratio clamp. If there is a clamp, both of these outputs will be clamped to minus 12 volts output.

The low-signal-level clamp operates off the carrier level signal of the S/N detection module which is basically the same signal fed to the CLI instrument.

It is fed through terminal 7 into the voltage comparator circuit built around operational amplifier IC21B. This comparator compares this signal level with the voltage reference from IC21A, and if the signal level is greater than the low level at which clamping is desired, the output of IC21B will be negative causing the yellow LED to glow indicating OK level and there will consequently be no low signal clamping. If the signal level is below the level at which clamping is desired, then the output of IC21B will be positive causing the red LED to glow indicating low level. In addition, both transistors Q67 and Q64 will become conducting. Transistor Q64 conducting will prevent plus 12 volt signals

from appearing on the outputs going to the outside world by preventing transistors Q65 and Q62 from conducting. Transistor Q67 conducting causes Q68 to become non-conducting and thus removes the not low signal output from terminal 1. Under good or OK signal level, this not low signal output at terminal 1 of this module is plus 12 volts.

The S/N clamp output from the S/N detection module is fed into terminal 35 of this module. At low signal-to-noise ratio level, this +6 volt signal will cause transistors Q70 and Q61 to conduct. Transistor Q70 conducting will cause both the red LED to glow indicating low S/N and transistor Q71 to conduct supplying plus 12 volts out of terminal 13 to the outside world. Transistor Q61 conducting will prevent both transistors Q62 and Q65 from conducting, and thus prevent plus 12 volt signals from appearing at their respective outputs to the outside world. It should be noted that the S/N clamp also operates for a high signal level of approximately plus 25dB above normal when set to operate at 10dB signal to noise ratio.

OUTPUT MODULE – CONTACT OUTPUT

The output module-contact output performs two functions; alarming on low signal level using a telephone relay with two form C contacts, and indicating signal level with its self-contained CLI instrument.

The alarm circuit consists of all components associated with IC1, IC2, Q1, Q2, Q3, and relay AL. The signal level from the S/N detection module is fed into a level detector consisting of IC1B and resistors R6, R7, R8, and R9. An adjustable reference for the level detector consisting of IC1A and R1, R2, R17, R3, R4, and R5 is also fed into the level detector. As long as the signal level exceeds the value set by the reference, there will be approximately plus 12 volts out of the level detector into the photo-optical isolator. This causes Q1 to become non-conducting and thus transistors Q2 followed by transistor Q3 to become conducting. As a consequence, the alarm relay AL is picked up on signal levels above the alarm level. When the signal level drops below the alarm level set by the reference, the output of the level detector will be minus 12 volts causing Q1 to become conducting and Q2 and Q3 to become non-conducting and drop out the alarm relay AL. The alarm relay has a delay of

approximately 40 milliseconds on dropout to prevent undesirable alarming on short temporary loss of signal. Note that the level of alarm is set by adjusting alarm level R17, accessible from front of module, independent of the low signal level output from the output module (which is set by L.L. ADJ. R178). Also both of these outputs operate on total signal level within the passband of the receiver.

The CLI instrument operates directly on signal level received from the S/N detection module. It measures signal level in the entire bandwidth of the receiver and thus closely correlates with the low level clamp (L.L. ADJ.) and the low signal alarm AL (alarm level). It thus can be used in setting both of these adjustments.

POWER SUPPLY

The +12 volt dc, -12 volt dc, and the +45 volt dc supply voltages for the receiver are derived from the power supply module.

The +12 volt dc supply and the -12 volt dc supply are both derived from the DC to DC converter and are regulated for input voltages to the regulator of from 42 volts to 56 volts. For nominal 48 volt input units, the DC to DC converter has sufficient range so that the preregulator consisting of R1, R4, and Z1 is not necessary and is not connected by omitting jumpers J1 and J3 and supplying J7 and J2. In this case, then, the +45 volt supply is derived directly from the input supply voltage and is not regulated.

For nominal 125 volt input units, the pre-regulator consisting of R1, R4, and Z1 is necessary and is connected by supplying jumpers J1 and J3 and omitting J7 and J2. In this case then, the +45 volt supply is derived from this pre-regulator and is regulated.

The LED's D1 and D2 indicate when the power supply is energized with either 48V or 125V by the proper one glowing. Since all components are supplied in each power supply, a 48V supply can be converted to a 125V supply simply by removing jumpers J7 and J2 and inserting J1 and J3. Similarly, a 125V supply can be converted to a 48V supply by removing jumpers J1 and J3 and inserting J7 and J2. Capacitor C1 and C2 bypass rf or transient voltages to ground. Choke L1 with capacitor C3

form a trap to isolate the receiver from transient voltages in the 20kHz range that may appear on the dc supply and which could affect the receiver.

CHARACTERISTICS

Center Frequencies Available	30kHz to 300kHz in 0.5kHz increments
Maximum Sensitivity (Noise free)	0.005 volts (65dB below 1 watt for limiting)
Input Impedence	5000 ohms minimum
Bandwidth (Input L C Filter)	Down 3dB at ± 800 hertz Down 30dB at ± 5000 hertz
Overall receiver selectivity	Down 3dB at ± 225 hertz Down 35dB at ± 1000 hertz
Operating Time	4 milliseconds channel (Transmitter and receiver back to back)
Signal-to-noise ratio clamp setting	10dB SNR (as shipped) Nominal
Ambient Temperature Range	-20°C to $+55^{\circ}\text{C}$
Battery Voltage Variations	
Nominal 48V dc	42V dc — 56V dc
Nominal 125V dc	105V dc — 140V dc
Battery Drain	0.25 Amperes
Dimensions	Panel Height = $5\frac{1}{4}$ inches (3RU) Panel Width = 19 inches
Weight	13 pounds
CLI Accuracy	$\pm 2\text{dB}$ between -15dB and 0dB .

INSTALLATION

The TCF-10 receiver is generally supplied in a cabinet or a relay rack as part of a complete carrier assembly. The location must be free from dust,

excessive humidity, vibration, corrosive fumes, or heat. In particular equipment which generates excessive heat such as power supplies should not be mounted directly beneath the TCF-10. Heat rising will tend to raise the ambient temperature immediately around the chassis above acceptable levels. The maximum ambient temperature around the chassis must not exceed 55°C . In addition, sudden fluctuations in ambient temperature caused by these power supplies due to variations in load can cause variations in performance due to uneven heating of the receiver introducing abnormal temperature variations in the receiver.

ADJUSTMENTS

All factory adjustments of the TCF-10 receiver have been carefully made and should not be altered unless there is evidence of damage or malfunctioning. Such adjustments are: frequency and output level of the oscillator and mixer; input to the amplifier and limiter; frequency spacing and magnitude of discriminator output peaks; pickup of alarm relay; and pickup of low signal level clamp. The adjustment that must be made at time of installation is the setting of input attenuator R5. The input attenuator adjustment is made by a knob on the front of the panel of the input module.

The receiver should not be set with a greater margin of sensitivity than is needed to assure correct operation with the maximum expected variation to attenuation of the transmitter signal. In the absence of data on this, the receiver may be set to operate on a signal that is 15dB below the maximum expected signal. After installation of the receiver and the corresponding transmitter, and with a normal space signal level being received, input attenuator R5 should be adjusted to the position at which the receiver clamps into neither a mark nor space output. The attenuator R5 should then be readjusted to increase the voltage supplied to the receiver by 15dB. The scale markings for R5 permit approximate settings to be made, but it is preferable to make this setting by means of the dB scales of an ac VTVM connected across the terminals indicated at the front panel of the input module. The red terminal is connected to the wiper arm of R5 and the black terminal is connected to ground. With this setting, a 15dB drop in signal will cause a low signal level clamp operation which will lock the output of

the receiver into neither a mark nor a space output at the point at which the receiver just drops out of limiting.

The only other adjustment which may be necessary at the time of initial installation is the adjustment of the CLI instrument to correspond to proper variation of signal level from normal. This may be necessary if the instrument was not supplied with the receiver and was not adjusted by the factory. If this instrument was supplied and adjusted by the factory, then it could be used in adjusting R5. In this case, it would be necessary only to adjust R5 with a normal signal being received so that the instrument indicates 0dB.

If the instrument was not previously adjusted by the factory, then the following procedure should be used in adjusting the instrument. (Note: When CLI instrument is supplied within the chassis, this is factory adjusted.)

1. Set incoming level into receiver at +10dB above normal level.
2. Adjust span adjustment, R147, so that the voltage at TP72 with respect to TP62 (common) is +3.000 volts.
3. Reduce incoming signal into receiver by 30dB.
4. Adjust full scale adjustment, R153, so that instrument now reads -20dB. (This is approximately 0 microamperes).
5. Increase signal to +10dB level. (This is 100 microamperes).
6. Adjust slope adjustment R155 to read +10dB on instrument.
7. Reduce signal to normal level. Instrument should read 0dB. If desired, instrument could be adjusted to read 0dB with R155 with sacrifice in reading accuracy for +10dB.

FACTORY ADJUSTMENTS

In case the factory adjustments have been altered or there is suspicion of improper adjustments or malfunctioning, then the following procedures can

be used. In addition, alterations to the settings used by the factory for low signal level clamping and low signal-to-noise ratio clamping can be made using these procedures if desired.

Potentiometer R12 in the oscillator and mixer should be set for 0.3 volts, measured with a VTVM connected between TP11 and terminal 33 on the circuit board (ground terminal of voltmeter). A frequency counter can be connected to the same points for a check on the frequency which should be 20kHz above the channel center frequency. The frequency is fixed by the crystal used, except that it may be changed a few cycles by the value of capacitor C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that assures reliable starting of oscillation. The frequency at room temperature is usually several cycles above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should be connected from TP56 at the base of Q54 to terminal 33 of the limiter. With 5 millivolts of space frequency on the receiver input (R5 set at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting.

The adjustment of the signal to noise ratio clamp for clamping at 10dB signal to noise ratio is as follows:

1. Set the incoming signal into receiver at nominal level (28 mv.)
2. Adjust IF input with R111 so that signal at TP68 of the S/N detector module is +100 mv dc (with respect to TP62).
3. Adjust RF input with R94 so that signal at TP63 is +145 mv dc (with respect to TP62).
4. Adjust log amplifier balance potentiometer R129 so that S/N clamps operates. This will be +6 volts dc at TP75. This will also appear as +12 volts at TP91 of the output board and the red S/N level indicator will light.

5. Go back and readjust RF input with R94 so that signal level at TP63 is now 74.4 mv dc.

The adjustments above are for operation of the clamp at 10dB or less signal to noise ratios. If it is desired to clamp at other than 10dB or less, the following values can be used in place of the 145 mv value in step 3.

For S/N of 0dB set TP63 to 297mv.
5dB set TP63 to 200mv.
15dB set TP63 to 114mv.
20dB set TP63 to 97mv.

NOTE: When the SNR clamp is set to clamp at a 10dB signal to noise ratio, the receiver will also clamp at a high signal level of approximately 25dB above normal.

The low signal level clamp is set to operate at the signal level where the receiver just drops out of limiting. This is accomplished as follows:

1. With a normal space frequency signal being received and with an oscilloscope connected across TP56 and terminal 33 of the limited module, adjust input attenuator R5 to the point where the peaks of the oscilloscope trace just begin to flatten. (An alternate adjustment would be to set incoming signal level into receiver at 5mv with R5 set at zero which is the point at which limiting should begin.
2. Adjust the -V Ref. adjustment R178 on the output module so that the low level clamp just picks up. This will be indicated by the red low level light of the output module coming on. There also will be +12 volts at TP86 on the output module.
3. Adjust input attenuator R5 to increase signal into receiver by desired margin of operation. This normally should be 15dB. This is done by reducing the R5 attenuator setting.

The alarm level is set to alarm at a signal level 5dB above the signal where the receiver just drops out of limiting. This will result in an alarm be given at a point where the signal level has dropped 10dB from the initial nominal setting but the receiver signal level is still 5dB above limiting.

1. With a normal higher frequency signal being received and with an RF voltmeter connected across the input module input test jacks TJ1 and TJ2 (available at front on module), adjust input attenuator R5 to where signal level is 9mv across these test jacks.

2. Adjust the alarm level R17 on the output module – contact output to the point where the alarm relay AL just drops out.

3. Adjust input attenuator R5 to increase signal level into receiver by 10dB. (This is for operation with 15dB margin. For other than 15dB margin, this value should be changed accordingly.) This is done by reducing the R5 attenuator setting by 10dB.

MAINTENANCE

Periodic checks of the received carrier signal level and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenuation control, R5. A change in operating margin from the original setting can be detected by observing the change in the dial setting required to cause a low signal level clamp to operate as indicated by the red low level LED becoming lit. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal level or loss in receiver sensitivity.

All adjustable components for normal field adjustments on the printed circuit modules are accessible when the front cover on the chassis is removed. All other adjustable components on the printed circuit modules may be made entirely accessible while permitting electrical operation by using module extender style number 1447C86G01. This permits attaching instrument leads to the various test points of terminals when making voltage, oscilloscope or frequency checks.

RELAY MAINTENANCE AND ADJUSTMENT

The AL relay contacts should be cleaned periodically. A contact burnisher S#182A836H01 is recommended for this purpose. The use of abrasive

material for cleaning contacts is not recommended, because of the danger of embedding small particles in the face of the soft silver and thus impairing the contact. Care must be taken to avoid distorting the contact springs during burnishing.

These relays have been properly adjusted at the factory to insure correct operation, and under normal field conditions they should not require readjustment. If, however, the adjustments are disturbed in error, or if it becomes necessary to replace some part, the following adjustment procedure should be used.

In the AL relay the armature gap should be approximately 0.004 inch with the armature closed. This adjustment is made with the armature stop screw and locknut. The contact leaf springs should be adjusted to obtain at least 0.015 inch gap on all contacts when fully open. There should be at least 0.010 inch follow on all normally-open contacts and 0.005 inch follow on all normally-closed contacts. The relay should pick up at approximately 35 volts.

TABLE I
RECEIVER D-C MEASUREMENTS

NOTE: All voltage readings taken with the negative of dc VTVM on terminal 17 (negative dc). Receiver adjusted for 15dB operating margin with space and mark signals down 50dB from 1 watt or 60dB down from 10 watts. Unless indicated otherwise, voltage will not vary appreciably whether signal is lower frequency, higher frequency, or zero.

Collector of Transistor or Test Point	Voltage (Positive)
Q11	< 15
Q12 (TP12)	17 (Mark or Space)
Q13 (TP13)	17 (Mark or Space)
Q14 (TP14)	3
Q15 (TP15)	3
TP11	22
TP52	19
Q51 (TP51)	14
Q52 (TP53)	14.5
Q53 (TP54)	18

Q54 (TP55)	3
TP56	19
Q55	< 1 (Lower Freq. or No Signal)
Q55	23 (Higher Freq.)
Q56	23 (Lower Freq.)
Q56	< 1 (Higher Freq. or No Signal)

NOTE: The following readings are taken with the negative of dc VTVM on terminal 3 (common of dc power supply) of either the S/N detection module or the output module.

TP61	+ 4
TP62	0
TP63	+ 0.4
TP64	+ 6
TP65	- 12
TP66	0
TP67	+ 0.5
TP68	+ 0.5
TP70	- 6
TP71	+ 6
TP72	+ 1.5
TP73	+ 0.8
TP74	+ 0.3
TP81	+ 12 (Higher Frequency)
TP81	- 12 (Lower Freq. or No Signal)
TP82	+ 12 (Lower Frequency)
TP82	- 12 (Higher Freq. or No Signal)
TP83	+ 12 (Higher Frequency)
TP83	- 12 (Lower Freq. or No Signal)
TP84	+ 12 (Lower Frequency)
TP84	- 12 (Higher Freq. or No Signal)
TP85	+ 0.3
TP86	+ 12 (Low level clamp)
TP86	0 (No clamp)
TP87	+ 6 (Low SNR clamp)
TP87	- 6 (No SNR clamp)
TP88	+ 12
TP89	- 12
TP90	+ 12 (Good Signal Level)
TP90	- 12 (Low Signal Level clamp)

TABLE II
RECEIVER RF MEASUREMENTS

NOTE: Voltmeter readings taken at any point from receiver input to stage involving transistor Q15 are neither meaningful or feasible because of either waveform variations or the effect of instrument loading on the readings. Receiver adjusted as in Table I.

Collector of Transistor or Test Point	Volts with Signal At +10dB Above Normal Level
Q15 (TP15)	0.8
Q51 (TP51)	0.9
Q52 (TP53)	0.65
Q53 (TP54)	2.2
Q54 (TP55)	4.5
TP61	.013
TP67	.275

FILTER RESPONSE MEASUREMENTS

The LC input filter (FL201) and the IF filter (FL2) are in sealed containers, and repairs can only be made by the factory. The stability of the original response characteristics is such that in normal usage, no appreciable change in response will occur. However, the test circuits of Figure 19 can be used in case there is reason to suspect that either of the filters is not performing correctly.

Figure 2 shows the -3dB and -35dB checkpoints for the IF filter, and the -3dB checkpoints for the input filter. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Figure 2 was chosen to show the IF filter response, which permitted only a portion of the input filter curve to be shown. The checkpoints for the pass-band of each section of the IF filter are down 3dB maximum at 19.75 and 20.25kHz, and for the stop band are down 18dB minimum at 19.00 and 21.00kHz for each section. The signal generator voltage (Figure 19) must be held constant throughout the entire check. A value of 7.8 volts is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22dB below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only,

and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16dB less than the measured difference because of the input resistance and the difference in input and output impedances of the filter.

In testing the LC filter, a value of approximately 2.45V is suitable for the constant voltage at which to hold VM1 throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency, but should not be more than 18dB below the reading of VM1. (The filter insertion loss is approximately 6dB less than the difference in readings.

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a TCF-10 receiver for operating at a different channel frequency consist of a new LC input filter (FL201), a new local oscillator crystal (Y11) and probably a different feedback capacitor (C12). There are two ways of effecting this change. The easiest and preferred method is to order a new input filter module and a new oscillator mixer module for the new frequencies from the factory. The new modules would then just have to be plugged in as replacements for the original modules. The second method would involve ordering just replacement filter, FL201, and new local oscillator crystal for the new frequencies and making the substitution on the modules. These substitutions on the modules are not difficult as the crystal plugs in and the filter has five leads to be soldered. However, testing of the local oscillator for easy starting will have to be made, and the value of C12 chosen to assure this easy starting of oscillation. The whole receiver should then be checked out for correct performance.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation

- a. A-C Vacuum Tube Voltmeter (VTVM).
Voltage range 0.003 to 30 volts, frequency range 60 hertz to 330 kHz, input impedance 7.5 megohms.
- b. D-C Vacuum Tube Voltmeter (VTVM).
Voltage range: 1.5 to 300 volts
Input impedance: 7.5 megohms

- c. CLI Microammeter, range 0-100 μ A, style number 606B592A26, (if receiver has carrier level indicator)

II. Desirable Test Equipment for Apparatus Maintenance

- a. All items listed in I.
- b. Signal Generator
Output Voltage: up to 8 volts
Frequency Range: 20kHz to 330kHz
- c. Oscilloscope
- d. Frequency counter
- e. Ohmmeter
- f. Capacitor checker

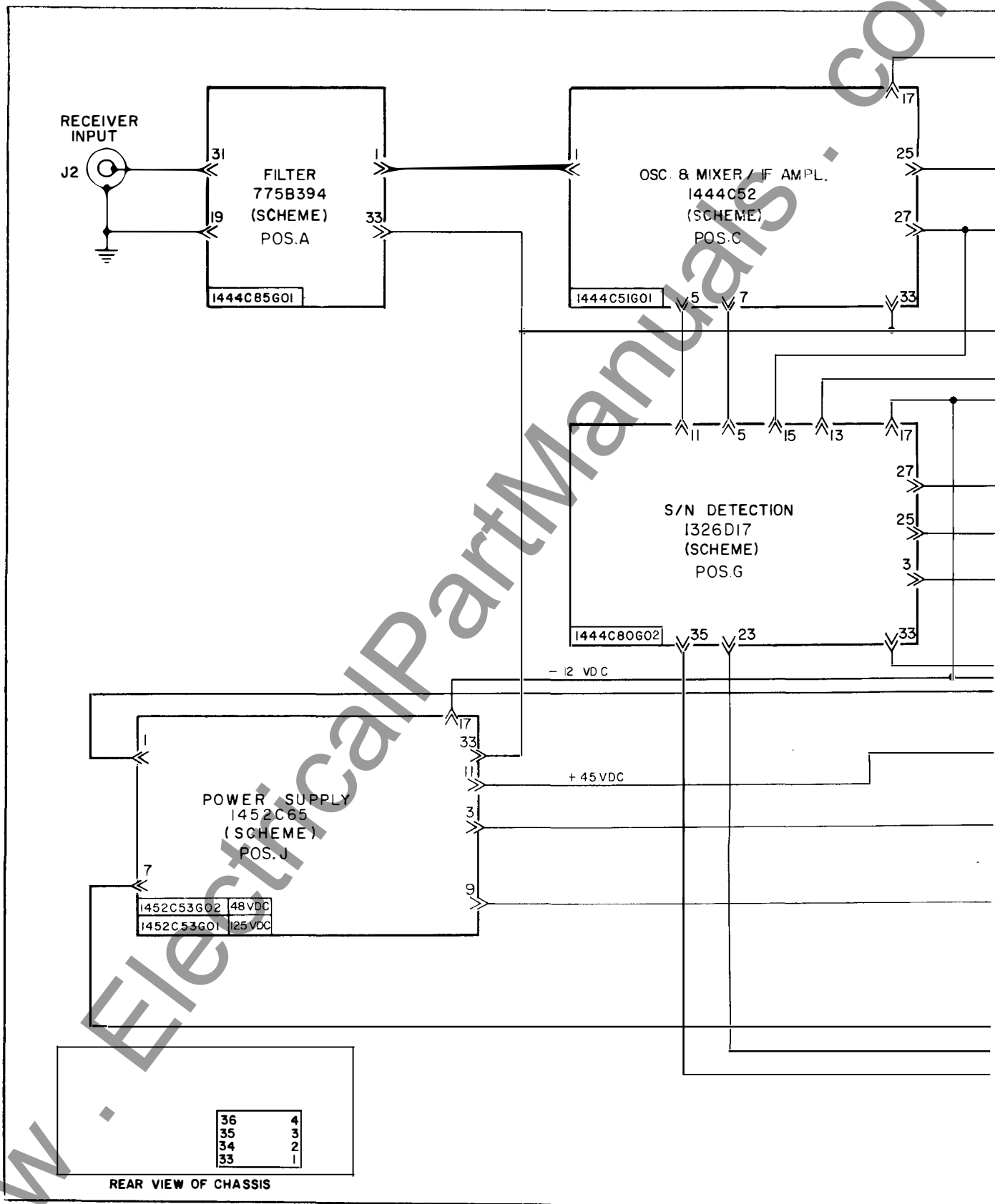
- g. Milliammeter, 0-1.5 or preferably 1.5-0-1.5 range, for checking discriminator.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard 19" rack but also can be removed and used as a portable unit.

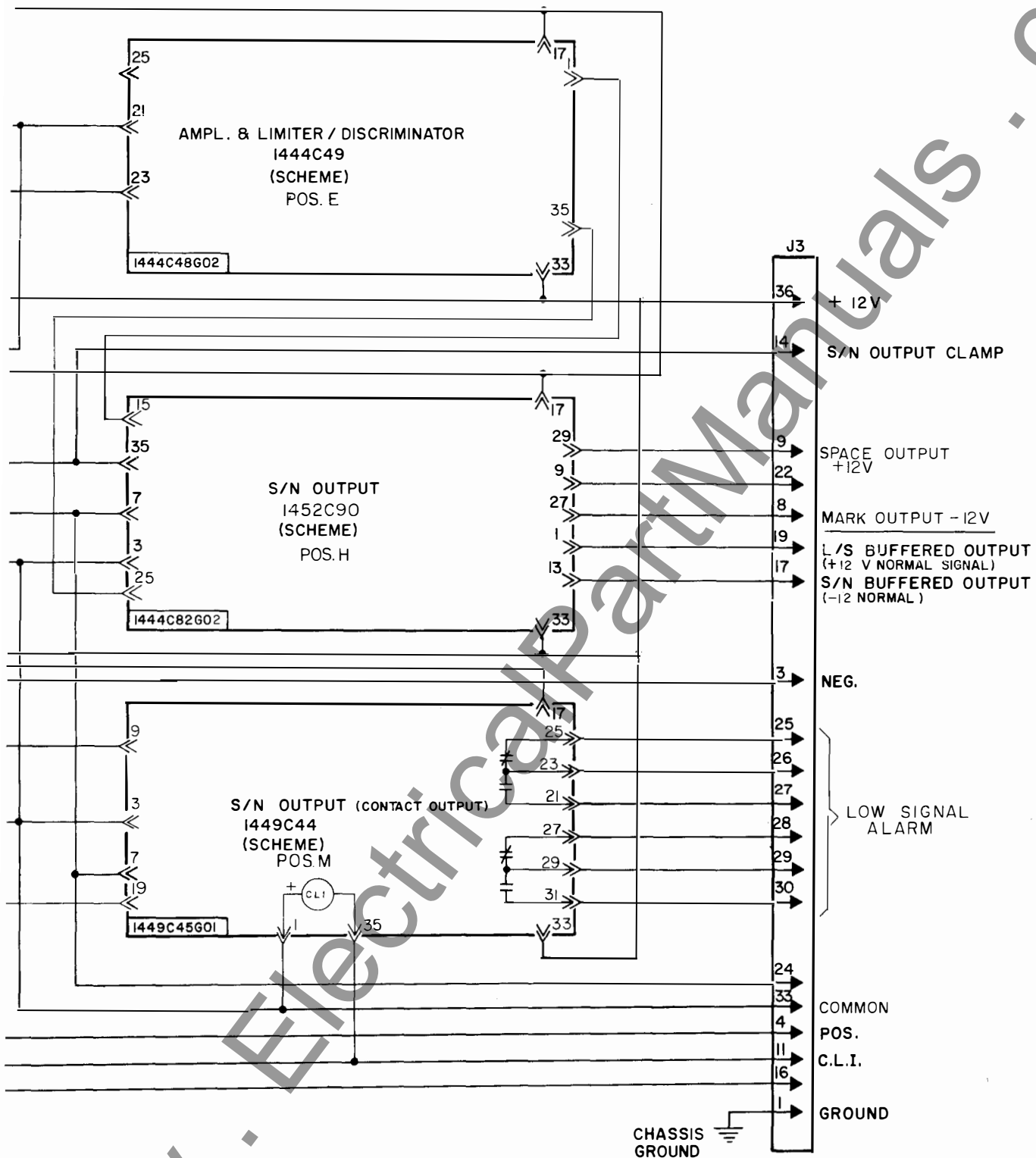
RENEWAL PARTS

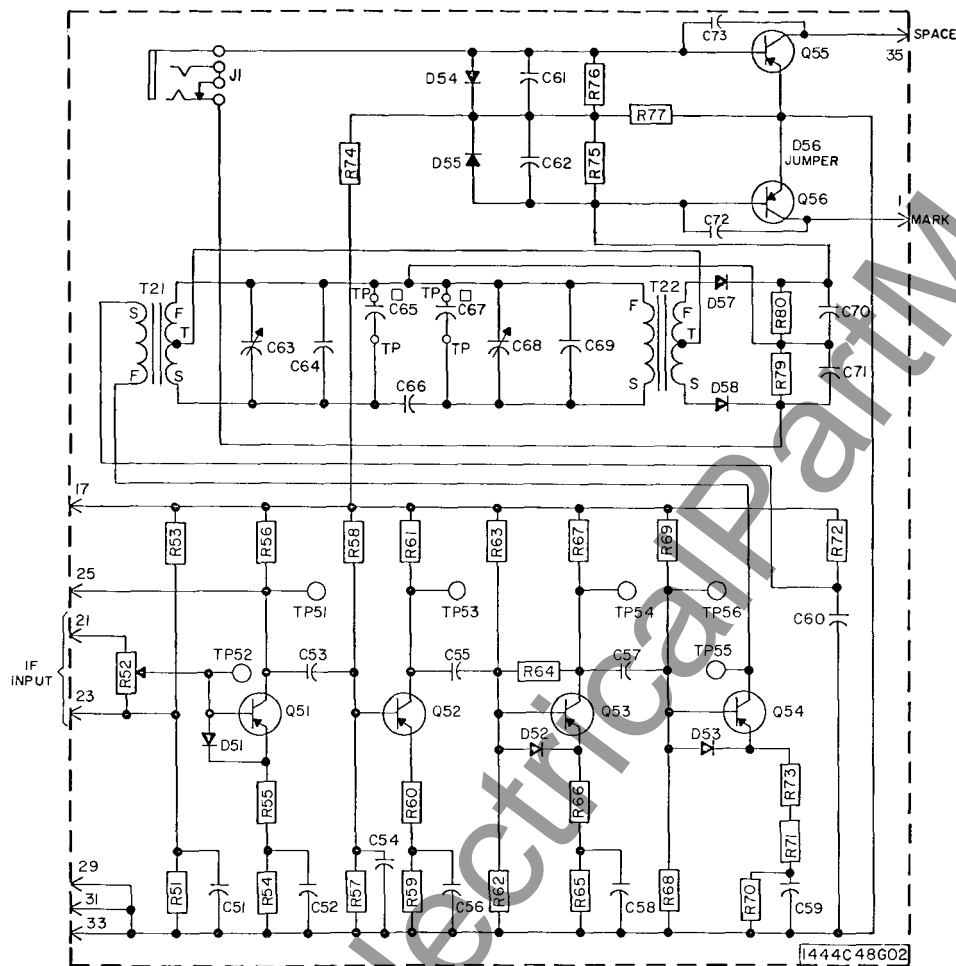
Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

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★ Fig. 1. Overall Scheme





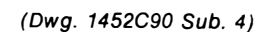
COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR .250UF 200V	187A624H02
C52	CAPACITOR .250UF 200V	187A624H02
C53	CAPACITOR .100UF 200V	187A624H01
C54	CAPACITOR 300.000PF 500V	187A584H15
C55	CAPACITOR .100UF 200V	187A624H01
C56	CAPACITOR .250UF 200V	187A624H02
C57	CAPACITOR .100UF 200V	187A624H01
C58	CAPACITOR .250UF 200V	187A624H02
C59	CAPACITOR .250UF 200V	187A624H02
C60	CAPACITOR 1.000UF 200V	187A624H04
C61	CAPACITOR .220UF 50V	762A703H01
C62	CAPACITOR .220UF 50V	762A703H01
C63	CAPACITOR 4.5TO 100PF	762A736H02
C64	CAPACITOR 9100.000PF 200V	187A624H16
C65	CAPACITOR SEE NOTE □	
C66	CAPACITOR 100.000PF 500V	187A684H08
C67	CAPACITOR SEE NOTE □	
C68	CAPACITOR 4.5TO 100PF	762A736H02
C69	CAPACITOR 9100.000PF 200V	187A624H16
C70	CAPACITOR .220UF 50V	762A703H01
C71	CAPACITOR .220UF 50V	762A703H01
C72	CAPACITOR 330.000PF 200V	880A397H01
C73	CAPACITOR 330.000PF 200V	880A397H01
D51	DIODE 1N457A	184A855H07
D52	DIODE 1N457A	184A855H07
D53	DIODE 1N457A	184A855H07
D54	DIODE 1N457A	184A855H07
D55	DIODE 1N457A	184A855H07
D56	DIODE 1N457A	184A855H07
D57	DIODE 1N628	184A855H12
D58	DIODE 1N628	184A855H12
R51	RESISTOR 4700.0 .50W 5%	184A763H43
R52	RESISTOR 27.0K .50W 5%	184A763H51
R53	RESISTOR 2200.0 .50W 5%	184A763H35
R54	RESISTOR 27.0 .50W 5%	184A763H51
R55	RESISTOR 13.0K .50W 5%	184A763H51
R56	RESISTOR 4700.0 .50W 5%	184A763H43
R57	RESISTOR 27.0K .50W 5%	184A763H43
R58	RESISTOR 150.0 .50W 5%	184A763H31
R59	RESISTOR 180.0 .50W 5%	184A763H09
R60	RESISTOR 4700.0 .50W 5%	184A763H43
R61	RESISTOR 2200.0 .50W 5%	184A763H35
R62	RESISTOR 33.0K .50W 5%	184A763H63
R63	RESISTOR 2700.0 .50W 5%	184A763H37
R64	RESISTOR 68.0 .50W 5%	184A763H23
R65	RESISTOR 4700.0 .50W 5%	184A763H43
R66	RESISTOR 2700.0 .50W 5%	184A763H37
R67	RESISTOR 18.0K .50W 5%	184A763H57
R68	RESISTOR 220.0 .50W 5%	184A763H11
R69	RESISTOR 68.0 .50W 2%	629A531H04
R70	RESISTOR 330.0 .50W 5%	184A763H15
R71	RESISTOR 56.0 .50W 2%	629A531H02
R72	RESISTOR 12.0K .50W 5%	184A763H53
R73	RESISTOR 3000.0 .50W 5%	184A763H38
R74	RESISTOR 2200.0 .50W 5%	184A763H35
R75	RESISTOR 220.0 .50W 5%	184A763H11
R76	RESISTOR 2200.0 .50W 5%	184A763H35
R77	RESISTOR 2200.0 .50W 5%	184A763H35
R78	RESISTOR 2200.0 .50W 5%	184A763H35
R79	RESISTOR 2200.0 .50W 5%	184A763H35
R80	RESISTOR 2200.0 .50W 5%	184A763H35
R81	RESISTOR 1.0K .50W	629A654H04
Q51	TRANSISTOR 2N4249	849A441H03
Q52	TRANSISTOR 2N4249	849A441H03
Q53	TRANSISTOR 2N4249	849A441H03
Q54	TRANSISTOR 2N4249	849A441H03
Q55	TRANSISTOR 2N3645	849A441H01
Q56	TRANSISTOR 2N3645	849A441H01
T21	TRANSFORMER	606B533G01
T22	TRANSFORMER	606B533G02
J1	TELEPHONE JACK	187A606H01

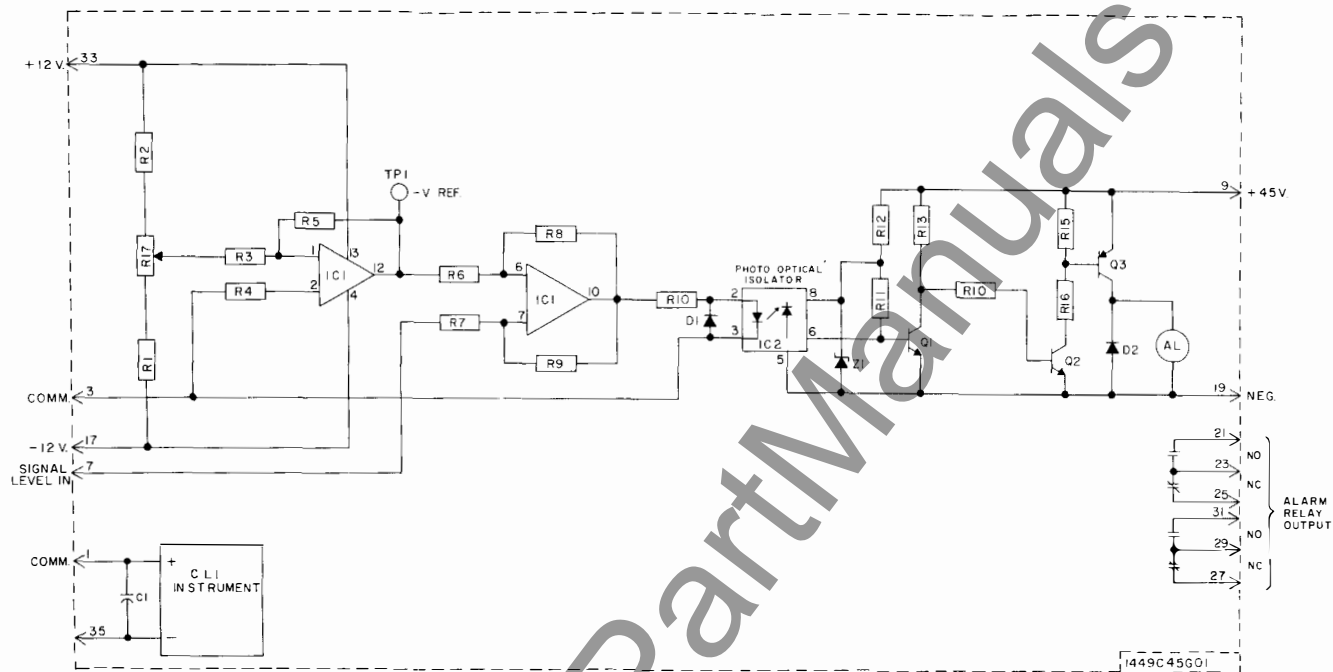
□—ONE OR TWO CAPACITORS USED; VALUES DETERMINED IN TEST.

Fig. 5. Internal Schematic Amplifier Limiter-Discriminator Module.

(Dwg. 1444C49 Sub. 4)

COMPONENT	DESCRIPTION	STYLE NO.	COMPONENT	DESCRIPTION	STYLE NO.
R81	RESISTOR 1000.0 .50W 1%	848A819H45	R94	POT 20.0K .50W	629A645H05
R82	RESISTOR 2210.0 .50W 1%	848A819H41	R111	POT 50.0K .50W	629A645H12
R83	RESISTOR 10.2K .25W 1%	848A820H46	R129	POT 2.5K .25W	629A645H07
R84	RESISTOR 10.0K .25W 1%	848A820H45	R147	POT 250.0K .75W	880A826H10
R85	RESISTOR 56.2K .25W 1%	848A821H18	R153	POT 2.5K .25W	629A645H07
R86	RESISTOR 10.0K .50W 1%	848A820H45	C81	CAPACITOR 2000.000PF 500V	187A584H01
R87	RESISTOR 2210.0 .50W 1%	848A819H31	C82	CAPACITOR 1000.000PF 200V	880A397H07
R88	RESISTOR 10.2K .25W 1%	848A820H46	C83	CAPACITOR 220.000PF 200V	879A989H17
R89	RESISTOR 10.0K .25W 1%	848A820H45	C84	CAPACITOR .010UF 50V	184A663H01
R90	RESISTOR 82.5K .50W 1%	848A821H34	C85	CAPACITOR 1.000UF 50V	3512A08H01
R91	RESISTOR 10.0K .50W 1%	848A820H45	C86	CAPACITOR .010UF 50V	184A663H01
R92	RESISTOR 6190.0 .50W 1%	848A820H25	C87	CAPACITOR 2000.000PF 500V	187A584H01
R93	RESISTOR 4990.0 .50W 1%	848A820H16	C88	CAPACITOR 1000.000PF 200V	880A397H07
R95	RESISTOR 4750.0 .25W 1%	848A820H14	C89	CAPACITOR 33.000PF 200V	879A989H07
R96	RESISTOR 4750.0 .25W 1%	848A820H14	C90	CAPACITOR .010UF 50V	184A663H01
R97	RESISTOR 4990.0 .50W 1%	848A820H16	C91	CAPACITOR .010UF 50V	184A663H01
R98	RESISTOR 15.0K .50W 1%	848A820H62	C92	CAPACITOR 1.000UF 50V	3512A08H01
R99	RESISTOR 4990.0 .50W 1%	848A820H16	C93	CAPACITOR .010UF 50V	184A663H01
R100	RESISTOR 4990.0 .50W 1%	848A820H16	C94	CAPACITOR 33.000PF 200V	879A989H07
R101	RESISTOR 4990.0 .50W 1%	848A820H16	C95	CAPACITOR .010UF 50V	184A663H01
R102	RESISTOR 10.0K .50W 1%	848A820H45	C96	CAPACITOR .010UF 50V	184A663H01
R103	RESISTOR 10.0K .50W 1%	848A820H45	C97	CAPACITOR .470UF 50V	762A620H04
R104	RESISTOR 10.0K .50W 1%	848A820H45	C98	CAPACITOR 33.000PF 200V	879A989H07
R105	RESISTOR 10.0K .50W 1%	848A820H45	C99	CAPACITOR .010UF 50V	184A663H01
R106	RESISTOR 10.0K .50W 1%	848A820H45	C100	CAPACITOR .010UF 50V	184A663H01
R107	RESISTOR 10.0K .50W 1%	848A820H45	C101	CAPACITOR 33.000PF 200V	879A989H07
R108	RESISTOR 100.0K .50W 1%	848A821H42	C102	CAPACITOR .010UF 50V	184A663H01
R109	RESISTOR 10.0K .50W 1%	848A820H45	C103	CAPACITOR 33.000PF 200V	879A989H07
R110	RESISTOR 1000.0 .50W 1%	848A819H43	C104	CAPACITOR .010UF 50V	184A663H01
R112	RESISTOR 4750.0 .25W 1%	848A820H14	C105	CAPACITOR .010UF 50V	184A663H01
R113	RESISTOR 4750.0 .25W 1%	848A820H14	C106	CAPACITOR .047UF 50V	848A646H07
R114	RESISTOR 15.0K .50W 1%	848A820H62	C107	CAPACITOR 33.000PF 200V	879A989H07
R115	RESISTOR 4990.0 .50W 1%	848A820H16	C108	CAPACITOR .010UF 50V	184A663H01
R116	RESISTOR 4990.0 .50W 1%	848A820H16	C109	CAPACITOR .010UF 50V	184A663H01
R117	RESISTOR 4990.0 .50W 1%	848A820H16	C110	CAPACITOR .22 UF 100V	3512A08H02
R118	RESISTOR 4990.0 .50W 1%	848A820H16	IC1	INT CKT SE531T	3512A10H01
R119	RESISTOR 10.0K .50W 1%	848A820H45	IC2	INT CKT SE531T	3512A10H01
R120	RESISTOR 1000.0 .50W 1%	848A819H48	IC3	INT CKT SE531T	3512A10H01
R121	RESISTOR 15.0K .50W 1%	848A820H62	IC4	INT CKT SE531T	3512A10H01
R122	RESISTOR 15.0K .50W 1%	848A820H62	IC5	INT CKT SE531T	3512A10H01
R123	RESISTOR 10.0K .50W 1%	848A820H45	IC6	INT CKT 747DM	1443C52H01
R124	RESISTOR 10.0K .50W 1%	848A820H45	IC7	INT CKT SE531T	3512A10H01
R125	RESISTOR 10.0K .50W 1%	848A820H45	IC8	INT CKT SE531T	3512A10H01
R126	RESISTOR 10.0K .50W 1%	848A820H45	IC9	INT CKT SN56502	3512A09H01
R127	RESISTOR 2.0K .50W 1%	848A819H77	IC10	INT CKT 747DM	1443C52H01
R128	RESISTOR 9530.0 .50W 1%	848A820H43	IC11	INT CKT 747DM	1443C52H01
R130	RESISTOR 9530.0 .50W 1%	848A820H43	IC12	INT CKT SN56502	3512A09H01
R131	RESISTOR 10.0K .50W 1%	848A820H45	IC13	INT CKT 747DM	1443C52H01
R132	RESISTOR 10.0K .50W 1%	848A820H45	D61	DIODE 1N4148	836A928H06
R133	RESISTOR 10.0K .50W 1%	848A820H45	D62	DIODE 1N4148	836A928H06
R134	RESISTOR 10.0K .50W 1%	848A820H45	D63	DIODE 1N4148	836A928H06
R135	RESISTOR 10.0K .50W 1%	848A820H45	D64	DIODE 1N4148	836A928H06
R136	RESISTOR 15.0K .50W 1%	848A820H62	D65	DIODE 1N4148	836A928H06
R137	RESISTOR 10.0K .50W 1%	848A820H45	Z11	ZENER 1N825A 6.2V	862A288H06
R138	RESISTOR 10.0K .50W 1%	848A820H45	Z12	ZENER 1N825A 6.2V	862A288H06
R139	RESISTOR 10.0K .50W 1%	848A820H45	Z113	ZENER 1N825A 6.2V	862A288H06
R140	RESISTOR 475.0K .25W 1%	848A822H03	J111	JUMPER 0 OHM RESISTOR	862A478H01
R141	RESISTOR 200.0K .50W 1%	848A819H71	J112	JUMPER 0 OHM RESISTOR	862A478H01
R142	RESISTOR 150.0 .50W 1%	848A819H68	J113	JUMPER 0 OHM RESISTOR	862A478H01
R144	RESISTOR 750.0 .50W 1%	848A819H36	J114	JUMPER 0 OHM RESISTOR	862A478H01
R145	RESISTOR 15.7K .50W 1%	848A820H71	T31	TRANSFORMER	7148677G01
R146	RESISTOR 4990.0 .50W 1%	848A820H16	T32	TRANSFORMER	7148677G01
R148	RESISTOR 1000.0 .50W 1%	848A819H48			
R149	RESISTOR 15.0K .50W 1%	848A820H62			
R150	RESISTOR 2.0K .50W 1%	848A819H77			
R151	RESISTOR 2.0K .50W 1%	848A819H77			
R152	RESISTOR 17.8K .25W 1%	848A820H69			
R154	RESISTOR 1.0K .50W 1%	848A819H48			
R155	RESISTOR 1.0K .25W 20% 629A430H02				
R156	RESISTOR 150.0 .50W 1%	848A819H68			
R157	RESISTOR 20.0K .50W 1%	848A820H74			
R158	RESISTOR 20.0K .50W 1%	848A820H74			

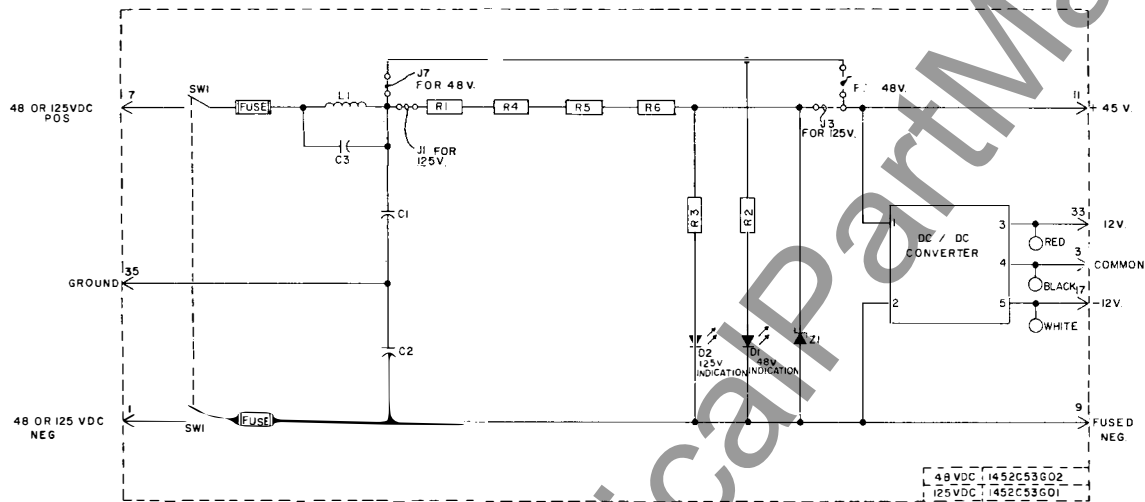




COMPONENT	DESCRIPTION	STYLE NO.
R1	RESISTOR	10K .50W 5%
R2	RESISTOR	10K .50W 5%
R3	RESISTOR	6.8K .50W 1%
R4	RESISTOR	4.99K .50W 1%
R5	RESISTOR	6.8K .50W 1%
R6	RESISTOR	2.0K .50W 1%
R7	RESISTOR	2.0K .50W 1%
R8	RESISTOR	562K .25W 1%
R9	RESISTOR	51K .50W 1%
R10	RESISTOR	3.3K .50W 2%
R11	RESISTOR	15K .50W 2%
R12	RESISTOR	120K .50W 2%
R13	RESISTOR	13.3K .50W 1%
R14	RESISTOR	15K .50W 2%
R15	RESISTOR	6.8K .50W 2%
R16	RESISTOR	6.8K .50W 2%
R17	POT	2.5K .25W 10%
J1	JUMPER	0 OHM RESISTOR
D1	DIODE	1N645A
D2	DIODE	1N645A
Z1	ZENER	1N9578
Q1	TRANSISTOR	2N3417
Q2	TRANSISTOR	2N699
Q3	TRANSISTOR	2N3645
IC1	INT. CKT.	747DM
IC2	INT. CKT.	5082-4371
C1	CAPACITOR	.25MF0.200VDC
CLI	INSTRUMENT	—
AL	RELAY	—

(Dwg. 1449C44 Sub. 4)

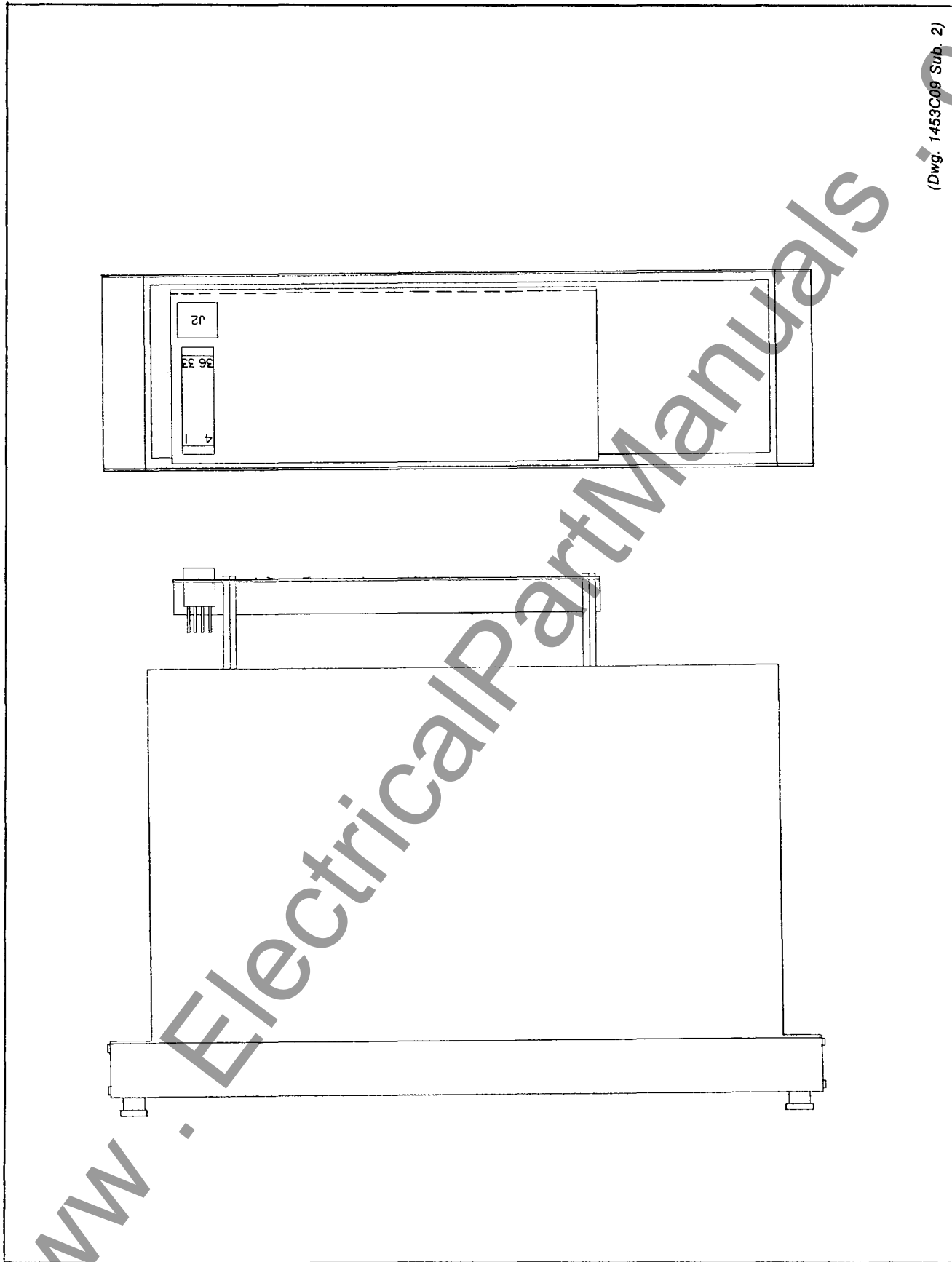
✱ Fig. 8. Internal Schematic Output Module-Contact Output.



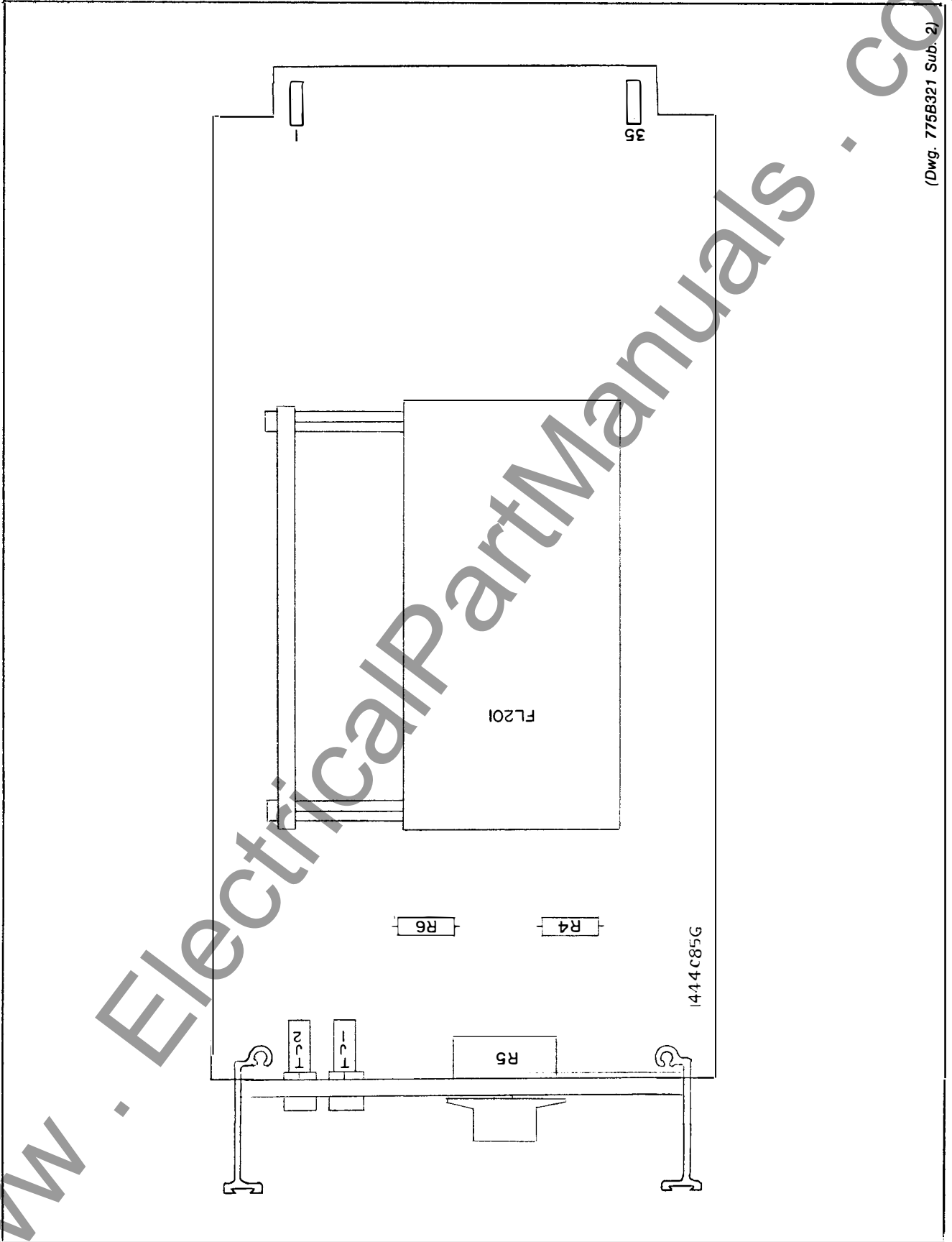
COMPONENT	DESCRIPTION	STYLE NO.
C1	CAPACITOR	01 MFD
C2	CAPACITOR	01 MFD
C3	CAPACITOR	047 MFD
R1,4,5,6	RESISTOR	75Ω 25 W
R2	RESISTOR	4.7K 50W 2%
R3	RESISTOR	4.7K 50W 2%
Z1	ZENER	IN2828B
J1	JUMPER	0 OHM RESISTOR
J2	JUMPER	0 OHM RESISTOR
J3	JUMPER	0 OHM RESISTOR
J7	JUMPER	0 OHM RESISTOR
SW1	SWITCH	DPDT
D1	DIODE	LED
D2	DIODE	LED
L1	COIL	292B096G02

(Dwg. 1452C65 Sub. 7)

★ Fig. 9. Internal Schematic Power Supply Module.



✱ Fig. 10. Component Location TCF-10 Receiver.



(Dwg. 775B321 Sub. 2)

Fig. 11. Component Location Input Filter Module

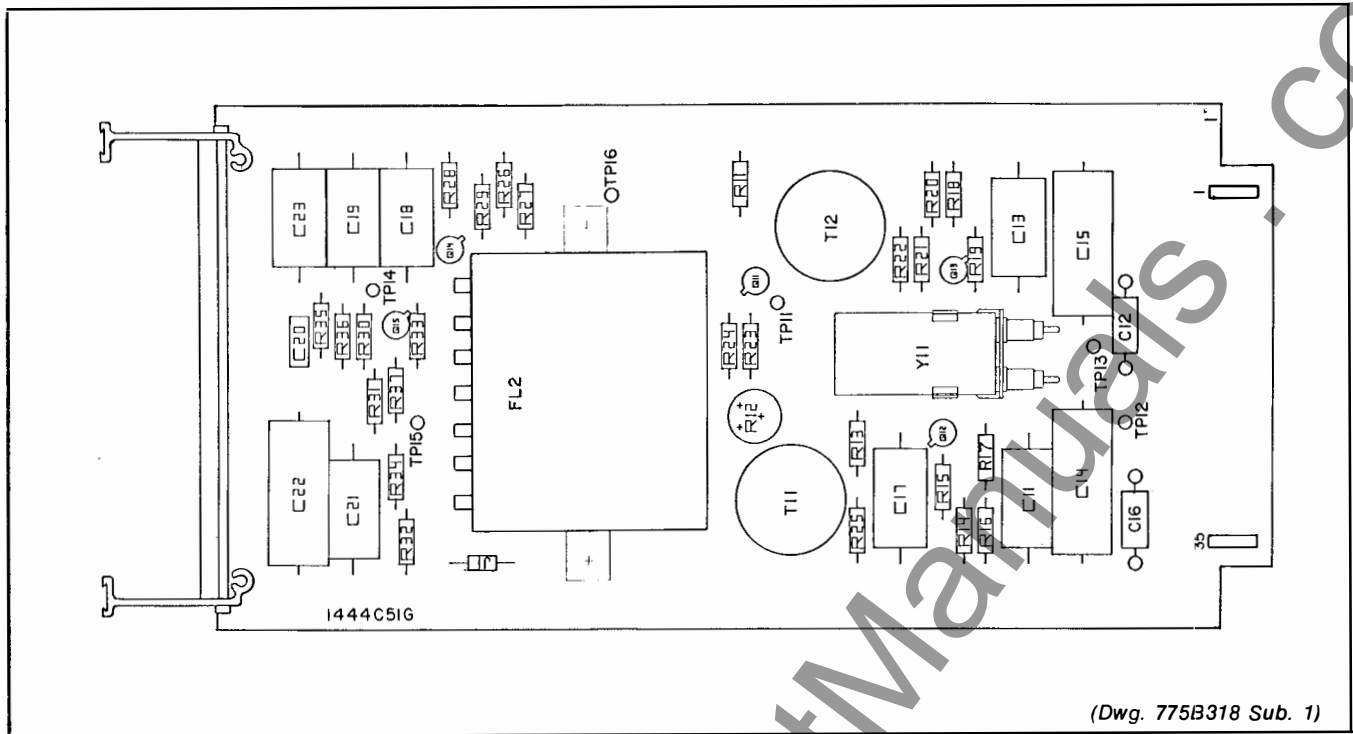


Fig. 12. Component Location Oscillator-Mixer-IF Amplifier Module.

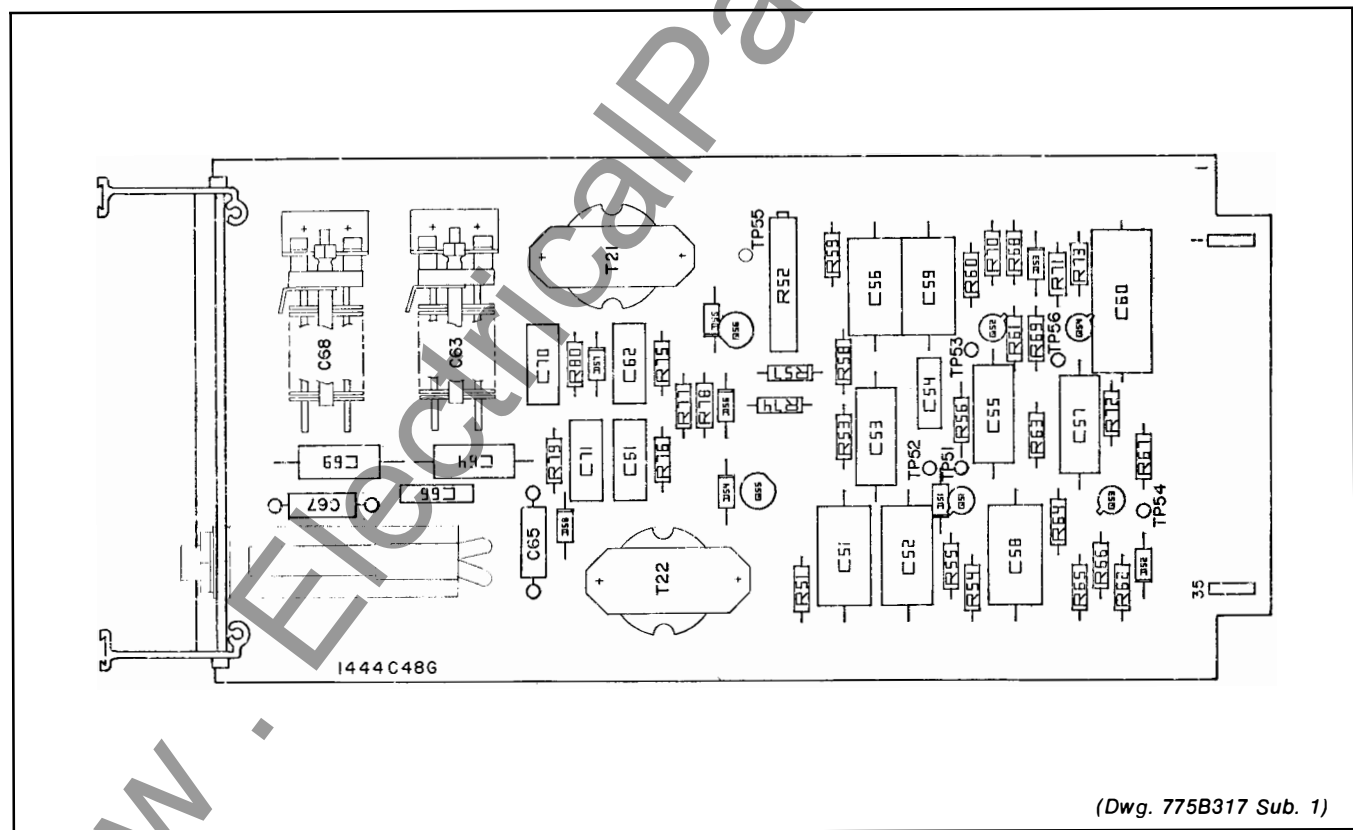


Fig. 13. Component Location Amplifier Limiter-Discriminator Module.

14-44 C826

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(Dwg. 775B320 Sub. 4)

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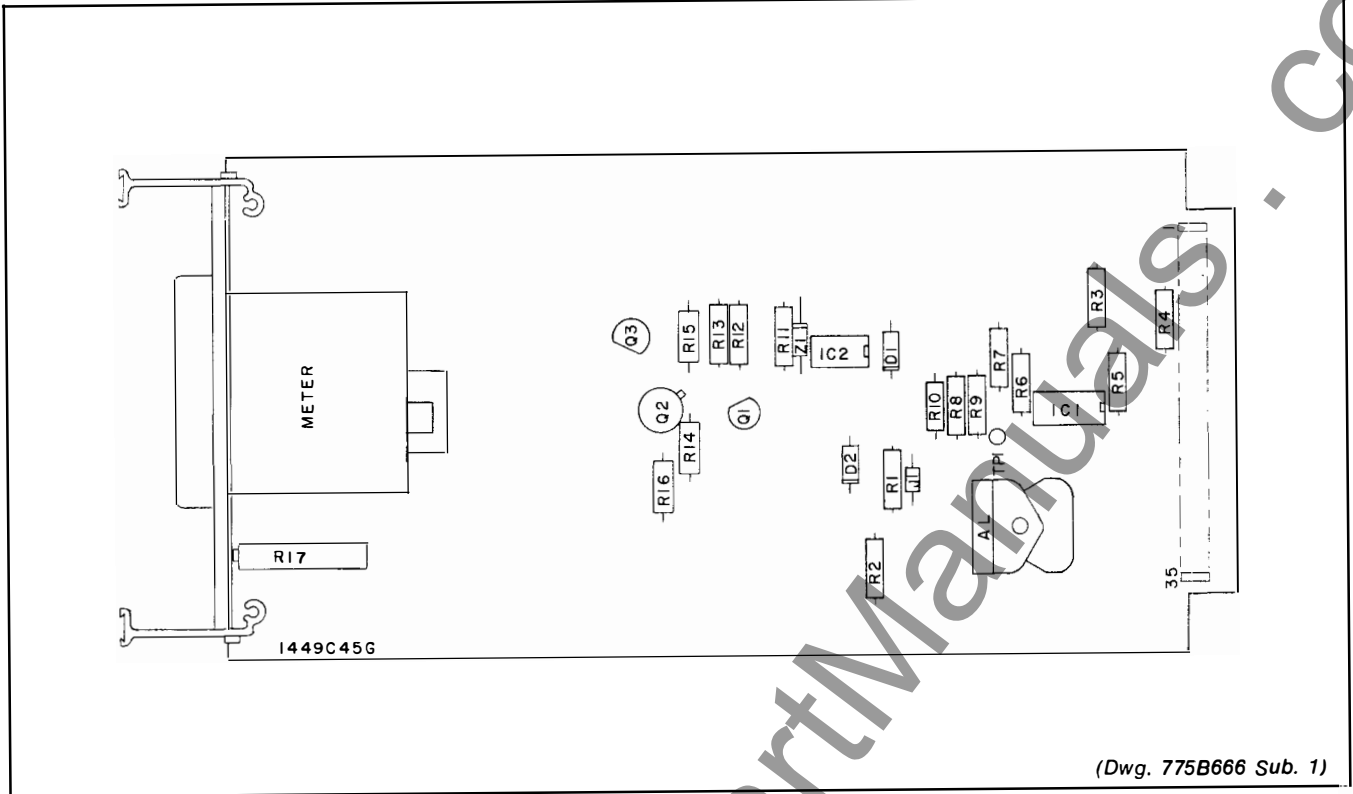


Fig. 16. Component Location Output Module - Contact Output.

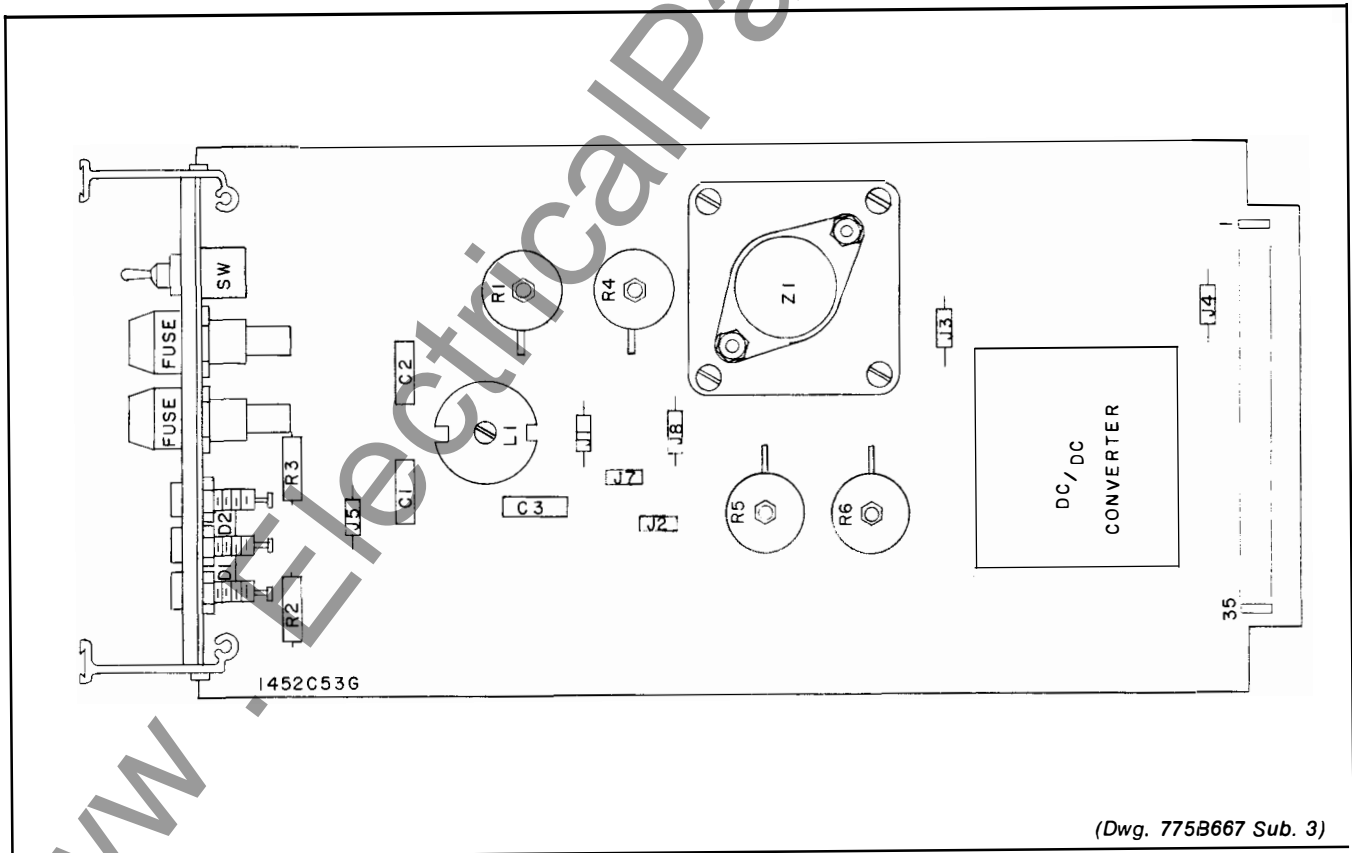
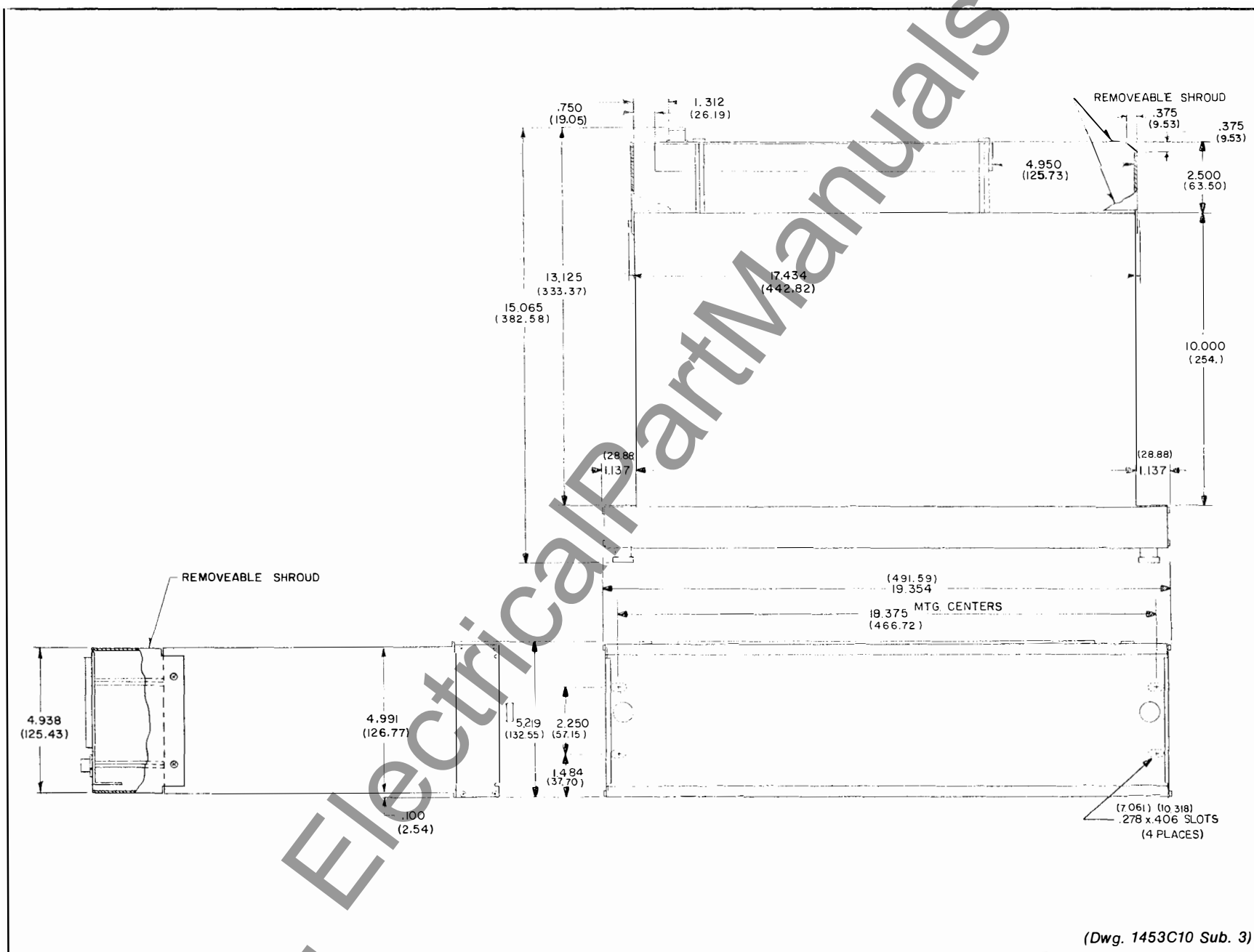
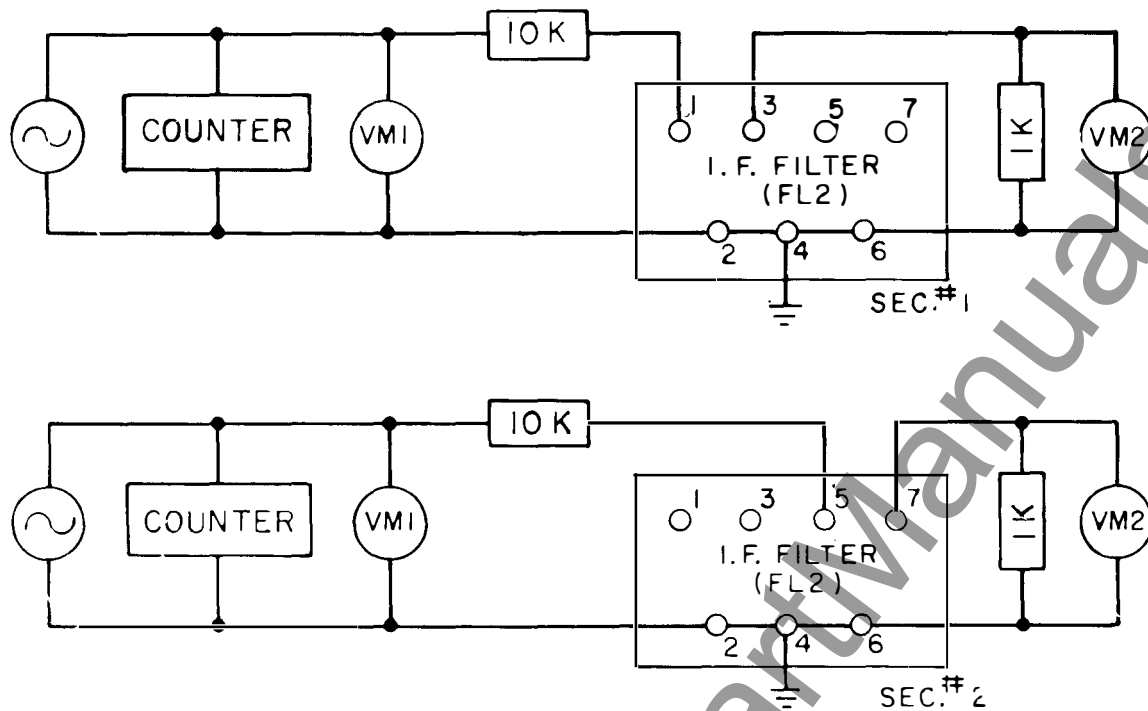


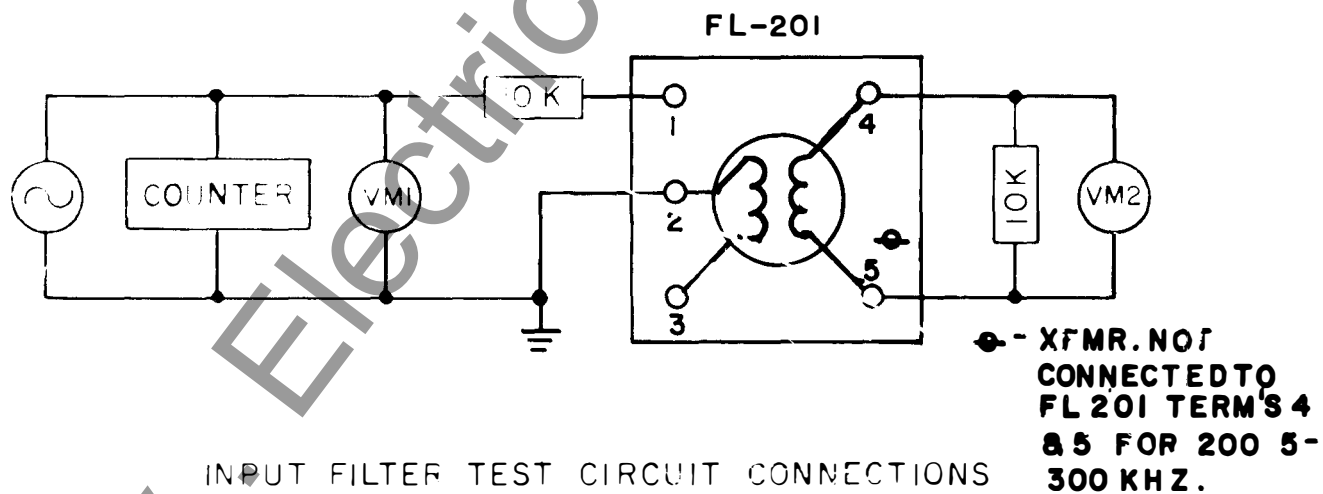
Fig. 17. Component Location Power Supply Module.



★ Fig. 18. Outline TCF-10 Receiver.

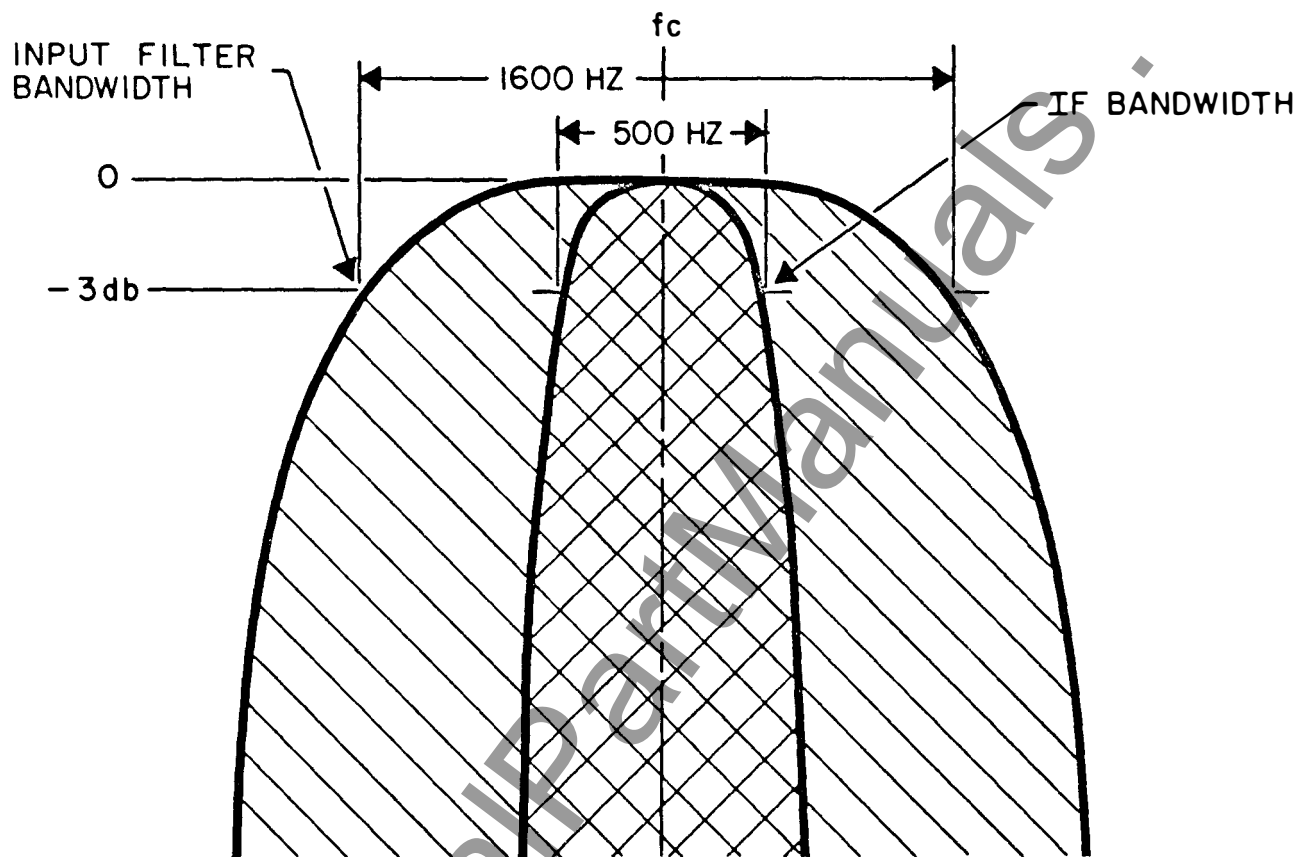


I. F. FILTER TEST CIRCUIT CONNECTIONS

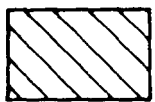


(Dwg. 877A794 Sub. 2)

Fig. 19. Test Circuits for TCF-10 Receiver Filters.



= SIGNAL + NARROW BAND NOISE

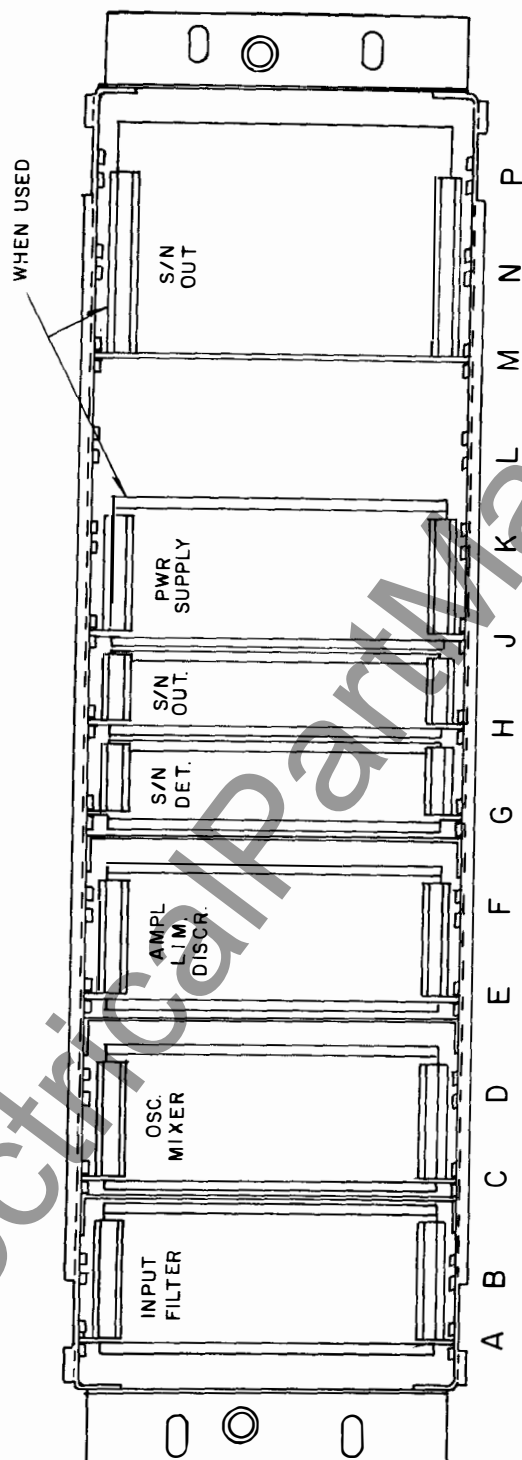


= SIGNAL + WIDE BAND NOISE - (SIGNAL + NARROW BAND NOISE)
= NOISE IN SURROUNDING BAND

AREAS USED FOR SNR ARE $\frac{\text{Cross-hatch area}}{\text{Diagonal line area}}$ OR $\frac{\text{Narrow band curve}}{\text{Wide band curve}}$

(Dwg. 3513A90 Sub. 2)

Fig. 21. Signal to Noise Ratio Characteristics.



Sub 1
1458C95

Fig. 22. Type TCF-10 RCVR, Circuit Board Location.

WESTINGHOUSE ELECTRIC CORPORATION
RELAY-INSTRUMENT DIVISION
NEWARK, N. J.

Printed in U.S.A.



INSTALLATION • OPERATION • MAINTENANCE I N S T R U C T I O N S

TYPE TCF-10 POWER LINE CARRIER FREQUENCY-SHIFT RECEIVER EQUIPMENT – WITH RELAY OUTPUT FOR SUPERVISORY CONTROL AND TELEMETERING

CAUTION

It is recommended that the user of this equipment become acquainted with the information in this instruction leaflet, and in the system instruction leaflet before energizing the system.

Printed circuit modules should not be removed or inserted when the equipment is energized. Failure to observe this precaution may result in an undesired tripping output or cause component damage. Care should also be exercised when replacing modules to assure that they are replaced in the same chassis position from which they either were removed or the module they are replacing was removed.

If the carrier set is mounted in a cabinet, it must be bolted down to the floor or otherwise secured before swinging out the equipment rack to prevent its tipping over.

APPLICATION

The TCF-10 frequency-shift receiver equipment as adapted for supervisory control and certain telemetering applications responds to carrier-frequency signals transmitted from the distant end of a power line and carried on the power line conductors. The Mark frequency is 100 hertz above the center frequency of the channel (which can be selected within the range of 30kHz to 300kHz), and it is transmitted continuously when conditions are normal and no information is to be conveyed over the channel. Its reception indicates that the channel is operative. The Space frequency is 100 hertz below the channel center frequency. When supervisory control or telemetering information is to be conveyed over the channel, the transmitter at one end of the channel is switched alternately between Mark and Space so as to produce at the receiving end a desired number of operations of a relay activated

by the Space frequency. Control of the durations of the intervals that the relay contacts are open and closed also can be utilized to convey information over the channel.

CONSTRUCTION

The TCF-10 receiver is mounted on a standard 19-inch wide chassis 5¼ inches high (3 rack units) with edge slots for mounting on a standard relay rack.

All of the circuitry that is suitable for mounting on printed circuit boards is contained on printed circuit modules that plug into the chassis from the front and are readily accessible by removing the transparent cover on the front of the chassis. The external connectors are located at the rear of the chassis as shown in Figure 10. Reference to the internal schematic connections of Figure 1 will show the location of these components in the circuit.

The printed circuit modules slide into position in slotted guides at the top and bottom of the chassis, and the module terminals engage a terminal block at the rear of the chassis. A handle on the front of each module is labeled to identify its function, and also identify adjustments and indicating lights if any are available at the front of the module. Of particular significance is the input attenuator contained on the front of the filter module which is used in adjusting the input receiver signal during initial field installation.

All possible contingencies which may arise during installation, operation, or maintenance, and all details and variations of this equipment do not purport to be covered by these instructions. If further information is desired by purchaser regarding his particular installation, operation or maintenance of his equipment, the local Westinghouse Electric Corporation representative should be contacted.

A module extender (Style No. 1447C86G01) is available for facilitating circuit measurements or major adjustments. After withdrawing any one of the circuit modules, the extender is inserted in that position. The module is then inserted into the terminal block on the front of the extender. This restores all circuit connections and renders all components and test points on the module readily accessible.

The receiver operates from a regulated +12V and -12V supply derived from a self-contained DC to DC converter. The power supply module containing the DC to DC converter has links which enable it to operate from either 48 volts or 125 volts dc.

External connections to the receiver are made through a 36-terminal receptacle, J3. The r-f input connection to the receiver is made through a coaxial cable jack J2.

OPERATION

INPUT MODULE

The input module contains the input control and the input filter. The signals to which the TCF-10 receiver responds are fed through a coaxial cable connected to jack J2 at the rear of the chassis to the input module. The input control R5, accessible at the front of the input module, attenuates the signal to a level suitable for the best operating range of the receiver.

A scale on the panel is graduated in dB. While this scale is typical rather than individually calibrated, it is accurate within several dB and is useful in setting approximate levels. Settings should be made more accurately utilizing a suitable ac voltmeter with a dB scale when possible.

From the attenuator, the signal passes through a crystal filter, FL1. This filter has a narrow pass band, and frequencies several hundred hertz above or below the center frequency (f_c) of the channel are greatly attenuated. Figure 2 shows a typical curve for the crystal filter, as well as a characteristic curve for the intermediate frequency filter, FL2, and for the discriminator output. The narrow pass band of FL1 permits close spacing of channel frequencies and reduces the possibility of false opera-

tion caused by spurious signals such as may result from arcing disconnects or corona discharge.

OSCILLATOR, MIXER, AND IF AMPLIFIER MODULE

From the input filter, the signal enters the oscillator and mixer stage of the receiver. Crystal Y11, transistors Q12 and Q13, and their associated resistors and capacitors, comprise a crystal-controlled oscillator that operates at a frequency 20kHz above the channel center frequency, f_c . The output from this local oscillator is fed through transformer T11 to potentiometer R12, and the latter is adjusted to feed a suitable input to the base of mixer transistor Q11. The output of filter FL1 is impressed on the emitter-collector circuit of Q11. As a result of mixing these two frequencies, the primary of transformer will contain frequencies of 20kHz, $2f_c + 20\text{kHz}$, $f_c + 20\text{kHz}$, and f_c .

The output from the secondary of T12 is amplified by Q31 in the intermediate frequency (IF) stage, and is impressed on FL2. This is a two-section filter, with both filters contained in a common case. Its pass band is centered at 20kHz. It eliminates the frequencies present at its input that are substantially higher than 20kHz. The output of this filter is the IF output which is fed to both the amplifier-limiter and the S/N Detection module.

AMPLIFIER LIMITER AND DISCRIMINATOR MODULE

The IF output signal from the IF amplifier is fed into the amplifier limiter through potentiometer R52 at the input of the amplifier limiter stage. Sufficient input is taken from R52 so that with minimum input signal (5 mv.) at J2 and with input control R5 set for zero attenuation, satisfactory amplitude limiting will be obtained at the output of the limiter stage.

The output of the limiter stage is fed to the discriminator. The discriminator is adjusted at the factory to have zero output (as measured by a milliammeter inserted in the circuit at jack J1) at the channel center frequency, f_c . The adjustment for zero output at f_c is made by capacitor C68. In addition, C63 is adjusted for maximum voltage reading across R80 when the output current is zero. Maximum current output, of opposite polarities,

will be obtained when the frequency is 100 hertz above or below the zero current output frequency. This separation of 200 hertz between the current peaks is affected by the value of C66 (the actual value of which may be changed slightly from its typical value in factory calibration if required).

It should be observed that although the mark frequency is $f_c + 100$ hertz, after leaving the mixer stage, and as seen by the discriminator, the mark frequency is 20kHz-100 hertz. Similarly the space frequency as seen by the discriminator is 20kHz + 100 hertz. The intermediate frequency at which the discriminator has zero output then is 20kHz. The discriminator is adjusted so that the mark and space outputs are of equal lengths for equal periods of mark and space signal frequencies.

The discriminator output is connected to the bases of transistors Q55 and Q56 in such a manner that transistor Q56 is made conductive when current flows, from the discriminator output, in the forward direction of diode D54, (which occurs with space output) and Q55 is made conductive when current flows in the forward direction of diode D55 (which occurs with mark output.) Consequently, terminal 35 is at a potential of approximately +20 volts at mark frequency and terminal 1 is at +20 volts at space frequency.

S/N DETECTION MODULE

The S/N detection module has one basic function: to measure incoming in-band signal level and provide both an output to a carrier level indicating instrument and to an alarm circuit in the output module for alarming at the desired low level of signal.

The narrow-band signal of 220 hertz bandwidth called the I.F. is fed into the S/N detection board through isolation transformer T32. The amount of signal fed into the board is adjustable by means of potentiometer R11. The circuit composed of operational amplifiers IC7 and IC8 and associated components is an RMS circuit which converts the signals into a dc voltage proportional to the r.m.s. value of the ac signals present in the IF bandwidth.

The output of the IF rms circuit is then fed to the logarithmic circuit composed of IC11A, IC12A,

and IC11B which puts out a dc signal level linearly proportional to signal level in dB for feeding a microammeter calibrated with a linear dB scale with 10dB equal to 33-1/3 microamperes, is contained on the output module (contact output).

This same output is also fed to an alarm circuit on the output module (contact output) for alarming at low signal levels.

OUTPUT MODULE

The output module provides three buffered outputs to the telemetering system. They are mark, space and not low signal with red indicating light emitting diodes for these outputs and a yellow indicating light emitting diode for normal level (satisfactory signal level).

The lower frequency of plus 12 volts (when present) from the discriminator is fed into the output module through terminal 15 into the gate consisting of diodes D78 and D79, transistors Q65 and Q66, and associated components R171, R172, R173, R174, R175, R176, D80, and Z24. Transistor Q65 then becomes conducting, causing Q66 to become conducting and a plus 12 volts to appear at terminal 27 as well as causing LED D89 to glow. This output labeled "Mark" is then fed into the output module – contact output – where it is used to energize the mercury wetted relay for contact outputs. Note that this "Mark" output is plus 12 volts on lower frequency and minus 12 volts on either higher frequency or no signal.

In a similar manner, the higher frequency output of +12 volts when present from the discriminator is fed into the output module through terminal 25 into the gate built about transistors Q62 and Q63. Just as in the case of the "mark" output, the "space" output of plus 12 volts will appear out of terminal 29. This output is wired out to the output connector J3 for external use if desired. Note also that this "space" output is plus 12 volts on higher frequency and minus 12 volts on either lower frequency or no signal.

The low-signal-level clamp operates off the carrier level signal of the S/N detection module which is basically the same signal fed to the CLI instrument.

It is fed through terminal 7 into the voltage comparator circuit built around operational amplifier IC21B. This comparator compares this signal level with the voltage reference from IC21A, and if the signal level is greater than the low level at which clamping is desired, the output of IC21B will be negative causing the yellow LED to glow indicating OK level and there will consequently be no low signal clamping. If the signal level is below the level at which clamping is desired, then the output of IC21B will be positive causing the red LED to glow indicating low level. In addition, transistor Q67 will become conducting. Transistor Q67 conducting causes Q68 to become non-conducting and thus removes the not-low-signal output from terminal 1. Under good or OK signal level, this not-low-signal output at terminal 1 of this module is plus 12 volts.

OUTPUT MODULE – CONTACT OUTPUT

The output module-contact output performs three functions; contact output of mark and spaces using a mercury wetted relay with two form C contacts, alarming on low signal level using a telephone relay with two form C contacts, and indicating signal level with its self-contained CLI instrument.

The mercury wetted relay is energized by the mark output of the output module and picks up on the lower frequency and drops out at the higher frequency.

The alarm circuit consists of all components associated with IC1, IC2, Q1, Q2, Q3, and relay AL. The signal level from the S/N detection module is fed into a level detector consisting of IC1B and resistors R6, R7, R8, and R9. An adjustable reference for the level detector consisting of IC1A and R1, R2, R17, R3, R4, and R5 is also fed into the level detector. As long as the signal level exceeds the value set by the reference, there will be approximately plus 12 volts out of the level detector into the photo-optical isolator. This causes Q1 to become non-conducting and thus transistors Q2 followed by transistor Q3 to become conducting. As a consequence, the alarm relay AL is picked up on signal levels above the alarm level. When the signal level drops below the alarm level set by the reference, the output of the level detector will be minus 12 volts causing Q1 to become conducting and Q2 and Q3 to become non-conducting and drop out the

alarm relay AL. The alarm relay has a delay of approximately 40 milliseconds on dropout to prevent undesirable alarming on short temporary loss of signal. Note that the level of alarm is set by adjusting alarm level R17, accessible from front of module, independent of the low signal level output from the output module (which is set by L.L. ADJ. R178). Also both of these outputs operate on total signal level within the passband of the receiver.

The CLI instrument operates directly on signal level received from the S/N detection module. It measures signal level in the entire bandwidth of the receiver and thus closely correlates with the low level clamp (L.L. ADJ.) and the low signal alarm AL (alarm level). It thus can be used in setting both of these adjustments.

POWER SUPPLY

The +12 volt dc, -12 volt dc, and the +45 volt dc supply voltages for the receiver are derived from the power supply module.

The +12 volt dc supply and the -12 volt dc supply are both derived from the DC to DC converter and are regulated for input voltages to the regulator of from 42 volts to 56 volts. For nominal 48 volt input units, the DC to DC converter has sufficient range so that the preregulator consisting of R1, R4, and Z1 is not necessary and is not connected by omitting jumpers J1 and J3 and supplying J7 and J2. In this case, then, the +45 volt supply is derived directly from the input supply voltage and is not regulated.

For nominal 125 volt input units, the pre-regulator consisting of R1, R4, and Z1 is necessary and is connected by supplying jumpers J1 and J3 and omitting J7 and J2. In this case then, the +45 volt supply is derived from this pre-regulator and is regulated.

The LED's D1 and D2 indicate when the power supply is energized with either 48V or 125V by the proper one glowing. Since all components are supplied in each power supply, a 48V supply can be converted to a 125V supply simply by removing jumpers J7 and J2 and inserting J1 and J3. Similarly, a 125V supply can be converted to a 48V supply by removing jumpers J1 and J3 and inserting J7 and J2. Capacitor C1 and C2 bypass rf or transient

voltages to ground. Choke L1 with capacitor C3 form a trap to isolate the receiver from transient voltages in the 20kHz range that may appear on the dc supply and which could affect the receiver.

CHARACTERISTICS

Frequency range	30-300kHz
Sensitivity (noise-free channel)	0.005 volt
Input Impedance	5000 ohms minimum
Bandwidth (crystal filter)	down < 3dB at 220 Hz. down > 60dB at 1000 Hz.
Discriminator	Set for zero output at channel center frequency and for max. outputs at 100 hertz above and below center frequency.
Operating Time	9 ms. channel (transm. and recvr.) 2 ms. HG relay operate and release times
Frequency spacing	
A. For two or more signals over one-way channel	500 hertz minimum
B. For two-way channel	1000 hertz minimum between transmitter and adjacent receiver frequencies with proper hybrids.
Ambient temperature range	-20°C to +55°C temperature around chassis.
Battery voltage variations	
Rated Voltage	Allowable Variation
48 V dc	42- 56 V dc
125 V dc	105-140 V dc
Battery drain	.25 a. at 48 V dc or 125 V dc
Dimensions	Panel height - 5¼" or 3 r.u. Panel width - 19"
Weight	13 lb.

INSTALLATION

The TCF-10 receiver is generally supplied in a cabinet or a relay rack as part of a complete carrier assembly. The location must be free from dust, excessive humidity, vibration, corrosive fumes, or heat. In particular equipment which generates excessive heat such as power supplies should not be mounted directly beneath the TCF-10. Heat rising will tend to raise the ambient temperature immediately around the chassis above acceptable levels. The maximum ambient temperature around the chassis must not exceed 55°C. In addition, sudden fluctuations in ambient temperature caused by these power supplies due to variations in load can cause variations in performance due to uneven heating of the receiver introducing abnormal temperature variations in the receiver.

ADJUSTMENTS

All factory adjustments of the TCF-10 receiver have been carefully made and should not be altered unless there is evidence of damage or malfunctioning. Such adjustments are: frequency and output level of the oscillator and mixer; input to the amplifier and limiter; frequency spacing and magnitude of discriminator output peaks; pickup of alarm relay; and pickup of low signal level clamp. The adjustment that must be made at time of installation is the setting of input attenuator R5. The input attenuator adjustment is made by a knob on the front of the panel of the input module.

The receiver should not be set with a greater margin of sensitivity than is needed to assure correct operation with the maximum expected variation to attenuation of the transmitter signal. In the absence of data on this, the receiver may be set to operate on a signal that is 15dB below the maximum expected signal. After installation of the receiver and the corresponding transmitter, and with a normal space signal level being received, input attenuator R5 should be adjusted to the position at which the low level clamp operates, causing a red LED low level light. The attenuator R5 should then be readjusted to increase the voltage supplied to the receiver by 15dB. The scale markings for R5 permit approximate settings to be made, but it is preferable to make this setting by means of the dB scales of an ac VTVM connected across the terminals indicated

at the front panel of the input module. The red terminal is connected to the wiper arm of R5 and the black terminal is connected to ground. With this setting, a 15dB drop in signal will cause a low signal level clamp output which will produce a -12V output at the low level output, cause the red LED low level light to come on, and cause the yellow LED O.K. level light to go out.

The only other adjustment which may be necessary at the time of initial installation is the adjustment of the CL1 instrument to correspond to proper variation of signal level from normal. This may be necessary if the instrument was not supplied with the receiver and was not adjusted by the factory. If this instrument was supplied and adjusted by the factory, then it could be used in adjusting R5. In this case, it would be necessary only to adjust R5 with a normal signal being received so that the instrument indicates 0dB.

If the instrument was not previously adjusted by the factory, then the following procedure should be used in adjusting the instrument. (Note: When CL1 instrument is supplied within the chassis, this is factory adjusted.)

1. Set incoming level into receiver at +10dB above normal level.
2. Adjust span adjustment, R147, so that the voltage at TP72 with respect to TP62 (common) is +3.000 volts.
3. Reduce incoming signal into receiver by 30dB.
4. Adjust full scale adjustment, R153, so that instrument now reads -20dB. (This is approximately 0 microamperes).
5. Increase signal to +10dB level. (This is 100 microamperes).
6. Adjust slope adjustment R155 to read +10dB on instrument.
7. Reduce signal to normal level. Instrument should read 0dB. If desired, instrument could be adjusted to read 0dB with R155 with sacrifice in reading accuracy for +10dB.

FACTORY ADJUSTMENTS

In case the factory adjustments have been altered or there is suspicion of improper adjustments or malfunctioning, then the following procedures can be used. In addition, alterations to the settings used by the factory for low signal level clamping and low signal-to-noise ratio clamping can be made using these procedures if desired.

Potentiometer R12 in the oscillator and mixer should be set for 0.3 volts, measured with a VTVM connected between TP11 and terminal 33 on the circuit board (ground terminal of voltmeter). A frequency counter can be connected to the same points for a check on the frequency which should be 20kHz above the channel center frequency. The frequency is fixed by the crystal used, except that it may be changed a few cycles by the value of capacitor C12. Reducing C12 increases the frequency, but the capacity should never be less than a value that assures reliable starting of oscillation. The frequency at room temperature is usually several cycles above the crystal nominal frequency as this reduces the frequency deviation at the temperature extremes.

The adjustment of the amplifier and limiter is made by potentiometer R52. An oscilloscope should be connected from TP56 at the base of Q54 to terminal 33 of the limiter. With 5 millivolts of higher frequency on the receiver input (R5 set at zero), R52 should be adjusted to the point where the peaks of the oscilloscope trace begin to flatten. This should appear on the upper and lower peaks at approximately the same setting. (Note: Input attenuator R5 could be used to produce 5mv of signal across input test jacks J1 and J2 if desired.)

The low signal level clamp is set to operate at the signal level where the receiver just drops out of limiting. This is accomplished as follows:

1. With a normal higher frequency signal being received and with an RF voltmeter connected across test jacks J1 and J2 of the input module, adjust input attenuator R5 to the point where 5mv of signal appear across these test jacks. (An alternate adjustment would be to set incoming signal level into receiver at 5mv with R5 set at zero which is the point at which limiting should begin).

2. Adjust the L.L. adjustment R178 on the output module so that the low level clamp just picks up. This will be indicated by the red low level light on the output module coming on. There also will be +12 volts at TP86 on the output module. And the yellow O.K. level light will go out.
3. Adjust input attenuator R5 to increase signal into receiver by desired margin of operation. This normally should be 15dB. This is done by reducing the R5 attenuator setting. (Note: The low signal clamp as used in this receiver is just used to put out a signal to external equipment for use by the external equipment. It does not clamp any signals within this receiver.)

The alarm level is set to alarm at a signal level 5dB above the signal where the receiver just drops out of limiting. This will result in an alarm be given at a point where the signal level has dropped 10dB from the initial nominal setting but the receiver signal level is still 5dB above limiting.

1. With a normal higher frequency signal being received and with an RF voltmeter connected across the input module input test jacks TJ1 and TJ2 (available at front on module), adjust input attenuator R5 to where signal level is 9mv across these test jacks.

2. Adjust the alarm level R17 on the output module – contact output to the point where the alarm relay AL just drops out.

3. Adjust input attenuator R5 to increase signal level into receiver by 10dB. (This is for operation with 15dB margin. For other than 15dB margin, this value should be changed accordingly.) This is done by reducing the R5 attenuator setting by 10dB.

MAINTENANCE

Periodic checks of the received carrier signal level and the receiver sensitivity will detect gradual deterioration and permit its correction before failure can result. The carrier level indicator, when provided, permits ready observation of the received signal level. With or without a carrier level indicator, an overall check can be made with the attenuation control, R5. A change in operating margin from

the original setting can be detected by observing the change in the dial setting required to cause a low signal level clamp to operate as indicated by the red low level LED becoming lit. If there is a substantial reduction in margin, the signal voltage at the receiver input should be checked to see whether the reduction is due to loss of signal level or loss in receiver sensitivity.

All adjustable components for normal field adjustments on the printed circuit modules are accessible when the front cover on the chassis is removed. All other adjustable components on the printed circuit modules may be made entirely accessible while permitting electrical operation by using module extender style number 1447C86G01. This permits attaching instrument leads to the various test points of terminals when making voltage, oscilloscope or frequency checks.

RELAY MAINTENANCE AND ADJUSTMENT

The AL relay contacts should be cleaned periodically. A contact burnisher S#182A836H01 is recommended for this purpose. The use of abrasive material for cleaning contacts is not recommended, because of the danger of embedding small particles in the face of the soft silver and thus impairing the contact. Care must be taken to avoid distorting the contact springs during burnishing.

These relays have been properly adjusted at the factory to insure correct operation, and under normal field conditions they should not require readjustment. If, however, the adjustments are disturbed in error, or if it becomes necessary to replace some part, the following adjustment procedure should be used.

In the AL relay the armature gap should be approximately 0.004 inch with the armature closed. This adjustment is made with the armature stop screw and locknut. The contact leaf springs should be adjusted to obtain at least 0.015 inch gap on all contacts when fully open. There should be at least 0.010 inch follow on all normally-open contacts and 0.005 inch follow on all normally-closed contacts. The relay should pick up at approximately 35 volts.

TABLE I
RECEIVER D-C MEASUREMENTS

NOTE: All voltage readings taken with the negative of dc VTVM on terminal 17 (−12V dc). Receiver adjusted for 15dB operating margin with Space and Mark signals down 50dB from 1 watt or 60dB down from 10 watts. Unless indicated otherwise, voltage will not vary appreciably whether signal is lower frequency, higher frequency, or zero.

Collector of Transistor or Test Point	Voltage (Positive)
Q11	< 15
Q12 (TP12)	17 (High or Low Freq.)
Q13 (TP13)	17 (High or Low Freq.)
Q14 (TP14)	3
Q15 (TP15)	3
TP11	22
TP52	19
Q51 (TP51)	14
Q52 (TP53)	14.5
Q53 (TP54)	18
Q54 (TP55)	3
TP56	19
Q55	< 1 (Lower Freq. or No Signal)
Q55	23 (Higher Freq.)
Q56	23 (Lower Freq.)
Q56	< 1 (Higher Freq. or No Signal)

NOTE: The following readings are taken with the negative of dc VTVM on terminal 3 (common of dc power supply) of either the S/N detection module or the output module.

Collector of Transistor or Test Point	Voltage (Positive)
TP62	0
TP64	+10
TP65	−12V
TP67	+ .5
TP68	+ .5
TP70	− 6
TP71	+ 6
TP72	+ 1.5
TP74	+ .5
TP81	+12 (Higher Frequency)

TP81	−12 (Lower Freq. or No Signal)
TP82	+12 (Lower Frequency)
TP82	−12 (Higher Freq. or No Signal)
TP83	+12 (Higher Frequency)
TP83	−12 (Lower Freq. or No Signal)
TP84	+12 (Lower Frequency)
TP84	−12 (Higher Freq. or No Signal)
TP85	+ 0.3
TP86	+12 (Low level clamp)
TP86	−12 (No clamp)
TP88	+12
TP89	−12
TP90	+12 (Good Signal Level)
TP90	−12 (Low Signal Level clamp)

TABLE II
RECEIVER RF MEASUREMENTS

NOTE: Voltmeter readings taken at any point from receiver input to stage involving transistor Q15 are neither meaningful or feasible because of either waveform variations or the effect of instrument loading on the readings. Receiver adjusted as in Table I.

Collector of Transistor or Test Point	Volts with Signal At +10dB Above Normal Level
Q15 (TP15)	0.8
Q51 (TP51)	0.9
Q52 (TP53)	0.65
Q53 (TP54)	2.2
Q54 (TP55)	4.5
TP67	.275

FILTER RESPONSE MEASUREMENTS

The crystal input filter (FL1) and the IF filter (FL2) are in sealed containers and repairs can be made only by the factory. The stability of the original response characteristics is such that in normal usage no appreciable change in response will occur. However the test circuits of Fig. 19 can be used in case there is reason to suspect that either of the filters has been damaged.

Fig. 2 shows the -3dB and -60dB check points for the crystal filters. The response curve of the IF filter shows the combined effect of the two sections, and was obtained by adding the attenuation of each section for identical frequencies. The scale of Fig. 2 was chosen to show the crystal filter response, which permitted only a portion of the IF filter curve to be shown. The check points for the pass band of each section of the latter are "down 3dB maximum at 19.75 and 20.25 kHz ", and for the stop band are "down 18dB minimum at 19.00 and 21.00 kHz ." The signal generator voltage (Fig. 19) must be held constant throughout the entire check. A value of 20dB (7.8 volts) is suitable. The reading of VM2 at the frequency of minimum attenuation should not be more than 22dB below the reading of VM1. It should be noted that a limit measured in this manner is for convenience only and does not indicate actual insertion loss of the filter. The insertion loss would be approximately 16dB less than the measured difference because of the input resistor and the difference in input and output impedances of the filter.

Because of the extreme frequency sensitivity of the crystal filter, the oscillator used in its test circuit should have very good frequency stability and a close vernier control. The oscillators used for factory testing have special modifications for this use. A value of approximately 10dB (2.45 volts) is suitable for the constant voltage at which to hold VMI throughout the check. The reading of VM2 at the frequency of minimum attenuation will vary somewhat with the channel frequency but should not be more than 11dB below the reading of VM1. (The filter insertion loss is approximately 6dB less than the difference in readings.)

CONVERSION OF RECEIVER FOR CHANGED CHANNEL FREQUENCY

The parts required for converting a TCF-10 receiver for operating at a different channel frequency consist of a new crystal input filter FL1, a new local oscillator crystal (Y11) and probably a different feedback capacitor (C12). There are two ways of effecting this change. The easiest and preferred method is to order a new input filter module and a new oscillator mixer module for the new frequencies from the factory. The new modules would then just have to be plugged in as replacements for the original modules. The second method would involve ordering just replacement filter, FL1, and new local oscillator crystal for the new frequencies and making

the substitution on the modules. These substitutions on the modules are not difficult as the crystal plugs in and the filter has four leads to be soldered. However, testing of the local oscillator for easy starting will have to be made, and the value of C12 chosen to assure this easy starting of oscillation. The whole receiver should then be checked out for correct performance.

RECOMMENDED TEST EQUIPMENT

I. Minimum Test Equipment for Installation

- a. A-C Vacuum Tube Voltmeter (VTVM).
Voltage range 0.003 to 30 volts , frequency range 60 hertz to 330 kHz , input impedance 7.5 megohms .
- b. D-C Vacuum Tube Voltmeter (VTVM).
Voltage range: 1.5 to 300 volts
Input impedance: 7.5 megohms

II. Desirable Test Equipment for Apparatus Maintenance

- a. All items listed in I.
- b. Signal Generator
Output Voltage: up to 8 volts
Frequency Range: 20 kHz to 330 kHz
- c. Oscilloscope
- d. Frequency counter
- e. Ohmmeter
- f. Capacitor checker
- g. Milliammeter, $0-1.5$ or preferably $1.5-0-1.5$ range, for checking discriminator.

Some of the functions of the recommended test equipment are combined in the type TCT carrier test meter unit, which is designed to mount on a standard $19''$ rack but also can be removed and used as a portable unit.

RENEWAL PARTS

Repair work can be done most satisfactorily at the factory. However, replacement parts can be furnished, in most cases, to customers who are equipped for doing repair work. When ordering parts, always give the complete nameplate data, the electrical value, style number, and identify the part by its designation on the Internal Schematic drawing.

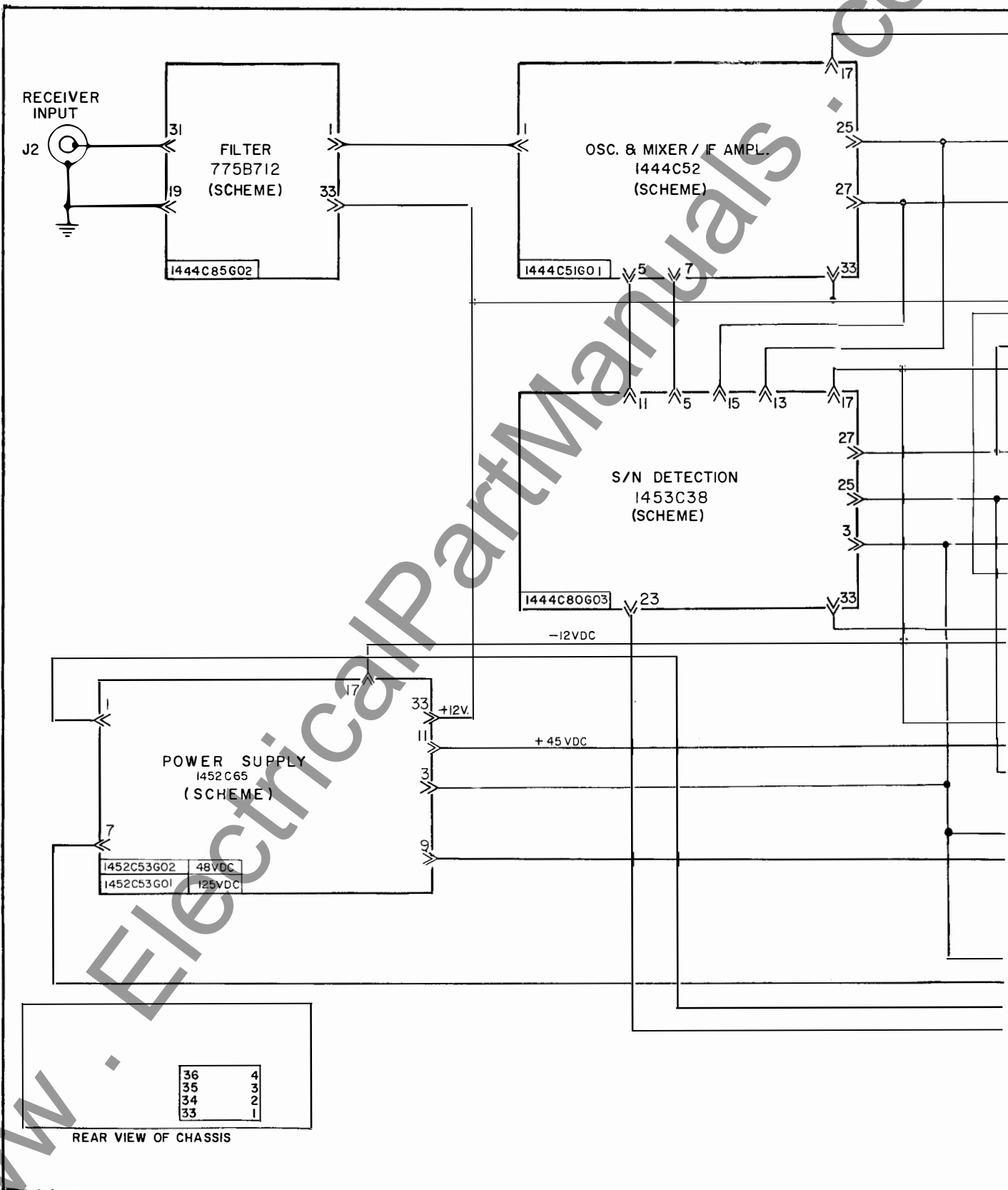
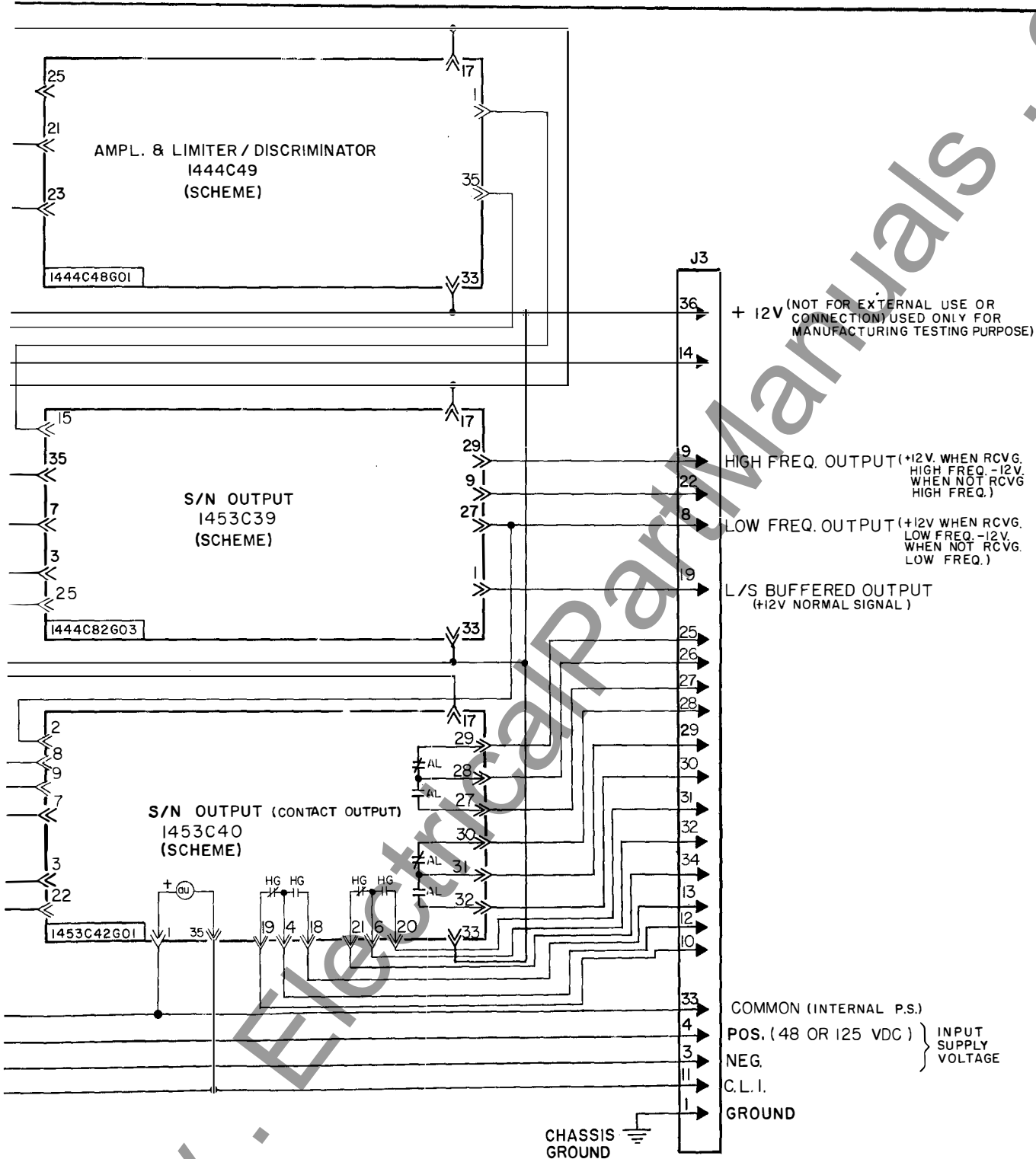
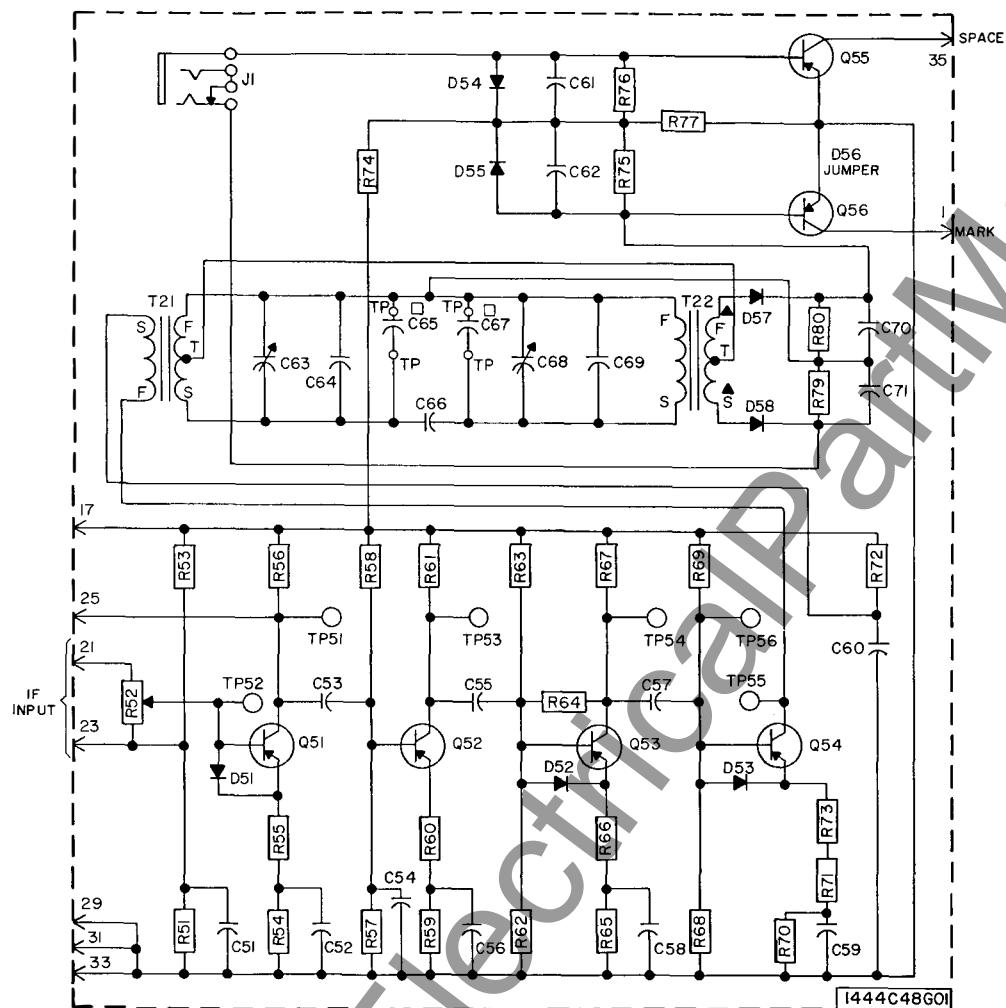


Fig. 1. Overall Schematic



Sub. 3
(Dwg. 1322D48)



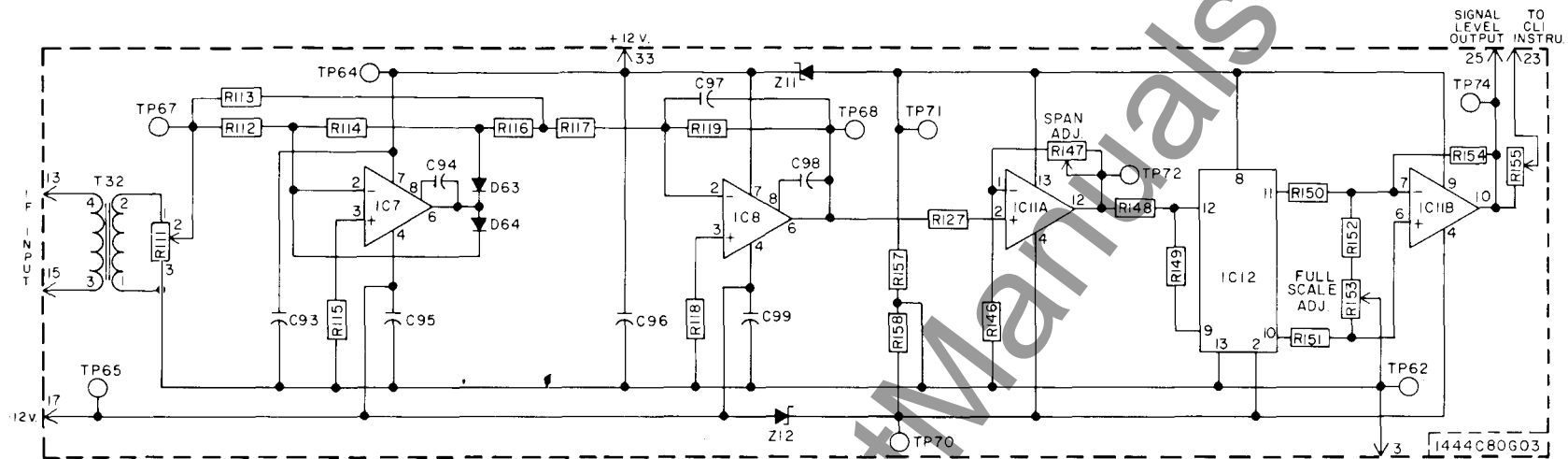
COMPONENT	DESCRIPTION	STYLE NO.
C51	CAPACITOR .250UF 200V	187A624H02
C52	CAPACITOR .250UF 200V	187A624H02
C53	CAPACITOR .100UF 200V	187A624H01
C54	CAPACITOR 1300.000PF 500V	187A584H15
C55	CAPACITOR .100UF 200V	187A624H01
C56	CAPACITOR .250UF 200V	187A624H02
C57	CAPACITOR .100UF 200V	187A624H01
C58	CAPACITOR .250UF 200V	187A624H02
C59	CAPACITOR .250UF 200V	187A624H02
C60	CAPACITOR 1.000UF 200V	187A624H04
C61	CAPACITOR .220UF 50V	762A703H01
C62	CAPACITOR .220UF 50V	762A703H01
C63	CAPACITOR 4.570 100PF	762A736H02
C64	CAPACITOR 9100.000PF 200V	187A624H16
C65	CAPACITOR SEE NOTE □	
C66	CAPACITOR 100.000PF 500V	187A684H08
C67	CAPACITOR SEE NOTE □	
C68	CAPACITOR 4.570 100PF	762A736H02
C69	CAPACITOR 9100.000PF 200V	187A624H16
C70	CAPACITOR .220UF 50V	762A703H01
C71	CAPACITOR .220UF 50V	762A703H01
D51	DIODE 1N457A	184A855H07
D52	DIODE 1N457A	184A855H07
D53	DIODE 1N457A	184A855H07
D54	DIODE 1N457A	184A855H07
D55	DIODE 1N457A	184A855H07
D56	JUMPER	862A478H01
D57	DIODE 1N628	184A855H12
D58	DIODE 1N628	184A855H12
R51	RESISTOR 4700.0 .50W 5%	184A763H43
R53	RESISTOR 27.0K .50W 5%	184A763H61
R54	RESISTOR 2200.0 .50W 5%	184A763H35
R55	RESISTOR 27.0 .50W 5%	187A290H11
R56	RESISTOR 10.0K .50W 5%	184A763H51
R57	RESISTOR 4700.0 .50W 5%	184A763H43
R58	RESISTOR 27.0K .50W 5%	184A763H61
R59	RESISTOR 1500.0 .50W 5%	184A763H31
R60	RESISTOR 180.0 .50W 5%	184A763H09
R61	RESISTOR 4700.0 .50W 5%	184A763H43
R62	RESISTOR 2200.0 .50W 5%	184A763H35
R63	RESISTOR 33.0K .50W 5%	184A763H63
R64	RESISTOR 2700.0 .50W 5%	184A763H37
R65	RESISTOR 680.0 .50W 5%	184A763H23
R66	RESISTOR 68.0 .50W 5%	187A290H21
R67	RESISTOR 4700.0 .50W 5%	184A763H43
R68	RESISTOR 2700.0 .50W 5%	184A763H37
R69	RESISTOR 18.0K .50W 5%	184A763H57
R70	RESISTOR 220.0 .50W 5%	184A763H11
R71	RESISTOR 68.0 .50W 2%	629A531H04
R72	RESISTOR 330.0 .50W 5%	184A763H15
R73	RESISTOR 56.0 .50W 2%	629A531H02
R74	RESISTOR 12.0K .50W 5%	184A763H53
R75	RESISTOR 3000.0 .50W 5%	184A763H38
R76	RESISTOR 3000.0 .50W 5%	184A763H38
R77	RESISTOR 220.0 .50W 5%	184A763H11
R79	RESISTOR 2200.0 .50W 5%	184A763H35
R80	RESISTOR 2200.0 .50W 5%	184A763H35
R52	POT 1.0K .50W	629A645H04
Q51	TRANSISTOR 2N4249	849A441H03
Q52	TRANSISTOR 2N4249	849A441H03
Q53	TRANSISTOR 2N4249	849A441H03
Q54	TRANSISTOR 2N4249	849A441H03
Q55	TRANSISTOR 2N3645	849A441H01
Q56	TRANSISTOR 2N3645	849A441H01
T21	TRANSFORMER	606B533G01
T22	TRANSFORMER	606B533G02
J1	TELEPHONE JACK	187A606H01

□—ONE OR TWO CAPACITORS USED; VALUES DETERMINED IN TEST.

▲—FOR STYLE 1444C48G03 REVERSE START AND FINISH LEADS OF T22.

Sub. 2
(Dwg. 1444C49)

Fig. 5. Internal Schematic Amplifier Limiter-Discriminator Module.



COMPONENT	DESCRIPTION	STYLE NO.
C93	CAPACITOR .010UF 50V	184A663H01
C94	CAPACITOR 33.000PF 200V	879A989H07
C95	CAPACITOR .010UF 50V	184A663H01
C96	CAPACITOR .010UF 50V	184A663H01
C97	CAPACITOR .470UF 50V	762A680H04
C98	CAPACITOR 33.000PF 200V	879A989H07
C99	CAPACITOR .010UF 50V	184A663H01
D63	DIODE 1N4148	836A728H06
D64	DIODE 1N4148	836A728H06
IC7	INT CKT SESJ11	3512A10H01
IC8	INT CKT SES31T	3512A10H01
IC11	INT CKT 747UM	1443C52H01
IC12	INT CKT SN56502	3512A09H01
J111	JUMPER 0 0HM RESISTOR	862A478H01
J112	JUMPER 0 0HM RESISTOR	862A478H01
J113	JUMPER 0 0HM RESISTOR	862A478H01
J114	JUMPER 0 0HM RESISTOR	862A478H01

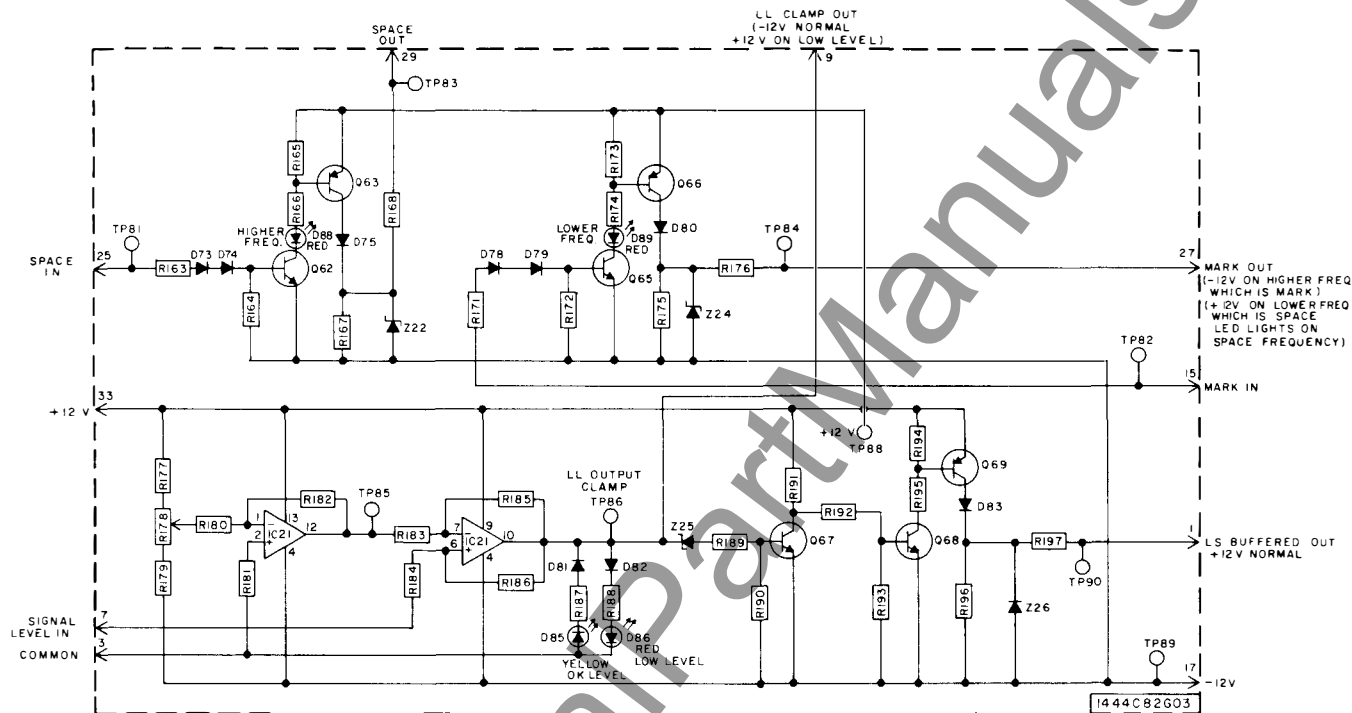
R111	POT	50.0K	.50W	629A645H06
R147	POT	250.0K	.75W	830A826H10
R153	POT	2.5K	.25W	629A645H07

R112	RESISTOR	4750.0	.25W 1%	848A320H14
R113	RESISTOR	4750.0	.25W 1%	848A320H14
R114	RESISTOR	15.0K	.50W 1%	848A320H52
R115	RESISTOR	4990.0	.50W 1%	848A320H16
R116	RESISTOR	4990.0	.50W 1%	848A320H16
R117	RESISTOR	4990.0	.50W 1%	848A320H16
R118	RESISTOR	4990.0	.50W 1%	848A320H16
R119	RESISTOR	10.0K	.50W 1%	848A320H45
R127	RESISTOR	2.0K	.50W 1%	848A319H77
R146	RESISTOR	4990.0	.50W 1%	848A320H16
R148	RESISTOR	1000.0	.50W 1%	848A319H43
R149	RESISTOR	15.0K	.50W 1%	848A320H52
R150	RESISTOR	2.0K	.50W 1%	848A319H77
R151	RESISTOR	2.0K	.50W 1%	848A319H77
R152	RESISTOR	17.8K	.25W 1%	848A320H69
R154	RESISTOR	681.0	.50W 1%	848A319H32
R155	RESISTOR	1.0K	.25W 20%	629A430H02
R156	RESISTOR	150.0	.50W 1%	848A318H53
R157	RESISTOR	20.0K	.50W 1%	848A320H74
R158	RESISTOR	20.0K	.50W 1%	848A320H74

Z11	ZENER	1N825A	6.2V	862A288H06
Z12	ZENER	1N825A	6.2V	862A288H06

Sub. 2
(Dwg. 1453C38)

Fig. 6. Internal Schematic S/N Detection Module.



COMPONENT	DESCRIPTION	STYLE NO.
D73	DIODE	IN645A
D74	DIODE	IN645A
D75	DIODE	IN645A
D78	DIODE	IN645A
D79	DIODE	IN645A
D80	DIODE	IN645A
D81	DIODE	IN457A
D82	DIODE	IN457A
D83	DIODE	IN645A
D85	LED	3508A22H02
D86	LED	3508A22H01
D88	LED	3508A22H01
D89	LED	3508A22H01
IC21	INT CKT	7470M
J121	JUMPER	0 0HM RESISTOR
J122	JUMPER	0 0HM RESISTOR
J123	JUMPER	0 0HM RESISTOR
R178	POT	2.5K .25W

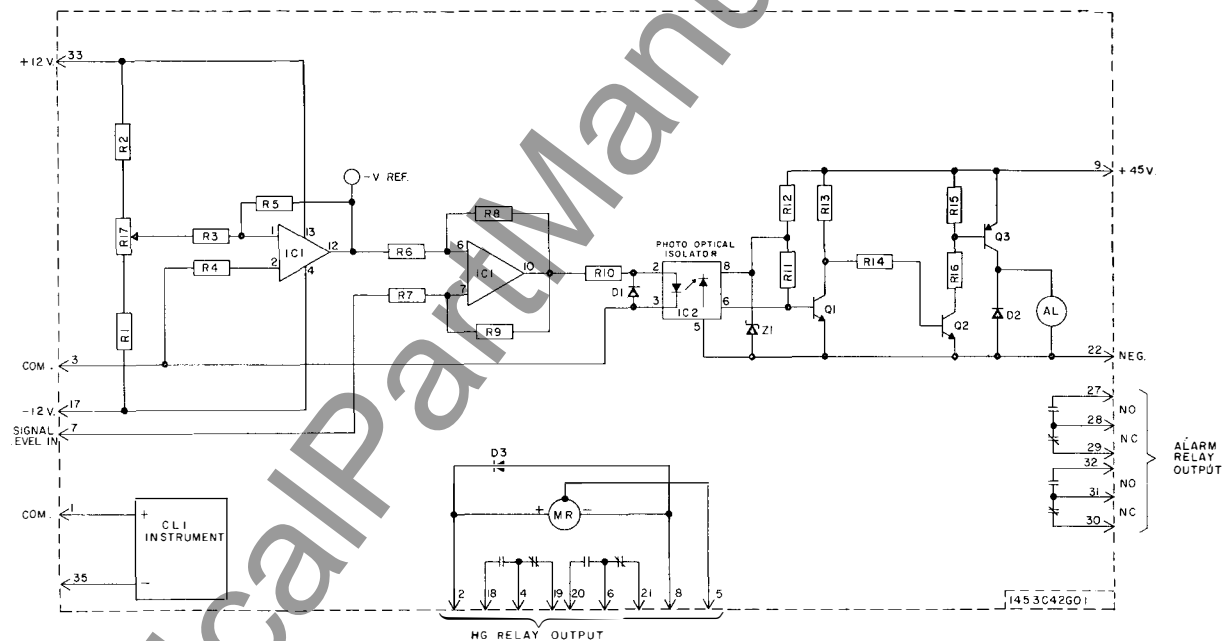
R163	RESISTOR	33.0K .50W 5%	184A763H63
R164	RESISTOR	120.0K .50W 5%	184A763H77
R165	RESISTOR	4700.0 .50W 5%	184A763H43
R166	RESISTOR	2400.0 .50W 5%	184A763H36
R167	RESISTOR	1.5 K .50W 1%	848A819H65
R168	RESISTOR	150.0 3.00W 5%	762A679H01
R171	RESISTOR	33.0K .50W 5%	184A763H63
R172	RESISTOR	120.0K .50W 5%	184A763H77
R173	RESISTOR	4700.0 .50W 5%	184A763H43
R174	RESISTOR	2400.0 .50W 5%	184A763H36
R175	RESISTOR	1.5K .50W 1%	848A819H65
R176	RESISTOR	150.0 3.00W 5%	762A679H01
R177	RESISTOR	10.0K .50W 1%	848A820H45
R179	RESISTOR	10.0K .50W 1%	848A820H45
R180	RESISTOR	68.1K .50W 1%	848A821H26
R181	RESISTOR	4990.0 .50W 1%	848A820H16
R182	RESISTOR	6810.0 .50W 1%	848A820H29
R183	RESISTOR	2.0K .50W 1%	848A819H77
R184	RESISTOR	2.0K .50W 1%	848A819H77
R185	RESISTOR	562.0K .25W 1%	848A822H15
R186	RESISTOR	511.0K .50W 1%	848A822H11
R187	RESISTOR	1620.0 .25W 1%	848A819H68
R188	RESISTOR	1620.0 .25W 1%	848A819H68
R189	RESISTOR	33.0K .50W 5%	184A763H63
R190	RESISTOR	68.0K .50W 5%	184A763H71
R191	RESISTOR	68.0K .50W 5%	184A763H71
R192	RESISTOR	33.0K .50W 5%	184A763H63
R193	RESISTOR	120.0K .50W 5%	184A763H77
R194	RESISTOR	10.0K .50W 5%	184A763H51
R195	RESISTOR	18.0K .50W 5%	184A763H57
R196	RESISTOR	1.5K .50W 1%	848A819H65
R197	RESISTOR	150.0 3.00W 5%	762A679H01

COMPONENT	DESCRIPTION	STYLE NO.
Q62	TRANSISTOR	2N699
Q63	TRANSISTOR	2N3645
Q65	TRANSISTOR	2N699
Q66	TRANSISTOR	2N3645
Q67	TRANSISTOR	2N699
Q68	TRANSISTOR	2N699
Q69	TRANSISTOR	2N3645
Z22	ZENER	IN4752A 33.0V
Z24	ZENER	IN4752A 33.0V
Z25	ZENER	IN961B 10.0V
Z26	ZENER	IN4752A 33.0V

Sub. 3
(Dwg. 1453C39)

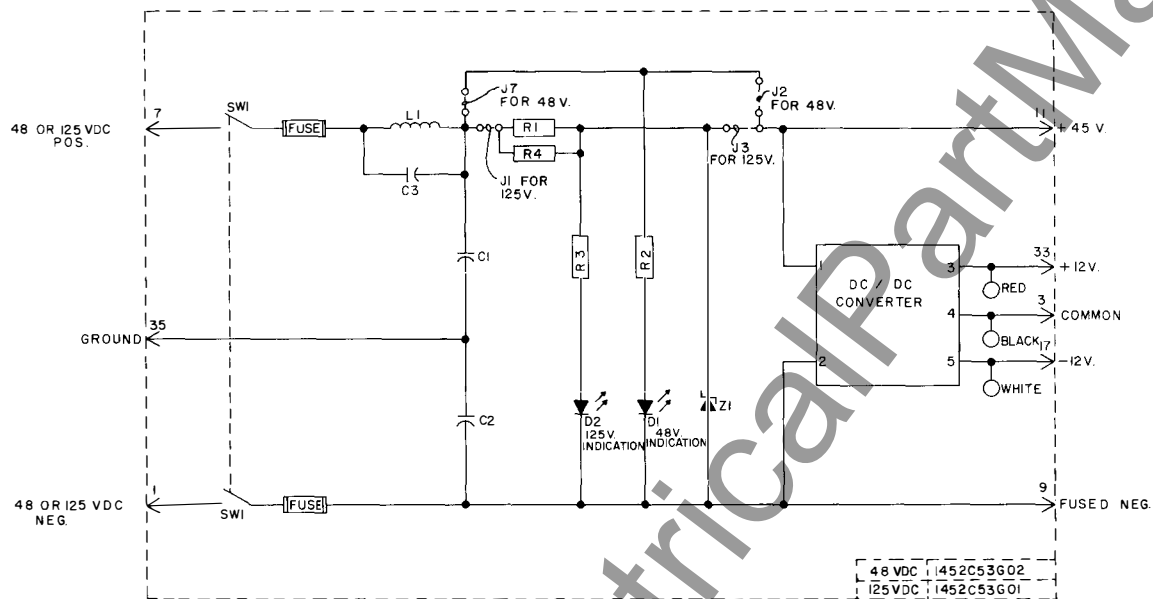
Fig. 7. Internal Schematic Output Module.

COMPONENT	DESCRIPTION	STYLE NO.
R1	RESISTOR	10K .50W 5%
R2	RESISTOR	10K .50W 5%
R3	RESISTOR	681K .50W 1%
R4	RESISTOR	490K .50W 1%
R5	RESISTOR	681K .50W 1%
R6	RESISTOR	2.0K .50W 1%
R7	RESISTOR	2.0K .50W 1%
R8	RESISTOR	562K .25W 1%
R9	RESISTOR	511K .50W 1%
R10	RESISTOR	3.3K .50W 2%
R11	RESISTOR	15K .50W 2%
R12	RESISTOR	120K .50W 2%
R13	RESISTOR	13.3K .50W 1%
R14	RESISTOR	15K .50W 2%
R15	RESISTOR	6.8K .50W 2%
R16	RESISTOR	6.8K .50W 2%
R17	POT	2.5K .25W 10%
J1	JUMPER	0.0HM RESISTOR
D1	DIODE	1N645A
D2	DIODE	1N645A
D3	DIODE	1N457A
Z1	ZENER	1N957B
Q1	TRANSISTOR	2N3417
Q2	TRANSISTOR	2N699
Q3	TRANSISTOR	2N3645
IC1	INT. CKT.	7470M
IC2	INT. CKT.	50B2-4371
		7758621H01



Sub. 2
(Dwg. 1453C40)

Fig. 8. Internal Schematic Output Module-Contact Output.



COMPONENT	DESCRIPTION	STYLE NO.
C1	CAPACITOR 01 MFD.	3516A36H01
C2	CAPACITOR 01 MFD.	3516A36H01
C3	CAPACITOR 0.047 MFD.	849A437H04
R1	RESISTOR 1000 10W	644B262H34
R2	RESISTOR 4.7K .50W 2%	629A531H48
R3	RESISTOR 4.7K .50W 2%	629A531H48
R4	RESISTOR 1000 10W	644B262H34
Z1	ZENER IN2828B	184A845H06
J1	JUMPER 0 OHM RESISTOR	862A478H01
J2	JUMPER 0 OHM RESISTOR	862A478H01
J3	JUMPER 0 OHM RESISTOR	862A478H01
J7	JUMPER 0 OHM RESISTOR	862A478H01
SW1	SWITCH DPDT	849A299H01
D1	DIODE LED	3508A22H02
D2	DIODE LED	3508A22H02
L1	COIL	2928096G02

(Dwg. 1452C65)

Fig. 9. Internal Schematic Power Supply Module.

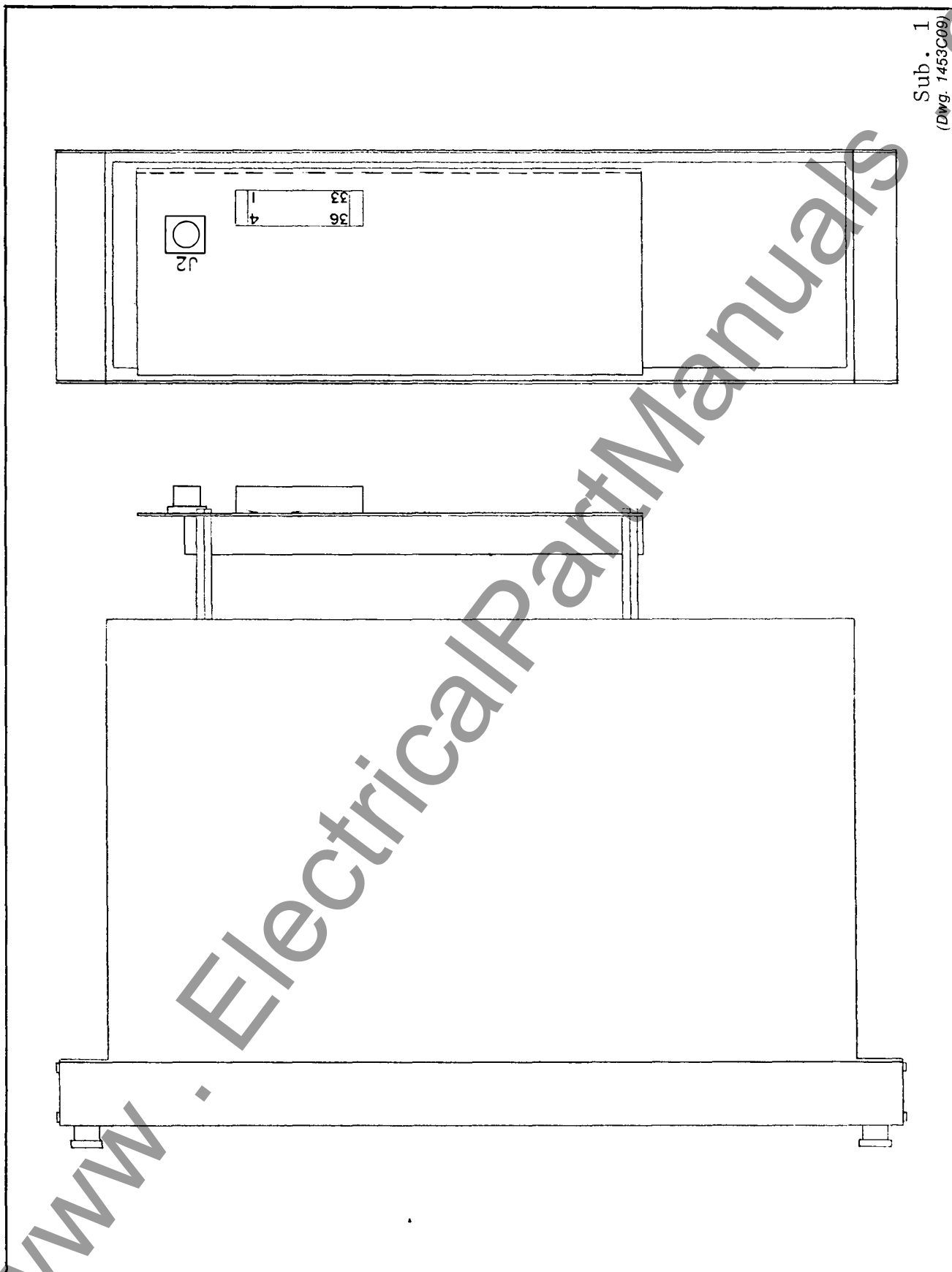


Fig. 10. Component Location TCF-10 Receiver.

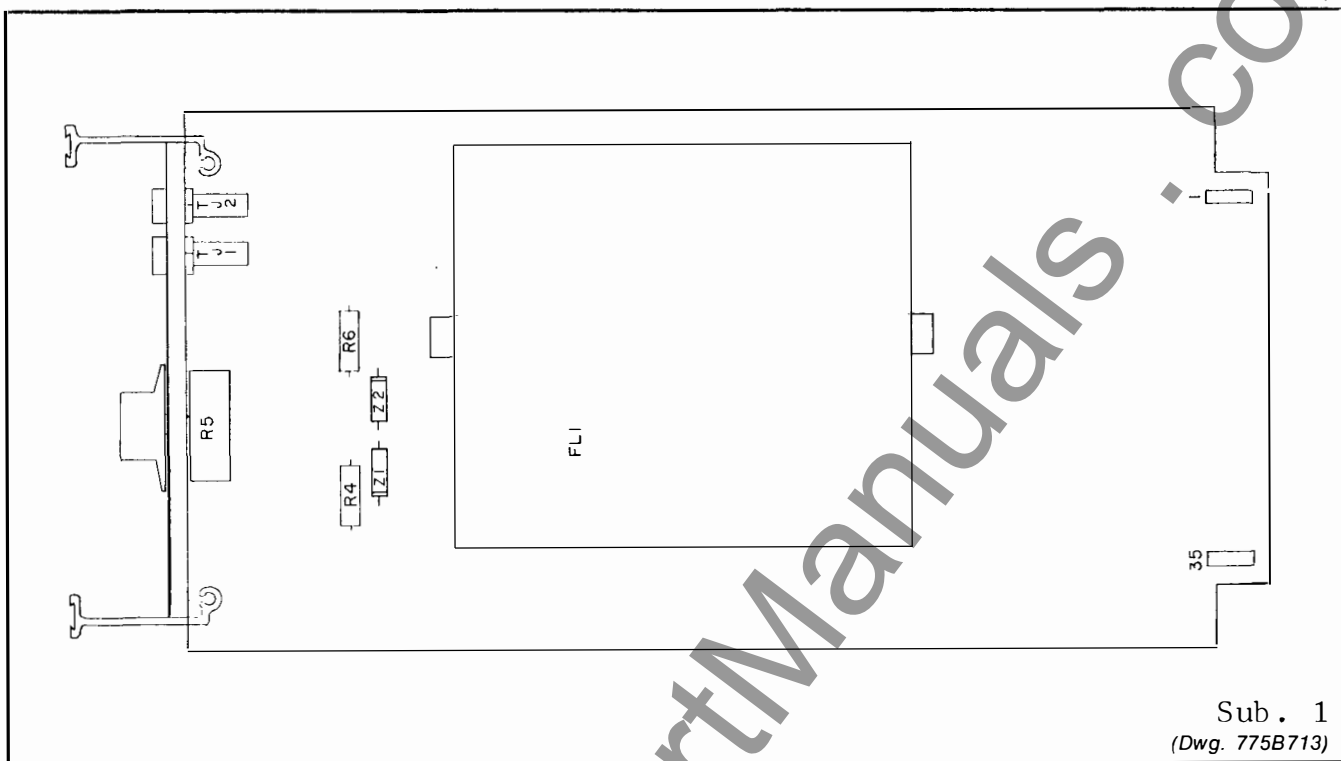
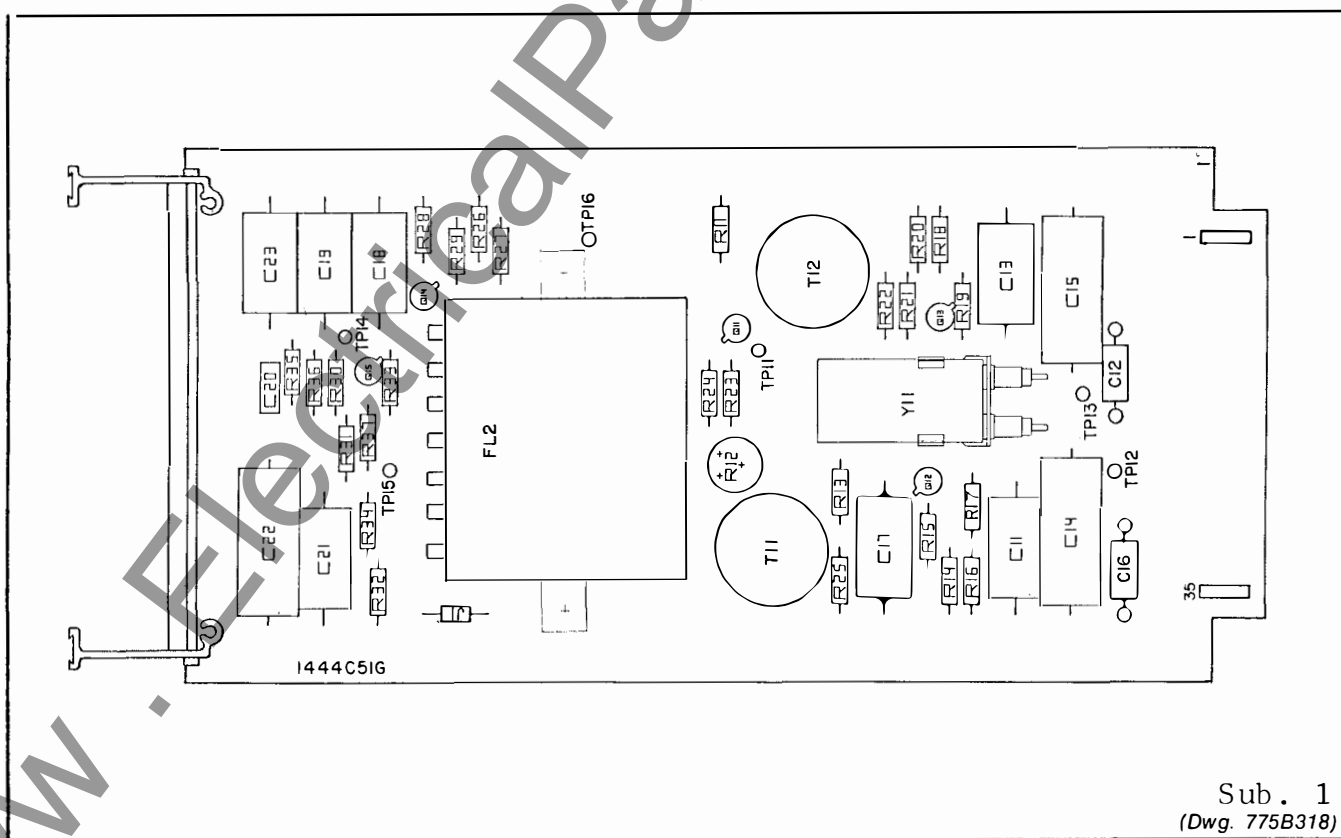


Fig. 12. Component Location Oscillator-Mixer-IF Amplifier Module.



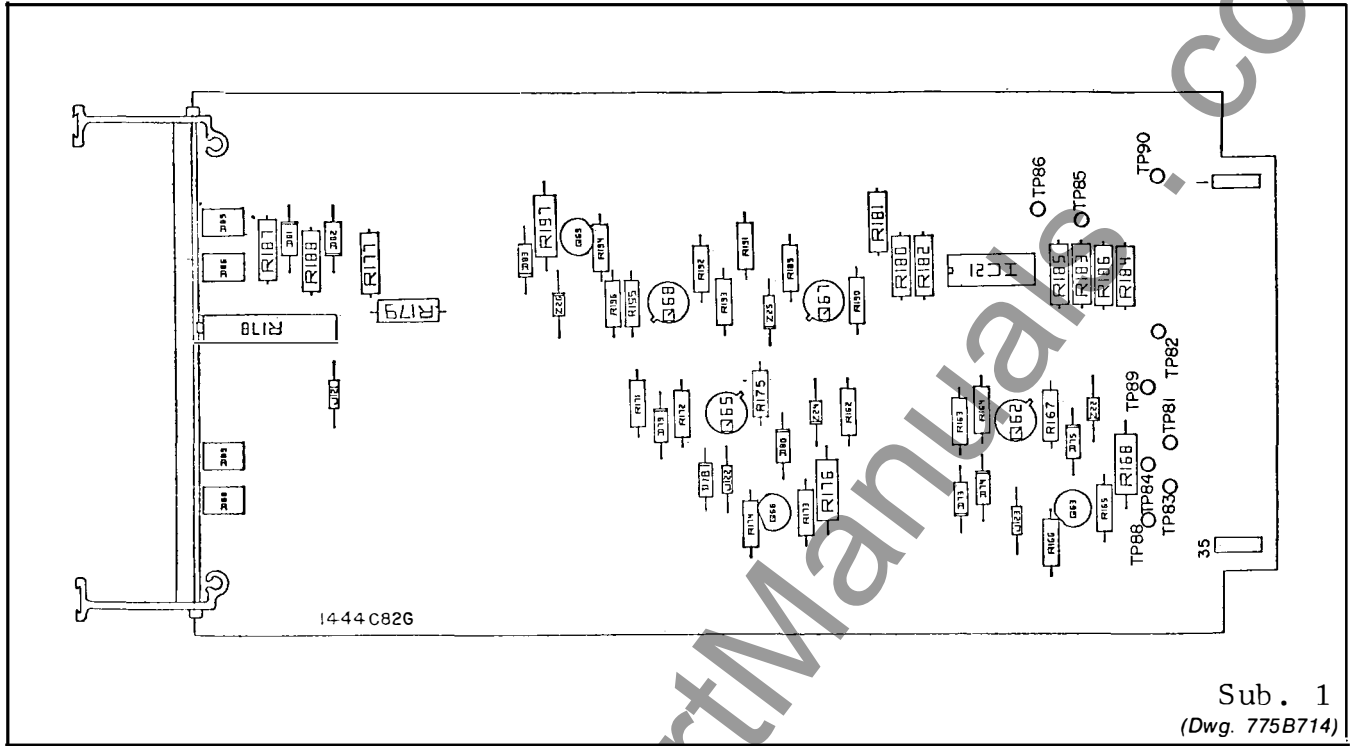


Fig. 15. Component Location Output Module.

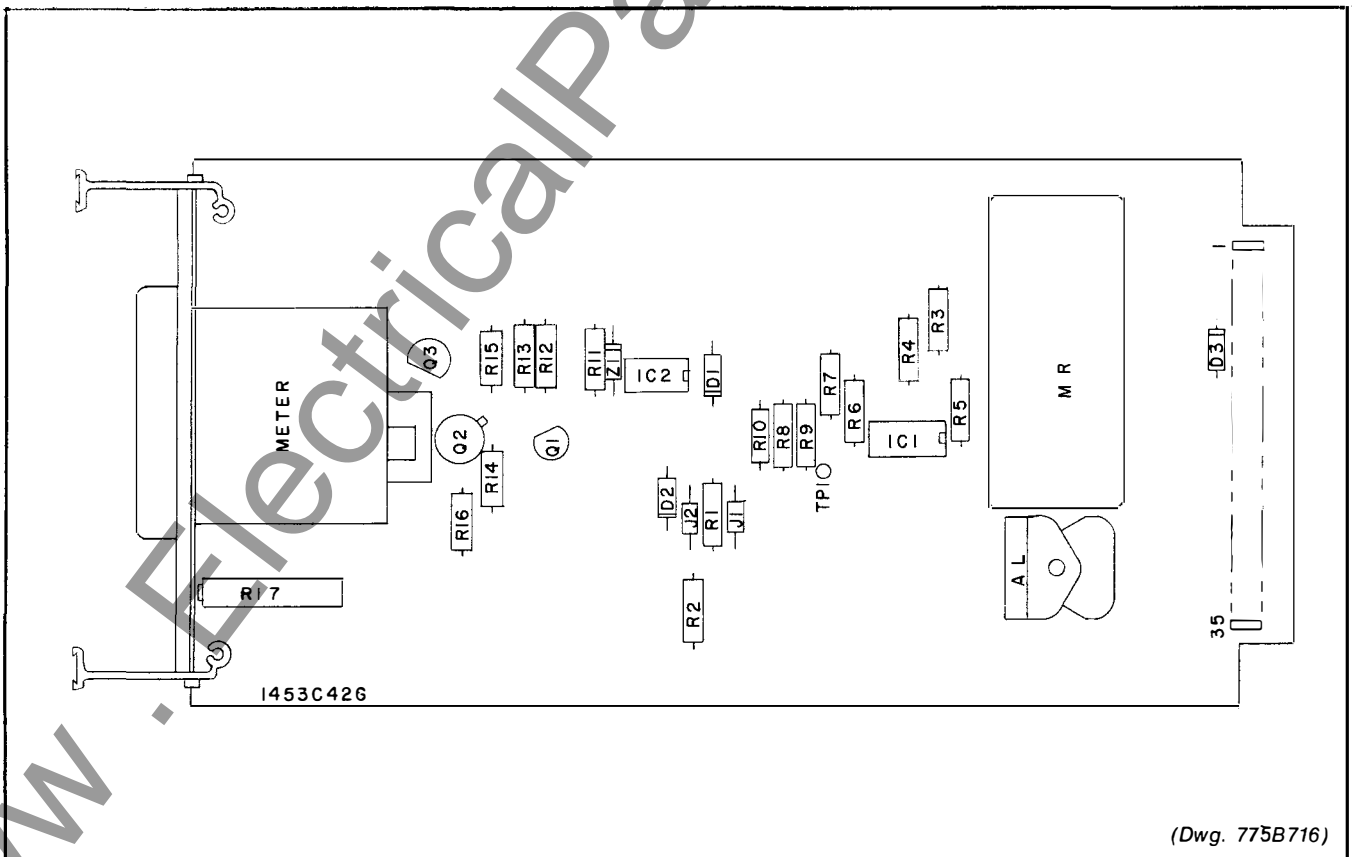


Fig. 16. Component Location Output Module - Contact Output.

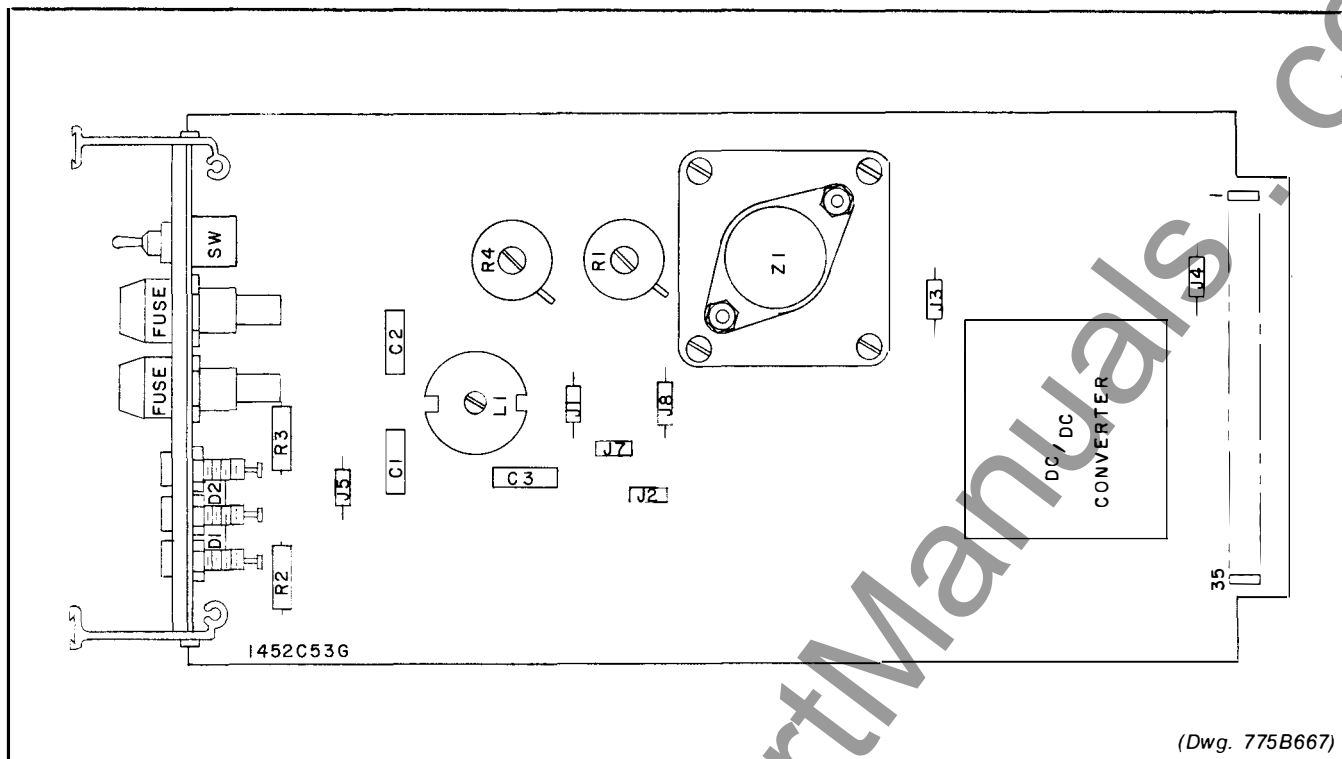


Fig. 17. Component Location Power Supply Module.

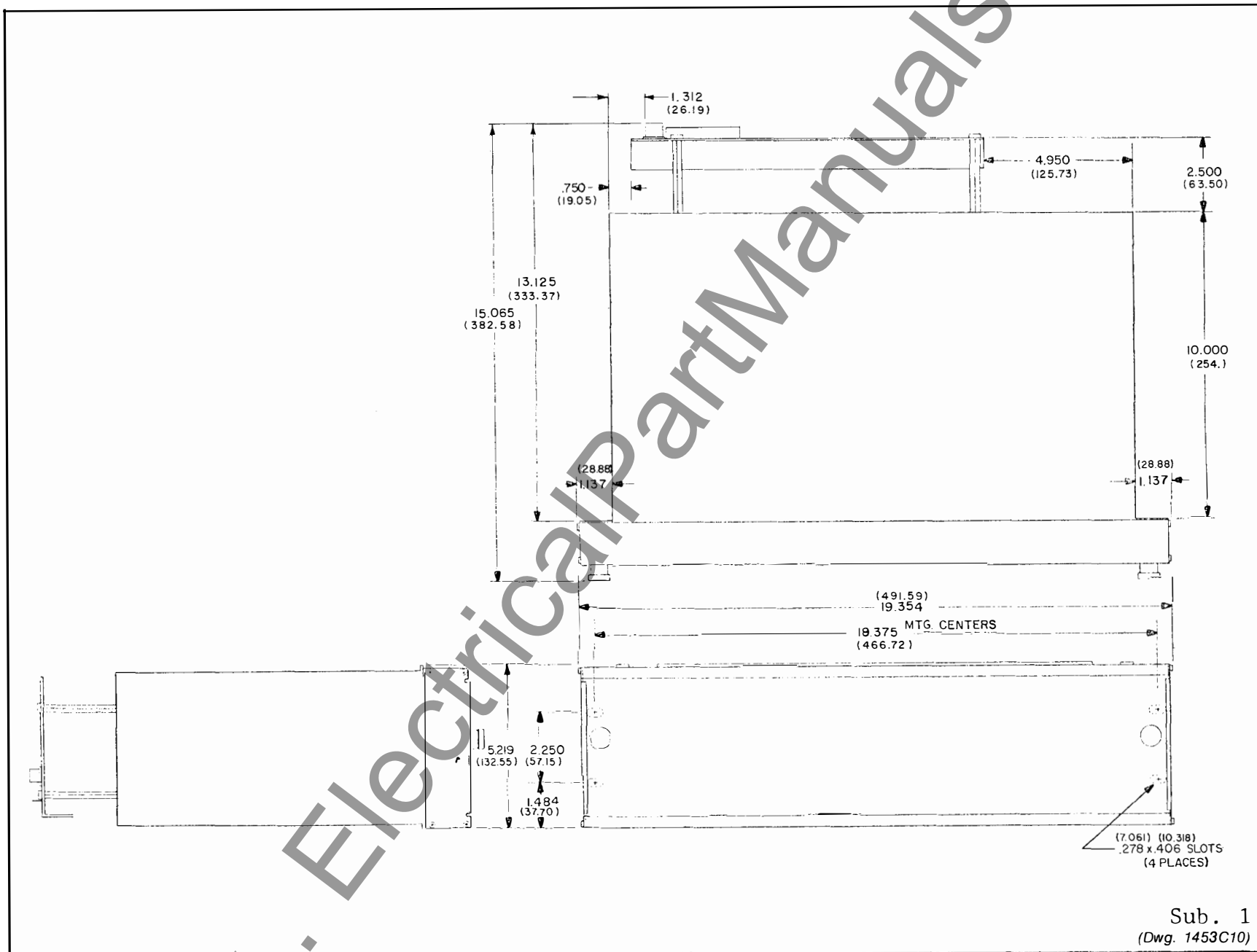
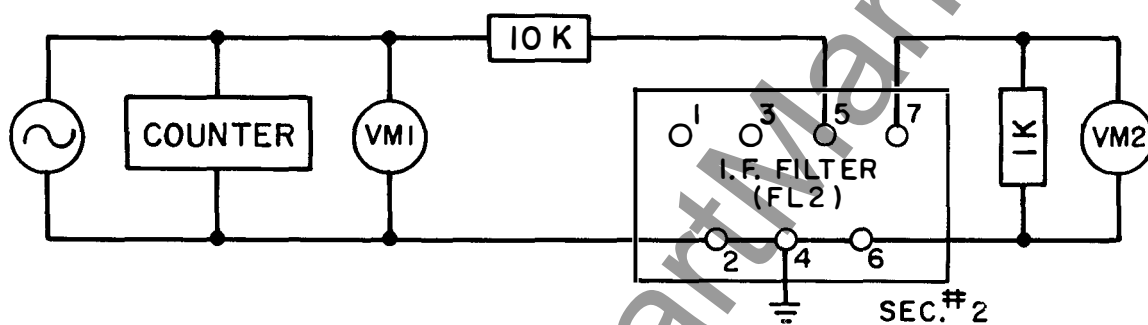
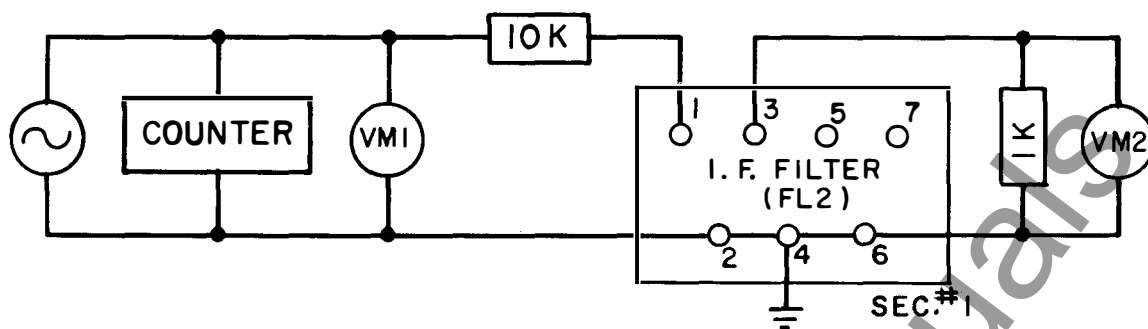
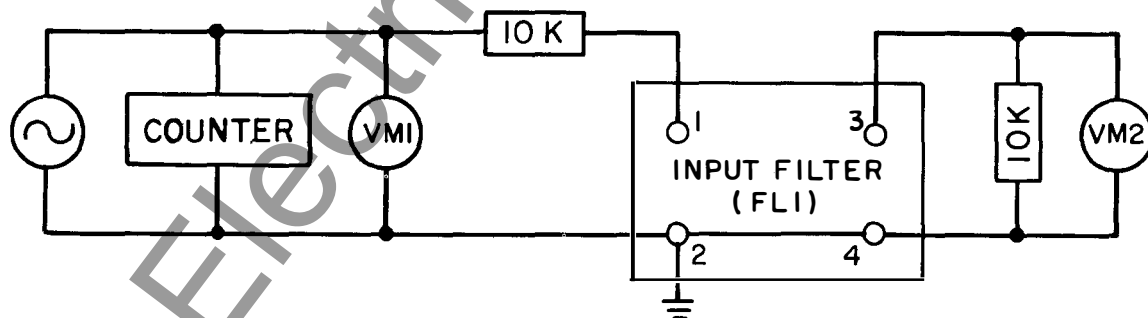


Fig. 18. Outline TCF-10 Receiver.



I. F. FILTER TEST CIRCUIT CONNECTIONS



INPUT FILTER TEST CIRCUIT CONNECTIONS

Sub. 1
(Dwg. 849A109)

Fig. 19. Test Circuits for TCF-10 Receiver Filters.

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